UNISYS

BT 3200 Series 324X/326X/328X Magnetic Tape Subsystem

Maintenance Manual

Class B Document

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	UNISYS Model No.	Description Model No.
	ONISIS MODEL NO.	bescription model no.
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	3242	F617A2
	3 2 4 4	F617B
	3243	F617E
ed of the latest and	3261	F618A1
	3262	F618A2
ANGERS CONTROL	3266	Fó18B
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TST6240

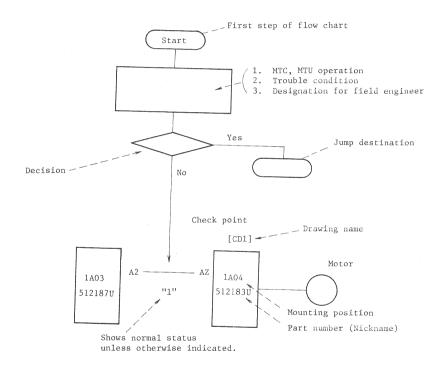
PLAN 1 Introduction, How to Use the MAP

Introduction

This Maintenance Manual describes tracing of visible trouble and tracing of trouble from sense data. It also includes checking and adjustment in OFFLINE mode and part replacement.

How to use the MAP

The symbols used in this manual are described below:



PLAN 2 How to Use the OLTE

I. The Online Test Program (OLTE) is used for the following purposes.

Trace of trouble Checking after trouble correction Preventive maintenance

The general flow charts of maintenance procedure, including OLTE running for these purposes, are shown in MAP50 and MAP90.

OLTE is composed of several sections and can be grouped in following four parts.

Each section in these groups may be choosed by means of maintenance purpose. The contents and purposes of each section are detailed in the OLTE GUIDE.

A. Magnetic tape subsystem function test (JYOMT6A-G)

This group tests basic operation of the magnetic tape subsystem. When an error is detected in these sections, trace of trouble is performed by MAP $00001\ ^{\circ}$ according to the sense data and the error messages.

B. Magnetic tape subsystem running test (JYOMT6H-I)

The read/write operation and data transfer functions are tested. This group is used in the case of read/write trouble and preventive maintenance.

When an error is detected in these sections, trace of trouble is performed by MAP D0001 $^{\circ}$ according to the sense data and the error messages.

C. MTC diagnosis (JYOMT6DA-DK)

Error detection and correction functions in the MTC are checked by diagnostic read/write operation.

When an error is detected in these sections, trace of trouble is performed by MAP D0001 $^{\circ}$ according to the sense data and the error messages.

D. MTU prognosis

The MTU basic operation is tested by XFR mode of the set diagnose command. At the preventive maintenance, the machine is checked by MAP TST6220 $^{\circ}$ according to MTU prognose data.

E. MTC function test (JYOMT6K-M, FA-FZ, SB-SL)

This is the function tests for the MTC which aim primarily at testing the control function of the MTC on the reserve/release operation of the MTU, the functions accompanied by the cross-call constitution, and high speed functions.

II. Starting of OLTE

When the on-line test program (OLTE) has responded to the output message from the control program (OLTEC), it is loaded by control program and the execute phase is transferred. Response format is shown below.

DEVICE/TEST/OPTION

DEVICE: Device address

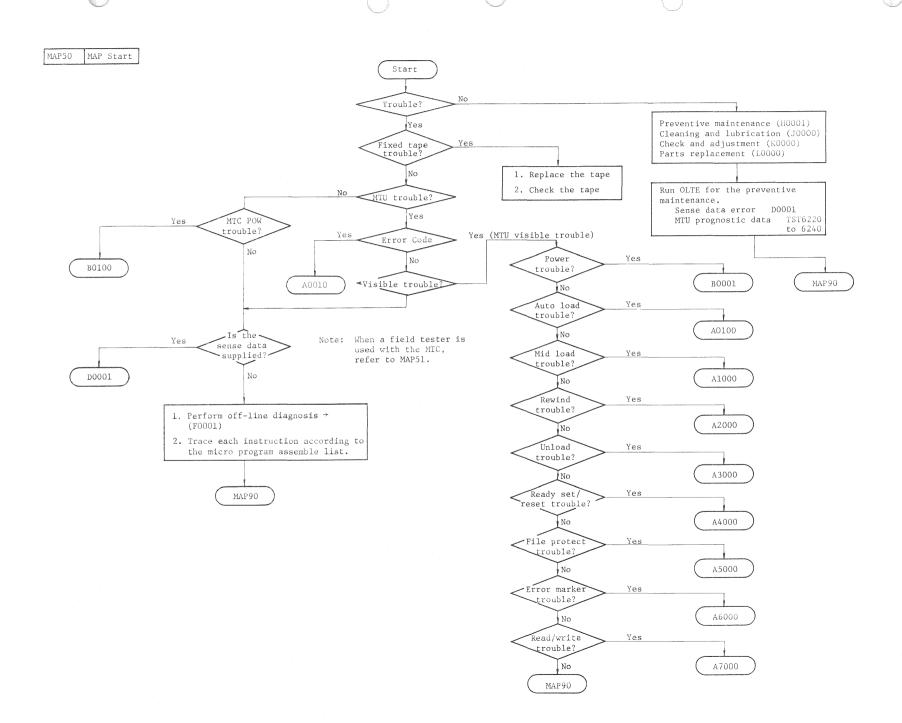
This address is pre-determined at the time of system generation.

TEST: Section name

Specify the section name of the test module.

OPTION: Option and reference value

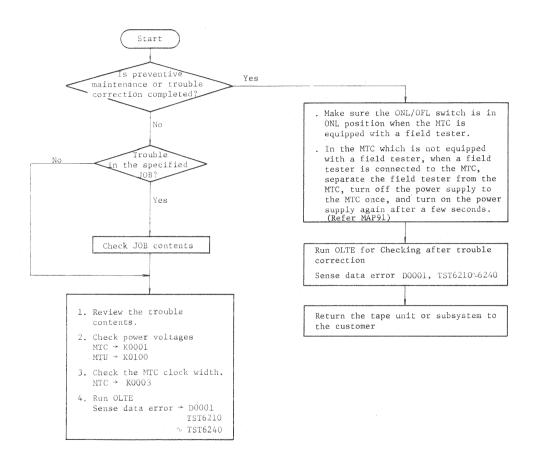
This can assign CP, FE, LP, TL, MI, EX, etc. (Refer to the OLTE Guide in detail.)



A field tester may be connected to the MTC for the maintenance purpose. When a field tester is connected to the MTC, the state of the ONL/OFL switch of the field tester connected to the MTC exerts influence on the MTC (when the MTC changes the operating mode from ONLINE to OFFLINE or vice versa, a system reset signal is issued). Accordingly, attention must be paid for the environment of the MTC to which a field tester is connected such as one that there is no job using this MT subsystem. Either one of the following ways is desirable for the connection of a field tester and the MTC.

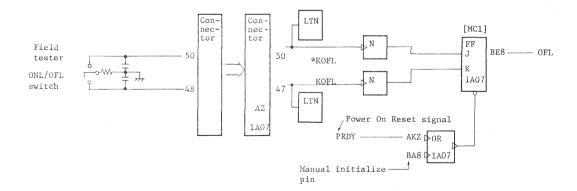
- A field tester is connected to the MTC when the power supply to the MTC is off.
- (2) To connect a field tester to the MTC while the power supply to the MTC is kept on, the connection may be done with the power supply being kept on if the MTC may be put to the offline status.
- (3) To connect a field tester to the MTC while the power supply to the MTC is kept on, the following procedure is used if the MTC needs to be kept in the online status.
 - 1) Clip BA8 card pin on 1A07 column at 0 V.
 - Connect a field tester to the MTC, in the location 1A07 Port A with the ONL/OFL switch on field tester remaining the ONL position.
 - 3) In the case where only the display function of field tester is used, BA8 card pin on 1A07 column may be left clipped. In the case where the control function of field tester is used (CNT or SSS switch is operated), release the BA8 card pin on 1A07 column clipped at 0 V. (Refer to MAP91)





When a field tester connected to the MTC is separated, the status of the MTC might become indefinite either ONLINE status or OFFLINE status due to the state or chattering of the ONL/OFL switch of the field tester which may occur. Accordingly, the separation of field tester should be done by one of the following ways.

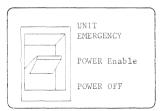
- (1) CE panel is separated when the power supply to the MTC is OFF.
- (2) CE panel may be separated when the power supply to the MTC is ON, but after that turn off the power supply to the MTC once and after a few seconds turn on the power supply again. When the power supply is turned on again, the MTC is always initialized into the online status.
- (3) When it is not desirable to turn off the power supply, the MTC can be initialized into the online status by manually clipping card pin BA8 on 1A07 column at 0 V.



MAP0120 How to Reset UEPO Switch

Because an emergency happened, UEPO SW was set to OFF; it cannot be set to Power Enable from the front.

After removing the cause of the emergency, open the rear door at buck of the unit and push the switch indicated by the arrow in Fig. 3 Rear View; the UEPO switch can be set to Power Enable.



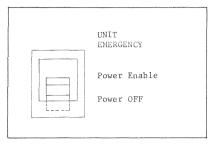


Fig. 1 Front view

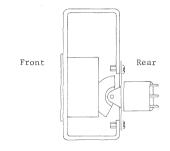


Fig. 2 Side view

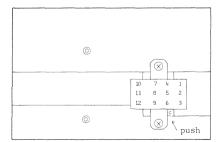
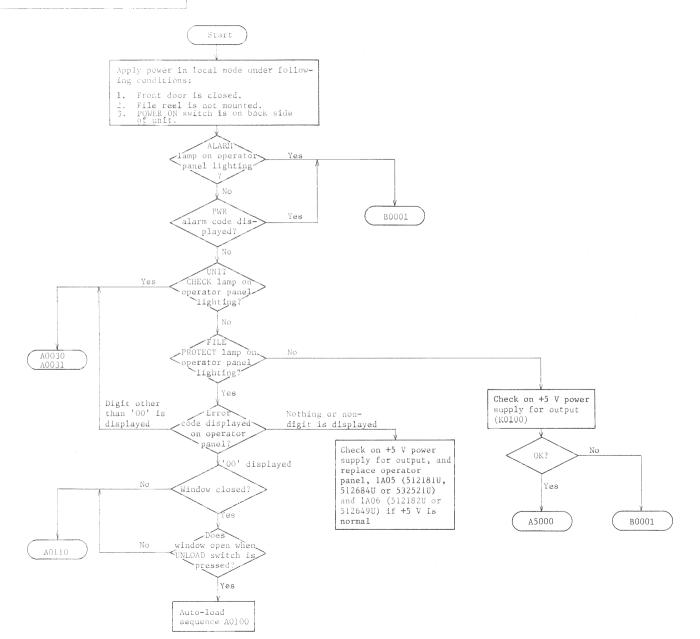


Fig. 3 Rear view



A0010 Error Code Assign Table (1)

1. Error codes listed in the following table each indicate the abnormal conditions occurring in arithmetic circuits, registers, timers, counters, or sense signal at the time of power on.

Error	Content of error	Cause of error	MAP No.
00	Parity error of the ROM detected before starting execution of the microprogram. (When the Unit Check LED lights.)	Hard-ER	A0030
01	Faulty arithmetic operation of ALU (Arithmetic Logic Unit)	Hard-ER	A0030
02	Faulty execution of a subroutine of microprogram	Hard-ER	A0030
03	Faulty operation of register at file address $\$00\ ^{\circ}\03	Hard-ER	A0030
04	Faulty operation of register at file address $\$04 \sim \07	Hard-ER	A0030
05	Faulty operation of register at file address $$508\ ^{\circ}\ \$0B$	Hard-ER	A0030
06	Faulty operation of generated register at file address $\$0C \sim \$0F$	Hard-ER	A0030
07	Faulty operation of timer 0 at file address \$10	Hard-ER	A0030
08	Faulty operation of timer 1 at file address \$11	Hard-ER	A0030
10	Faulty operation of the counter at file address \$12	Hard-ER	A0030
11	Faulty operation of general register at file address \$13	Hard-ER	A0030
1.2	Some of bits 0, 4, and 5 at file address \$14 are wrong.	Hard-ER	A0031
13	Some of bits 0, 1, and 4 at file address $$15$ are wrong.	Hard-ER	A0031

Error	Content of error	Cause	MAP No.
code		of error	
14	Faulty operation of general register at file address \$18.		
15	Either bit 6 or bit 7 at file address \$17 is wrong.	Hard-ER	A0031
16	Faulty operation of the register at file address \$18	Hard-ER	A0030
17	Some of bits 0 to 5 in file address \$19 are wrong.	Hard-ER	A0031
18	Some of bits 0 to 5 in file address \$1A are wrong.	Hard-ER	A0031
19	Some of bits 3, 4, and 5 in file address \$13 is wrong.	Hard-ER	A0031
20	Bit 0 in file address \$1C is wrong.	Hard-ER	A003I
21.	Some of bits 1, 2, 5, 6, and 7 in file address \$1D are wrong.	Hard-ER	A0031
22	One of read data detecting signals TMSR0 ~ 7 in file address \$1E is erroneously set at '1'	Hard-ER	A0031
23	One of read data detecting signals TMSR0 $^{\circ}$ 7 in file address \$1E is erroneously set at '0'	Hard-ER	A0031
24	One of bits 0, 1, 2, 3, 4, 6, and 7 in file address \$1F is erroneously set at '1' or bit 5 is erroneously set at '0'	Hard-ER	A0031
25	One of bits 2, 3, and 4 in file address \$1F is erroneously set at '0' or bit 5 is erroneously set at '1'	Hard-ER	A0031

A0011 Error Code Assign Table (2)

2. Abnormality of internal components

Error code	Content of error	Cause of error	MAP No.
28	A parity error was detected in ROM during the execution of an instruction	Hard-ER	A0030
29	A parity error occurred in register LSI in file address \$00 to \$0B.	Hard-ER	A0030

3. Abnormality in the servo off status

Error	Content of error	Cause of error	MAP No.
30	Current flows even after resetting the error marker drive.	Hard-ER	A0043 A6000
31	The window does not close within a prescribed time.	OP-Miss Hard-ER	A0110
32	Reel Hub Lock signal was erroneously detected.	Hard-ER	A0041
35	Door open was detected during unloading.	OP-Miss Hard-ER	A0420
36	File Column In Signal is not set to OFF state during unloading.	Hard-ER	A3020
37	Machine Column In signal is not set to OFF state during unloading.	Hard-ER	A3020
38	Tape Present signal is not set to OFF state when the tape is wound up by both reels for a con- tain prescribed time during unloading.	Hard-ER	A3030
39	Failure of forced unload		

4. Abnormality during auto loading

Error code	Content of error	Cause of error	MAP No.
40	Door open was detected during auto loading.	OP-Miss Hard-ER	A0420
41	Cartridge does not open.	Hard-ER	A0120
42	The low tape cannot be detected within a prescribed number of rotations of the machine reel.	Hard-ER	A0300
43	Auto hub is not locked.	Hard-ER	A0320
44	Load/rewind or Unload key pressed while door had opened.		
45	The window is not closed.	Hard-ER	A0110
46	File Column In signal was erroneously detected.	Hard-ER	A0310
47	Machine Column In signal was erroneously detected.	Hard-ER	A0310
48	Tape Present signal is detected even after the tape is wound up for load retry.	Hard-ER	A3030
49	The tape has not passed the BOT/EOT sensor (Tape Present signal is not detected.)	Hard-ER	A0350
50	Reel Loaded signal was erroneously detected.	Hard-ER	A0360
51	Reel Loaded signal is not detected.	Hard-ER	A0360
52	The length from the starting tip of tape to the BOT marker is too short.	OP-Miss	A0380
53	BOT marker cannot be detected within a certain prescribed distance.	OP-Miss Hard-ER	A0400
54	Machine Column In signal is not detected.	Hard-ER	A0310
55	File Column In signal is not detected.	Hard-ER	A0310
56	Loop alarm was detected after machine reel column in.	Hard-ER	A0430
57	Loop alarm was detected after file reel column in.	Hard-ER	A0430

A0012 Error Code Assign Table (3)

5. Abnormality in the servo on status

Error code	Content of error	Cause of error	MAP No.
60	Loop alarm in file reel column is detected when the capstan speed down (HSCF) is on.	Hard-ER	
61	Loop alarm in file reel column is detected when the capstan speed down (HSCF) is off.	Hard-ER	A0170 A2000
62	Loop alarm in machine reel column is detected when the capstan speed down (HSCM) is on.	Hard-ER	A0170
63	Loop alarm in machine reel column is detected when the capstan speed down (HSCM) is off.	Hard-ER	A0170 A2000
64	Reel hub lock was released.	Hard-ER	A0320
65	Door open was detected.	Hard-ER	A0420
66	Left tape-loop alarm detected in servo-on state (HSCF = 1)		
68	Window open detected while tape running	Hard-ER	A0460
69	Failure of auto-cleaner while tape running	Hard-ER	A0470

6. Abnormality in the capstan system

Error code	Content of error	Cause of error	MAP No.
70	Tacho pulse cannot be detected when capstan motor is started.	Hard-ER	A0550
71	The phase of capstan tacho pulse A/B is wrong.	Hard-ER	A0550
72	Capstan repeats turning during position control. (Direction Detecting signal OD remains set at '1'.)	Hard-ER	A0500
73	Capstan does not turn back and forth during position control. (Direction Detecting signal OD remains set at '0'.)	Hard-ER	A0500
74	A range of stop position of capstan is too long (longer than $\pm 36~\mathrm{QTP}$).	Hard-ER	A0450
75	The stop position of capstan is not stable even when servo lock is applied after capstan stops.	Hard-ER	A0450

A0013 Error Code Assign Table (4)

7. Abnormality in the read/write system

Error	Content of error	Cause of error	MAP No.
80	Write voltage was turned to on during the read status, or write voltage is not turned to off within a prescribed time.	Hard-ER	A0330
81	Write voltage was turned to off during the write status, or write voltage is not turned to on within a prescribed time.	Hard-ER	A0330
82	Erase current was turned to on during the read status, or erase current is not turned to off within a prescribed time.	Hard-ER	A0330
83	Erase current was turned to off during the erase status, or the erase current is not turned to on within a prescribed time.	Hard-ER	A0330
84	An error occurred in the +12 V power supply.	Hard-ER	A0330
85	Write voltage could not be turned to on within a certain distance during write operation in the streaming mode.	Hard-ER	A0340
86	The file protect was turned to on during write erase operation.	OP-Miss Hard-ER	A5000
87	The file protect was turned to on during the DSE (Data Security Erase) operation.	OP-Miss Hard-ER	A5000
88	An error occurred in level setting for PE mode.	Hard-ER	A0044

8. Other abnormality

Error	Content of error	Cause of error
99	Error occurs frequently in tape medium (Error is to be displayed after unloading is completed. However, the Unit Check LED is off.)	Tape medium Hard-ER

9. Abnormality during troubleshooting

Error code	Content of error	Cause of error	MAP No.
0	Capstan Tacho Pulse A is erroneously set at '0', or it remains at '0' for one cycle during high speed rotation.	Hard-ER	A0550
1	Capstan Tacho Pulse A is erroneously set at '1', or it remains at '1' for one cycle during high speed rotation.	Hard-ER	A0550
2	Capstan Tacho Pulse B is erroneously set at '0'.	Hard-ER	A0550
3	Capstan Tacho Pulse B is erroneously set at 'l'.	Hard-ER	A0550
	Duty of Capstan Tacho Pulse A is less than 40%.	Hard-ER	A0550
4	Faulty operation of the error marker drive system system	Hard-ER	A6000
	Duty of Capstan Tacho Pulse A is greater than 60%.	Hard-ER	A0550
5	Faulty operation of the cartridge opener drive system	Hard-ER	A0120
6	Duty of Capstan Tacho Pulse B is less than 40%.	Hard-ER	A0550
. 6	Faulty operation of the window drive system	Hard-ER	A0110
7	Duty of Capstan Tacho Pulse B is greater than 60%.	Hard-ER	A0550
8	The phase difference between Capstan Tacho Pulse A and B is less than 16%.	Hard-ER	A0550
9	The phase difference between Capstan Tacho Pulse A and B is greater than 34%.	Hard-ER	A0550

A0020	РСВ	Locati	on

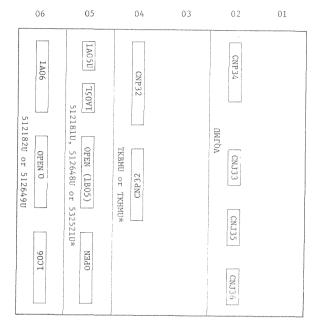
PCA location table

Location	Identifications	Designation
1A01		
1A02	B16B-7220-0020A#U	VQJMU
1A03		
1A04	B16B-7190-0020A#U or B16B-7190-0100A#U*	TKBMU or TKHMU*
1A05	C16B-5121-0810#U, C16B-5126-0480#U or C16B-5325-0210#U*	512181U, 512648U or 532521U*
1A06	C16B-5121-0820#U or C16B-5126-0490#U	512182U or 512649U

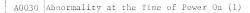
Note: The PCA marked * is used in 200 ips model.

Attentions at PCA replacement

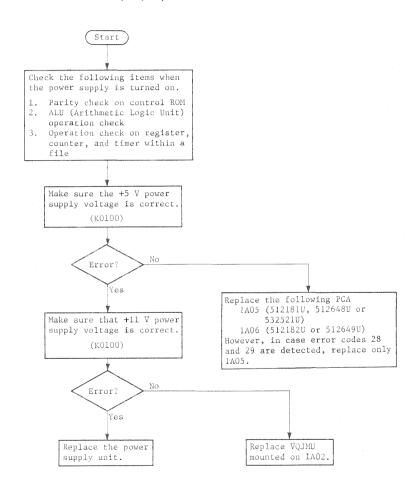
- 1. Turn off the power supply before the replacement.
- When replacing the PCA at Gate Section, you must use the Extraction tool
 Extraction tool: P/N C960-0300-T001
- 3. Attend to bending of PCA contact at installation. When using Card Extender too, attend to bending in same as above. Card Extender: P/N C960-0030-T029
- After replacement, connect the connector to the same position as before the replacement.



Install side view



Error Code 00 ∿ 11, 16, 28, 29



A0031 Abnormality at the Time of Power On (2)

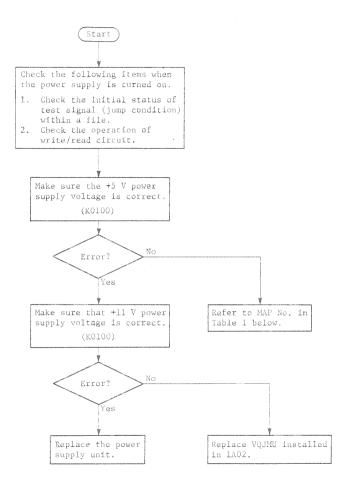
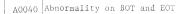
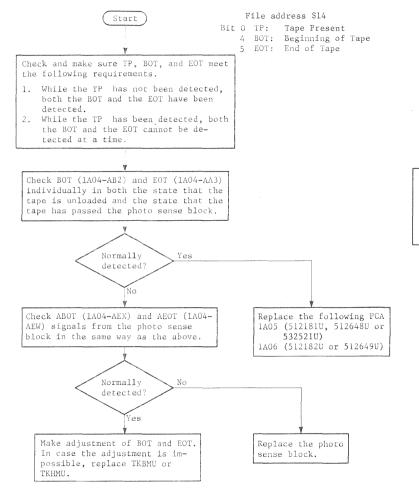


Table 1

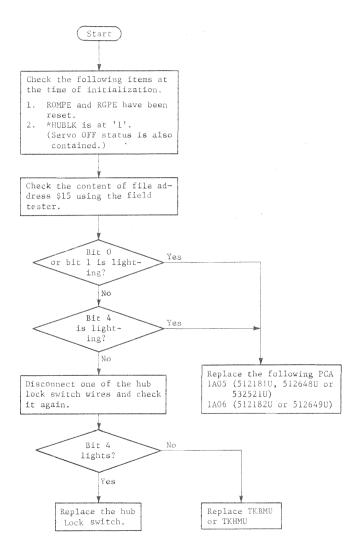
Error code	File address	Point of failure	Reference MAP No.	
12	\$14	There is inconsistency between three signals TP (Tape Present), BOT (Beginning of Tape), and EOT (End of Tape).	A0040	
13	\$15	Either ROMPE (ROM Farity Error) signal, RGPE (Register Parity Error) signal, or HUBLK (Hub Lock) signal is set.	A0041	
15	\$17	Either TSFL (Test Flag) signal or TST (Test Start) signal is set. Repla		
17	\$19	Either ONL (Online), INTRP (Interruption), UCHLD (Unit Check Hold), TUCHK (Tape Unit Check), GAPCT (Gap Control), or TWA (Tape Warning Area) signal is set.	following PCA 1A05 (512181U) 1A06 (512182U)	
18	ŞIA	Either RTLAL (Right Tape Loop Alarm), LTLAL (Left Tape Loop Alarm), HUBAL (Hub Lock Alarm), ECER (Erase Circuit Error), WCER (Write Circuit Error), or WRIST (Write/Reac PCA Installed) is wrong.	A0042	
19	\$1B	Either CLINF (Column In File), CLINM (Column In Machine), or EMMVD (Error Marker Moved) signal has been detected.	A0043	
20	\$1C	Failure in STEP6 (Step 6 ALL) - PE level setting operation	A0044	
21	\$1D	Either WVON (Write Voltage ON), ECON (Erase Current ON), AGCON (SAGC OK), or VELO.1 (Velocity Mode 0.1) signal is wrong.	A0045	
22	61.0	One of TMSR0 ${\scriptstyle {}^{\circ}}$ 7 (Time Sensor 0 ${\scriptstyle {}^{\circ}}$ 7) is erroneously set at '1'.	A0046	
23	- \$1E	One of TMSR0 \circ 7 (Time Sensor 0 \circ 7) is erroneously set at '0'.		
24	\$1F	Either GOB (Go Tag), STS (Status Tag), TMSR8 (Time Sensor 8), DNOIS (Detected Noise), DBOB (Detected Beginning of Block), DTM (Detected Tape Mark), or O (Logical '0') signal is erroneously set at '1', or DIBG (Detected Inter Block Gap) signal is erroneously set at '0'.	A0046	
25		Either TMSR8, DNOIS, or DBOB signal is erroneously set at '0', or DIBG signal is erroneously set at '1'.		







A0041 Abnormality on File Address \$15

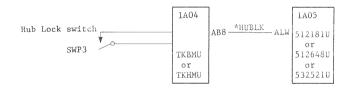


File address \$15

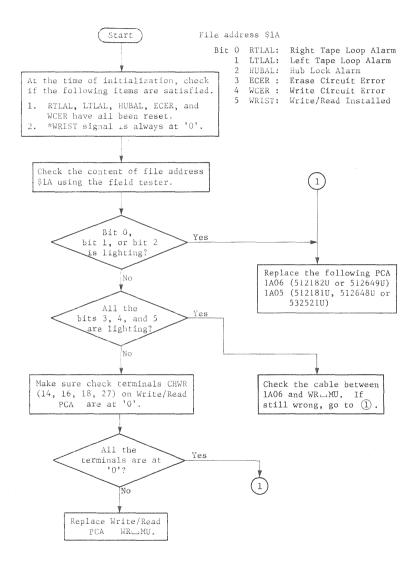
Bit O ROMPE: ROM Parity Error

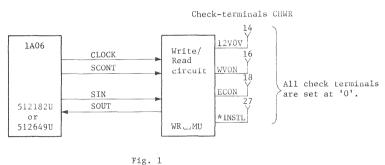
1 RGPE : Register Parity Error

4 *HUBLK: Hub Lock



A0042 Abnormality on File Address \$1A (Error Code = 18)





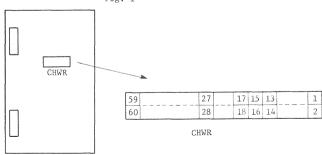
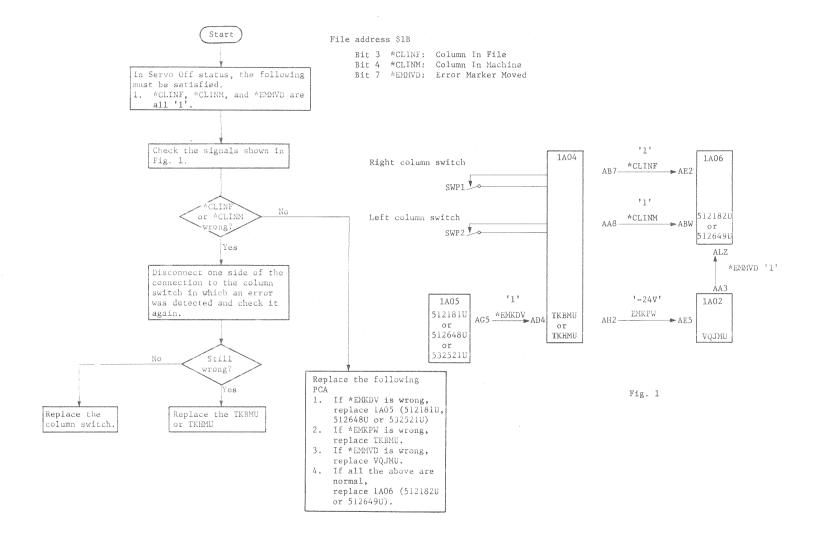
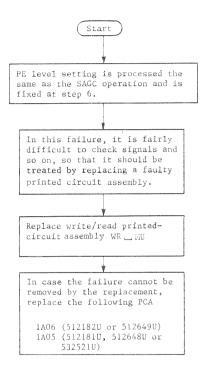


Fig. 2 Write/Read printed-circuit assembly (WR ... MU)



A0044 Faulty PE Level Setting



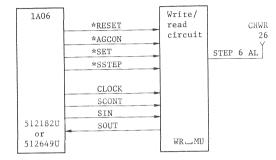
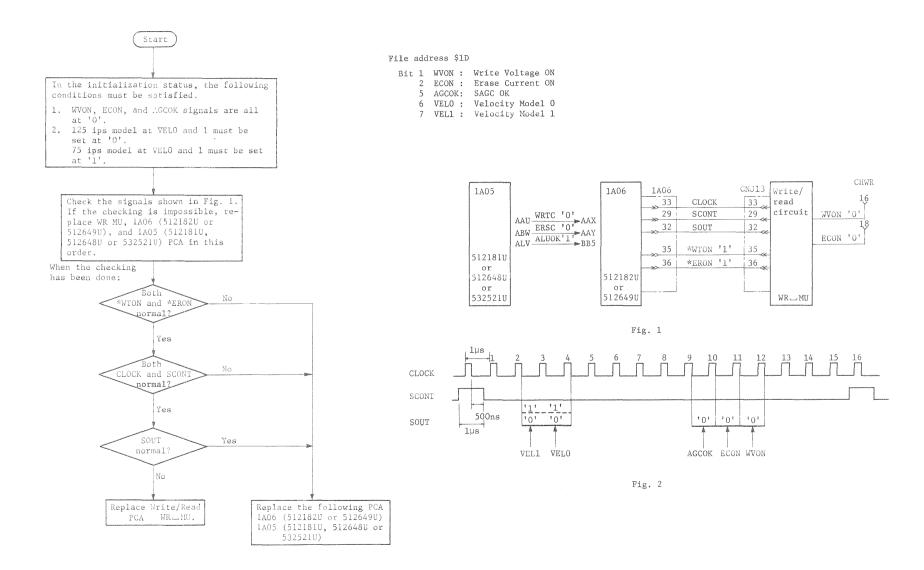
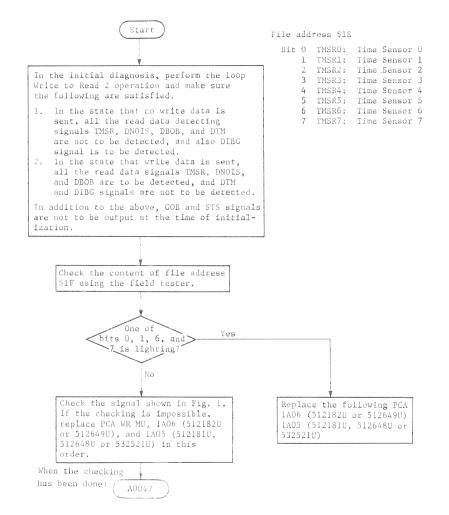


Fig. 1



A0046 Abnormality on File Address \$1E and \$1F (Error Codes = 22 to 25)



File address \$1F

Bit 0 GOB : Go Tag
1 STS : Status Tag
2 TMSR8: Time Sensor 8
3 DNOIS: Detected Noise
4 DBOB : Detected Beginning of Block
5 DIBG : Detected Inter Block Gap
6 DTM : Detected Tape Mark
7 0 : Logical 'O'

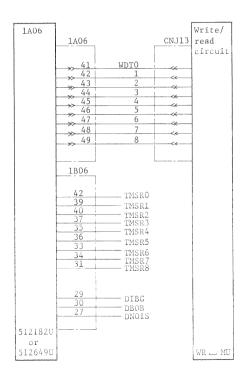
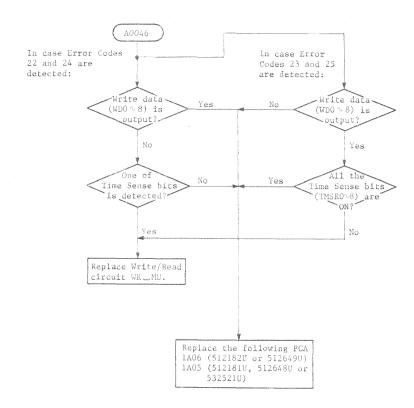


Fig. 1



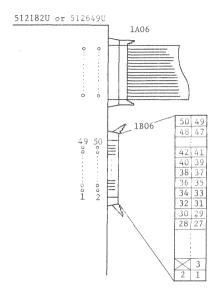
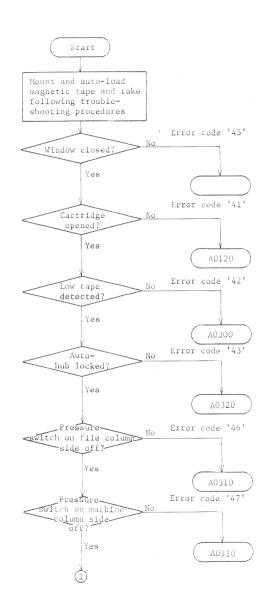
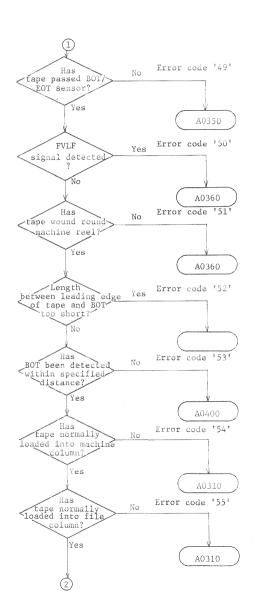
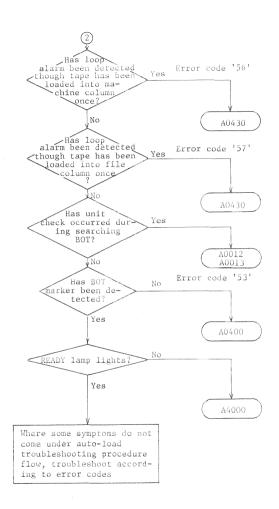
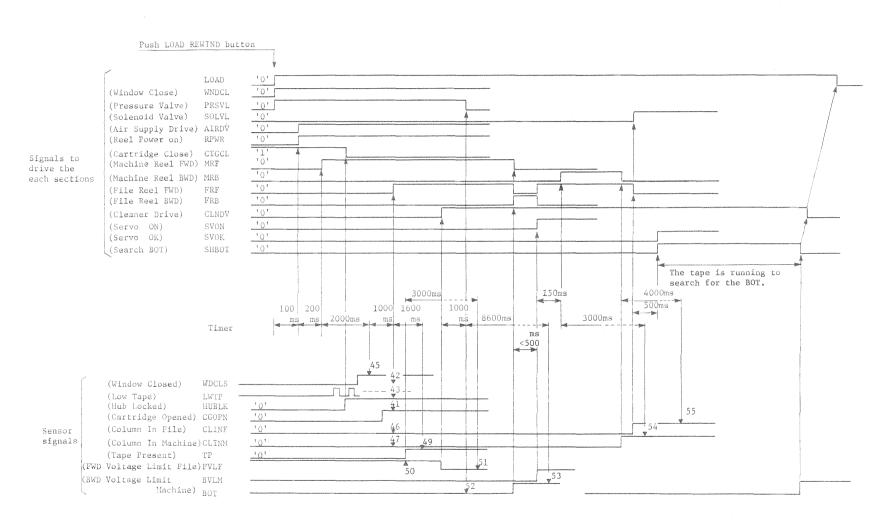


Fig. 2

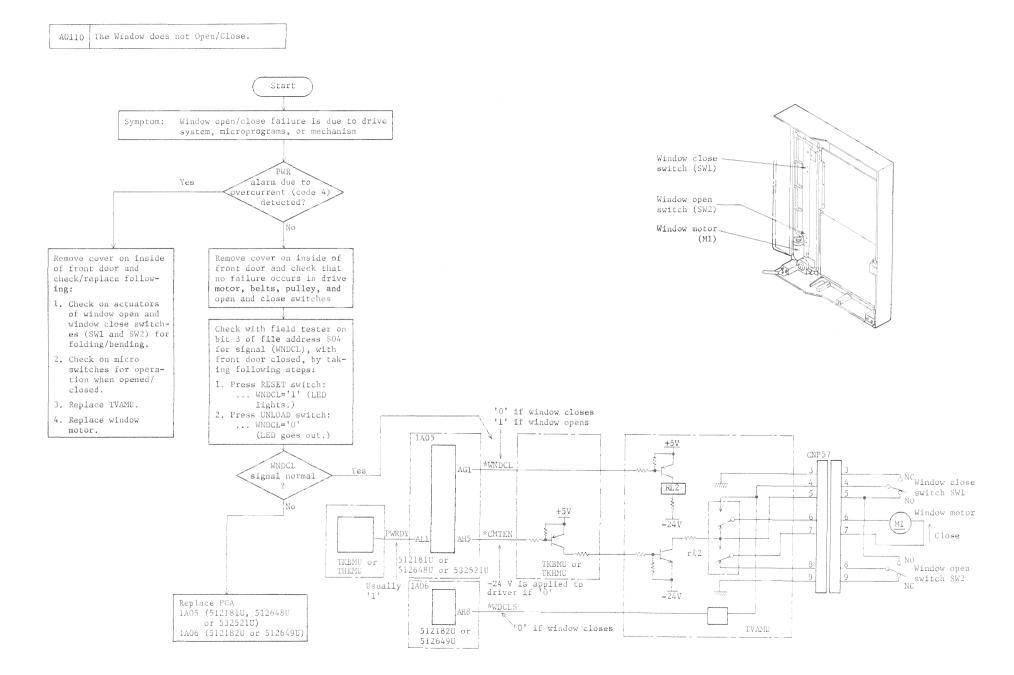


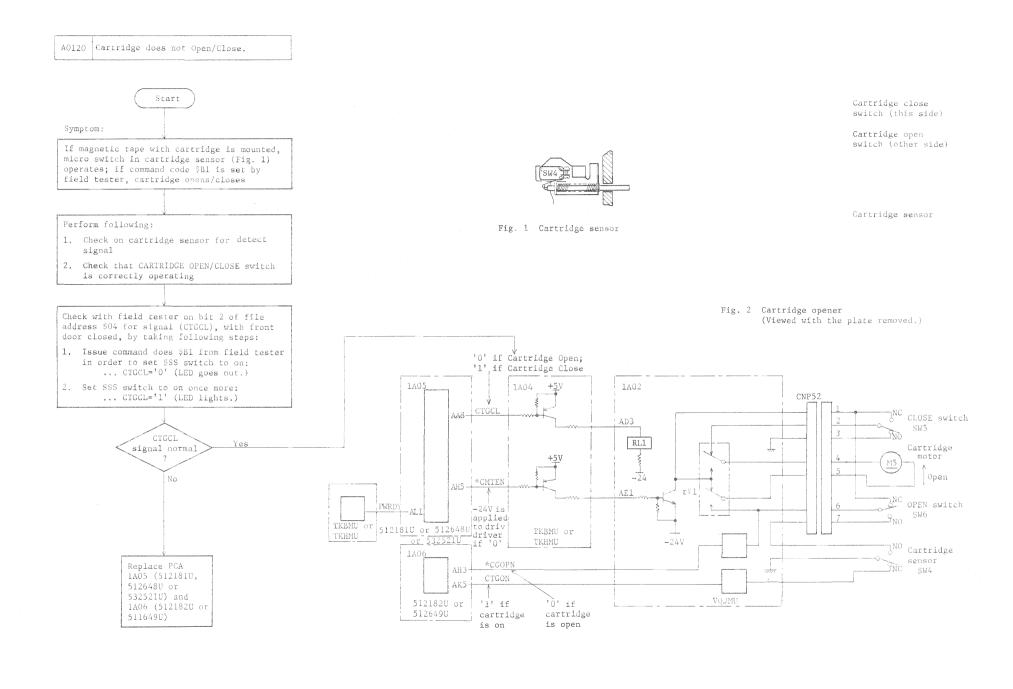


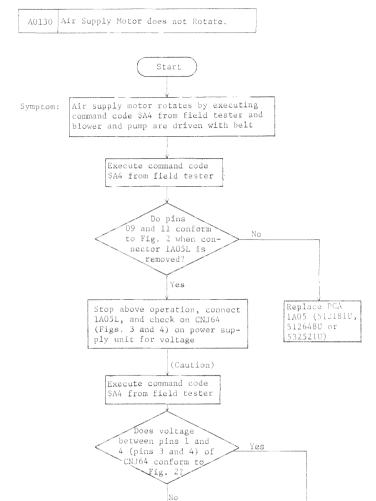




Note: The marks ' ψ ' indicate the timings when the program checks the logical level of each sensor during auto loading. The hexadecimal number in upper of the mark ' ψ ' means Error code which is set to ER register.







Power supply unit

failure

Replace air

supply unit

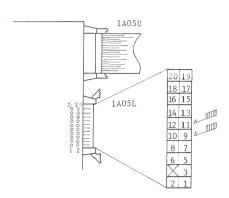


Fig. 1 Logic PCA at 1A05

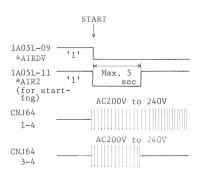


Fig. 2 Timing chart

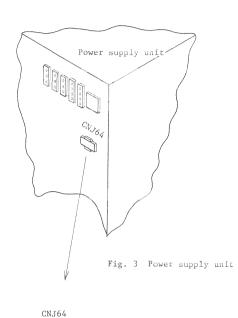




Fig. 4

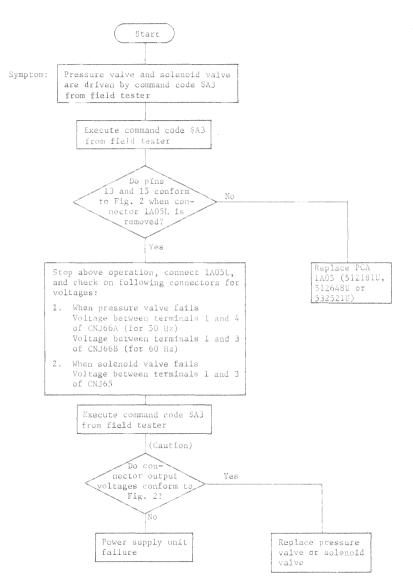
CAUTION

Special attention must be paid to checking in this area because dangerous voltage exists in the connector CNJ64.

Measurement points (connector pin number)

CNJ64 1-4 and 3-4





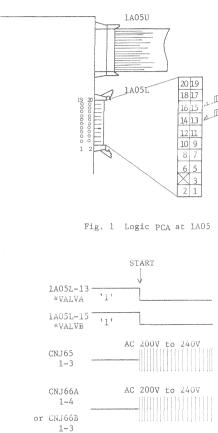
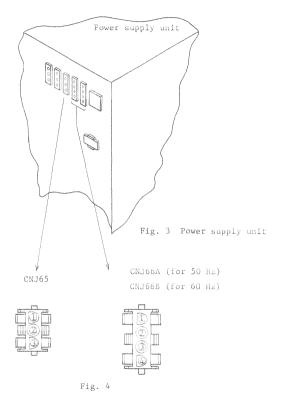


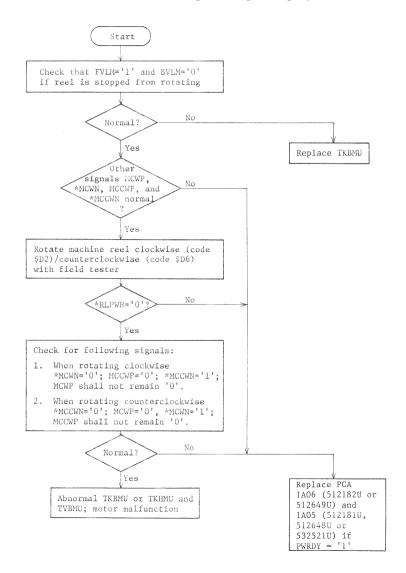
Fig. 2



CAUTION

Special attention must be paid to checking in this area because dangerous voltage exists in the connector CNJ65 and CNJ66A/B. Measurement point (Connector pin number) A0140 Machine Reel Motor Trouble

Symptom: The machine reel does not rotate during unloading/loading tape.



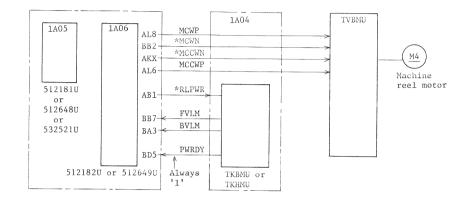


Fig. 1

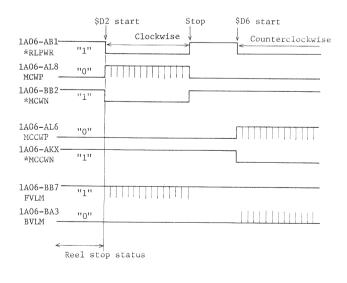
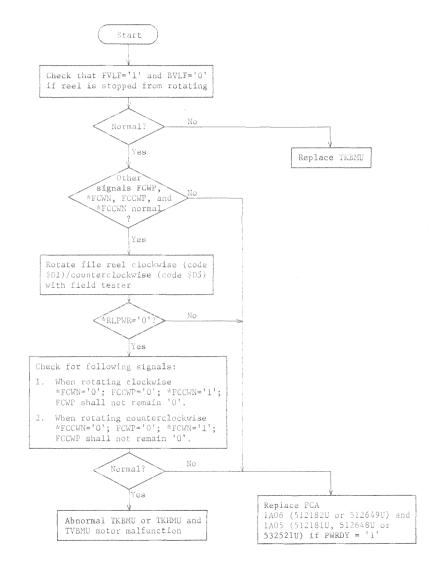


Fig. 2

A0141 File Reel Motor Trouble

Symptom: The file reel does not rotate during loading/unloading tape.



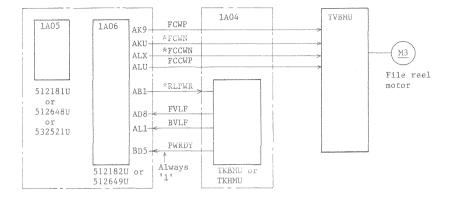


Fig. 1

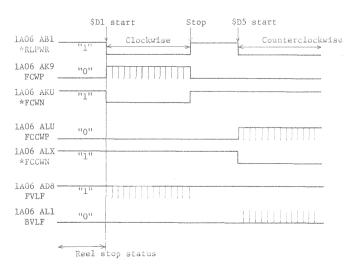
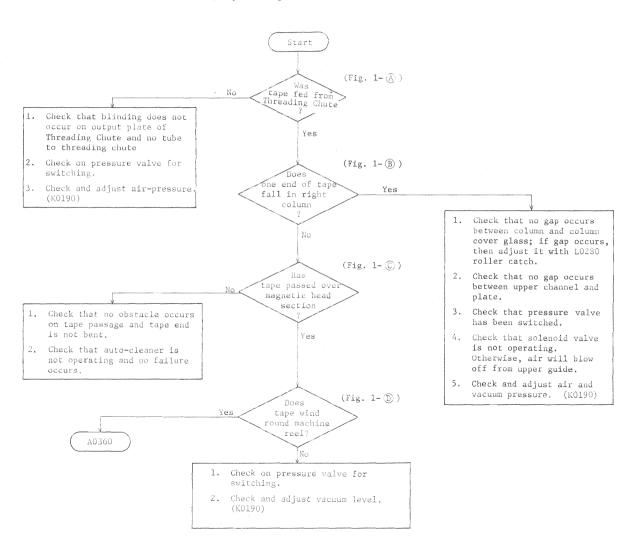


Fig. 2

A0150 Tape is not wound to the Machine Reel

Symptom: Tape does not wind round machine reel even though it has been loaded from file reel; tape running trouble has occurred.



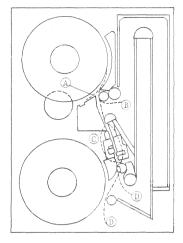
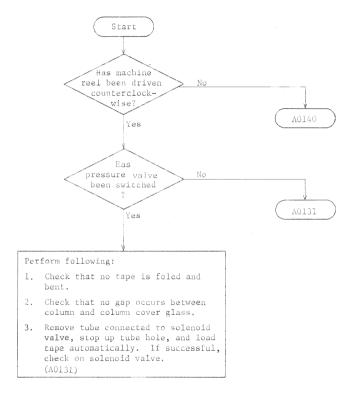
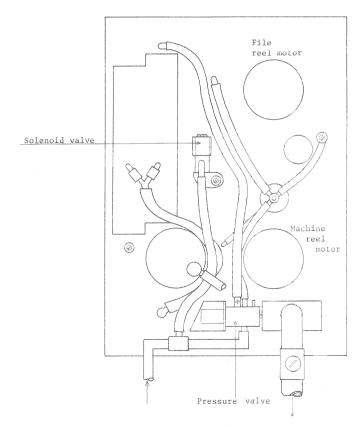


Fig. 1

A0160 Column-In Fail

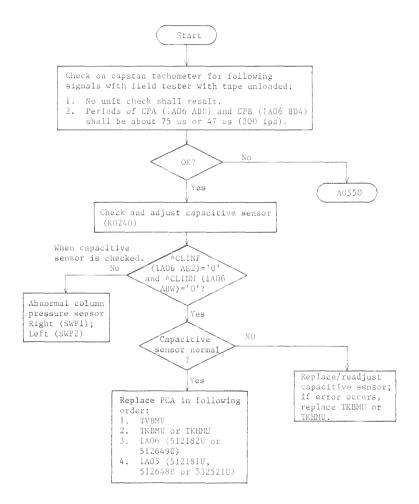
Symptom: Machine reel is driven counterclockwise and tape is loaded into both columns if tape has wound round machine reel and BOT detected during automatic loading.

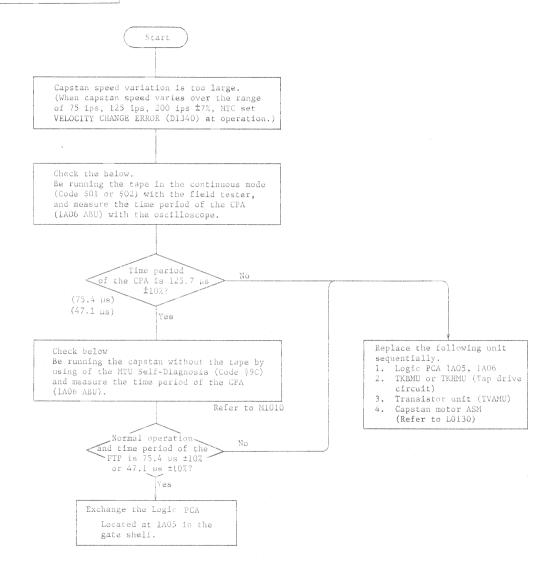


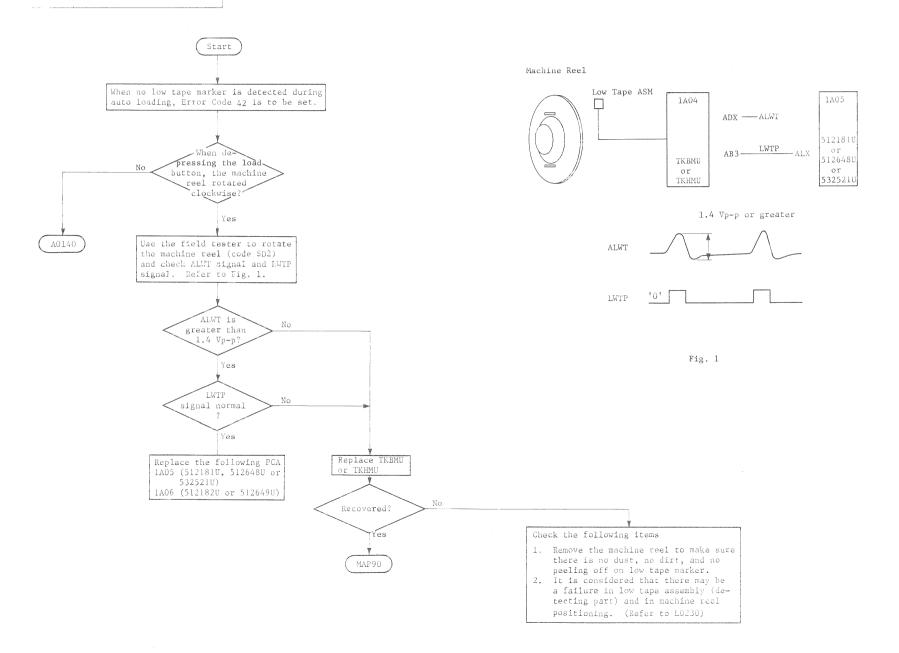


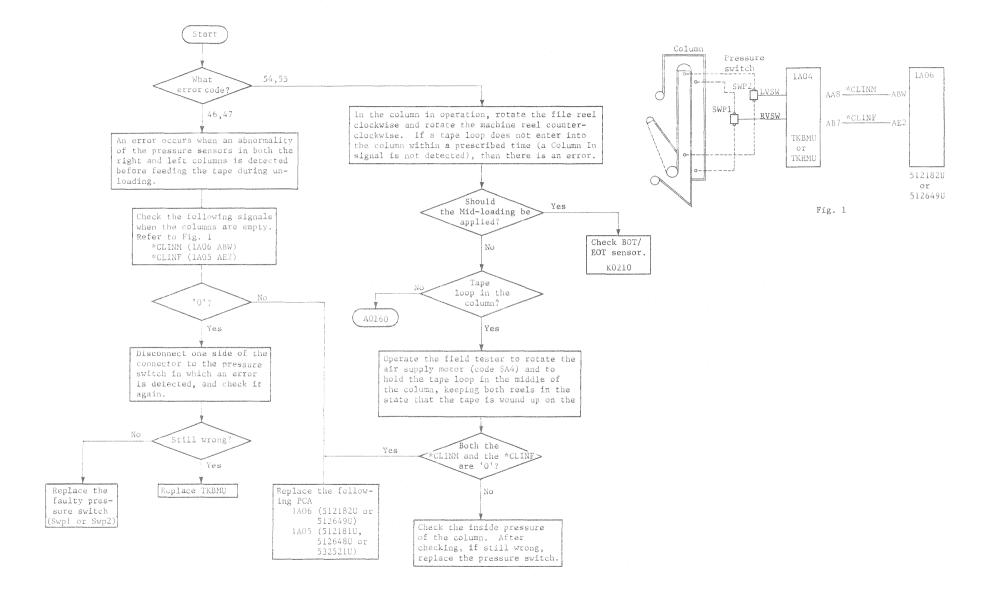
A0170 Tape Loop Vibration in Column is Considerable Size.

Symptom: A unit check results if tape loop in the column passes the warning detection hole with the servo set on.



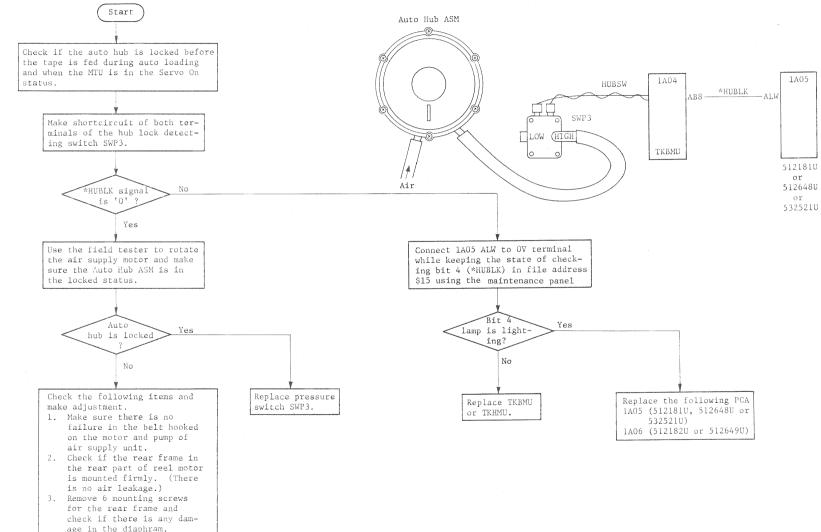


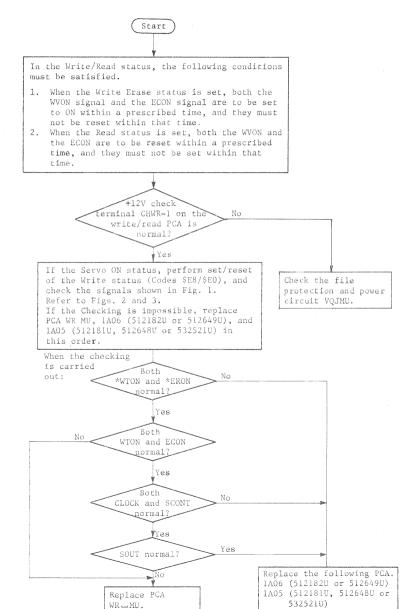






4. Check and adjust the blowout air pressure. (K0190)





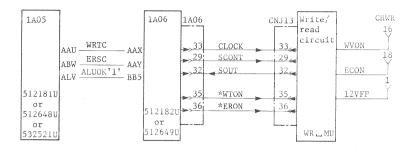


Fig. 1

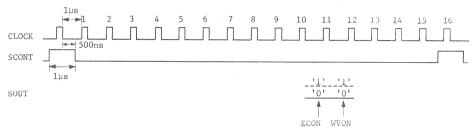


Fig. 2

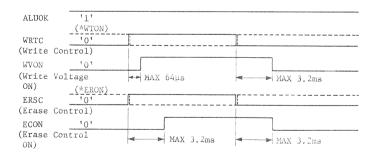
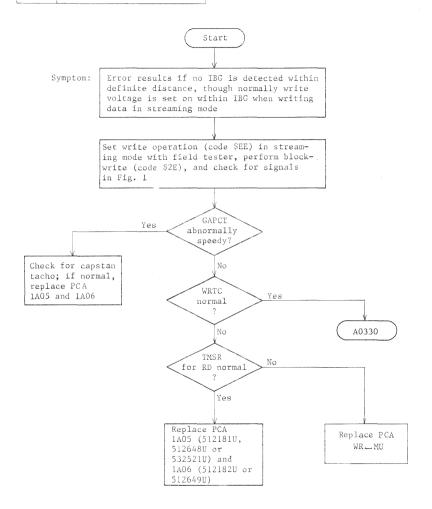
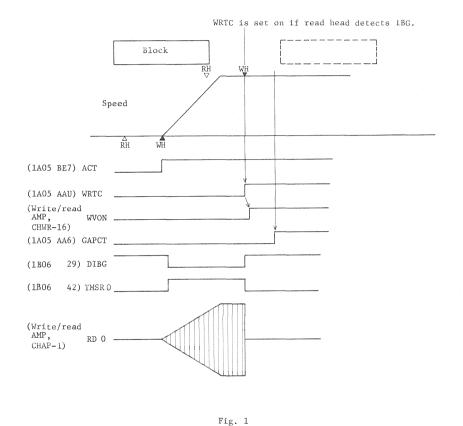
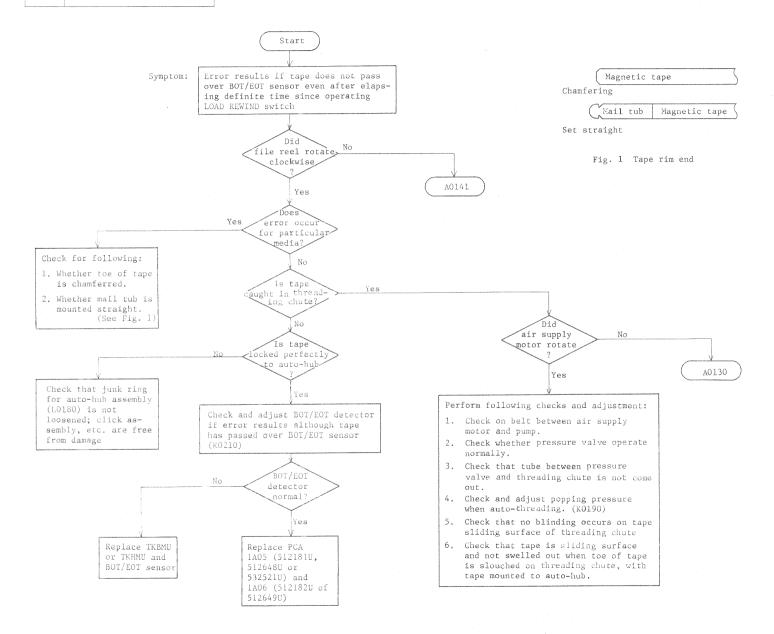


Fig. 3

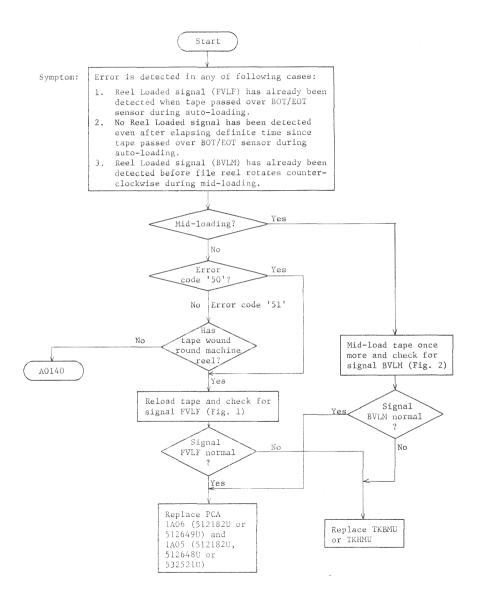








A0360 Error Code = 50, 51



FVLF: Forward Voltage Limit File
BVLM: Backward Voltage Limit Machine

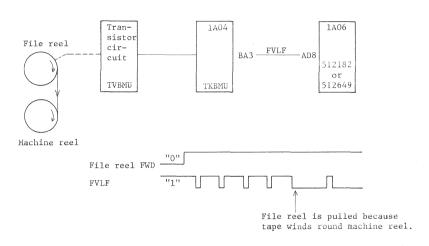


Fig. 1 Reel Loaded check when auto-loading

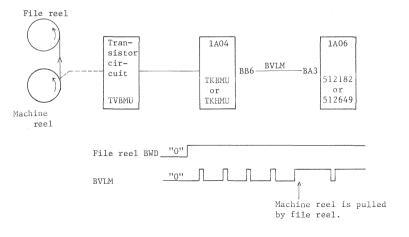
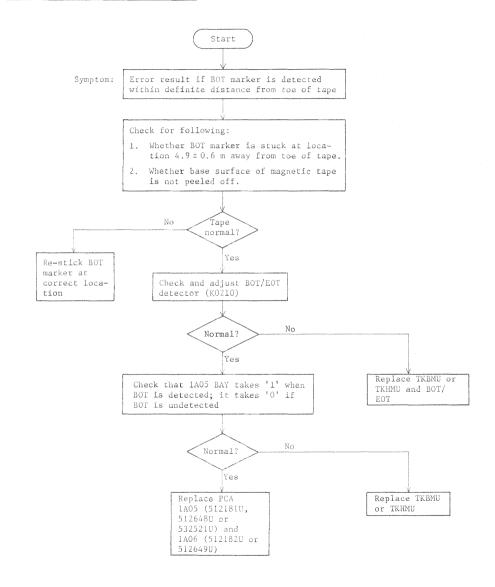
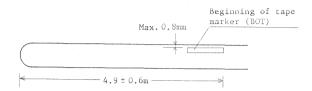


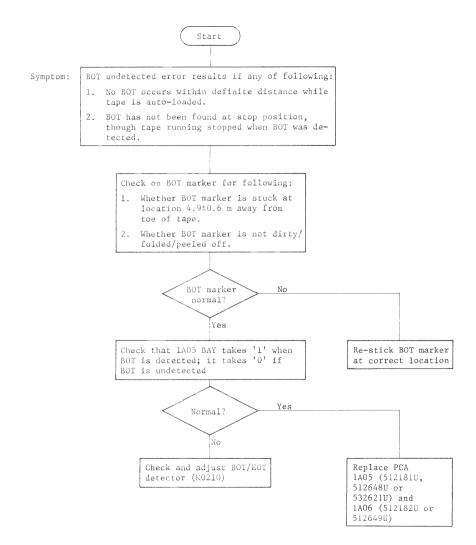
Fig. 2 Reel Loaded check when mid-loading

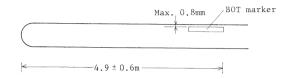
A0380 Error Code = 52



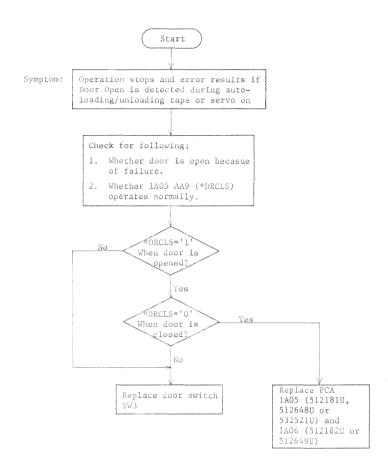


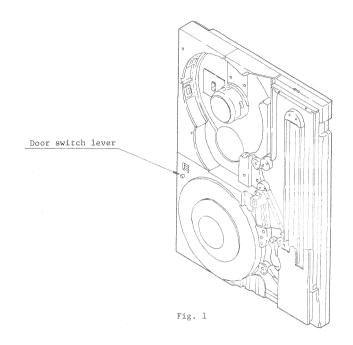
A0400 BOT Marker is not Detected





A0420 Error Code = 35, 40, 65





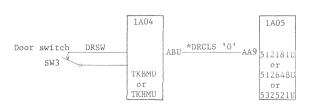
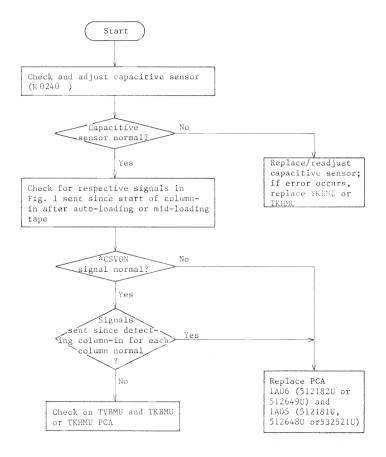


Fig. 2

A0430 Error Code = 56, 57

Symptom: Error results if tape loop pass warning detection hole after column-in has been detected once during column-in action.



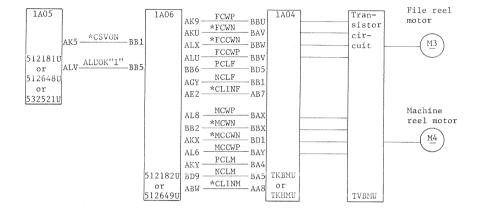


Fig. 1

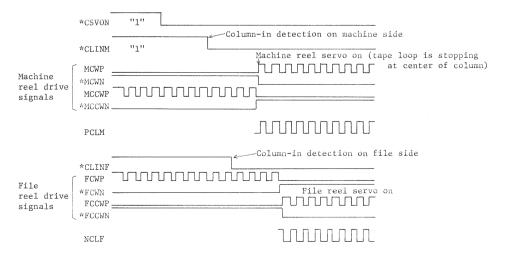
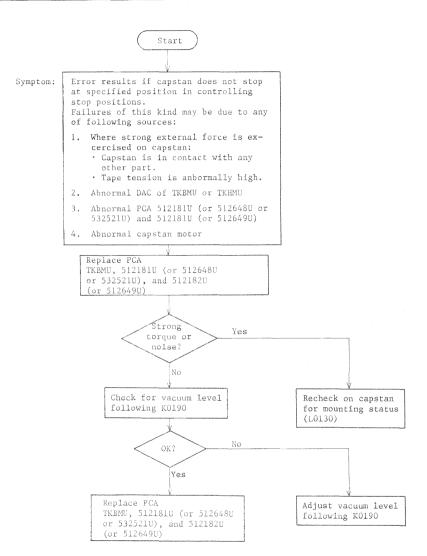
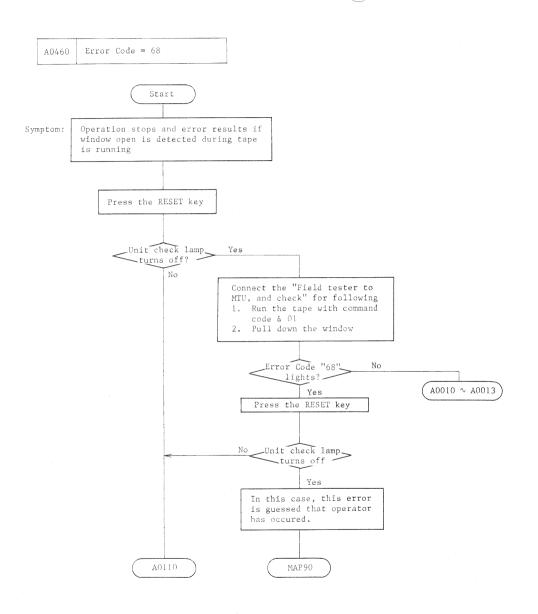


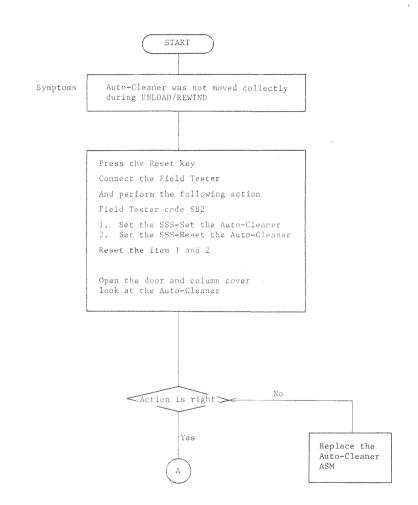
Fig. 2

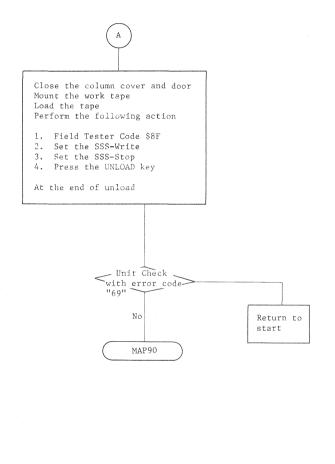


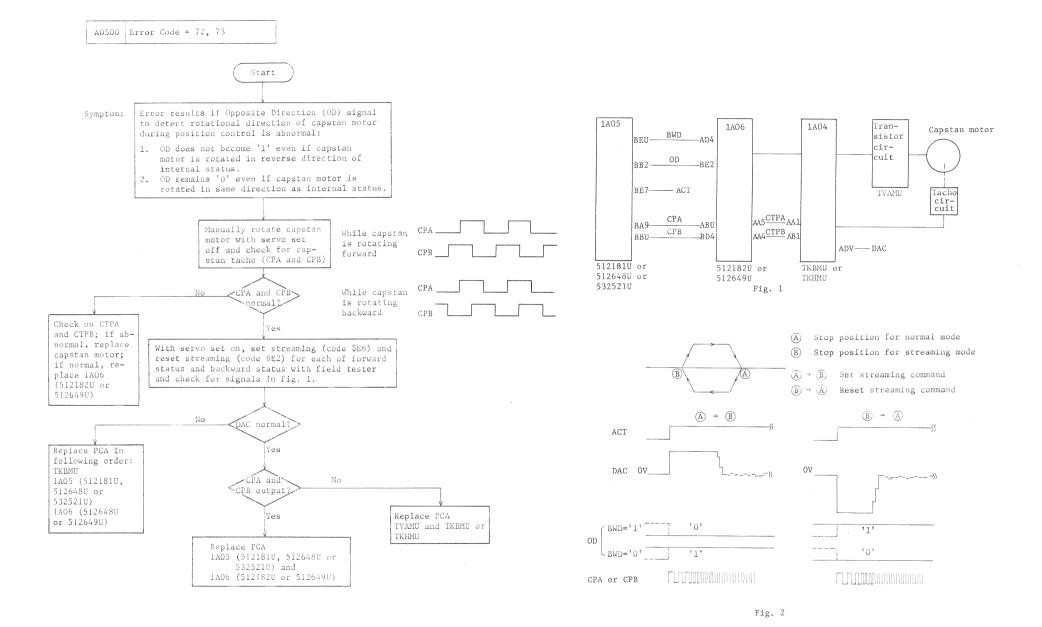
n

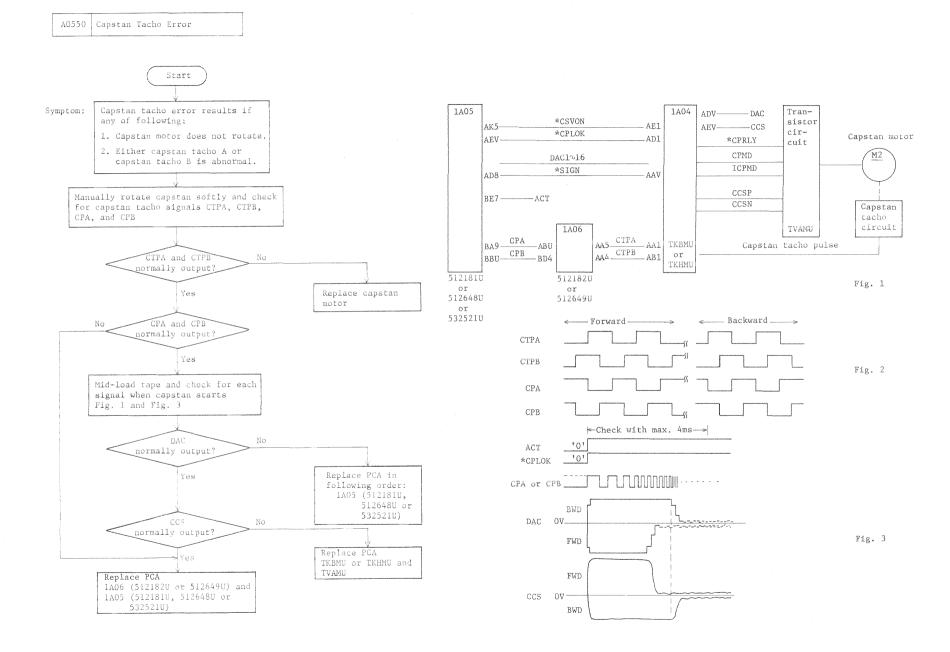


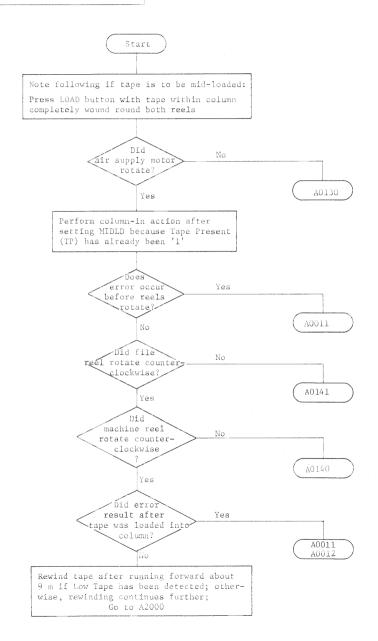
A0470 Error Code = 69

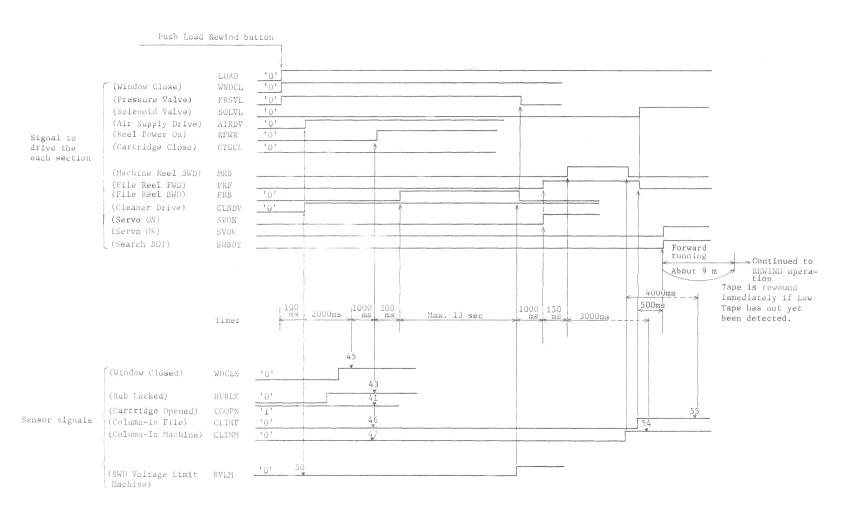






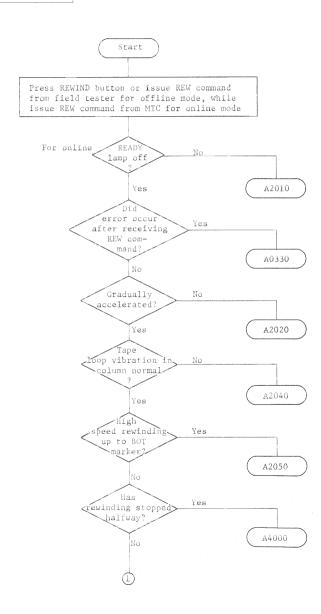


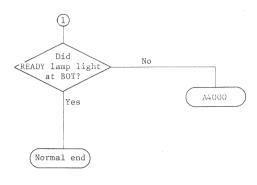




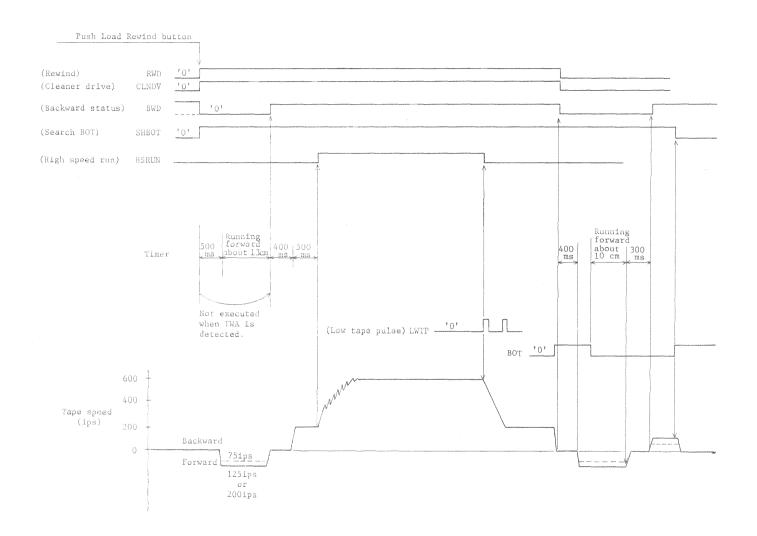
Note: The marks " ψ " indicate the timings when the program checks the logical level of sensors during mid-loading. The hexadecimal number in upper of the mark " ψ " means Error code which is set to ER register.

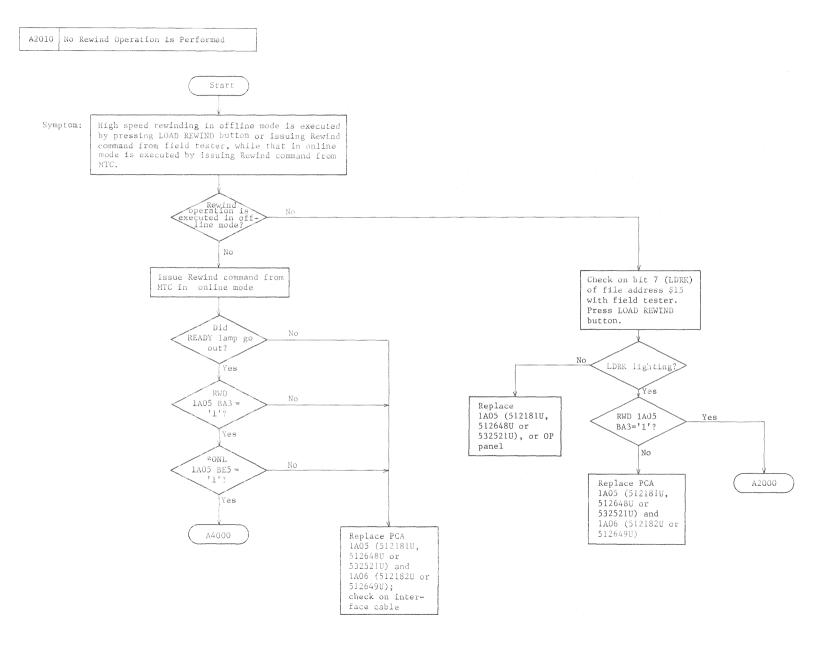
A2000 Rewind Trouble



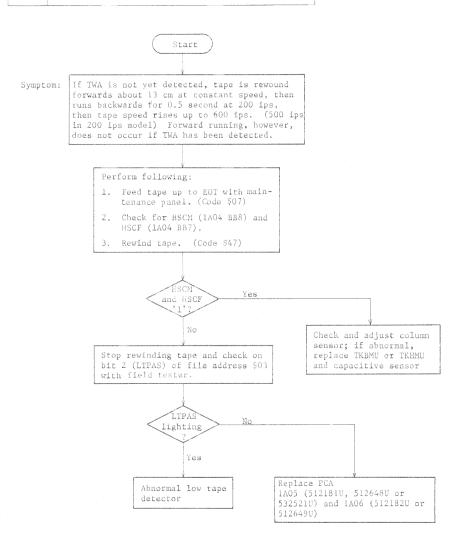


Note: Perform the troubleshooting procedures under error codes shown in A0012 if you can check on the ER register for contents (error code).





A2020 Capstan Rotation does not Gradually Acceleratd.



Start

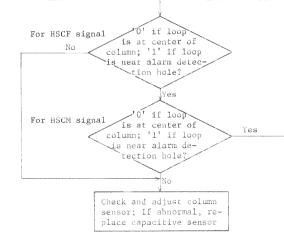
Symptom:

After tape is rewound for 0.5 second at 200 ips, tape speed accelerates gradually by 40 ips per 100 ms if Speed Down signal (HSCM/HSCF) from reel controller does not become 'l', while it decelerates gradually by 40 ips per 100 ms if Speed Down signal becomes 'l'.

If low tape marker is detected, then tape speed decelerates gradually at intervals of $100\ \mathrm{ms}$.

Check for HSCM (1A04 BA8) and HSCF (1A04 BB7) by taking following steps with tape stopped:

- Lower file column loop slowly and stop it near alarm detection hole to check for HSCF signal.
- Wind up machine column loop slowly and stop it near alarm detection hole to check for HSCM signal.

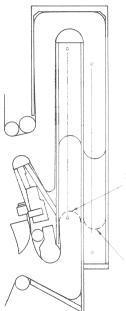


Wind up tape and check for capstan tacho with maintenance panel (code \$9D)

Replace capstan motor because capstan tacho

is abnormal

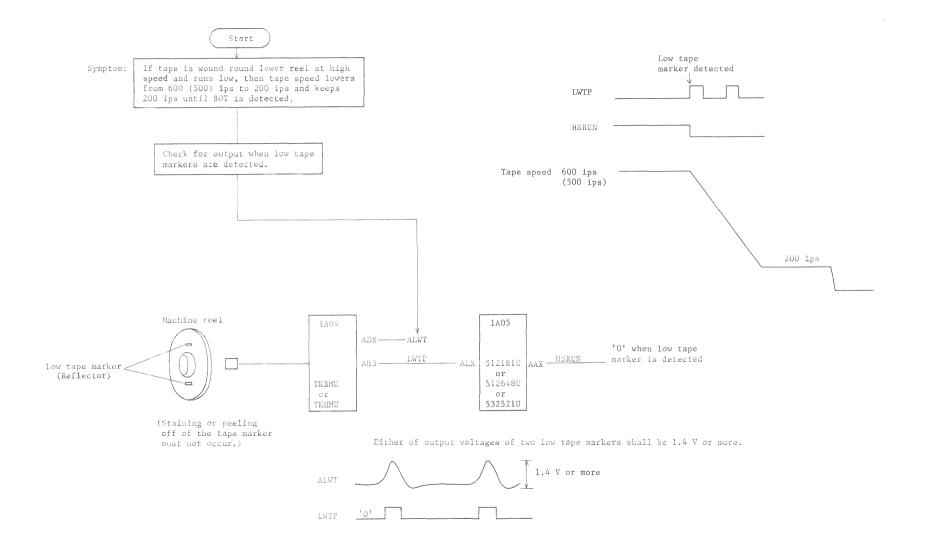
Replace PCA 1A05 (512181U, 512648U or 532521U) and 1A06 (512182U or 512649U)

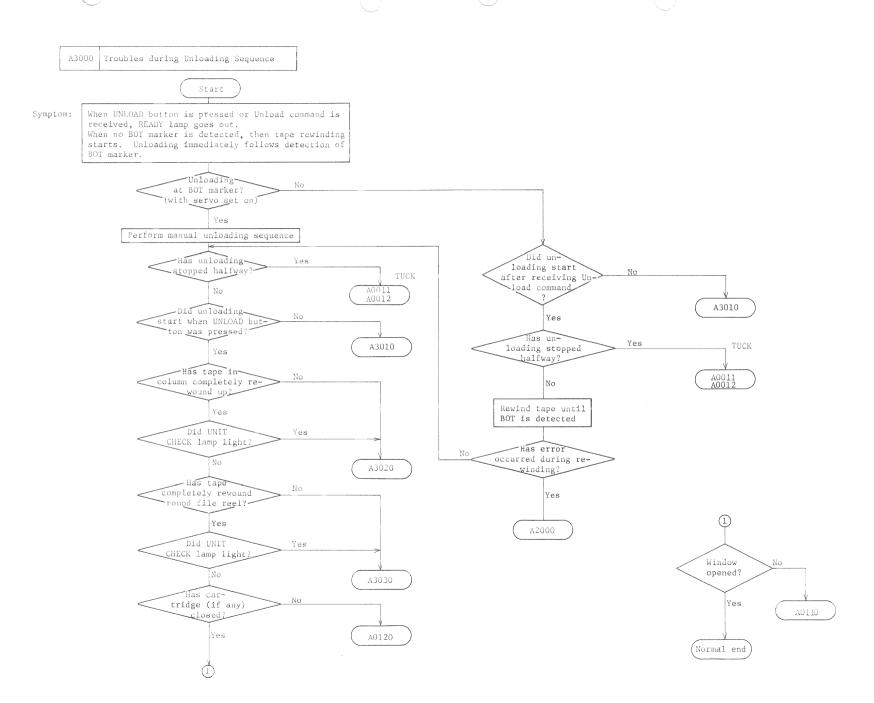


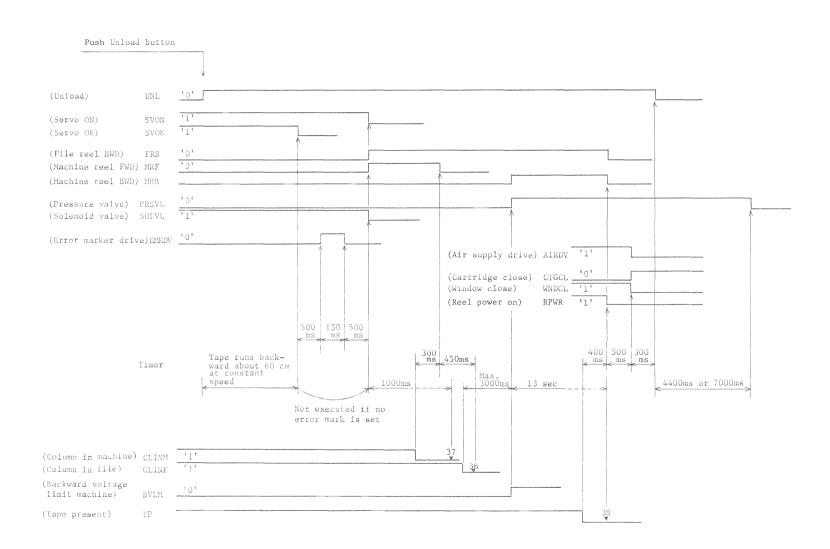
Manually rotate machine reel and check for HSCM signal at this position.

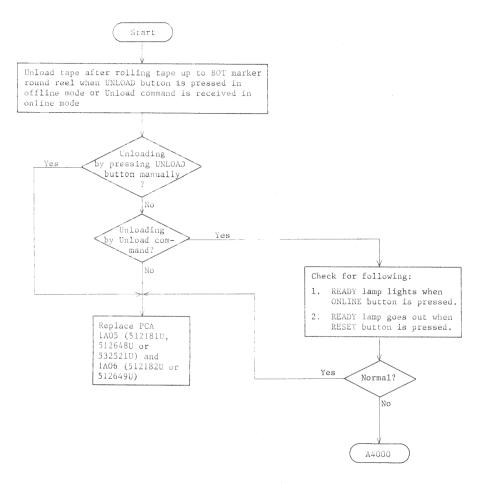
Manually rotate file reel and check for HSCF signal at this position.

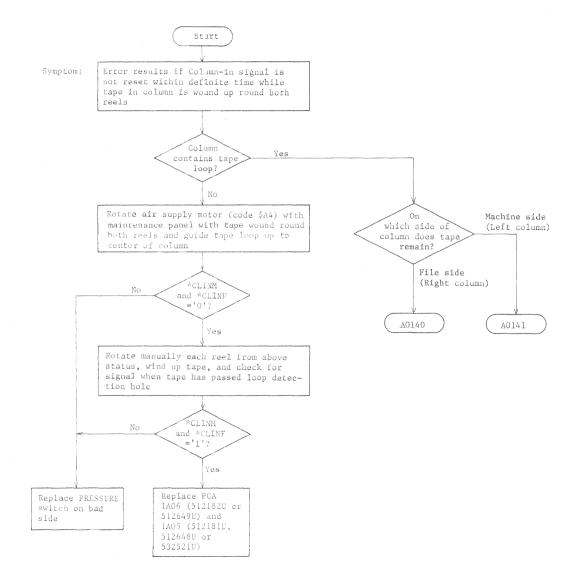
Fig. 1











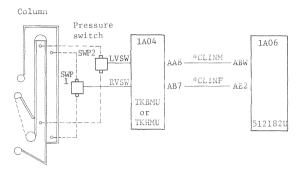
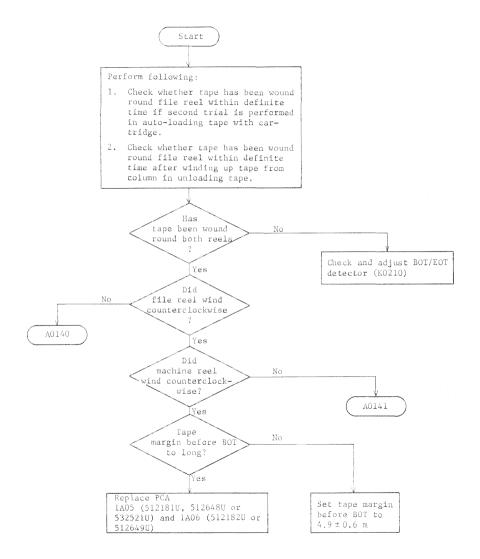
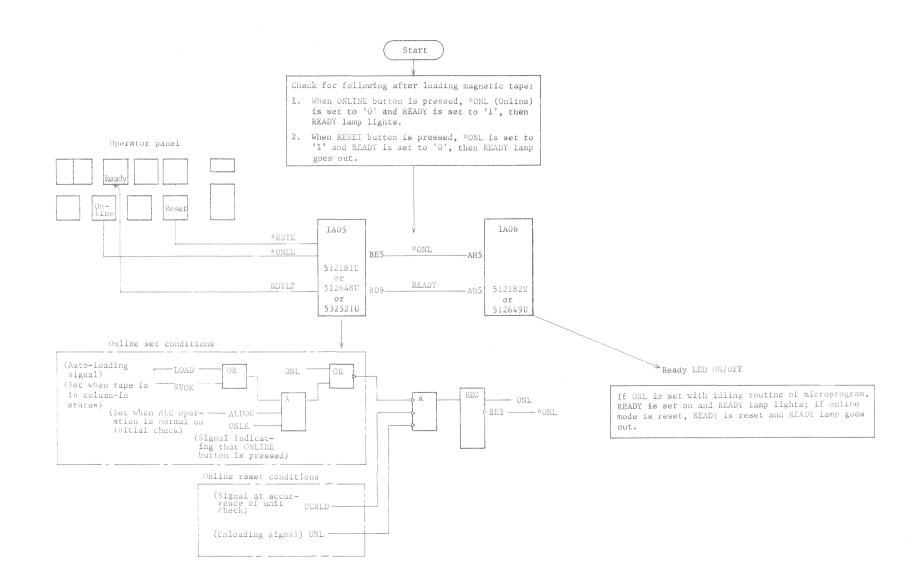


Fig. 1





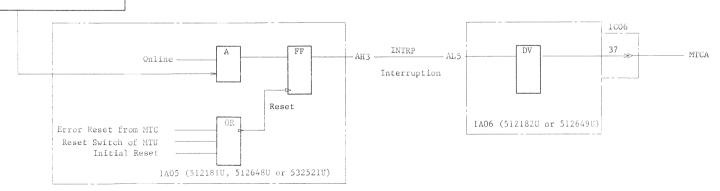
A4010 Interruption

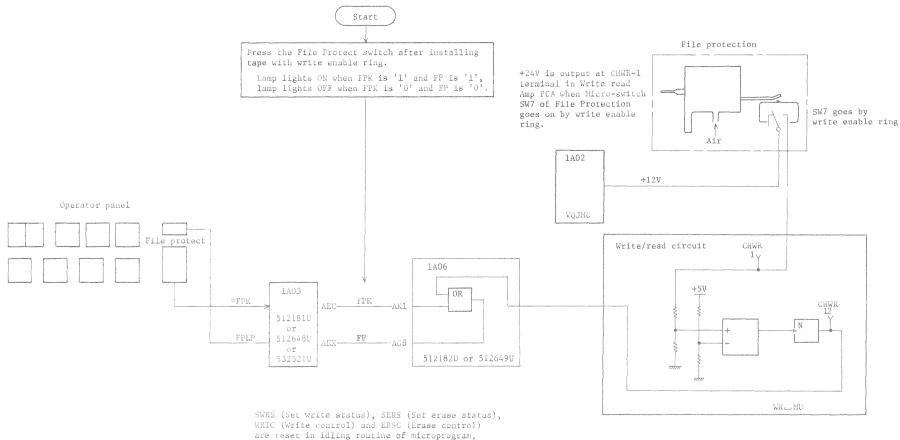
START

Interruption signal to MTC is set by following condition.

- File Protect is detected during Write/ Erase.
- · Unit check is issued.
- · Online/Ready is reset.
- BOT is detected during Backward Read operation.
- When Test Mode is set condition, TWA is detected during Forward operation.
- Device became SAGE Check during SAGC operation.
- · BOT is detected during Backspace File.
- Device became 20 m Check during Space
 File

 File

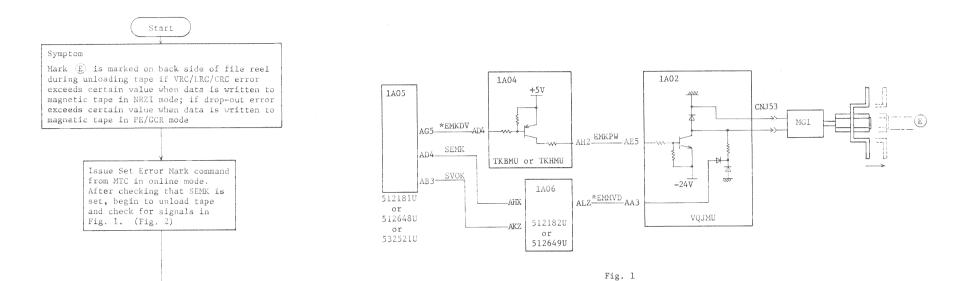




by FP (File Protect).

write enable ring





SEMK '0'

SVOK '1'

*EMKDV '1'

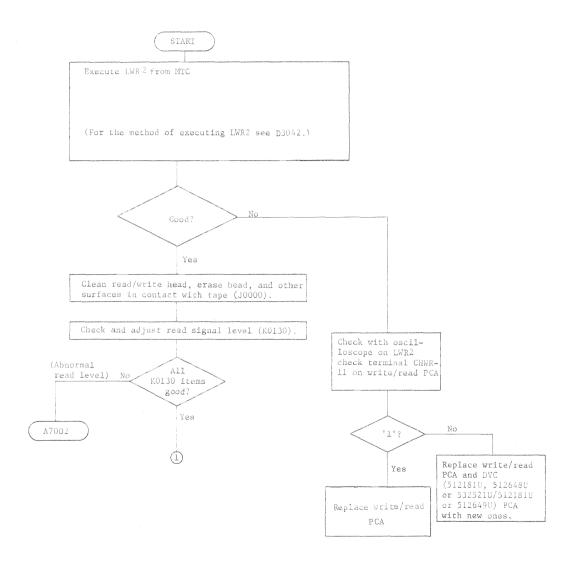
EMKPW -24V

*EMMVD '1'

Fig. 2

A7000 Read/Write Section Troubleshooting Procedures

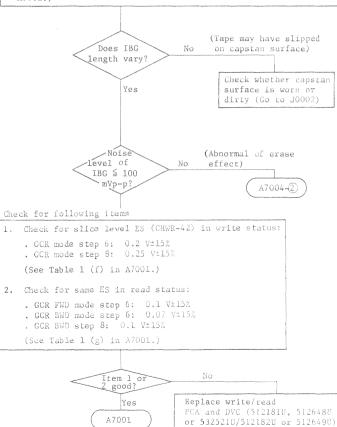
If a malfunction occurs in read/write operation of a 6250/1600 rpi MTU, then take the following troubleshooting procedures.





Execute following, with field tester connected to MTC:

- . Writes 3200 fci in PE mode at error detected speed (See Table 1 (c) in A7001.)
- . After rewinding tape, block-write 9042 fci in GCR mode at same speed (See Table 1 (d) in A7001,)
- . After rewinding tape, read tape written at item (2) in GCR mode at same speed and observe with oscilloscope check terminals CHAJ-1 to CHAR-1 in write/read circuit (See Table 1 (e) in A7001.)



A7001 Troubleshooting for Read/Write Start Execute block write from field tester in error detected mode (See Table 1 (f).) Then, observe with oscilloscope terminals 1806-42, -39, -40, -37, -35, -36, -33, -34, -31. Do observing points satisfy specifications in Fig. 12 Replace write/read PCA Yes Replace write/read circuit and DVC (512181U, 512648U or 532521U/512182U or 512649U) PCA Block IBG CHAJ-1 ∿ CHAR-1 Approx. in write/read _ 2 Vp-p PCA 100 mVp-p or less 1BO6-42 etc. Help H-C

t = 6 $\mu s \pm 30\%$ (Tape speed; 200 ips) Fig. 1

 $t = 15 \mu s \pm 30\%$ (Tape speed; 75 ips) $t = 9 \mu s \pm 30\%$ (Tape speed; 125 ips)

Table 1

		Proce-	Field tester		
Item	Operation	dure	Code	Setting switch	Remarks
(a)	Write mode	1	Low speed PE : \$E8 Low speed GCR: \$EA High speed PE: \$EC High speed GCR: \$EE	SSS	
(b)	Read mode	1	Low speed PE: \$E0 Low speed GCR: \$E2 High speed PE: \$E4 High speed GCR: \$E6	SSS	
(c)	PE 3200 fci write	1.	Set to PE write mode at item (a).	SSS	
		2	\$89	SSS	
(d)	Block write	1	Set to write mode specified at item (a).	SSS	
		2	\$25	SSS	
(e)	FWD read	1	Set to read mode specified at item (b).	SSS	
		2	Low speed: \$01 High speed: \$02	SSS	
(f)	GCR write mode with specified step	1	Step specification: Step 6: \$C6 Step 8: \$C8	Switch SSS sw twice.	First switching causes tape to run; second switching causes tape to stop.
		2	Low speed GCR write: \$EA	SSS	
(g)	GCR read mode with specified step	1	Step/running direction specification: FWD step 6: \$C6 FWD step 8: \$C8 BWD step 6: \$D6 BWD step 8: \$D8	Switch SSS sw twice.	

Note: For details see "Maintenance Panel Operating Method".

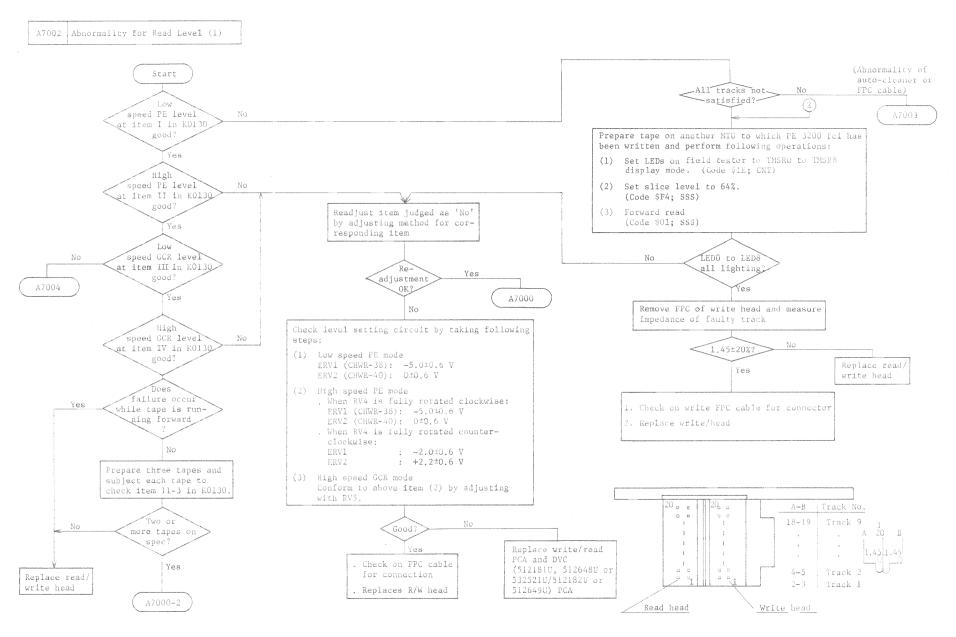
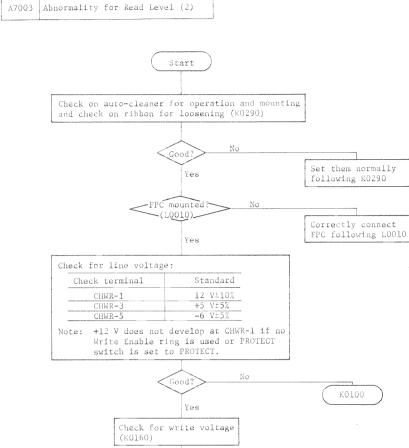


Fig. 1 R/W head (viewed from head connector side)

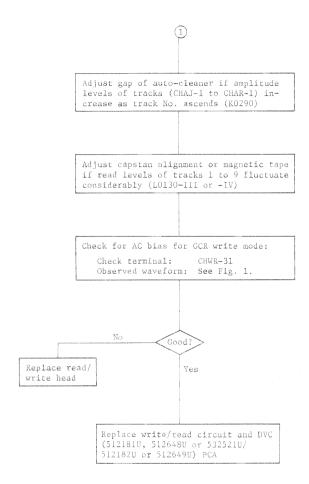


Replace write/read

A7002- 2



A7004 Abnormality for Read Level (3)



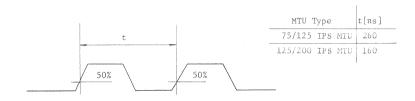
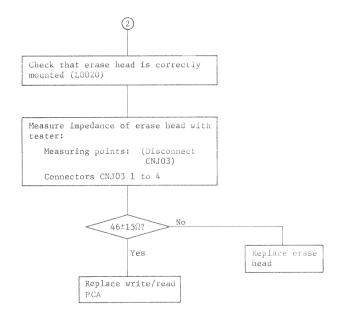


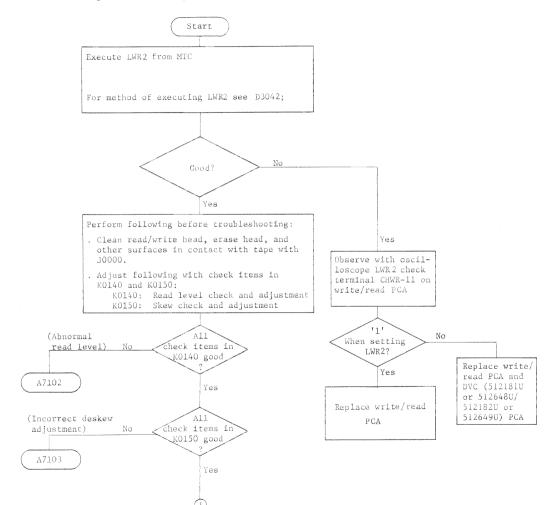
Fig. 1 AC bias waveform (CHWR-31)



A7100 Troubleshooting for Read/Write Section (1600/800 rpi MTU) (1)

Symptom:

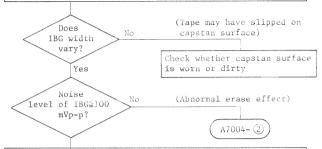
If a read/write system failure occurs in the 1600/800 rpi MTU, then perform troubleshooting in the following sequence:



(1)

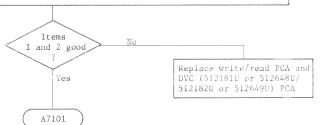
Perform following, with field tester connected to MTU:

- 1. Write NRZI 800 fci at low speed (Table 1(c) in A7101)
- Block write 3200 fci in PE mode at error detected speed after rewinding tape
- Read tape written at above item (2) in same speed PE mode after rewinding tape and observe waveform at check terminals CHAJ-2 to CHAR-2 on write/read circuit PC board (Table 1(e) in A7101)

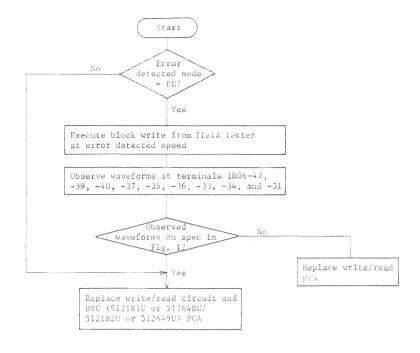


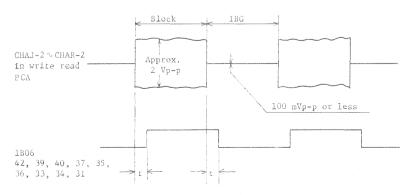
Check for following items:

- 1. Check for slice level ESNZ (CHWR-44) for NRZI mode:
 - . Write mode: 0.4 $\mbox{V$\pm$20\%}$ (Table 1(a) in A7101)
 - . Read mode : 0.17 V±20% (Table 1(b) in A7101)
- 2. Check for slice level ESPE (CHWR-42) for PE mode:
 - . Write mode: 0.25 V±20% (Table 1(a) in A7101)
 - . Read forward mode: 0.10 V±20% (Table 1(e) in A7101)
 - . Read backward mode: 0.07 V±20% (Table 1(e) in A7101)



A7101 Troubleshooting for Read/Write Section (1600/800 rpi MTU) (2)





t = 25 µs±30% (Tape speed: 75 ips) Fig. 1 t = 15 us±30% (Tape speed: 125 ips) t = 9 µs±30% (Tape speed: 200 ips)

Table 1

	T	·			
	0	Proce-	Field tester		
Item	Operation	dure	Code	Setting switch	Remarks
(A)	Write mode	1	NRZI : \$E8 Low speed PE : \$EA High speed PE : \$EE	SSS	
(b)	Read mode	1	NRZI : \$E0 Low speed PE : \$E2 High speed PE : \$E6	SSS	
(c)	NRZI 800 fci write	1	\$89	SSS	
(d)	Block write	1	Set to write mode specified at item (a)	SSS	
		2	\$25	SSS	
(e)	FWD read action	1	Set to read mode specified at item (b)	SSS	Does not operate at the high
		2	Low speed FWD : \$01 High speed FWD : \$02 Low speed BWD : \$41 High speed BWD : \$42	SSS	speed while in NRZI mode.

Note: For details see Field Tester Operating Method".

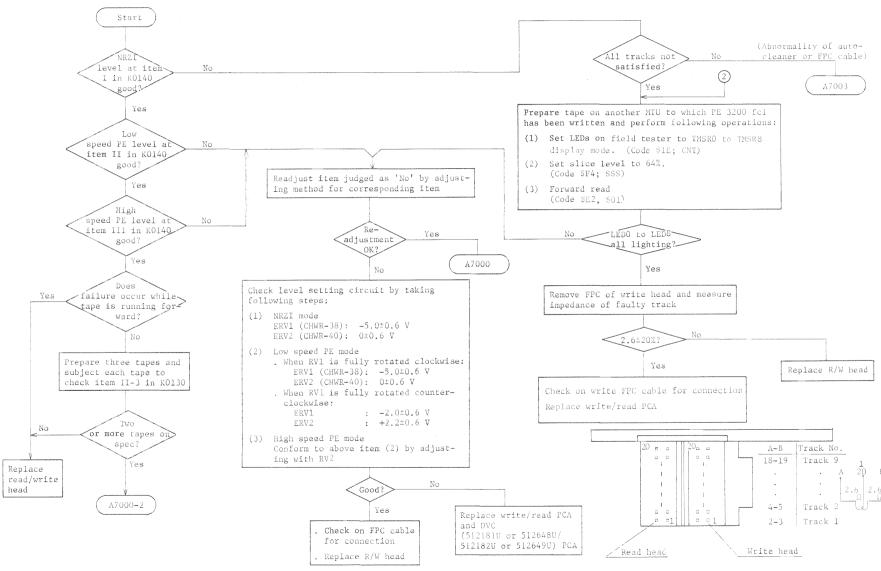
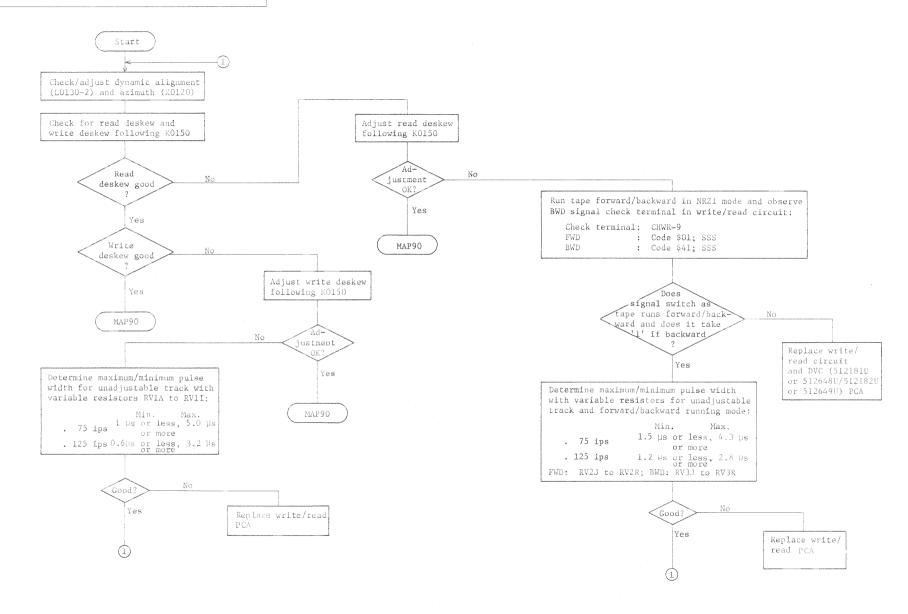
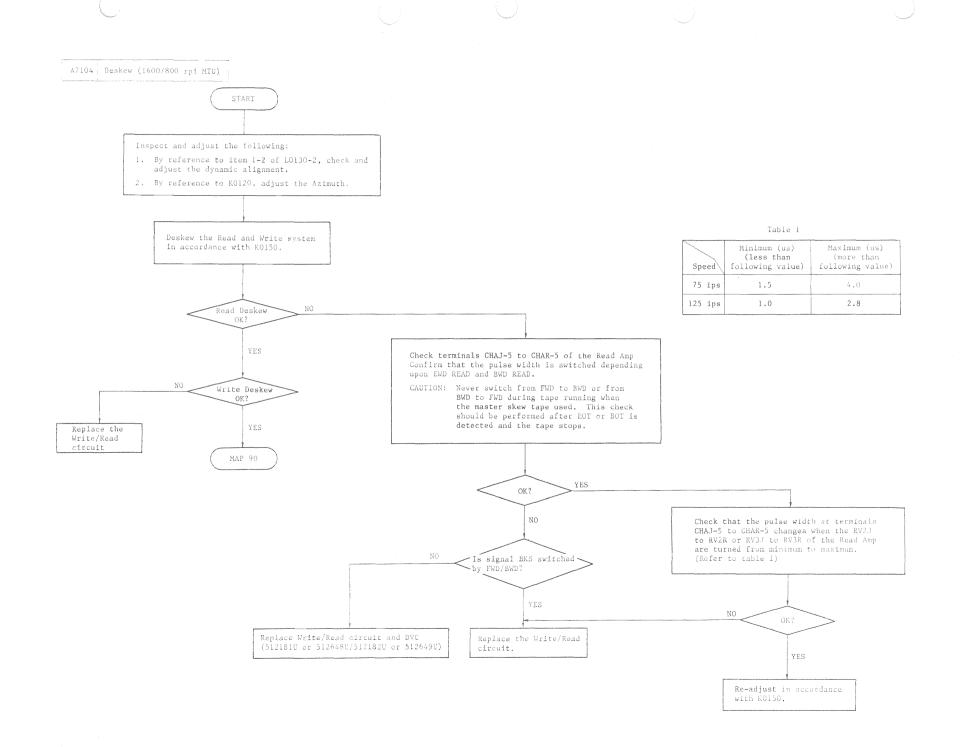
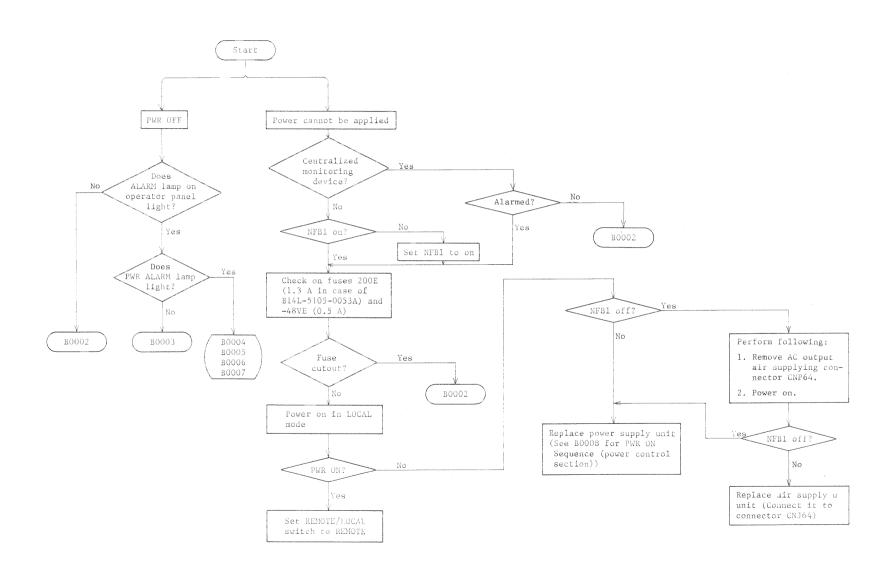
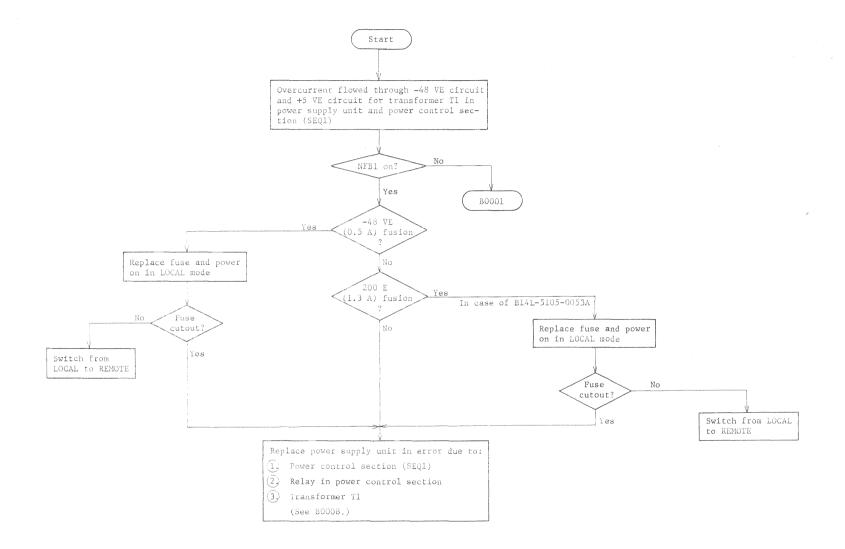


Fig. 1 R/W head (viewed from head connector side)

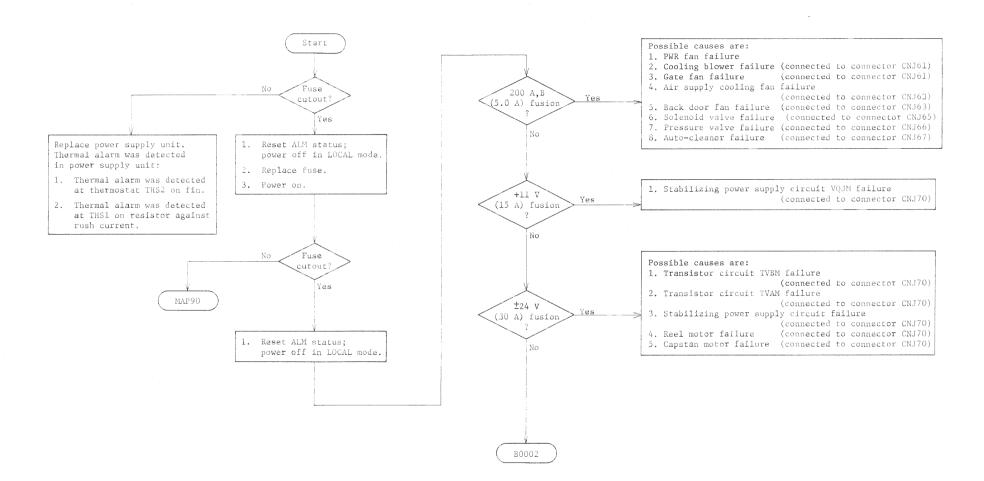


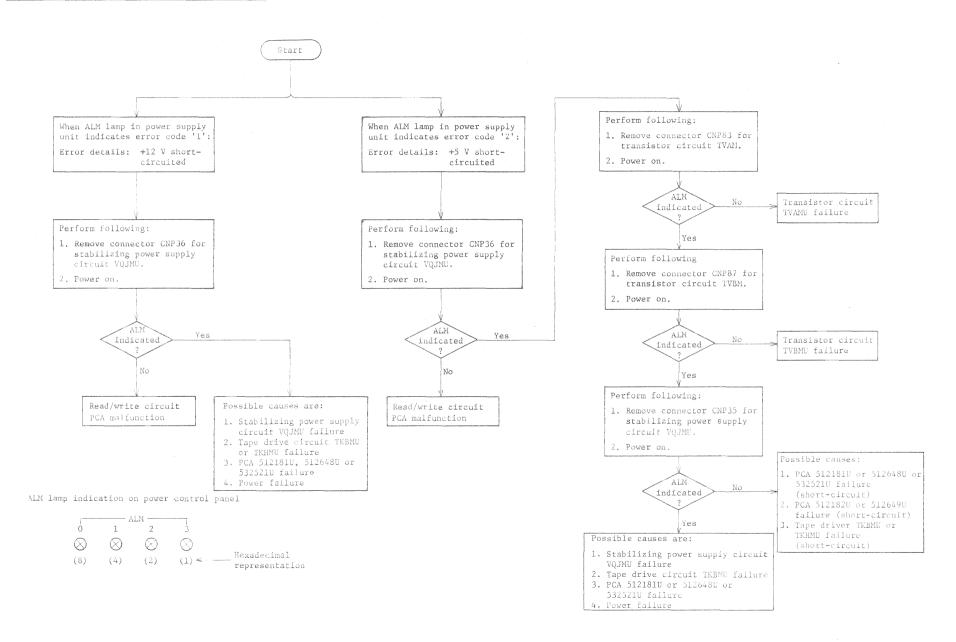




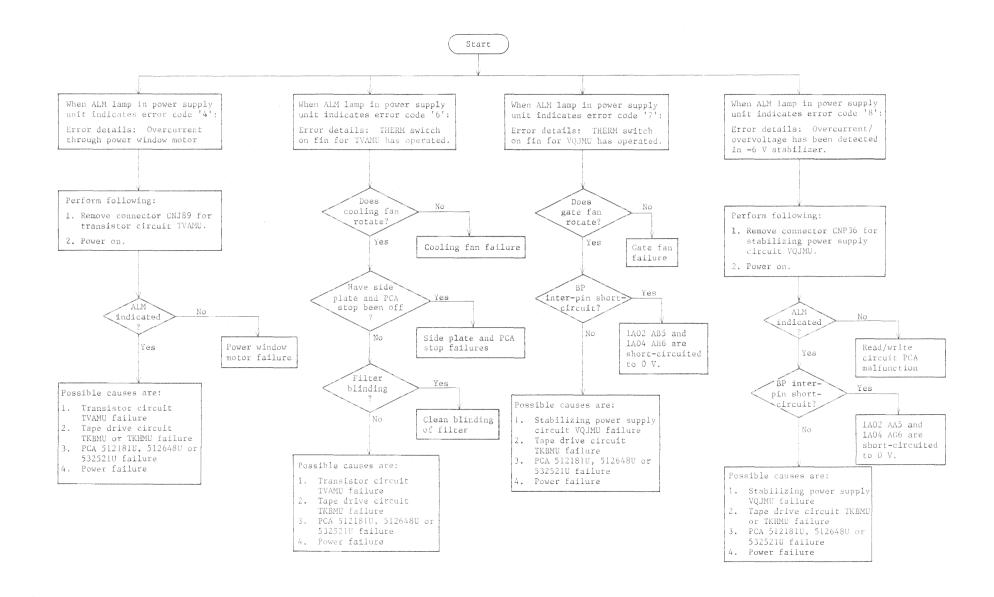


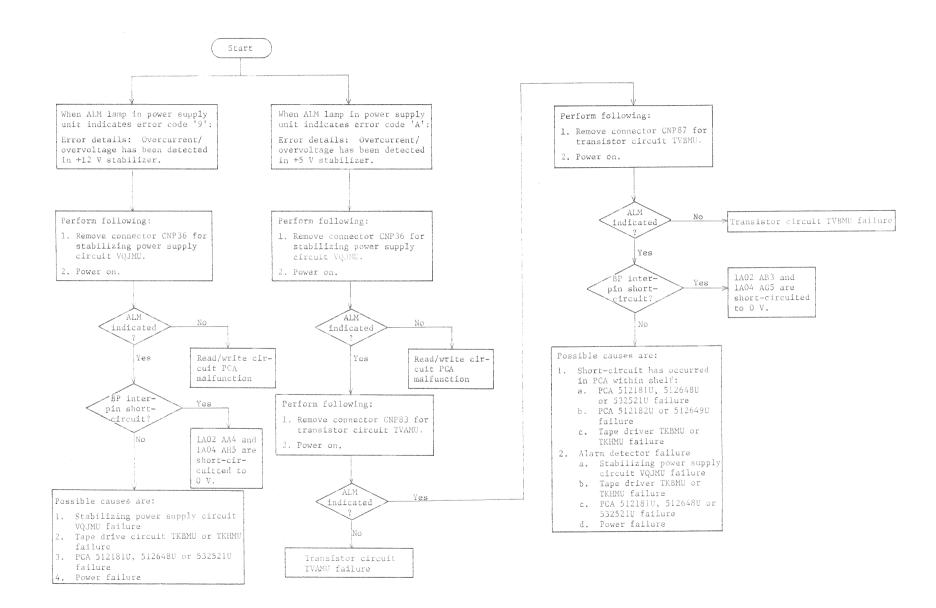
B0003 | Alarm LED Indication by Power Supply Trouble



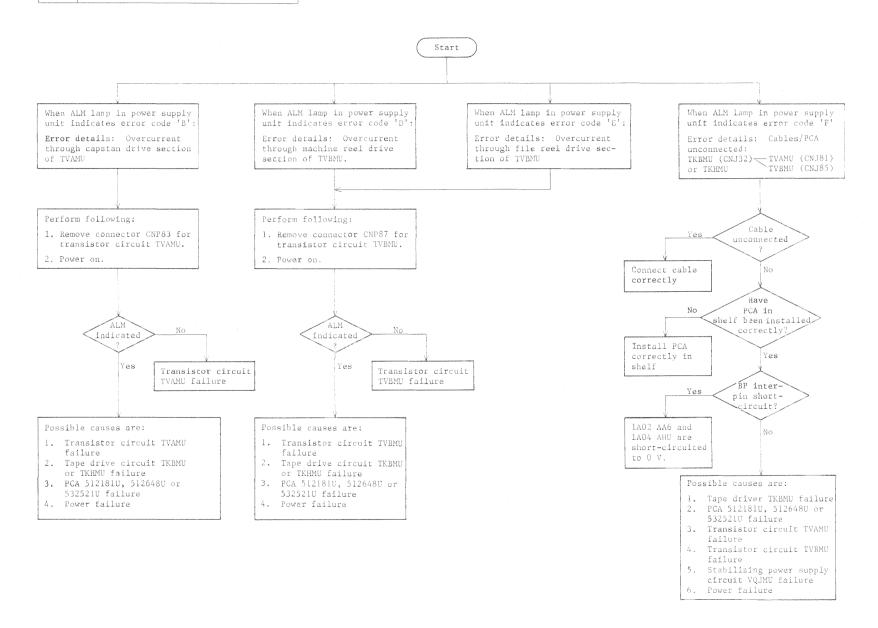


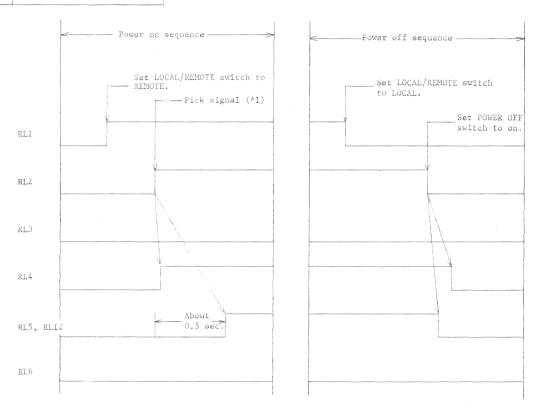
B0005 Alarm LED Indication by MTU Trouble (2)

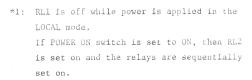


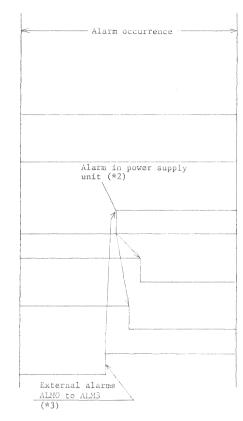


B0007 Alarm LED Indication by MTU Trouble (4)

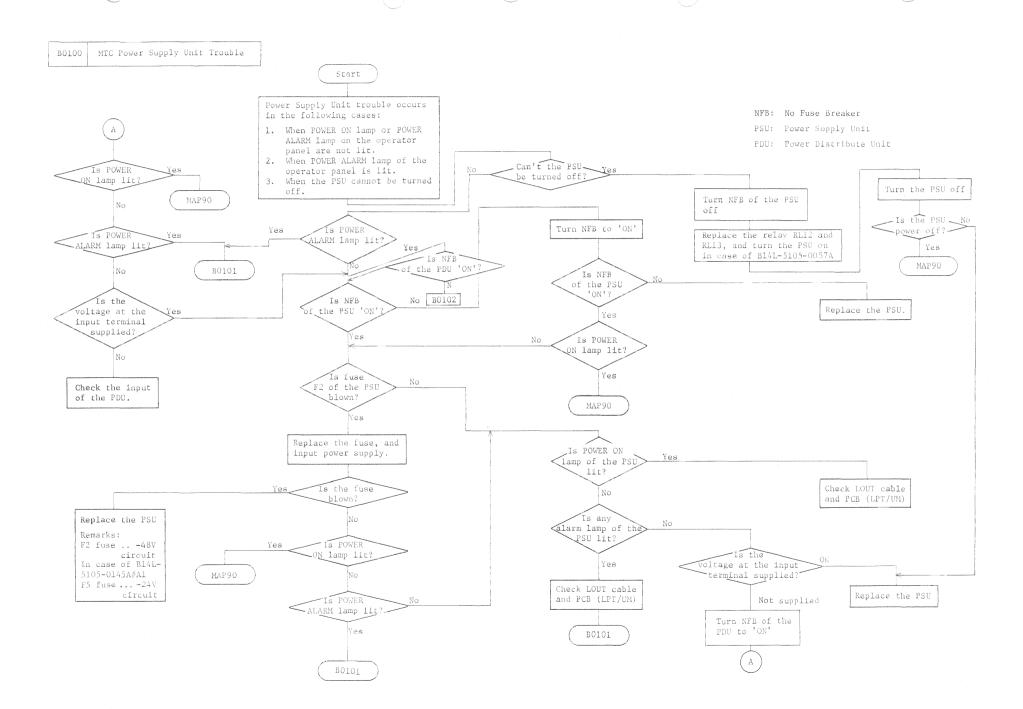


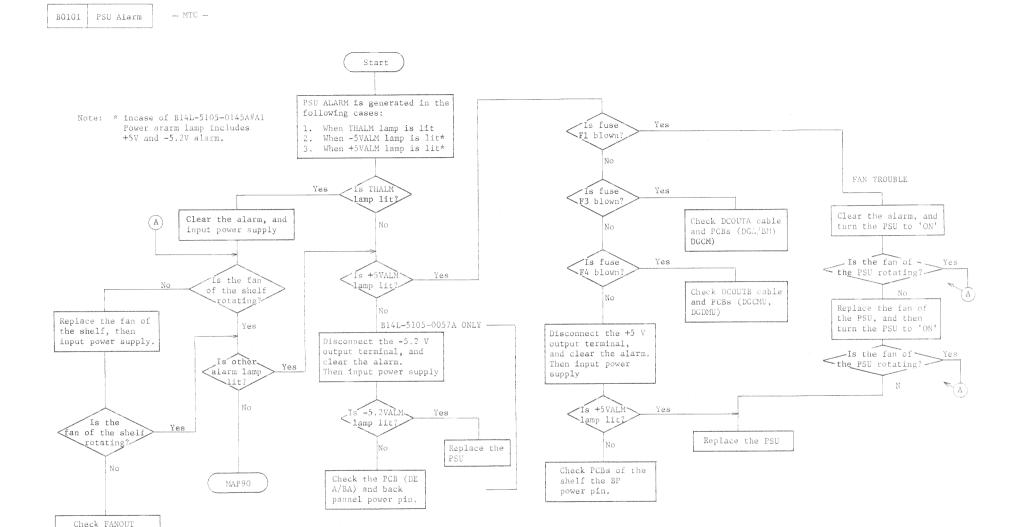






- *2: If any fuses except -48 VE and 200E are melted or a thermal alarm status in the power supply unit is detected by THS1 and THS2, then RL3 is set on and the powering off sequence starts.
- *3: If an external alarm status occurs in a section other than the power supply section, then RL6 is set on, then RL3 operates, then the powering off sequence starts.





cable.

B0102 MTC Power Supply ALARM

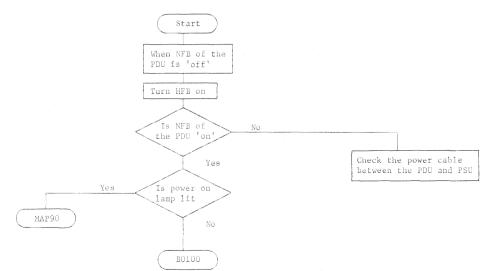
MTC POWER ALARM

B14L-5105-0057A refer to Fig. 1

	Appearance	Cause					
1	NFB break	Short circuit of AC 200V input circuit.					
2	F1 FUSE ALARM	Power Supply internal FAN, Gate FAN	(200VF 1.3A)				
3	F2 FUSE ALARM	Power Supply internal circuit	(200VE 1.3A)				
4	F3 FÚSE ALARM	CHU A Interface circuit	(+5V 7.5A)				
5	F4 FUSE ALARM	CHU B Interface circuit	(+5V 7.5A)				
6	+5V ALARM LAMP	+5V Overvoltage or Undervoltage					
		Thermal alarm for Tr. unit	(80°C)				
		Thermal alarm for a resistor against					
		rush current	(90°C)				
		Fuse F1, F3 or F4 blown					
7	-5.2V ALARM LAMP	-5.2V Overvoltage or Undervoltage					
8	TH ALARM LAMP	Thermal alarm for external PC board	gate				

B14L-5105-0145A#Al refer to Fig. 2

~~~		
	Appearance	Cause
1	NFB break	Same as left
2	Fl Fuse	Same as left (200VF 1.3A)
3	F2 Fuse	Same as left (200VE 3A)
4	F3 Fuse	Same as left
5	F4 Fuse	Same as left
6	F5 Fuse	Power control (-24VE 1A)
7	POWER ALARM LAMP	+5V, -5.2V overvoltage or under voltage. Thermal alarm for PSU internal switch
8	FAN ALARM LAMP	Thermal alarm for external PC board gate



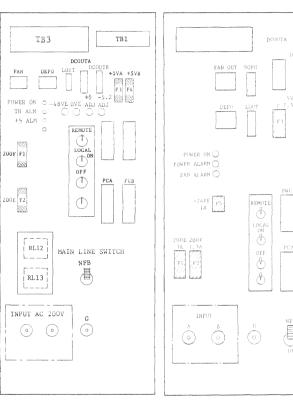
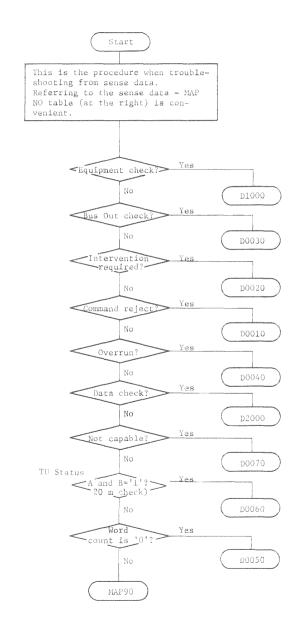


Fig. 1: MTC Power Supply B14L-5105-0057A

Fig. 2: MTC Power Supply B14L-5105-0145A#A1

D0001 Troubleshooting According to Sense Data



Bit Byte	0	1	2	3	4	5	6	7		
Byte O	Command reject D0010	Intervention required D0020	Bus Out check D0030	Equipment check D1000	Data check D2000	Overrun DOO40	Word count zero D0050	Data convert- er check 'O'		
1	Noise D2100	TU status A When both A and DOC		7 track	Load point	Write status	File protect	Not capable D0070		
2	Error track									
-	0	1	2	3	4	5	6	7		
3	VRC error D2001	Multiple track error D2001 LRC error D2001	Skew error D2001	End data check D2001 CRC error D2001	Envelope check D2001	1600 rpi	Backward	P compare D2110		
4	MP hardware error D1010	Reject TU D1200	Tape indicate (EOT)	Write trigger VRC D2120		Loop write read	Tape unit check D1210			
_	New Sub	system	Write tape	ID burst	Start read	Partial	Postamble	Error count		
5	'0'	11'	mark error D1220	check D1230	check D2002	record D2002	error D2002	overflow D2004		
						Tape unit model				
6	7 Track TU	Write cirucit alarm A0330	Dual density	Not set 1600 rpi	6250 rpi tape unit	'1' '1'	'0' '0'	'1': 200 ips '0': 125 ips '1': 75 ips		
7	Miscellane- ous error A0010	Tape loop alarm left A0310	Tape loop alarm right A0310	Reset key D1300	DSE	Fuse alarm A0100 A0110	Air bearing alarm A0310	Load failure A0100		
8	IBG detected D1250	Error track P		Early begin read back check D1350	SASC check D1260	Slow begin read back check D1350	Slow end read back check D1350	Velocity retry D1330		
9	l or 2 track correction	Velocity change D1340	Channel buffer check D2110	CRC III error D2003	6250 rpi MTC	111	MTU reserve	MTC reserve		
10	Status tag response check D1400	Command tag response check D1400	Control tag response check D1400	No block detected D1270	Dynamic reversal D1310	Tacho start failure D1320		Velocity check D1330		
Ll	Read/write overrun D1450	Missing position D1460	Tag in check D1440	Register parity error D1010	MP detec- tion error D1010	ROM parity error D1010	MP trap D1205	TU ROM Parity error A0030		
				MlU inner	status					
12	Erase current ON	MTU action	Backward action	Write current	ARA 65% slice	High speed mode	1600 rpi mode	Tape mark detected		

D0002	Sense	Byte	Table

Bit Byte	0	) poe	2	3	4	5	6	7	
Byte O	Command reject	Interven-	Bus Out check	Equipment check	check	overrun	Word count zero	Data converter check '0'	
***************************************	(0)	(U)	(U)	(U)	(U)	(U)	(U)	(Not used	
1	Noise (E)(D)	TU status A	TU status B	7 track '0'	Load point (U)*	Write status	File protect	Not capable (U)	
	Error track								
2	0	1	2	3	4	5	6	7	
3	VRC error	Multiple track error LRC error		check	Envelope check	1600 rpi	Bachward	P compare	
	(D)	(D)	(D)	(D)	(D)			(D)	
4	MP hardware error (E)	Reject tape unit (E)	Tape indicate	Write trigger VRC (D)		Loop write to read	Tape unit check (E)**		
	New sub	system	Write tape	ID burst	Start	D . 4 4	Post-	Error	
5	101	1 1 1	mark error (E)	check (U)	read check (D)	Partial record (D)	amble error (D)	count overflow (D)	
6	7 track TU '0'	Write circuit alarm (E)	Dual densíty	Not set 1600 rpi	6250 rpi Tape unit	10	Tape unit 1 01: 200 1 00: 125 1 11: 75 i	ps MTU	
7	Miscel- laneous error	Tape loop alarm left	Tape Loop alarm right	Reset key	DSE	Fuse alarm	Air bearing alarm	Load failure	
8	IBC detected	Error track P		Early begin read back check (D)	SAGC check (E)(D)	Slow begin read back check	Slow end read retry check (D)	Velocity	
9	l or 2 Track correction	Velocity change (D)	Channel buffer check (D)	CRCIII error (D)	6250 rpi MTC	* ] *	MTU reserve	MTU reserve	
10	Status tag response check (E)	Command tag response check (E)	Control tag response check (E)	No block detected (E)	Dynamic reserval	Tacho start failure (E)		Velocity check (E)	
11	Read/write overrun (E)	Missing position (E)	Tag in check (E)	Register parity error (E)	MP detection error (E)	ROM parity error (E)	MP Trup	TU ROM parity error	

	}	1			į.	1	1		
13	Error count								
14	MTC unique 1D								
15	High speed feature Skip file Reserve Reserve TU unique ID (High order K0010						r)		
16	TU unique ID (Low order)								
17	2-channel switch	800 rpi option	l6-drive option		MTC EC level K0006				
18	SAGC count TST6210				Model Conver- TU EC level K0011 sion				
19	TU7	TU6	TU5	TU4	TU3	TU2	TUL	TU0	
20		Primed for DEVICE END							
21		MTU error code A0010, D3000, D3010							
22			Field re	eplaceable	unit (FRU-	·1)			
23			Field re	eplaceable	unit (FRU-	.2)			

2

Write

ON

current

High

speed

mode

1600 rpi Tape mark

detected

mode

ARA 65%

slice

Back-

ward

action

Bit

Erase

12 current

ON

MTU

action

Byte

⁽U) sets "Unit Check".

⁽E) sets "Equipment Check".

⁽D) sets "Data Check.

⁽U)* becomes a cause of "Unit Check" while commands belonging to back category are being executed.

⁽E)** becomes a cause of "Equipment Check" except load failure.

D0010 | Command Reject

Generated in the following cases:

(1) Invalid command has been given.

(Command with command byte bits 5, 6, 7 defined as 011 is handled the same as NO OPERATION.)

FRU1 (Sense byte 22) .... 01

FRU2 (Sense byte 23) .... Rejected command code

(2) Sense & controller reserve, sense & controller release command has been given to an MTC not having the 2CH switch function. Otherwise, sense & tape unit reserve, sense & tape unit release, unconditional reserve, sense IO type command has been given to an MTC in "1-compatible" mode.

FRU1 (Sense byte 22) .... 02

FRU2 (Sense byte 23) .... Rejected command code

(3) DATA SECURITY ERASE command (DSE) has been given without chaining with ERASE command.

FRU1 (Sense byte 22) .... 03

RFU2 (Sense byte 23) .... Last command code

(command code before DSE command)

(4) A write tape mark command, a erase command or a write command has been given to a file protected MTU.

FRU1 (Sense byte 22) .... 04

FRU2 (Sense byte 23) .... Rejected command code

(5) CAPSTAN TRANSFER WRITE, TIME-SENSE TRANSFER WRITE, ERASE TRANSFER operation has been given to a file protected MTU.

FRUI (Sense byte 22) .... 05

FRU2 (Sense byte 23) .... Rejected transfer code

(6) Diagnostic transfer operation has been given to a MTU detecting BOT/EOT.

FRU1 (Sense byte 22) .... 06

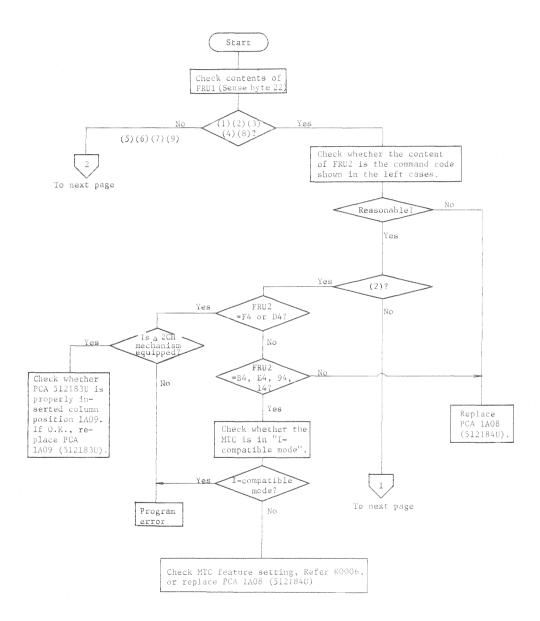
FRU2 (Sense byte 23) .... Rejected transfer code

(7) Invalid diagnostic transfer code has been given.

FRU1 (Sense byte 22) .... 07

FRU2 (Sense byte 23) ..... Rejected transfer code

(Continue)



00011 Command Reject (continued)

(8) Sense & controller reserve, sense & controller release, sense & tape unit reserve, sense & tape unit release, unconditional reserve has been given as a command other than the first command of the chain sequence.

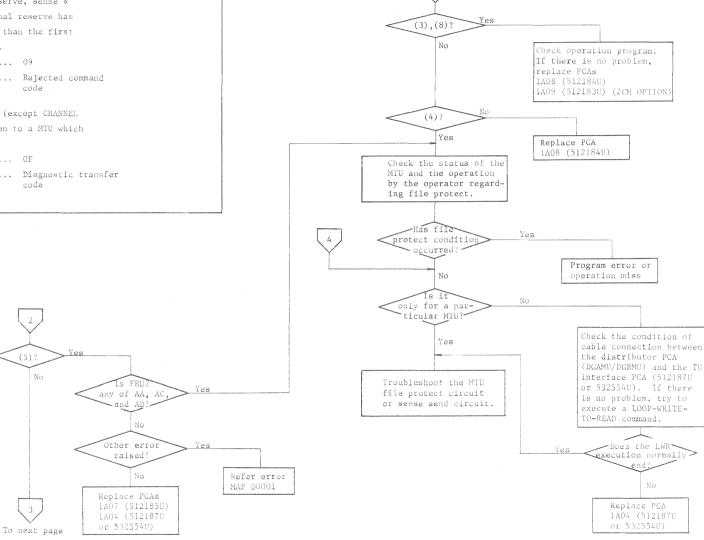
FRU1 (Sense byte 22) .... 09

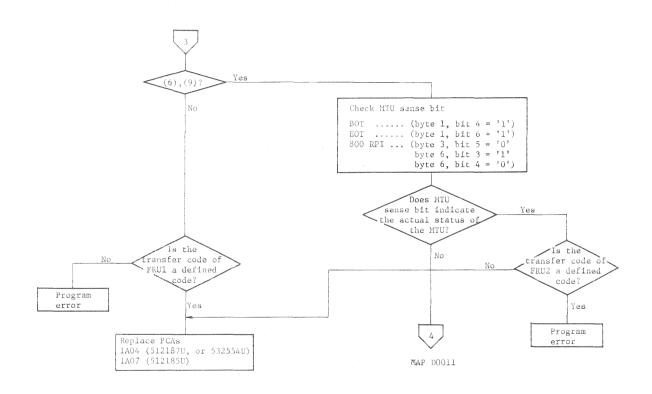
FRU2 (Sense byte 23) ..... Rejected command

(9) Diagnostic transfer operation (except CHANNEL BUFFER TRANSFER) has been given to a MTU which is in 800 BPI mode.

FRU1 (Sense byte 22) .... OF

FRU2 (Sense byte 23) ..... Diagnostic transfer





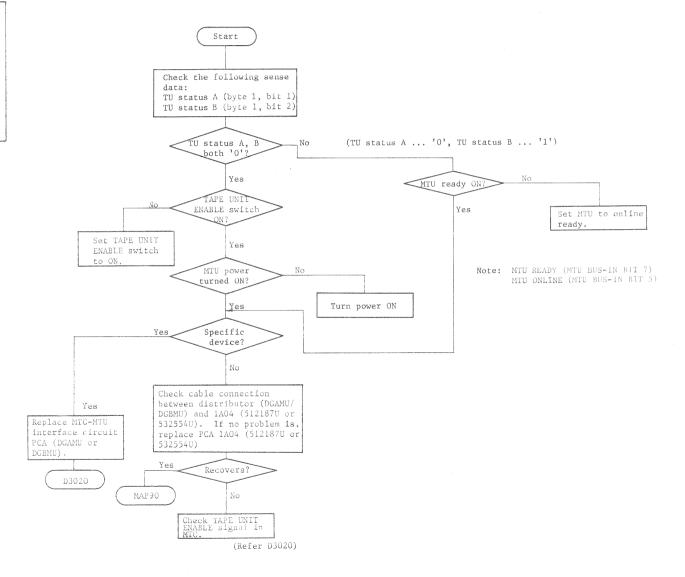
D0020

Intervention Required

# Intervention Required

Generated in the following cases,

- (1) When MTC operator panel TAPE UNIT ENABLE switch is OFF (DISABLE).
- (2) Unpowered MTU specified.
- (3) OFFLINE state MTU specified.
- (4) MTU placed in OFFLINE status during operation execution.



D0030 Bus Out Check

Generated in the following cases.

(1) Parity error

in a command or data byte received from channel.

FRU1 (Sense byte 22) ... BO

FRU2 (Sense byte 23) ... Content of IFSTA register

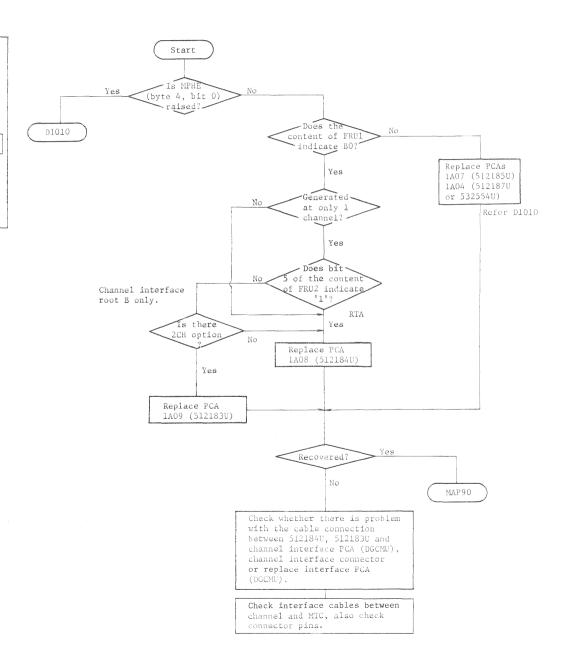
	0	1	2	3	4	5	6	7
IFSTA						RTA	RTB	
regis- [					L		L	
ter								

(2) Control unit has detected a temporary hardware error.

In this case;

MP hardware error (byte 4, bit 0) is set, and

also FRU1, FRU2 give more detail information. See D1010.



D0040

Overrun

#### Overrun

Generated when channel did not respond to data service request within the prescribed time at a write, LWR, read, read backward command.

Note: Overrum is not posed when data check is 'l'.

FRU1, FRU2 give more detailed information;

(1) FRU1 (Sense byte 22) ... 20
FRU2 (Sense byte 23) ... The content of IFCTL register

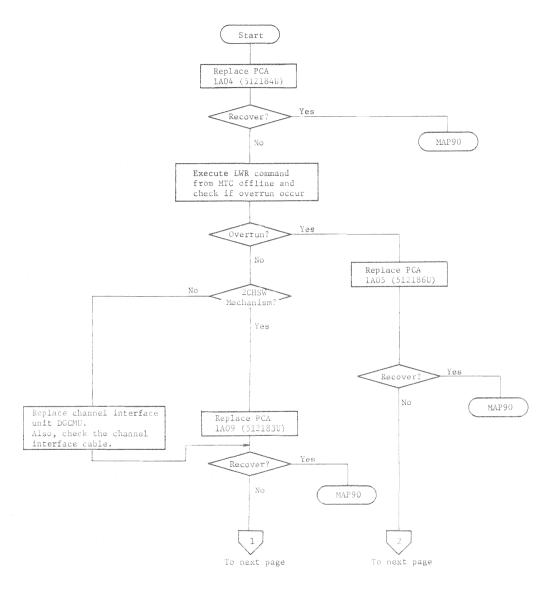
In the WRITE or LWR command, when the amount of the data in a channel data buffer becomes less 6 bytes in case of 6250 RPI mode or zero byte in case of 1600/1800 RPI mode, the data writing ends, and control moves to writing of postamble.

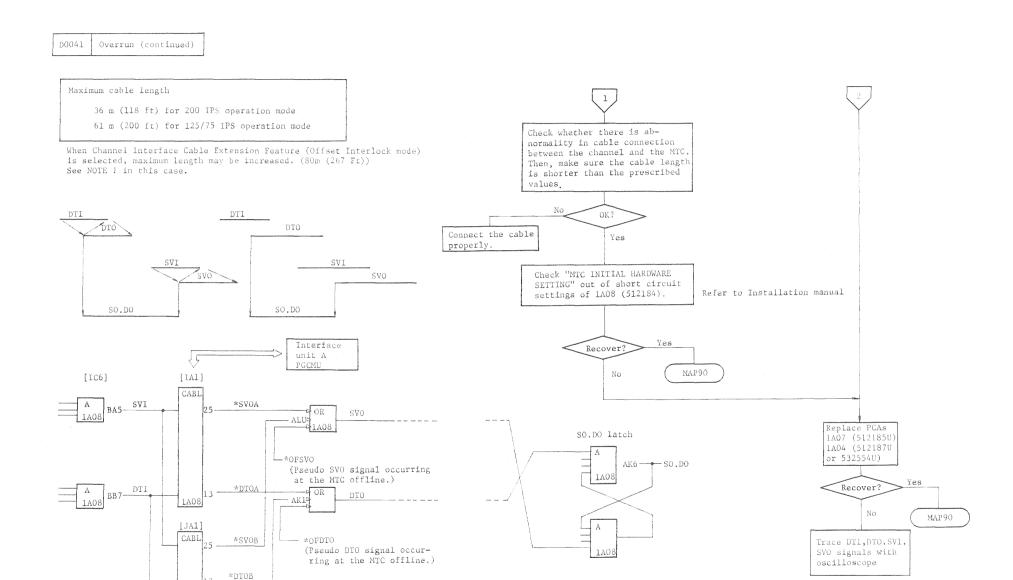
this error is generated;

- The case when it is detected that channel data buffer does not become empty at the time when all the write operations end.
   Failure in the data transfer sequence control circuit or the channel buffer circuit.
- 3) In the read or read backward command, the case when the channel buffer does not become empty even after reading of all the data is completed and further a certain time passes.
- (2) FRU1 (Sense byte 22) ... 21
  FRU2 (Sense byte 23) ... The content of IFCTL

In the WRITE or LWR command, the case when the channel buffer becomes the empty state in which there is no data in the channel buffer (less than 6 bytes in case of 6250 RPI mode) before receiving a message of indicating data ending from the channel during writing data.

In the READ or READ BACKWARD command, the case when the channel buffer becomes full during reading data.





NOTE 1 Following FRU code may be posted when Offset-Interlock mode. Refer FRU code table for detail explanation.

FRU1 .... '22'

Interface

unit B DGCMU

1A09

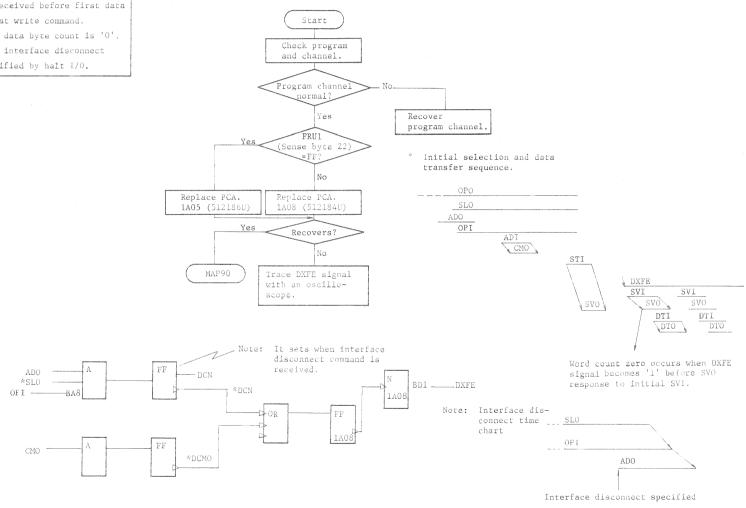
FRU2 .... contents of IFCTL register

D0050 Word Count Zero

Word Count Zero

Generated when data transfer halt command received before first data received at write command.

- (1) When data byte count is '0'.
- (2) When interface disconnect specified by halt I/O.

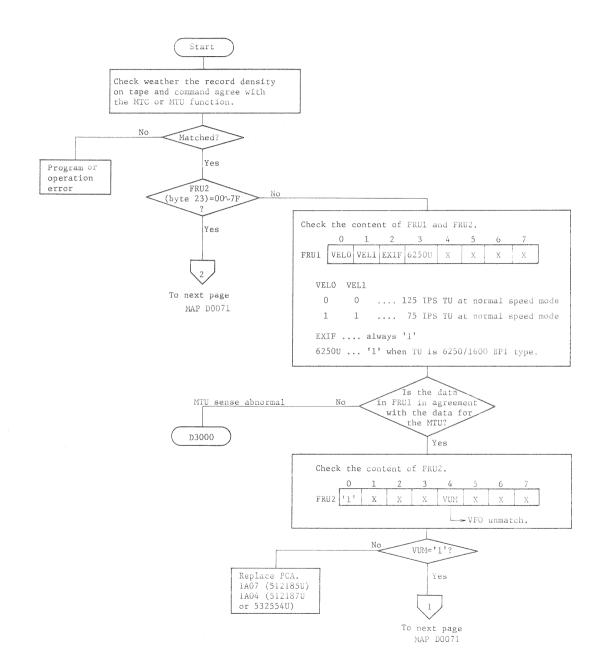


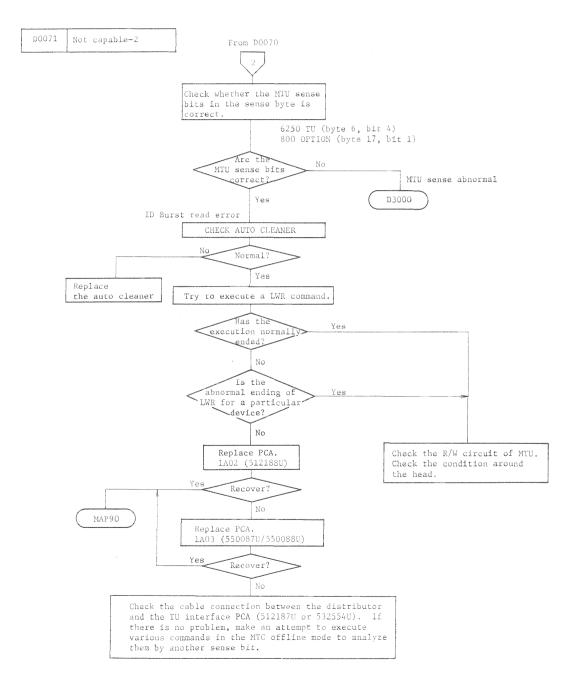
D0060 20 m Check (When TU status A, B both '1') 20 m Check (When TU status A, B both '1') Start Generated when any data was not detected for Specific more than 20 m at read command. (Any of BOB, DTM, ARA, or NRZ data byte was not detected.) No Probable cause is virgin tape. DBOB, DDTM, DARA signal may be detected at read even if bits 2-4 cleaner operation dropped. normal? Replace auto-Yes cleaner. 800 RPI tape? Execute LWR command No From either CPU or MTC. Refer to D3040. Replace PCA. 1A01 (512189U) Replace PCA. 1A02 (512188U Normal? No Check MTU R/W circuit. Recovers? A7000 (6250/1600 RPI MTU) A7100 (1600/800 RPI MTU) 6250 rpi? Yes D2010 MAP90 Yes 1600 rpi? D2030 D2040

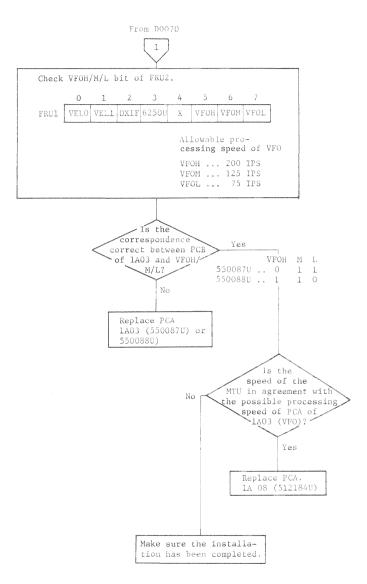
D0070 Not Capable-1

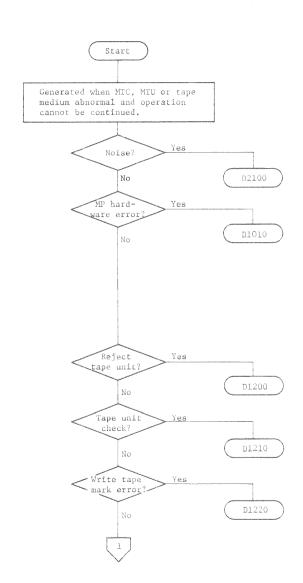
## Not capable is generated;

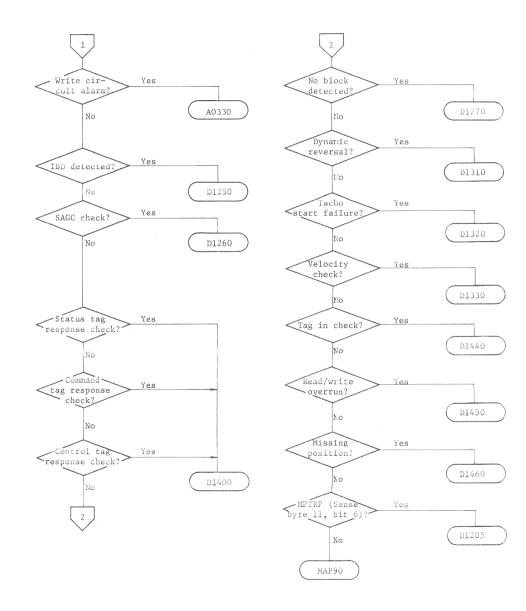
- (1) If an attempt is made to read 800 BPT tape through the MTC or MTU without 800 BPI feature or function.
- (2) If an attempt is made to read 6250 BPI tape with the MTU without 6250 BPI function.
- (3) If the specification for the maximum possible processing speed of the demodulation circuit is not in agreement with that for the speed of the MTU. (In this case, FRU2 = 80  $^{\circ}$  FF).











D1010 MP Hardware Error

ROM parity error Register parity error MP detect error

MPHE (Sense byte 4, bit 0) is generated in following cases:

 When parity error of MTC's microprogram control storage occurs

In this case, bit 5 of sense byte 11 (MTC ROM parity error) is set.

(2) When parity error of MTC's local storage (register)

In this case, bit 3 of sense byte 11 (register parity error) is set.

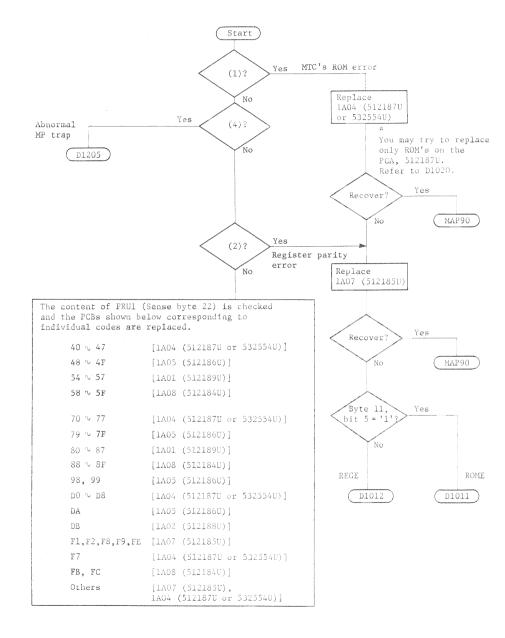
(3) When an error is detected during the idle diagnosing or in the TEST MTC (MPDE-Sense byte 11, bit 4 is set), an error is detected during the power-on-diagnosing and the disconnect-in-sequence has been executed for channel during the preceding operation.

Note: The case where the MPHE is accompanied by BOC

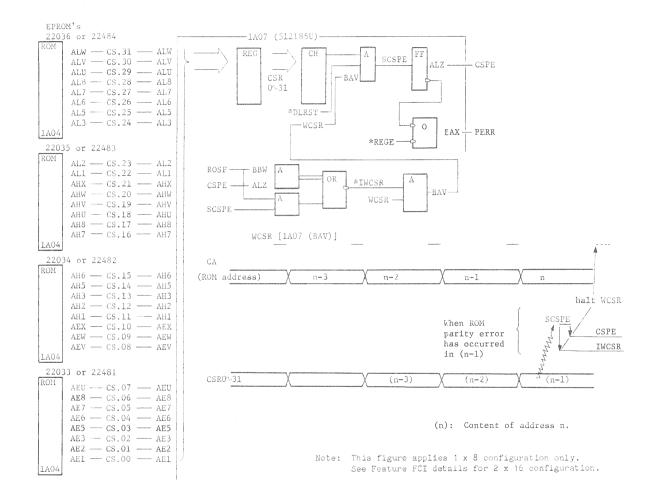
Error must have actually occurred during the operation immediately preceding the operation and the disconnect-in-sequence must have occurred. Namely, the ICC (Interface Control Check) takes place in the channel. The BOC which is accompanied by the above MPHE responds to the command first appearing after the selective reset is carried out. The above three cases point out the cause of ICC and they can be considered temporary hardware failures. The command execution answered by the BOC is retried in accordance with the usual error recovery procedure.

(4) When an unknown trap occurs

FRU1 (Sense byte 22) = 78



D1011 ROM Parity Error

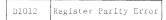


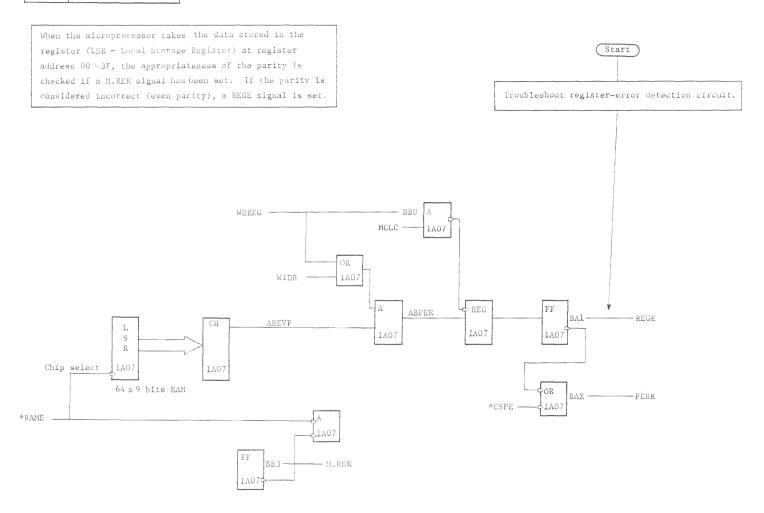
Start

Make sure that ROM's are mounted at correct position, then track down ROM parity.

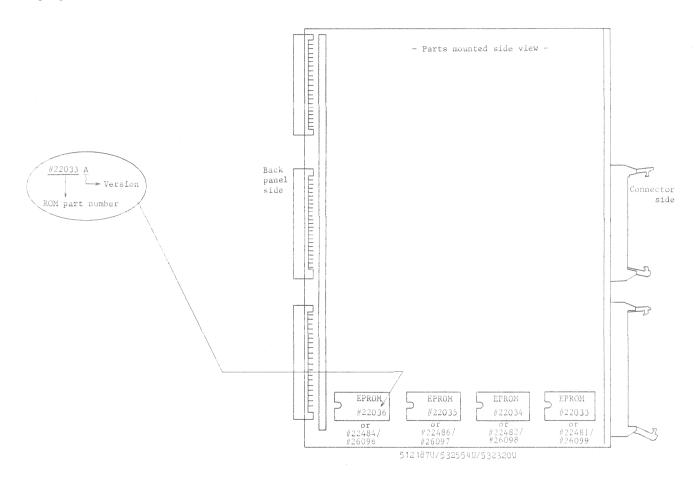
You may use ROM scan function with field tester as follows. (M0150)  $\,$ 

- (1) Make CE-ONL/OFL switch OFFLINE.
- (2) Set switches SO-S7 to X'F4', then make CNT switch ON. (ROM scan function begins.)
- (3) Set switches S0-S7 to X'A4', and lamps L0 ~ L11 will be in half-lighted condition if any ROM parity error has not occurred.
  - When ROM parity error occur, microprocessor is halted immediately.
- (4) Set switches SO-S7 to X'FO', then make CNT switch ON to terminate ROM scan function. Don't forget to return CE-ONL/OFL switch ONLINE after all troubleshooting.





1. Compare each ROM part number with following figure.



D1200 Reject Tape Unit

Reject Tape Unit

### Generated in the following cases:

- (1) When capstan tacho pulse stopped during drive. ... Tacho start failure FRU1 (Sense byte 22) = 74 TCSF (Sense byte 10, bit 5) = 0N
- (2) When MTU has become abnormal condition while MTU connected to MTC and

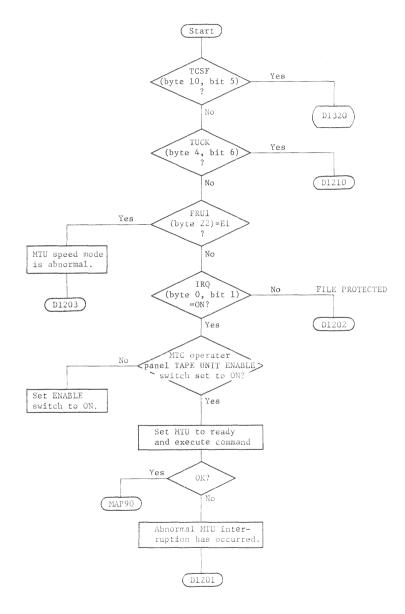
  - 2) MTU has become 'not ready' or 'not online' condition.
     FRU1 (Sense byte 22) = 70
     FRU2 (Sense byte 23) = Tape unit sense byte 0
     IRO (Sense byte 0, bit 1) = ON
  - 3) MTU has become 'file protected' condition during write, write tape mark, erase operation.

FRU1 (Sense byte 22) = 70

FRU2 (Sense byte 23) = Tape unit sense byte 0

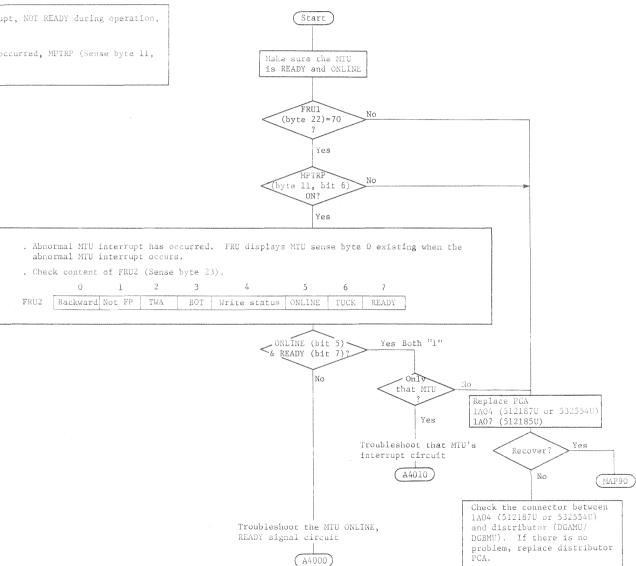
FP (Sense byte 1, bit 6) = ON

4) MTU, in 800 BPI mode and not at BOT, has become 'high speed' mode. FRU1 (Sense byte 22) = E1  $\,$ 



Abnormal MTU interrupt, NOT READY during operation, is suspected.

When MTU interrupt occurred, MPTRP (Sense byte 11, bit 6) was set.



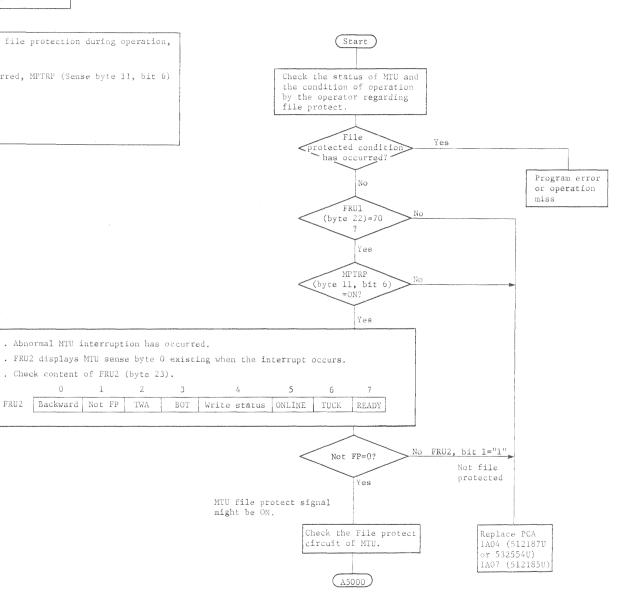
Abnormal MTU interruption, file protection during operation, is suspected.

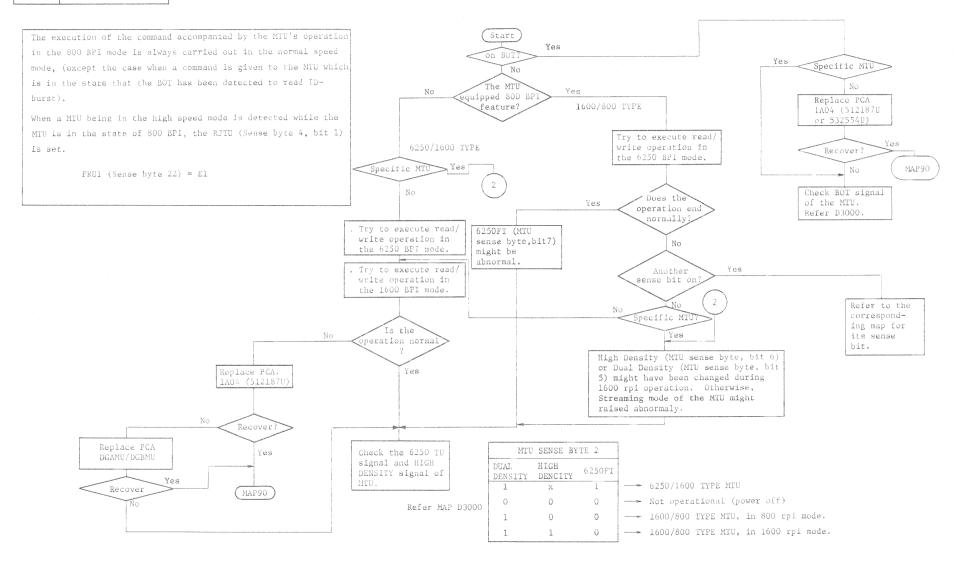
When MTU interruption occurred, MPTRP (Sense byte 11, bit 6)

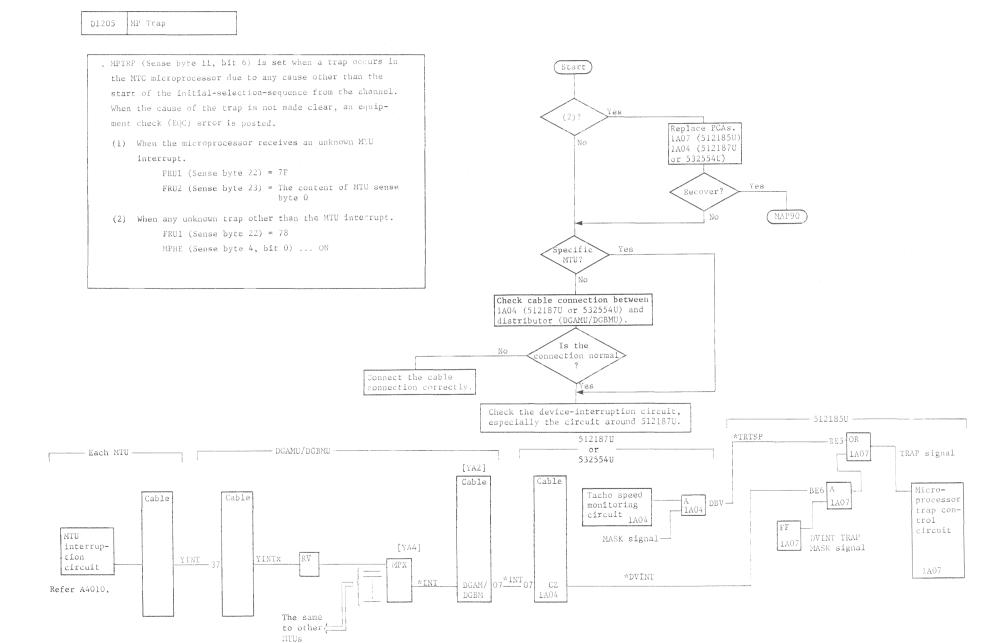
. Check content of FRU2 (byte 23).

TWA

FRU2 Backward Not FP

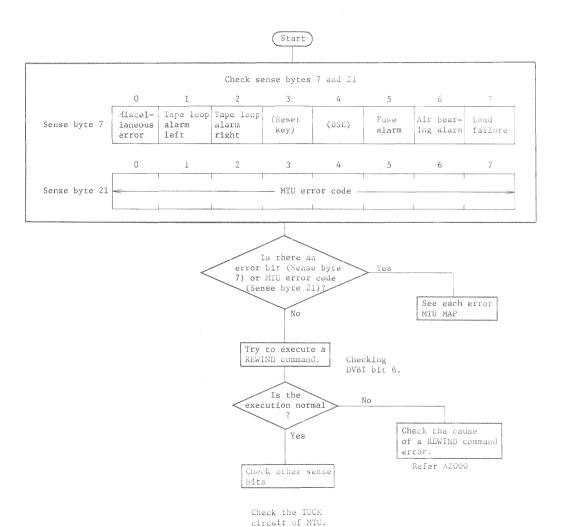






D1210 Tape Unit Check

- . Tape Unit Check (Sense byte 4, bit 6) is set when the MTC detects an abnormal state of the selected tape unit. More detailed error information is displayed on Sense bytes 7 and 21.
- . When the cause of tape unit check is laid only in load failure (Sense byte 7, bit 7), the EQC is not set. Otherwise, the EQC is set.
- . Sense byte 21 (MTU error code) is displayed as an error code on the MTU operation panel.

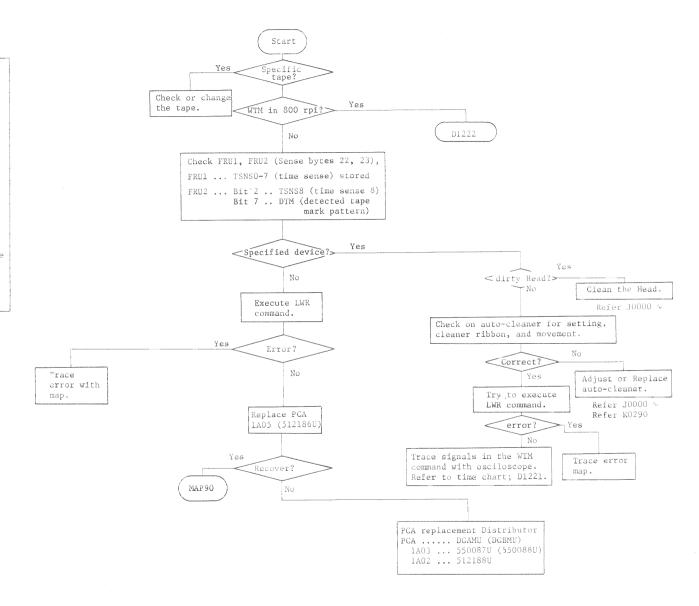


D1220 Write Tape Mark Error - 1

This error occurs when TM (Tape Mark) is not properly written.

- (1) When the TM pattern cannot be detected within the specific length from the end of recording the TM block in 6250/1600 rpi operation.
- (2) When IBG cannot be detected within the specific length from the end of the TM block in 6250/1600 rpi operation.
- (3) When the TM code cannot be detected in 800 rpi operation.

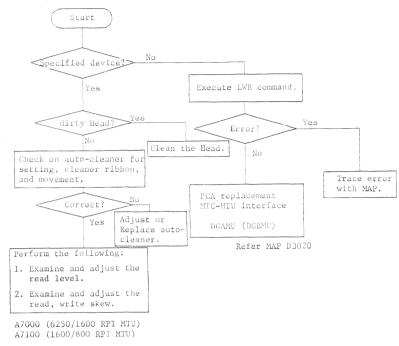
At this time, the contents of time sense are stored in FRU1 (Sense byte 22) in 6250/1600 rpi. Time sense data is the actual data bit pattern.

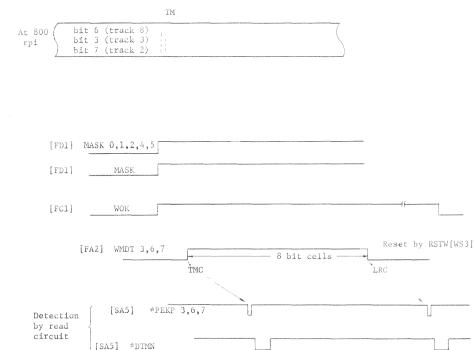


D1221 Write Tape Mark Error - 2

		TM(3200FCI)	TM
At 160	O rpi	ATTRICAS ANTONIAS ENTRAGES ORGANIAS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANTONISS ANT	STATES OF THE PROPERTY OF T
	[FD1]	MASK1.3.4	
	[FD1]	MASK	
	[FD1] ROK	WOK, WEC, ALIWT	
	[FA2] WMD	0,2,5,6,7,8	
	Detected by read circuit	[FL8] TSNS 0.2.5.6.7.8	

TM(9	042FC1)	TM		
At 6250   Bit 6 (Track 8) Bit 0 (Track 7) Bit 2 (Track 3) Bit 8 (Track 4) Bit 7 (Track 4) Bit 5 (Track 1)	trimeace conscret conscret conscret conscret conscret conscret conscret conscret conscret conscret conscret conscret conscret	6/2000000 6/20000000 6/20000000 5/20000000 6/20000000		
[FD1] <u>MASK1.3.4</u>				
[FD1] MASK				
[FD2] ROK, WOK, WEC,	AL1WT			
WMDT0.2.5.6.7.8	سسسن			
[FL8] TSNSC	.2.5.6.7.8			
[FN6] DTM				
arting WTM operation		at 1600 rpi		
1487 QTP		e at 6250 rpi		
	- Erase	24 QTP read at 1	tion TM block verification  TM block verification read at 6250 rpi	ition





#### ID Burst Check

Generated when recording density identification (ID), ARA and IVTM (ARA ID) are not written correctly on the load point.

1. ID Burst could not be detected.

6250 rpi - Track 6 (bit 1) 1600 rpi - Track 4 (bit 8)

2. ARA Burst was not written correctly. (Refer to D1260.)

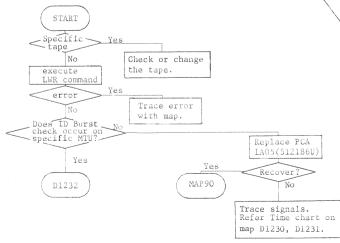
SAGC check (sense byte 8, bit 4) is set.

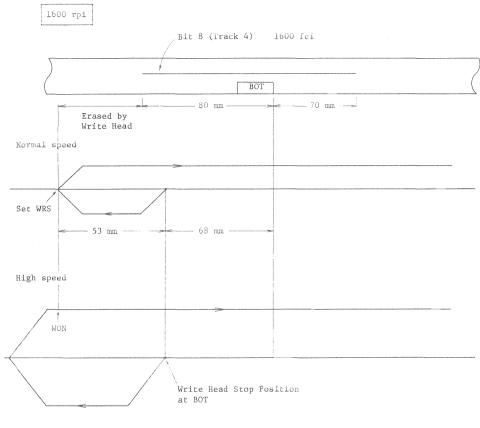
3. IVTM could not be detected.

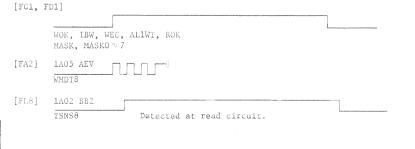
Case 1, 2 and 3, the contents of time sense are stored in FRUL (Sense byte 22) and FRU2 (Sense byte 23).

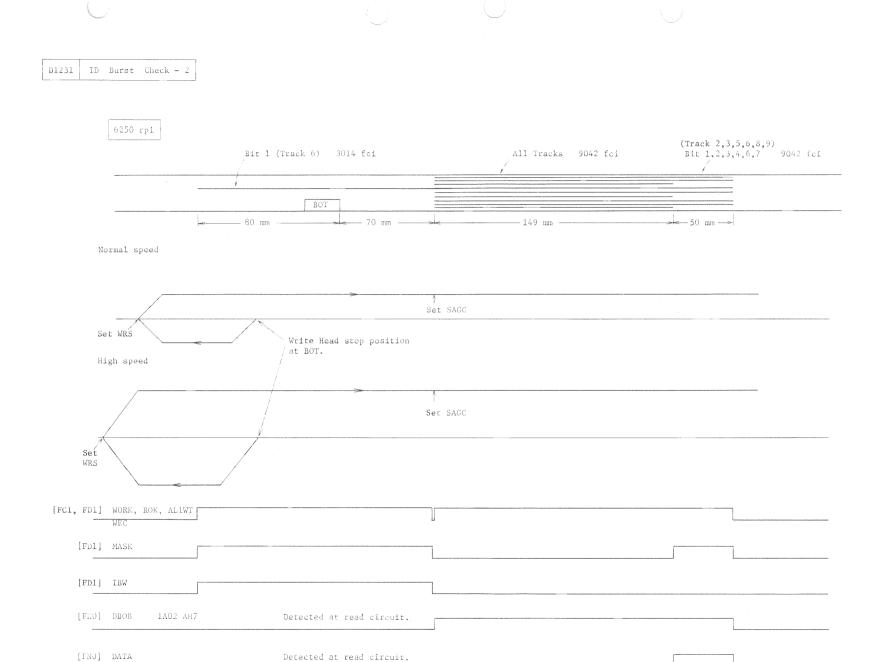
bit 0 - TSNSO bit 1 - TSNS1 bit 7 - TSNS7

bit 1 - TSNS8

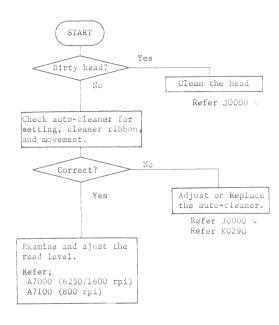








D1232 ID Burst Check-3

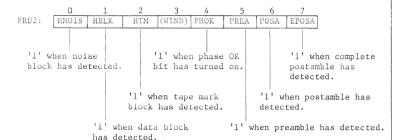


D1250 IBG Detected

Generated when;

(1) IBG was detected during write or Loop write to Read operation. Data Check bit (Sense byte 0, bit 4) is set together in this case. EVC (Sense byte 3, bit 4) may also be set in 6250/1600 rpi write operation. Following FRMs may be indicated on sense byte 22, 23.

FRU1 (Sense byte 22) ..... 'A8'
FRU2 (Sense byte 23) ..... Content of RDSNS Register.



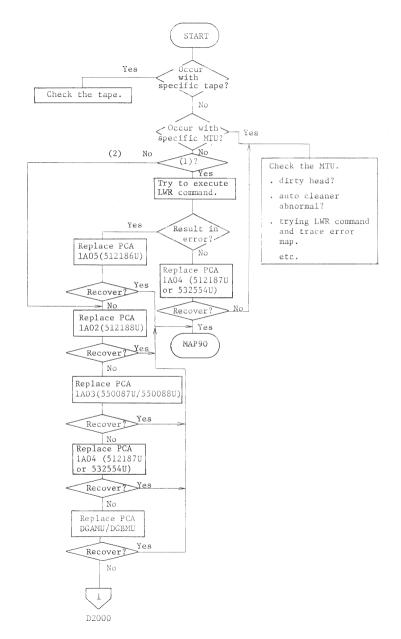
(2) IBG was not detected within the prescribed time from a point ARA on ID burst had recognized successfully in 6250 or 1600 rpi read operation respectively. Equipment Check (Sense byte 0, bit 3) is set together in this case. FRU1,2 give TSNS information as follow.

FRU1 (Sense byte 22)

0	1	2	3	4	5	6	7
TSNS0	TSNSl	TSNS2	TSNS3	TSNS4	TSNS5	TSNS6	TSNS7

FRU2 (Sense byte 23) ....

0	1	2	3	4	5	6	7
(102CR	)(DET8)	TSNS8	(DIBG)	(DNOIS)	(DBOB)	(DARA)	(DTM)

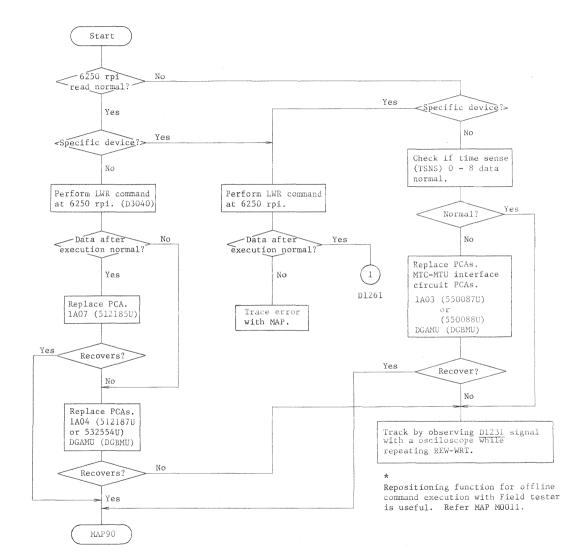


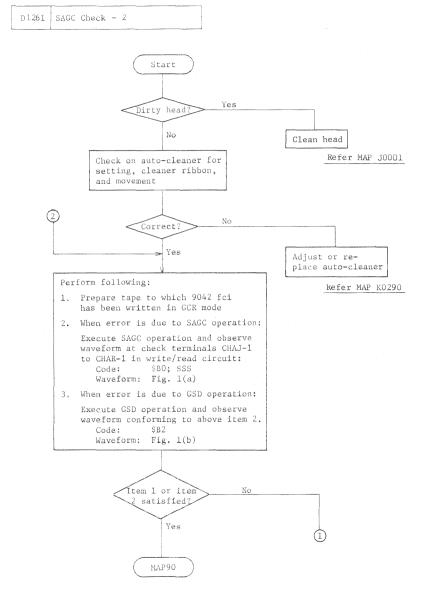
D1260 SAGC Check - 1

SAGC Check - 1

Generated in the following cases:

 When ARA burst read or write was not performed normally at 6250 rpi operation.





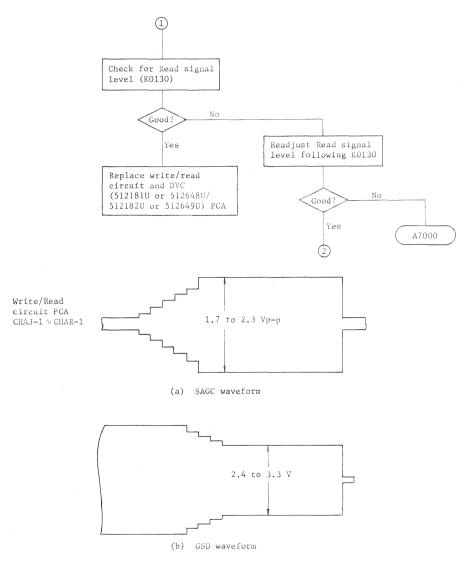


Fig. 1

D1270 No Block Detect

### No Block Detect

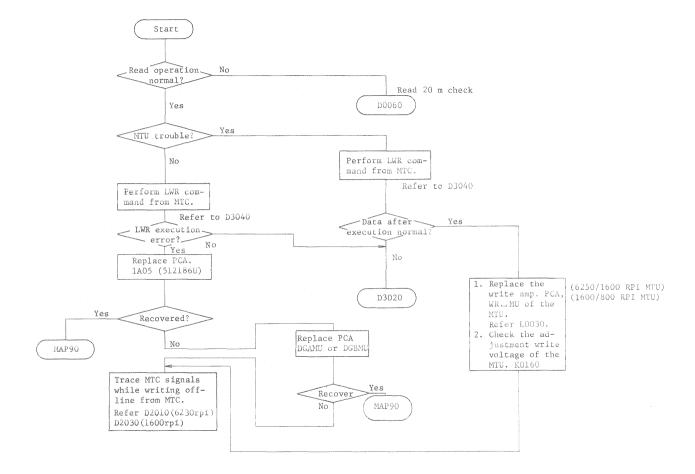
Generated when writing is started and data block cannot be detected within the prescribed length after the writing is ended at write command.

(Detected at 70 OTP)

When DNIS (Detection of Noise pattern) signal continues as long as 46 bit cell in 6250 rpi mode or 22 bit cell in 1600 rpi mode, HNOIS signal is generated.

Detection of data block depends on whether HNOIS signal is generated or not.

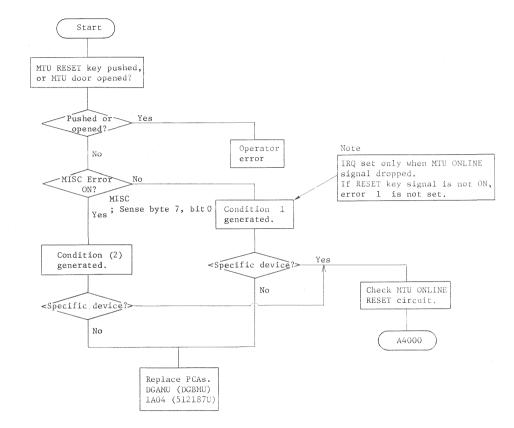
<u>DNOIS</u> Detection Pattern at 6250/1600 rpi Write 0.4.6 + 1.2.8 + 3.5.7 + (0+4+6)(1+2+8)(3+5.7)



D1300 Reset Key

### Reset Key

-	Gene	rated in the following cases:
	(1)	When MTU RESET key pushed mistakenly
-		during MTU drive.
-		(IRQ, RJTU also set)
-		FRU1 (Sense byte 22) 70
-		
With Street or other Designation of the last of the la	(2)	When MTU door opened mistakenly
-		during operation.
and distances		(IRQ, RJTU, Miscellaneous Error
-		also set)
-		FRU1 (Sense byte 22) 70
1		

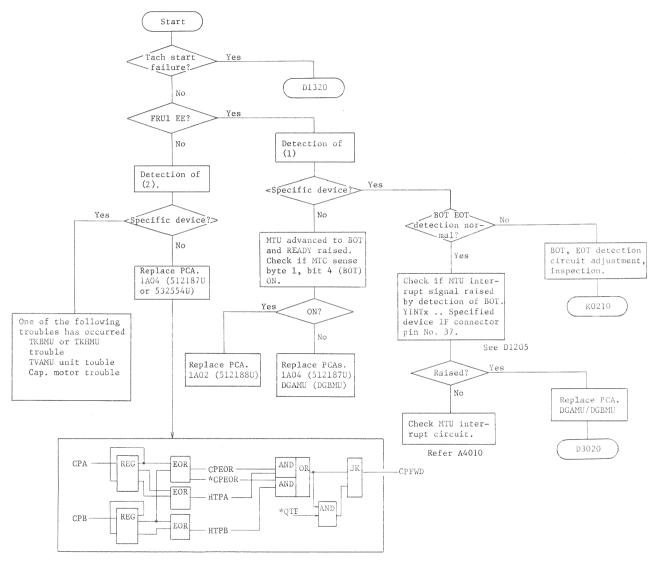


Dynamic Reversal

Generated in the following cases:

- IVTM block detected, but BOT not detected within the prescribed length at backward operation at 6250 rpi.
  - o FRU1 (sense byte 22) .... EE
  - o FRU2 (sense byte 23) .... Time sense 0-7
  - o IVTM detection detected at 28TP (6.7 mm)
  - o BOT must be detected within 2304FTP (550 mm) after IVTM detection.
- (2) Operated more than the prescribed QTP number in reverse direction at MTU starting.
  - o FRU1 (sense byte 22) .... CC
  - o FRU2 (sense byte 23) .... TQP count number (length of running in drive direction)

Error when operated 108TP in reverse direction.



Reverse or Forward Direction Detect Circuit

D1320 | Tach Start Failure - 1

Generated in the following cases:

 When prescribed QTP length within the prescribed time at MTU starting.

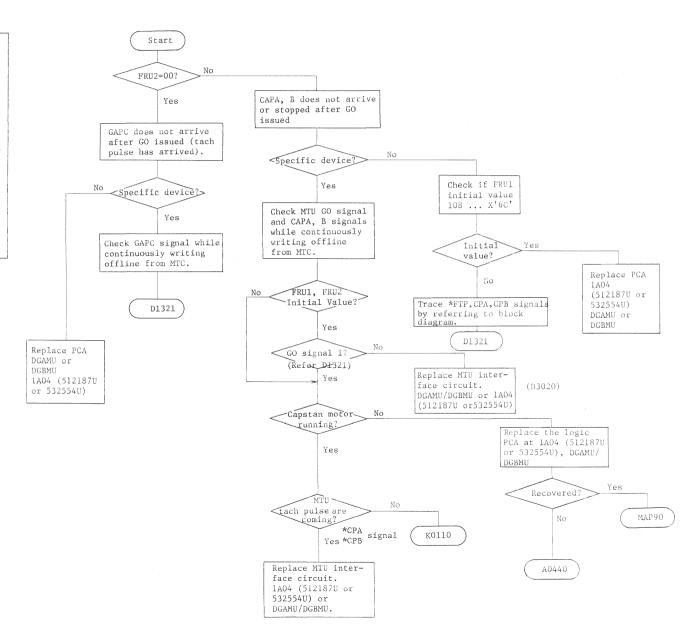
FRU1 (sense byte 22) ... 108-QTP count total (Drive direction and Reverse direction)

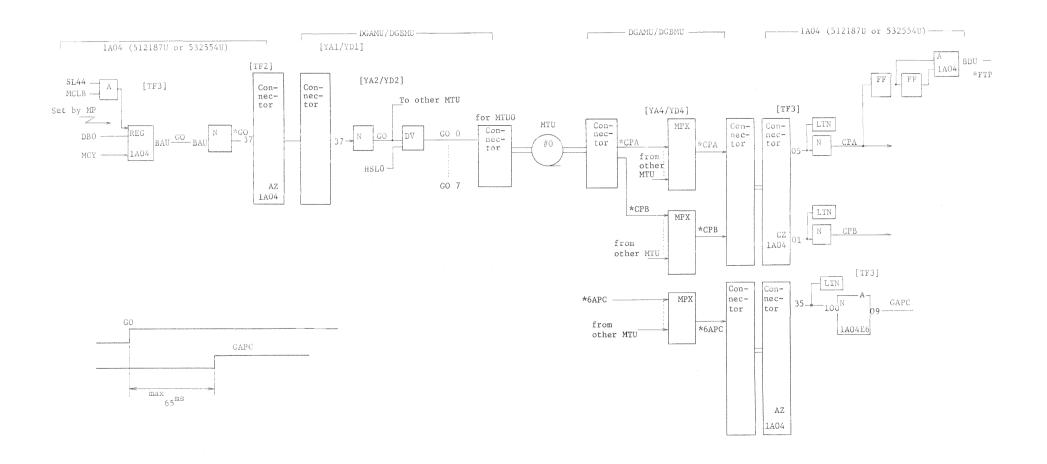
FRU2 (sense byte 23) ... 20-Drive direction QTP count

(2) When GAP CTL was not raised within prescribed time at MTU starting.

FRU1 ... 108-QTP spacing at that time FRU2 ... 00

Prescribed time .... 65 ms





D1330 | Velocity Check



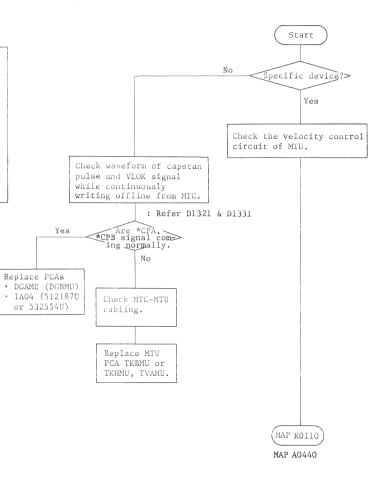
Generated when Velocity retry over (16 times) has occurred during write operation.

### o Velocity retry:

Write start was late because capstan speed was not prescribed value.

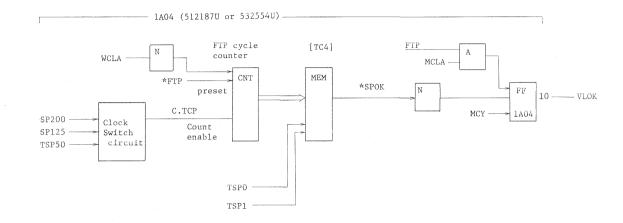
(Not within prescribed value

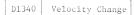
±7%

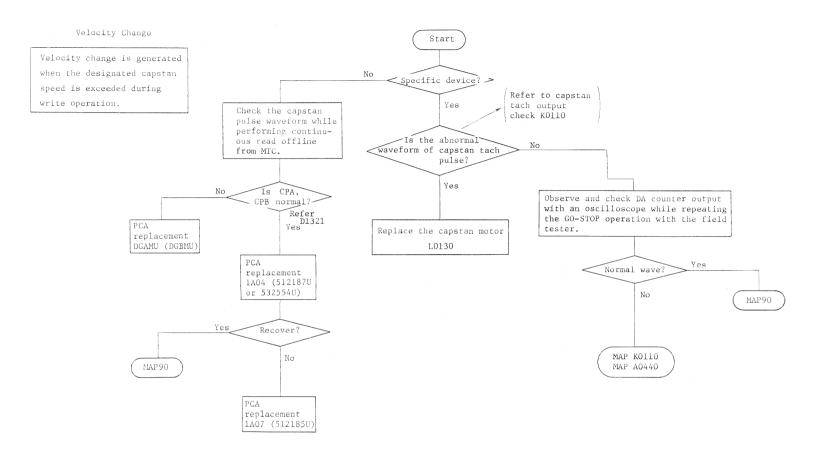


D1331 Velocity Check - 2

Velocity check circuit







Early begin read back check, D1350 Slow begin read back check, Slow end read back check

o Early begin read back check

These are generated in the following cases:

- (1) When data-byte (800 bpi) or DBOB pattern (1600/ 6250 rpi) is detected within (a) shown at Fig. 1 at write command execution. (When data is detected too early.)
- (2) When IBG is detected during writing (WOK signal on) at write command of 800 rpi. (When IBG is detected too early.)
- o Slow begin read back check Generated when data-byte (800 bpi) or No. 5 pattern (1600/6250 rpi) is detected within (b) shown in Fig. 1. (When data is detected too slow.)
- o Slow end read back check Generated when IBG detected at over 700TP after block end detected after write end.

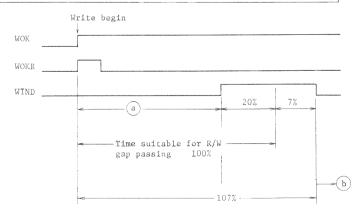
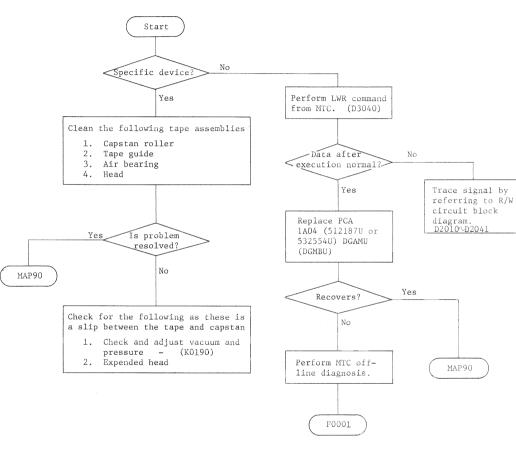


Fig. 1 Slip check timing



D1400

Status Tag Response Check Command Tag Response Check Control Tag Response Check

The MTC uses three tag signal lines (Status tag, Control tag, and Go tag) to carry out control on the MTU. Further, the MTC uses the status tag line in conjunction with the control tag line as a command tag line when both the status and the control tag lines are activated.

When the MTC uses the status tag, control tag, and command tag lines to control the MTU, the MTC receives a response from the MTU. When the response is not normal, the Status Tag Response Check, Control Tag Response Check, and Command Tag Response Check are set.

FRU1 (Sense byte 22) ..... Control data

(Content of DVBO register)

FRU2 (Sense byte 23) .... Response data

(Content of DVBO register)

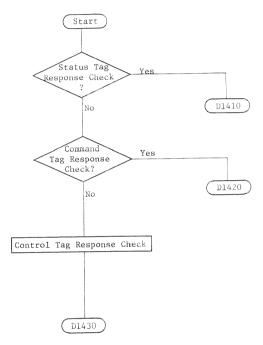
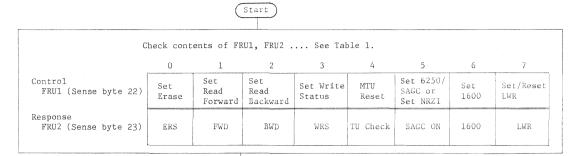
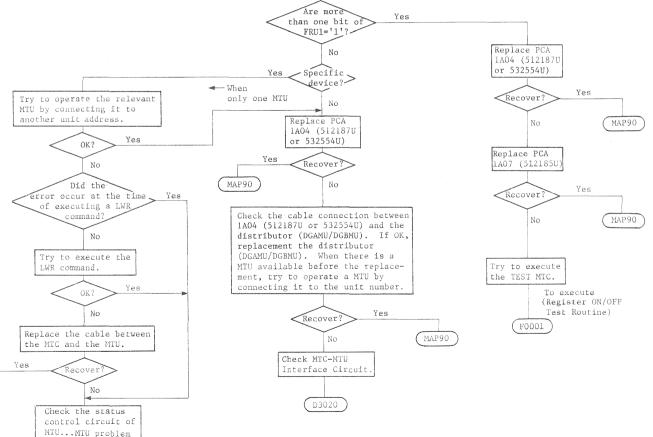


Table 1 Response check with status tag

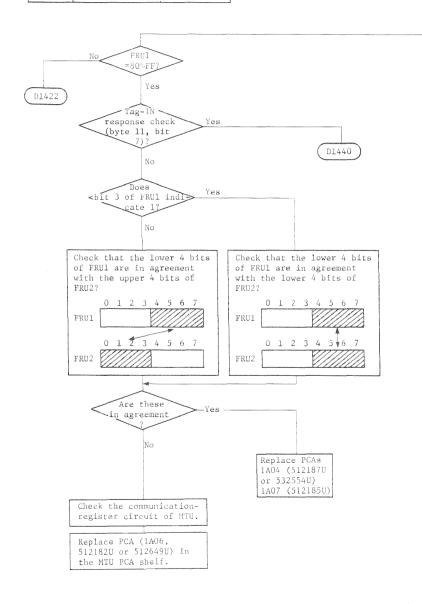
Control (FRU1) bit	Function	Response (FRU2) checked	Time out
bit 0	Set ERASE ("1")	ERS=1, LWR=0 FWD=1, BWD=0	500 ms
bit l	Set Read Forward ("1")	FWD=1, ERS=0 BWD=0 WR=0 LWR=0	500 ms
bit 2	Set Read Backward ("1")	BWD=1, ERS=0 FWD=0 WRS=0 LWR=0	500 ms
bit 3	Set Write Status ("1")	ERS=1, BWD=0 FWD=1, LWR=0 WRS=1	500 ms
bit 4	Reset MTU ("1")	TU check = 0 (DVINT=0)	10 μs (100 μs)
bit 5	Set GCR/NRZI	1600=0	13.6 ms
bit 6	Set PE ("1")	1600=1 SAGC=0	13.6 ms
bit 7	Set LWR Reset,LWR	LWR=1 LWR=0	13.6 ms

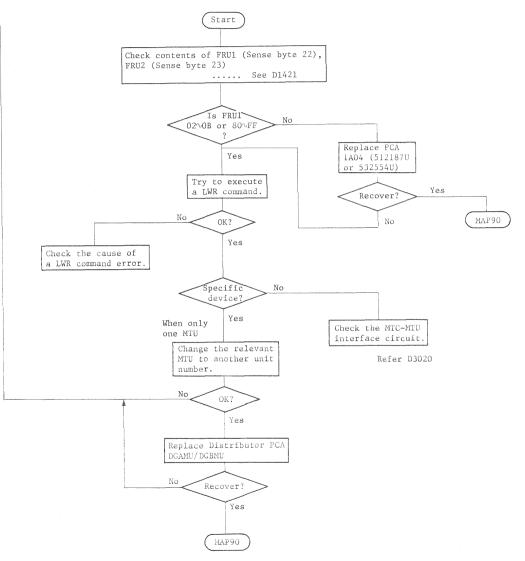
MAP90

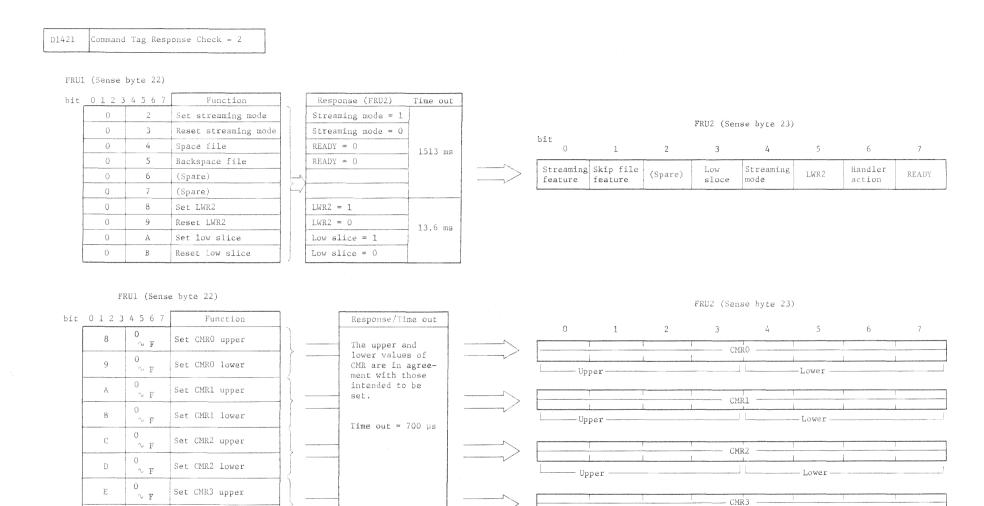












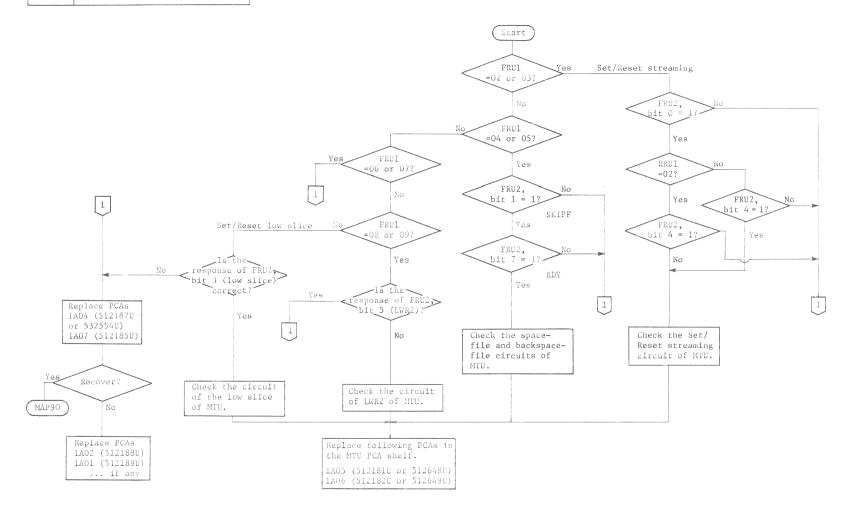
Upper

Lower -

CMR0  $\sim$  3: Communication register 0  $\sim$  3.

Set CMR3 lower

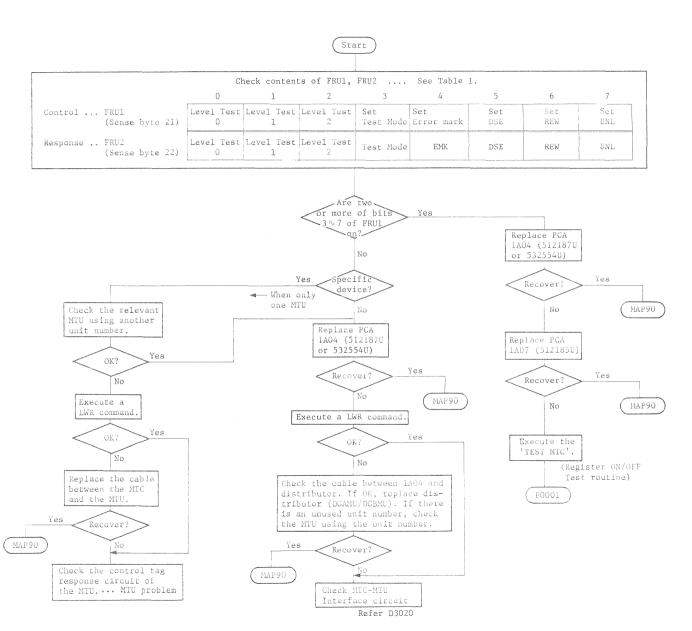
F



			_	
D1430	Control	Tag	Response	Check

Table 1 Response check with Control Tag

Control FRU1	Function	Response (FRU2)	Time out
bit 0 ~ bit 2	Level set	Level Test 0∿2	500 ms
bit 3	Set Test-Mode	Test Mode	500 ms
bit 4	Set EMK	EMT = 1	500 ms
bit 5	Set DSE	DSE = 1 (also READY = 0)	500 ms
bit 6	Set REW	REW = I (also READY = 0)	500 ms
bit 7	Set UNL	UNL = 1 (also READY = 0)	500 ms

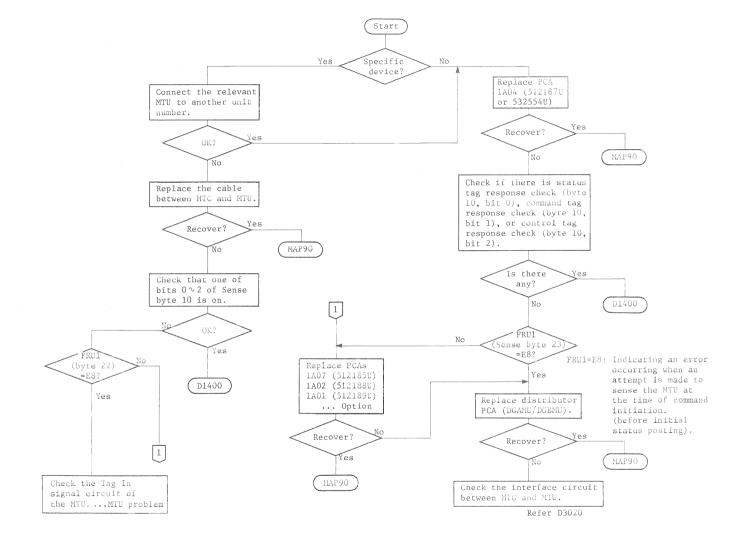


D1440 Tag In Check

Tag In Check

Generated when TAG-IN signal response does not arrive within the prescribed time from MTU for TU sense specified from MTC.

(Prescribed time =  $3 \sim 7 \ \mu s$ )



Read/Write Overrun (Read/write time-out)

Replace the cable.

< Recover

Return the current unitaddress put

on the relevant MTU to its original

unit address.

To be set on the occurrence of either of the following cases.

(1) When the write and read operations of one data block is carried out over 15 m or the time interval equivalent to 15 m run. ..... RWTO

> FRU1 (Sense byte 22) = 77MPTRP (Sense byte 11, bit 6) .... ON

(2) In case a missing position (Sense byte 11, bit 1) is set and the time when an abnormality occurs in the tape mark search of the MTU is indicated. See D1460.

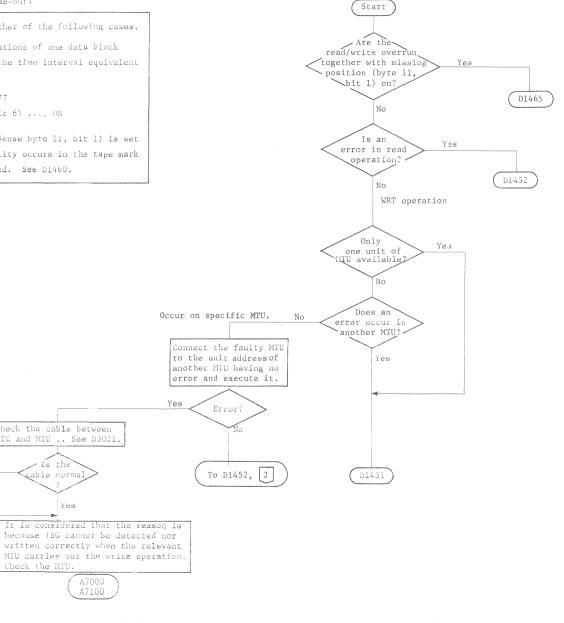
> Check the cable between MTC and MTU .. See D3021. Is the

> > able normal

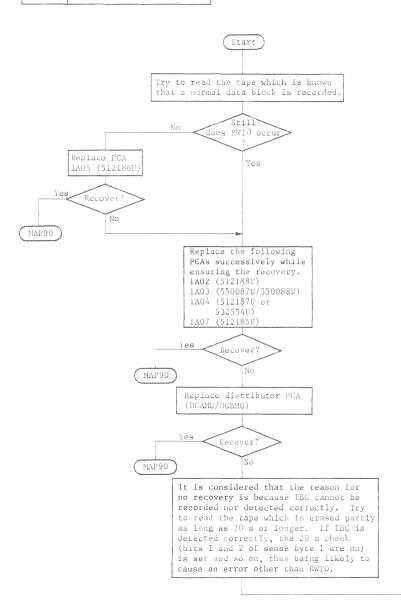
Check the MTU.

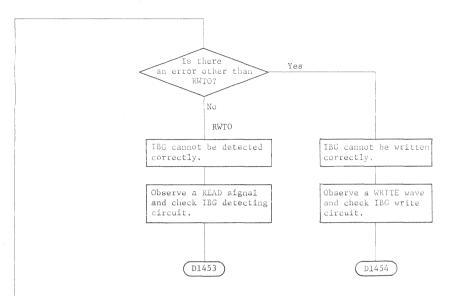
Yes

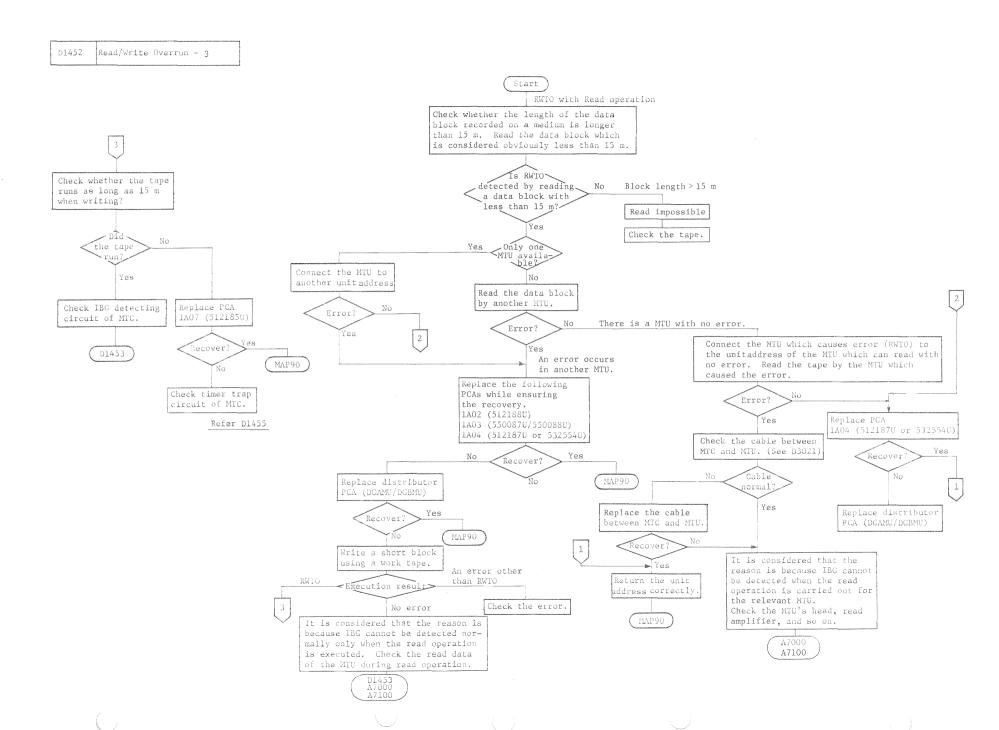
A7000

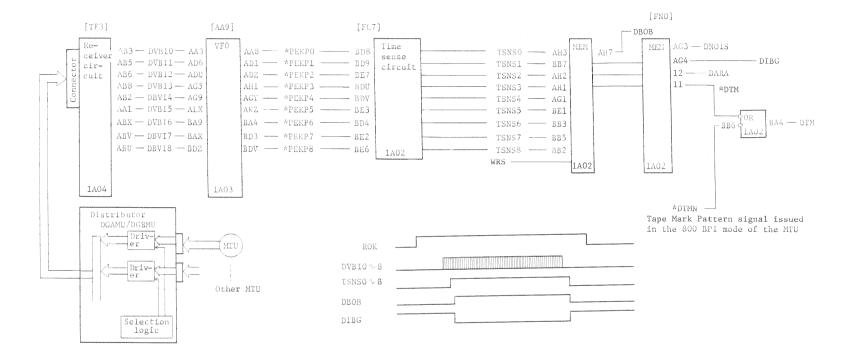


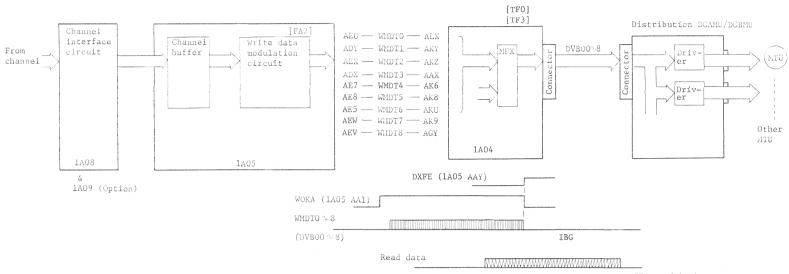
D1451 Read/Write Overrun - 2



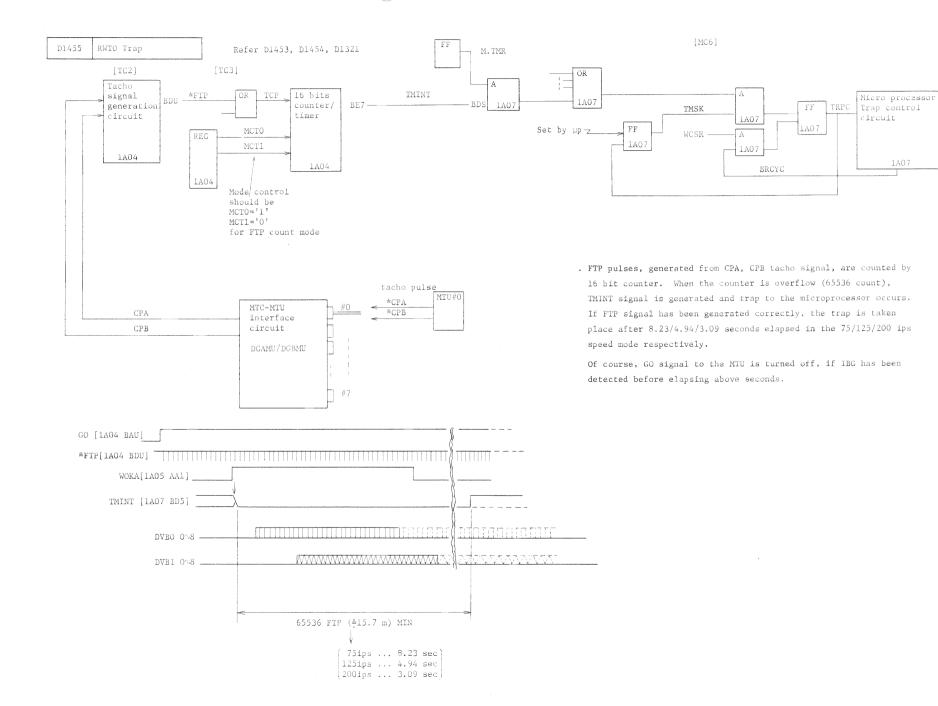








IBG read back



## D1460 Missing Position - 1

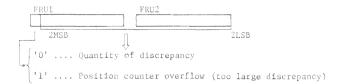
#### Generated in the following cases:

(1) When a data check error is generated in write, Read or Read Backward command operation, the information concerned with the length of block recorded in the operation is stored in communication register of MTU.

After that, for error recovery by retrying, the Back Space command corresponding to the Read and Write commands or the Space command corresponding to the Read Backward command is issued.

At that the space length associated with Space or Back Space command is compared with the error block length stored in communication register which is mentioned above. When the difference between both of the lengths is larger than the requirement, MISP (Sense byte 11, bit 1) is generated.

FRU1 (Sense byte 22) and FRU2 (Sense byte 23) provide a information of the length discrepancy.

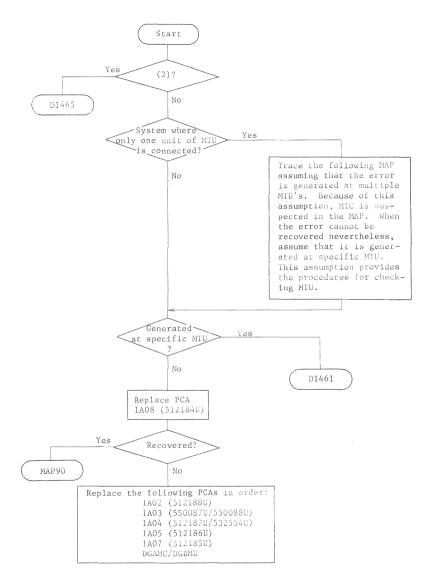


- (2) After instructing MTU to search for Tape Mark Search in order to perform Space File or Back Space File command;
  - When Tape Mark block cannot be detected correctly, though MTU enters ready status.

(Bit 7 of TU Sense byte, Tape Mark, is 0.)

 When MTU detects an interruption except EOT detecting and Tape overrun of the MTU.

In this case, RWTO (Sense byte 11, bit 0) is also generated.



D1461 Missing Position - 2

The reasons why trouble is generated only at specific MTU:

(a) Abnormality of communication register for storing of MTU position count value

(b) Slip has occurred.

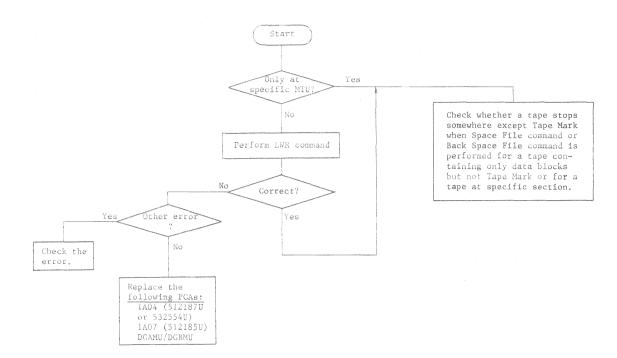
(c) Data is not regenerated correctly.

Check if there is a big difference between read signal level in Forward direction and one in Backward direction.

Check stains and an abnormality of Capstan.

MAP A0440

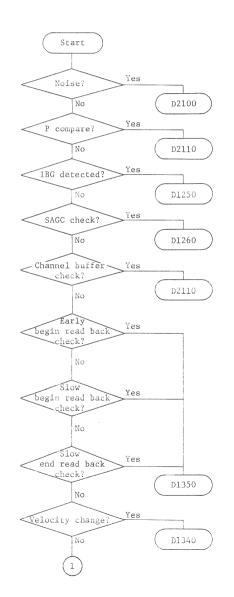
. . ) .

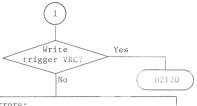


D2000 Data Check

### Data Check

Data check occurs when the following error are detected: (1) R/W and internal circuit error Noise Sense byte 1 - 0 3 - 0 VRC error Multiple track error/LRC error 3 - 1 3 - 2 Skew error End data check/CRC error 3 - 3 3 - 4 Envelope check 3 - 7 P compare 4 - 3 Write trigger VRC Start read check 5 - 4 Partial record 5 - 5 Postamble error 5 - 6 Error counter overflow 5 - 7 IBG detected 8 - 0 SAGC check 8 - 4 Channel buffer check 9 - 2 SRC III error 9 - 3 (2) Tape speed error Early begin read back check Sense byte Slow begin read back check 8 - 5 Slow end read back check 8 - 6 Velocity change 9 - 1



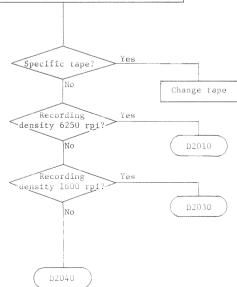


R/W data errors; Refer to D2001, 2 for a description of each error

Check error track from sense data.

- o 6250 rpi error track.

  Track at which dropout, invalid pattern, phase error generated.
- o 1600 rpi error track Track where dropout, phase error generated.
- o 800 rpi error track
  Track at which error generated when there
  was an error at a single track.
  '1' is set in bits 6, 7 when there was an
- error, but the track is unknown.



D2001 Data Check Sense Byte Explanation - 1

#### o VRC error

- (1) When recoverable VRC error generated at read, read backward command.
- (2) When VRC error generated at write, LWR command. (May have CRC error set also.)
- o Multíple track error/LRC error
  - When there is a pointer of 2 tracks or greater at 6250 rpi write, LWR command.
  - (2) When there is a pointer of 3 tracks or more at 6250 rpi read, read backward.
  - (3) When there is a pointer of 2 tracks or more at 1600 rpi read, read backward.
  - (4) When 800 rpi horizontal parity check error was generated. (Error Track may have been reset by RESYNC at 6250 rpi read operation.)

#### o Skew error

 When excessive skew detected at 6250/1600 rpi read, read backward, write command.

6250	rpi	write	RIC-ROC	2
1600	rpi	write	RIC-ROC	14
6250	rpi	read	RIC-ROC	30
1600	rpi	read	RIC-ROC	15

- (2) When excessive skew detected at 800 rpi write, write tape mark command.
- o End data check/CRC error
  - (1) When postamble cannot be detected at 1600 rpi read operation. (No READEND)
  - (2) When CRC error detected at 6250/800 rpi read operation or read after write.
  - (3) When FORME (Format Error) detected at 6250 rpi operation.
- o Envelope check

When dropout detected at 1600 rpi/6250 rpi write operation.

Note: Envelope check does not cause Data check at 6250 rpi operation.

Note: Use D2010 - D2020 for 6250 rpi
Use D2030 - D2032 for 1600 rpi
Use D2040 - D2041 for 800 rpi

D2002 Data Check Sense Byte Explanation -

- * Start read check
  - When IBG encountered before data part detected after block detected at 6250/1600rpi operation.
  - (2) When data part not detected within the prescribed time after block detected at 6250/ 1600rpi operation.
- Partial record
   When IBG encountered in data at 6250/1600rpi.
- Postable error
   When abnormality detected in postable at 6250/1600rpi.
- * IBG detected When IBG detected while reading data part at  $6250/1600\mathrm{rpi}$  write command.

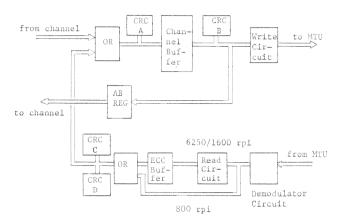
D2003

Explanation about CRC III Error

#### o CRC III error

- When CRC-B byte and CRC-D byte didn't match at 6250 rpi write, read command.
- (2) When CRC-C byte not expected pattern at 6250 rpi read backward.
- (3) When CRC-B byte and CRC-C byte didn't match at 1600/800 rpi write command.

----- CRC error set -----



CRC Generation Circuit

MODE	6250 rpi	1600/800 rpi	Sense
Write	A ≠ B	A ≠ B	Channel Buffer Check
	B ≠ D	B ≠ C	CRC III Error
Read	A ≠ B	A ≠ B	Channel Buffer Check
	B ≠ D		CRC III Error
Read	A ≠ B	A ≠ B	Channel Buffer Check
Backward	C≠Match pattern	-	CRC III Error

- ° CRCA: A.CRC pattern is generated from channel buffer input.
- ° CRCB : A.CRC pattern is generated from channel buffer output.
- ° CRCC: A.CRC pattern is generated from read data.
- ° CRCD : Set A.CRC of read data at 6250 rpi.

o When CRCIII error or P Compare error is indicated in the sense bytes, FRU1 and FRU2 described below may be indicated together.



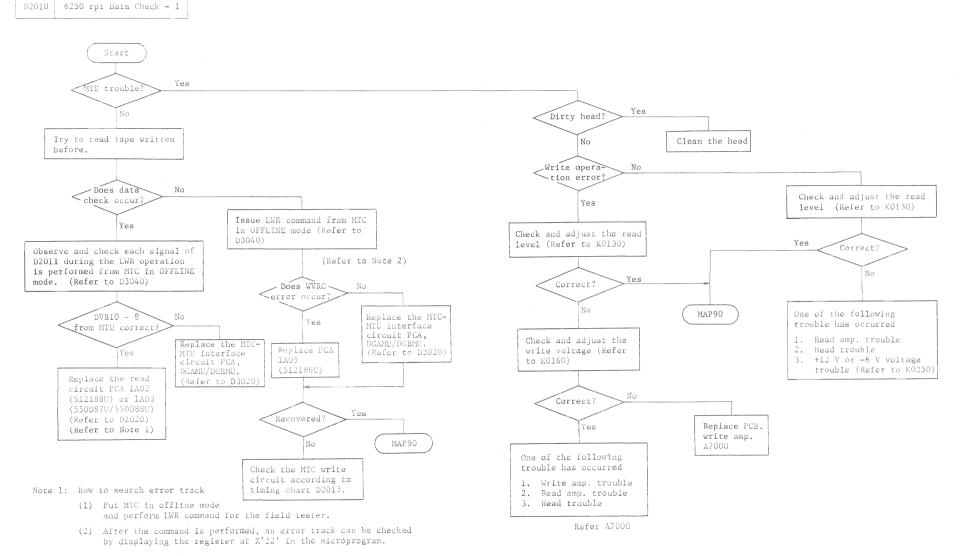
# D2004 Error Count Overflow

The error counter is incremented, if DCK and EVC (Envelope check: Sense byte 3, bit 4) are generated as a result of performing the write operation in 6250/1600 rpi mode. When performing write operation in 6250 rpi mode, if the error counter reaches X'00' or X'80', ECOVF (Error Counter Overflow: Sense byte 5, bit 7) is generated.

That is, ECOVF is generated each time  $128\ \mathrm{EVC}$  errors are detected.

The error counter is provided for each MTU.

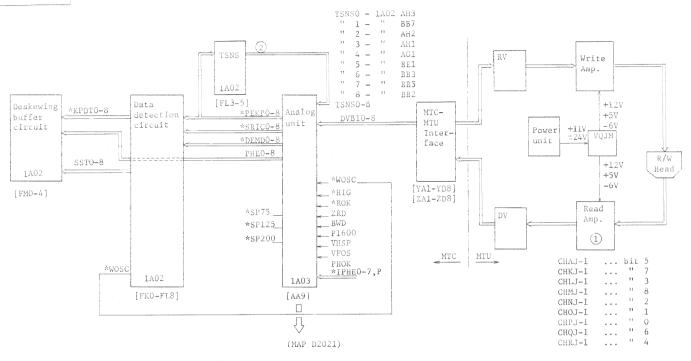
Start Confirm that DCK (Sense byte 0, bit 4) and EVC (Sense byte 3, bit 4) are on, and Error count (Sense byte 13) is X'00' or X'80'. Correct? Yes Replace the following PCAs: 1A07 (512185U) 1A04 (5121870 or 5325540) Check the cause of ENVC error Recover? MAP90 D2001 Perform LWR command Correct? Yes Check the cause of LWR command error with MAP. Check Error counter (communication register 0) circuit of MTU.



Note 2: How to search WVRC error

- (1) Display the contents of the register at  $X^{\dagger}24^{\dagger}$  in the microprogram by the field tester.
- (2) Bit 3 means WVRC.

D2011 6250 rpi Data Check - 2

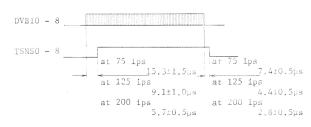




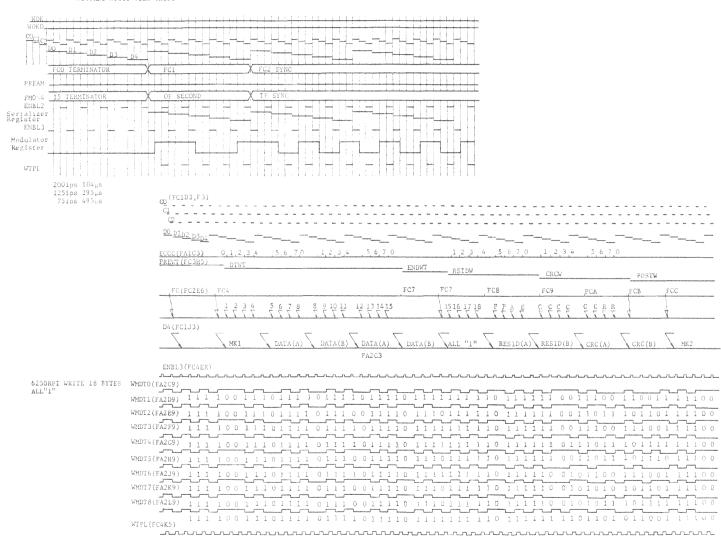
Check the wave-form during write by Field Tester. (K0130)

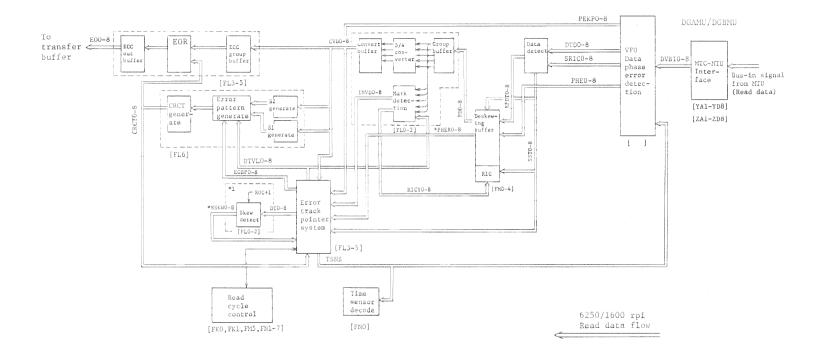
- 1) Set 9042 fci (GCR mode) after being 3200 fci (PE model) ... V ≥ 1.0V for a few seconds.
- 2) Set 9042 fci after set .... V = 2.0V±15% SAGC.
- 3) Perform the tape running backward which is written ......  $V \ge 1.0V$  in 9042 fci.

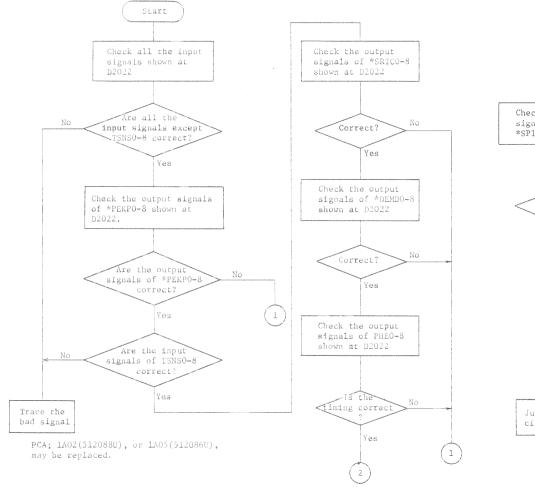


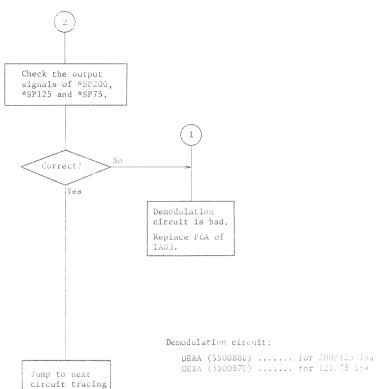












D2022 | Demodulation Circuit Trace Flow - 2

### Demodulation Circuit

## 1. Input Signals

# Table 1 Input signals

Item	Signal name	Contents	[	-			Bit					Reference
l	orgnar name	Contents	0	1	2	3	4	5	6	7	8	Reference
1	Peak Signal (DVBIO∿8)	Read peak position signal from MTU	AA3	AD6	ADU	AG5	AG9	ALX	GA9	BAX	BDZ	Fig. 1 Table 3
2	Time Sense (TSNSO∿8)	VFO input changing signal	AAU	AAV	ADY	AHZ	AK1	AKV	BA6	BD5	BD6	Fig. 3
3	Error Gener-   ated Signal  (IPHE0∿8)	Signal generating suspected <b>er</b> ror	AB7	AD3	AEV	AH7	AHW	BB1	вв3	BE2	BEW	0rdinarily +2.4 V ∿ +5.0 V
4	Read OK (*ROK)	Read start signal	NAME OF TAXABLE PARTY.				AL7					Fig. 3
5	Z Read (ZRD)	Signal indicating 800 bpi					AK6					
6	Backward (BWD)	Signal indicating tape running di- rection	AL6									
7	Write Clock (*WOSC)	Clock signal of basic frequency	AKU				Fig. 2 Table 3					
8	VFO Start (*VFOS)	Signal to reset VFO and start	AK8				Fig. 3					
9	Speed Signal (*HSP)	Signal indicating   tape speed	AL3									
10	1600 Signal (P1600)	Control signal indicating record density	AL5									
11	High Gain Signal (*HIG)	Signal changing VFO gain	BB5				Fig. 3 Table 4					
12	Phase OK (PHOK)	Signal to start data demodulation	AK4				Fig. 3					

## 2. Output Signals

Table 2 Output signals

	Signal name	Contents	Bit								Reference	
Trem	Signal name	Contents		0 1 2 3 4		5	6	7	8			
1	Peak Pulse (*PEKP0 ~8)	Rising and falling pulses of peak signal	AA8	AD1	ADZ	AH1	AGY	AKZ	BA4	BD3	BDV	Fig. 1
2	Read Clock (*SRIC0∿8)	Clock to get de- modulated data	AA6	ABX	AD8	AEX	AGX	ALB	вв7	BAV	BEU	Fig. 4
3	Demodulation Data (*DEMD0 ∿ 8)	Data recognized with 1 and 0	AB3	AE6	ADV	AH5	AHU	AKY	BBU	BZY	BDX	Fíg. 4
4	Phase Error (PHE0∿8)	Phase error detected signal	AA5	AAX	AEW	AG4	AGV	ALW	BAl	BD1	BD8	Fig. 5
5	*SP200 *SP125 *SP75	Signal indicating speed function of VFO	AE1 AK3 AK5									

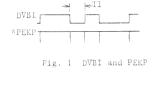




Table 3 Cycle of T1 and T2

Record density	Tape speed	T1 and T2
	200 ips	555=100 ns
6250 rpi	125 ips	885=180 ns
	75 ips	1475=300 ns
	50 ips	220=0.5 μs
	200 ips	1.56=0.3 μs
1600 rpi	125 ips	2.50±0.5 μs
	75 ips	4.20±0.8 µs
	50 ips	6.25±1.3 μs

*ROK TSNS *HIG *VFOS

Fig. 2 Input timing

Table 4 HIGH GAIN

Record density	Write/Read	*HIG						
6250 rpi	Write	+2.4∿+5.0 V						
	Read	Fig. 3						
1600 rpi	Write, Read	+2.4 √+5.0 ♥						
L	L							

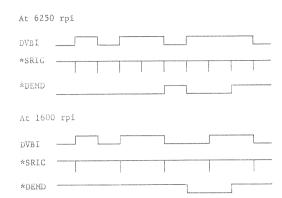


Fig. 4 Output timing

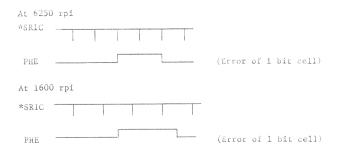
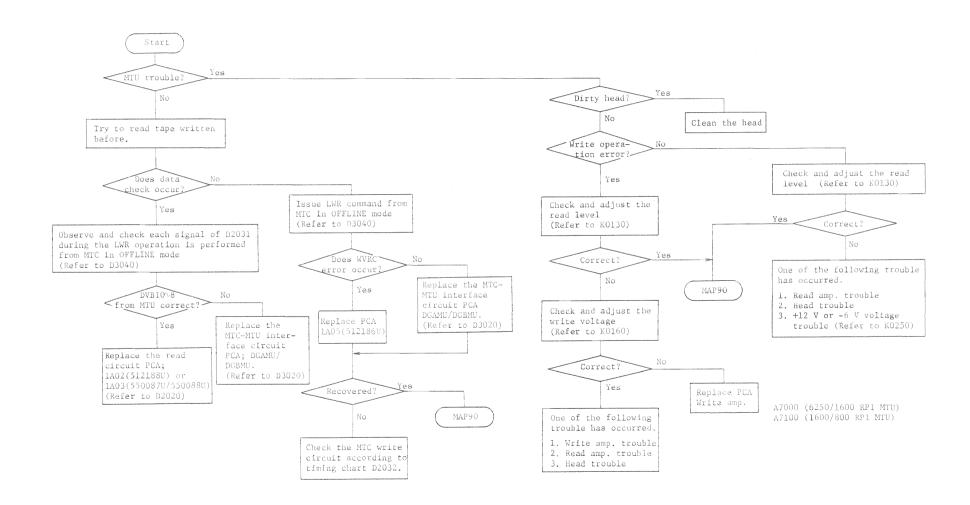
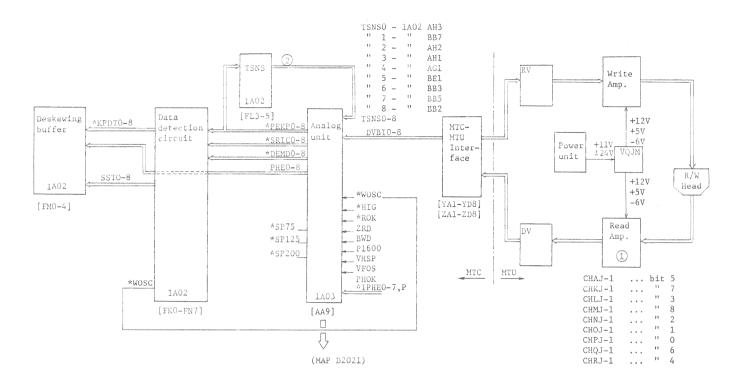


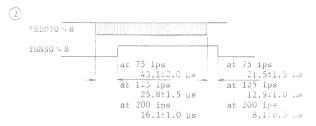
Fig. 5 PHE timing







Check the waveform during write in 3200 fci (PE mode) by Field Tester. (K0130, K1040)





( )

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One of the following troubles has occured:

1. Write amplifier, Read amplifier (WRUMU) trouble

2. Head trouble

Correct

Replace PCA.

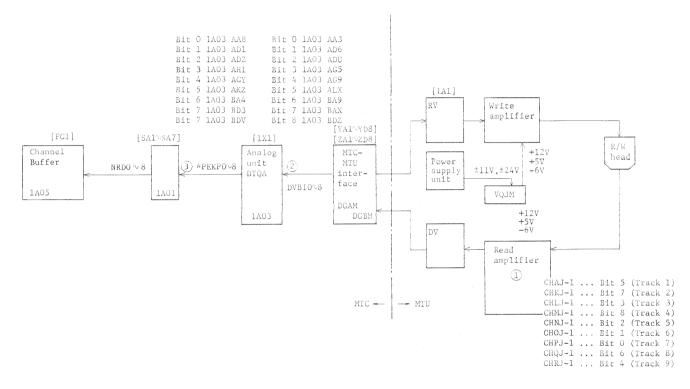
1. Read amplifier (WRUMU) trouble

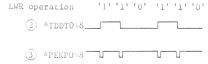
3.  $\pm$ 12 V,  $\pm$ 6 V voltage trouble

К0100

2. Head trouble

Replace PCA Write amplifier D2041 800 rpi Data Check - 2









Observe the wave form while repeating the write operation in  $800~\rm{fci}$  (NRZI mode) from the field tester.

D2100 Noise

#### Noise occurs

MTU

R/W Circuít

MTU -

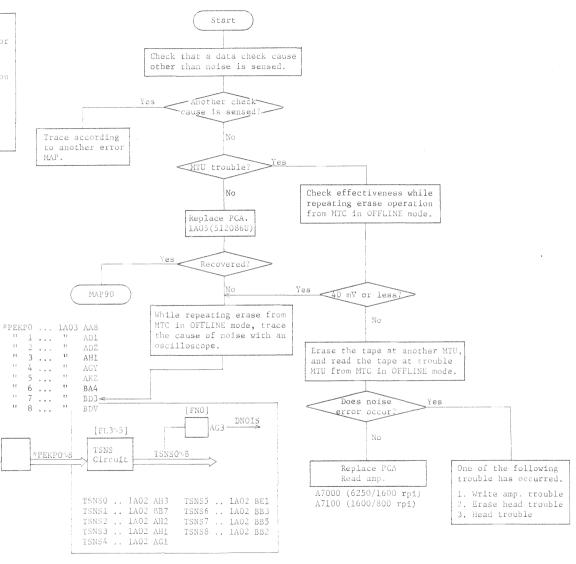
- When data check is set on read or read backward command.
- When a noise block is detected on read or read backward command.
- When a data is detected during erase operation on erase, write tape mark, or write command.

MTC-MTU

Inter-

face

DVBIO∿Ş

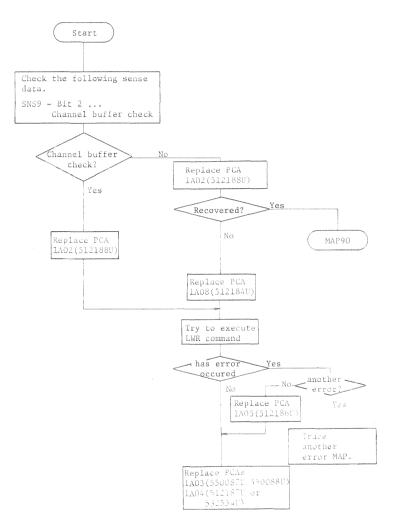


D2110 | P Compare (Channel Buffer Check)

P compare means MTC parity check or compare check. It occurs in the following cases.

- 1. Channel buffer check  $\label{thm:channel} \mbox{When the comparison between channel buffer input and output data does not agree. (CRCA <math display="inline">\neq$  CRCB)
- Parity check channel buffer
   When a parity error is detected in the channel buffer input data.
- A/B register error
   When a parity error is detected in the A/B register at read operation.
- Deskewing buffer check
   When an error is detected in the ROC of deskewing buffer.

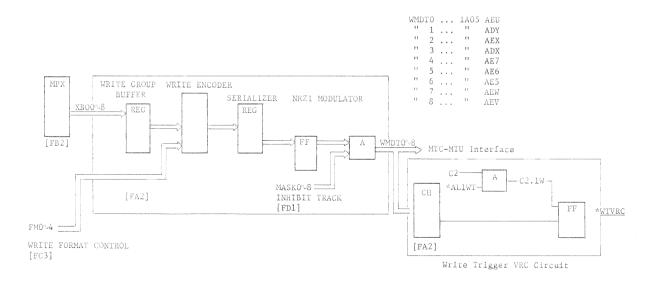
Refer D2003 for FRU1,2.



D2120 W-VRC Error

When writing on creased tape.In this case "IBG detected" is also set.





D3000	MTU	Sense	Abnormality	
			•	

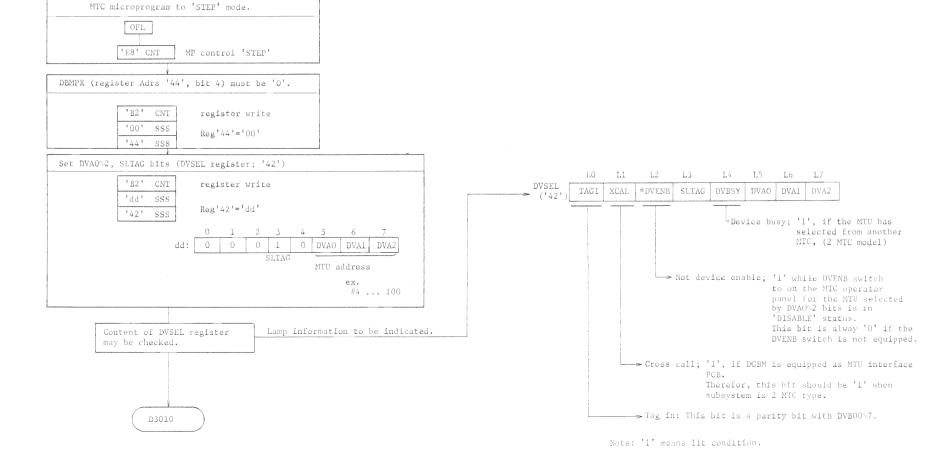
Field tester allows to confirm or manupulate the MTU status.

Various MTU status, e.g., BWD, NOT-FP, TWA or BOT, WRS, ONL, READY ... etc, can be displayed on field tester and checked.

MTU sense bytes representing those MTU status are showed in D3010, Table 1.

Turn MTC offline ONL/OFL switch of field tester,

To inspect TU sense bytes, following manupilations should be done.





D3010 MTU Sense bytes configuration



The NTU has been selected, set the DVBO (DEVICE BUS OUT) Register (Register address X'45') bit, and check the content of the DVBI (DEVICE BUS IN) Register (Register address X'46').

Using the field tester:

D3020

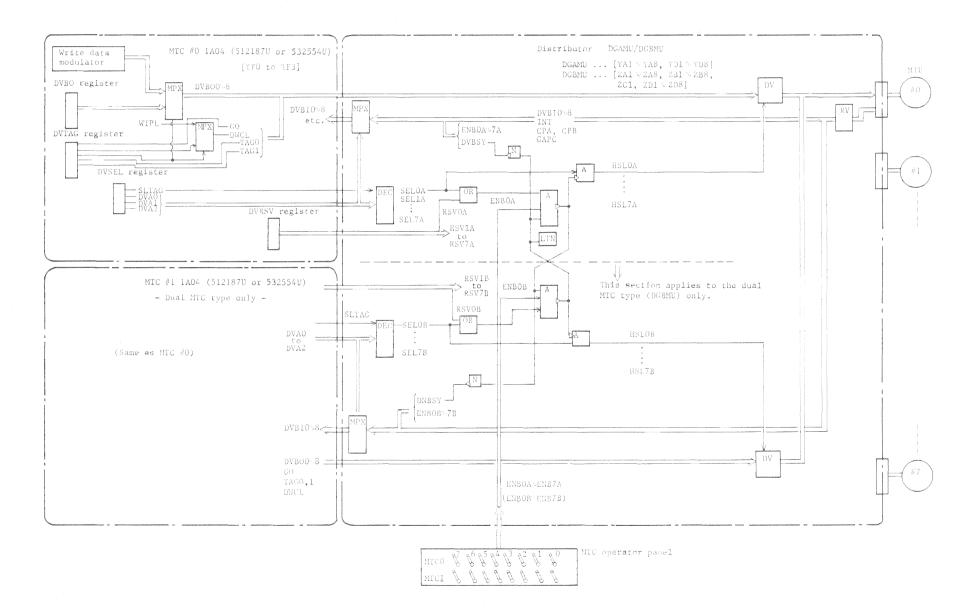
Set the value at address X'45' (DVBE Register) and observe the contents of address X'46' (DVBI Register).

TU sense byte	0	1	2	3		4		5		6		7		8
Bus-out Bus-in bb:	'01' ('00')	1021	'04'	'0	8'	1	0'	120	3	'40	'	'80'		* 14 *
Bit 0	BWD	New function	MISC error	VEL 0			27	SAGC	0	Read data	0	Error code	0	Handler erase current ON
Bit 1	NOT FP	RESET key	Tape loop alarm left	VEL 1				1.4	1	11	1	11	1	Handler action
Bit 2	TWA	DSE	Tape loop alarm right	Ready hold		Tape uniqu low c	ie ID	11	2	11	2	7.1	2	Handler backward status
Bit 3	BOT	7 tracks	ROM parity error		212	Tow c	raer	71	3		3	*1	3	Handler write current Ol
Bit 4	Write status	Test mode	Write circuit		211			EC level (Model		versi	_	**	4	Handler 65% slice
Bit 5	ONLINE	Dual density	Fuse alarm	Tape uniqu high	e ID	10 mm 1 m		EC level	22	fi	5	II.	5	Handler over run
Bit 6	TU CK	High density	Air bearing alarm	urgn				#1	21	3.5	6	11	6	Handler PE mode
Bit 7	READY	6250	Load failure		28		20	"	20	11	7	11	7	Tape mark
Bit 8	TAG-IN	TAG-IN	TAG-IN	TAG-I	N	TAG-I	N	TAG-I	N	11	8	TAG-IN		TAG-IN

Table 1. MTU Sense Bytes

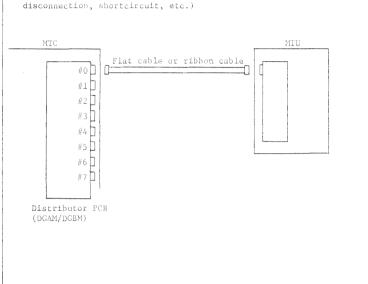
Non	cmal?	Yes	
	No	(	MAP
Observe the s			

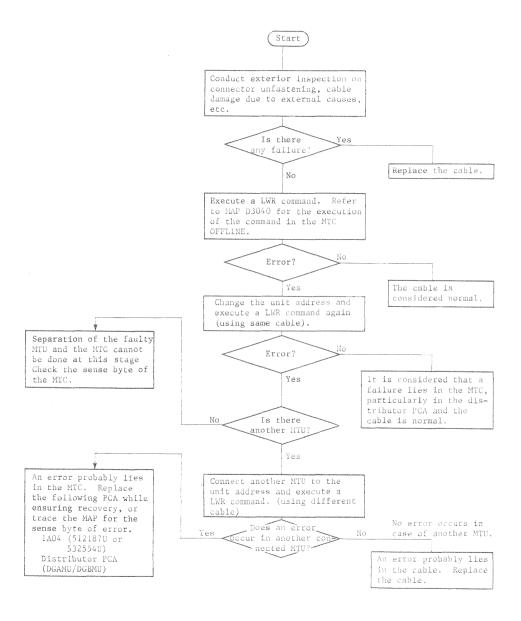
D3020 MTC-MTU interface circuit



D3021 Investigation of the Cable between the MTC and the MTU

In case a failure occurs in a particular MTU or the MTU having a specific unit number, an attempt is made to check whether the cable between the MTC and the relevant MTU is normal. (Connection failure, disconnection, shortcircuit, etc.)



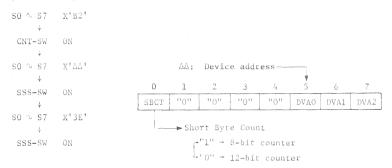


D3040 Loop Write to Read Command (LWR) Execution - 1

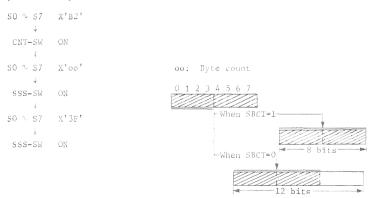
How to execute the LWR command offline from MTC, using Field Tester

- (1) If the MTC is not connected with a field tester, first a field tester must be connected. If a field tester is already connected, execution may be jumped to (7).
- (2) Turn the ONL/OFL switch of field tester to the OFL position, and insert the connector in the connector for field tester 1A07 (512185U).
  See MAP51
- (3) To execute system reset and lamp TEST from the CE panel, the steps (4) to (5) should be executed.
- (4) SO to S7 are set at X'FO'. (Lamp test)
  At this time, LO to L11 must all light.
- (5) Then, CNT switch is set on. ... System Reset
- (6) If the system reset is completed, L8 (ERRF), L10 (PHLT), and L11 (PERR) are supposed to be off.
- (7) To carry out command code setting, the field tester is operated in the following sequence. However, when register address '3D' is displayed in the register and '8B' is already set, this procedure may be omitted.

(8) To carry out device address setting, the field tester is operated in the following sequence. However, when register address '3E' is displayed in the register and the relevant device address is set, this procedure may be omitted.



(9) To carry out byte count setting, the field tester is operated in the following procedure. However, when register address '3F' is displayed in the register and already set at a predetermined byte count value, this procedure may be omitted.



(Continue to D3041)

D3041 LWR Command Execution - 2

(Continue from D3040)

(10) Preparation for executing an LWR command is completed by performing steps (7) and (8). Thus, various parameters can be available for the execution of an LWR command. To modify the execution of the LWR using these parameters, they are loaded in registers SDIAI (address X'38') ∿ SDIA3 (address X'3B') and OFLCNT (address X'3C').
→ See MAP M0000

By performing the above operations, in case it is considered that any unexpected parameters might have been set in registers, operate the register display to ensure the contents of registers.

These registers never be reset except the case when the MTC is power on.

#### (11) Execution of an LWR command

An LWR command is executed immediately when the SSS switch of field tester is turned on.

When 'REPEAT' parameter is designated, the execution of an LWR command is repeated even without turning on the SSS switch until 'REPEAT' parameter is reset, a stop condition is made by such parameter as 'UNIT-CHECK-STOP', or 'SINH' is indicated.

If there is no 'REPEAT' parameter in the register, an LWR command is executed every time the SSS switch is turned on.

#### (12) Confirmation of the execution result

When the execution of an LWR command results in an error, ERRF bit (L8 lamp to be used when SO to S7 are set at X'80') lights. When this bit lights, it indicates that UNIT CHECK is contained in the END status of the executed command. This lamp is kept lighting throughout the time starting from generation of the END status and ending with issuance of the next command.

The END status is stored in DSB register at address 'OA'.

#### (13) Sense byte

Since the sense data that indicates the cause of error is stored in SBO (address X '20') to SB23 (address X'2B') when the ERRF lights (when the UNIT CHECK of DSB register address 'OA' is set on), check the contents of these registers through register display function of field tester instead of issuance of a sense command.

D3042

LWR2 operation

LWR2 operation allows the MTU to bypass write data at different point from one in normal LWR operation as showed in Fig. 1.

LWR2 operation may be useful to MTU Read/Write fault isolation.

When Read/Write problem occures on specific MTU, examine LWR2 operation. If LWR2 operation has resulted in success, it is considered that the problem lies in a part of Write/Read Amps, Read/Write head, or adjustment related to those. (Refer A7000, A7100)

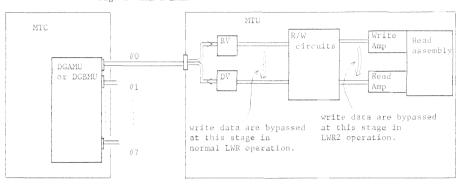
If LWR2 operation has resulted in failure, normal LWR operation should be executed next, then a appropriate PCB may be replaced.

To execute normal LWR operation with an MTU, procedure (1) $\sim$ (6) in MAP D03040 should be done. Then issue SDIA command with SLWR bit of SDIA FLAG BYTE 1. Detailed procedures are described in MAP D3043 $\sim$ .

#### - Restriction -

- 1) 'Not capable' is posted when the MTU is in status detecting BOT.
- 2) 'Not capable' is posted when the MTU is in 800 rpi mode.
- 3) Executing LWR2 operation clears SAGC-Count of the MTU.

Fig. 1 LWR & LWR2



## D3043 LWR2 Execution - 1

Refer M0100 about expression of field tester manupilation.

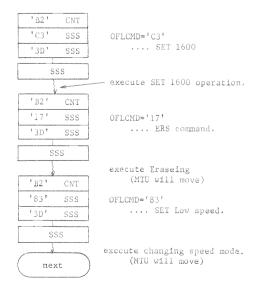
(I) Store MTU address and Byte count to OFLDVA, BCT register. See procedure (8) (9) on MAP D3040.

> OFLDVA = dd. BCT = bb.

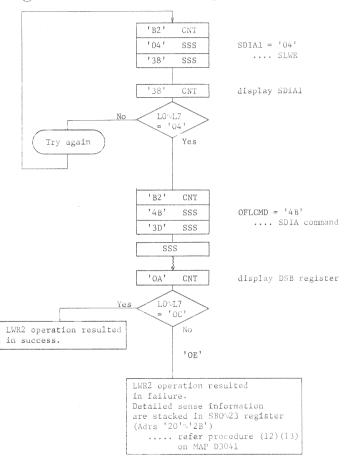
Store offline execution parameter to DFLCNT register. Here, parameter is .. all '0' (Single command execution).

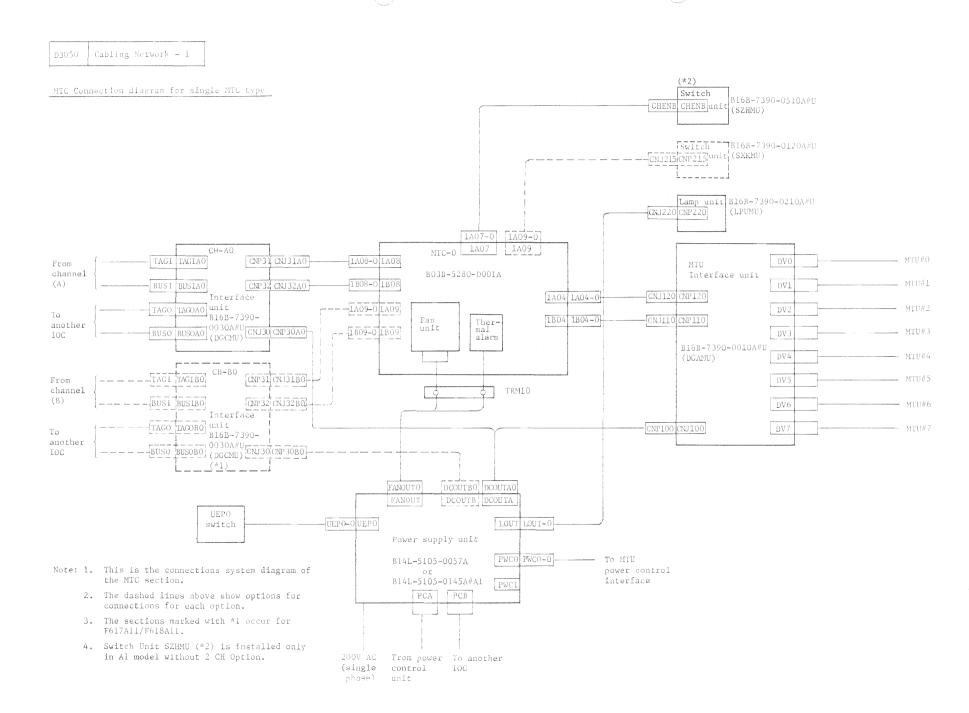
OFLONT = 00

3 To allow MTU to move foreard if the MTU is in BOT detected status, issue WRT, WTM, or ERS command to the MTU. If density or speed made have to be designated, SET 6250/SET 1600 command, or SET-HIGH SPEED/SET LOW SPEED command had better be issued. SET 6250/SET 1600 command should be issued to the MTU in BOT detected status.

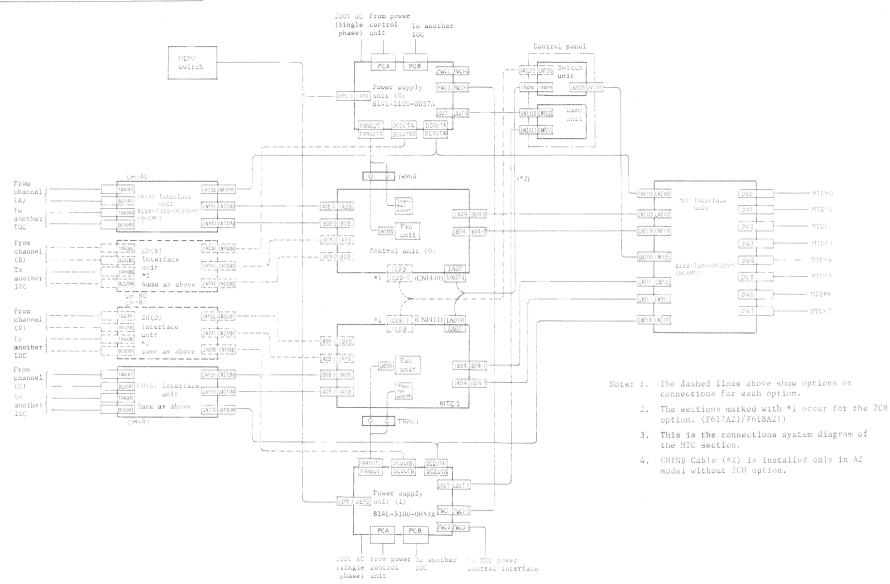


(4) Store SLWR bit ('04') to SDiAl register. Then, issue SDIA command.



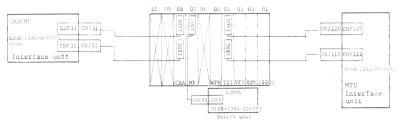


MTC Connection diagram for dual MTC type

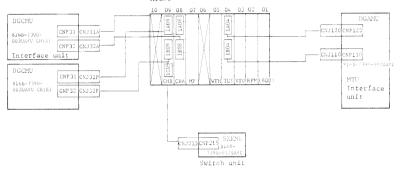


D3052 Cabling Network - 3

### Al 2CH switch option absent; monitor interface option absent



# Al 2CH switch option present; monitor interface option absent (with dashed lines)



The above diagrams show the cable connections of the  $\mathrm{Al/A2}$  type special PCAs with the MTC shelf.

*1 . When the 2CH option is present and the monitor interface option is absent:

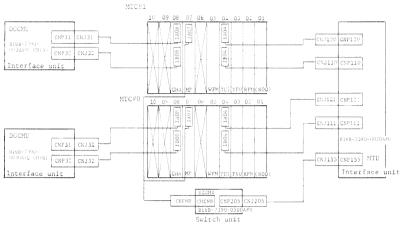
Al SXKMU.CNJ215 --- 1C09

A2 SXGMU.CNJ215 --- MTC#0.1C09, MTC#1.1C09

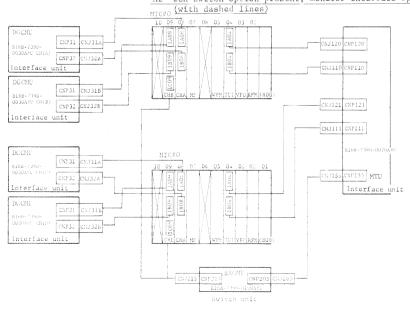
. When the monitor interface option is present:

A1 SXKMU.CNJ215 — DGDMU.CNJ410 DGDMU.CNJ420 — 1C09
A2 SXGMU.CNJ215 — DGDMU.CNJ410 DGDMU.CNJ420 — MTC#0.1C09
DGDMU.CNJ411 DGDMU.CNJ421 — MTC#1.1C09

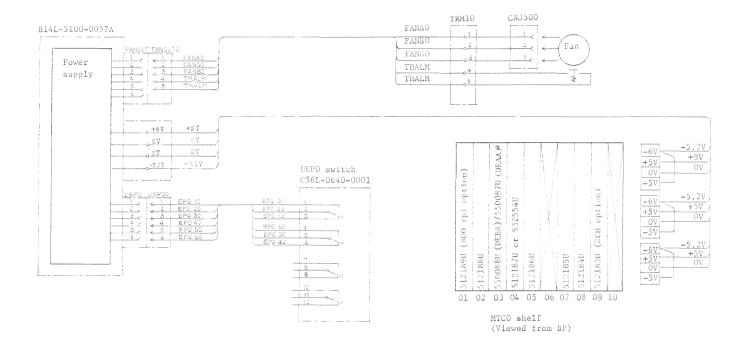
## A2 2CH switch option absent; monitor interface absent



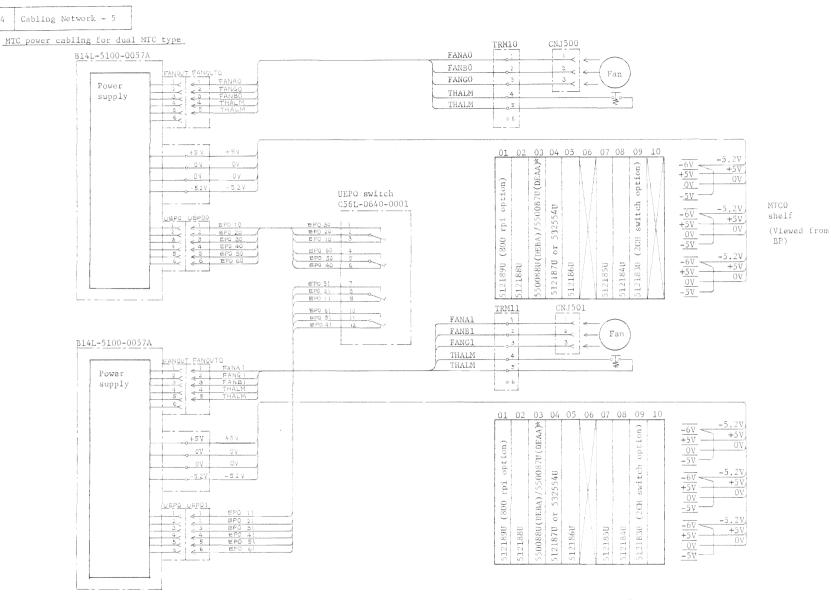
## A2 2CH switch option present; monitor interface option absent



## MTC power cabling for single MTC type



^{*: 5500880 (}DEBA) for 75/125 ips. 5500870 (DEAA) for 125/200 ips



D3054

*: 550088U (DEBA) if F617A2 550087U (DEAA) if F618A2

F0001 Off Line Diagnosis Procedure for MTC

Execute "TEST MTC" which is part of the Offline Diagnosis. See M0175.

Start

Initialization: Connect Field tester to the MTC, then,

- (1) Set the OFL/ONL switch at the upper position (OFL side) on the Field Tester.
- (2) Set value into the Microprogram Register.

MP Register address	Value (Hexadecimal)
3D (OFLCMD)	4 B
3C (OFLCNT)	00
38 (SDiAO)	01
39 (SDiAl)	00

(3) Set the device address in the Microprogram Register address X'3E'.

Diagnosis Execution

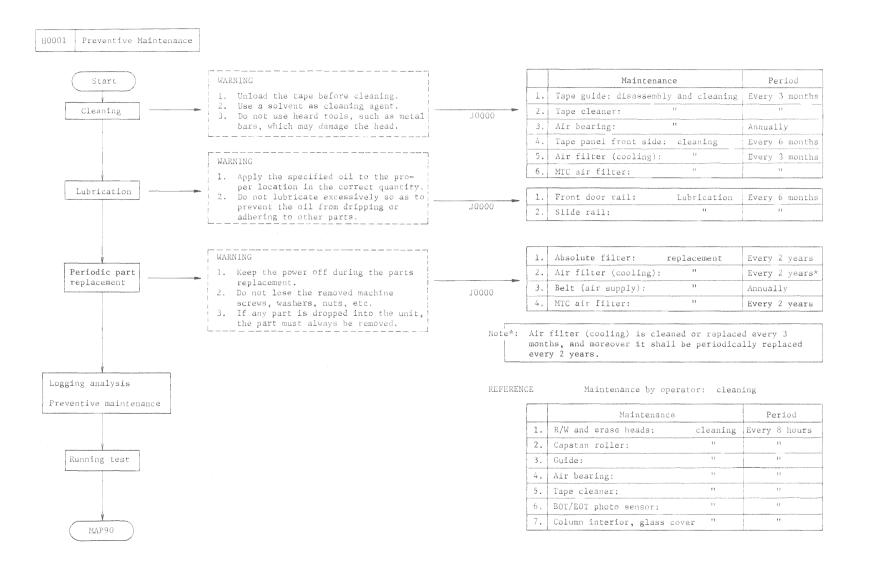
(1) Set the SSS switch on.

Diagnosis Analysis

- (a) Normal End
  - (1) Microprogram Register address (0A)  $_{16}$  contents will become (0C)  $_{16}$
- (b) Abnormal End
  - (1) Microprogram Register address  $(0A)_{16}$  contents will become  $(0E)_{16}$

The details of error depends upon the content of address (20)  $_{16} ^{\circ}$  (2B)  $_{16} (\text{SENSE bytes})$  of Microprogram Register. Refer to the corresponding map.

 SET DIAGNOSE command, with TEST MTC diagnotic flag fyte, is designated to the MTC in offline.

 When TEST MTC is abnormally ended, MPHE (MP hardware error) bit has been set with error code. See MAP D1010. 

J0000 Cleaning, Lubrication Procedure

## Cleaning

The parts which are in contact with the tape must be carefully cleaned. Cleaning is required before any continuous long job operation. If the cleaning is neglected, errors may occur and dust attached to the tape may cause trouble.

## Cautions in cleaning

- 1. Unload the tape before cleaning.
- 2. Use a solvent as a cleaning agent.
- Do not use a hard tools, such as metal bars, which may damage the device.

## Periodic cleaning by GE

	Maintenance	Period	Method	
1	Tape guide: disassembly and cleaning	Every 3 months	J0005	
2	Tape cleaner: "	tt	J0007	
3	Air bearing:	Annually	J0006	
4	Tape panel front side: cleaning	Every 6 months	J0009	
5	Air filter (cooling):	Every 3 months*	J0011	
6	MTC air filter: "	Every 3 months*	J0012	

Note*: Air filter (cooling) is cleaned or replaced every 3 months, and moreover it shall be periodically replaced every 2 years.

## Periodic cleaning by operator

	Maintenance		Period	Method
1	R/W head and erase head:	cleaning	Every & hours	J0001
2	Capstan roller:	11	11	J0002
3	Guide:	11	TT	J0003
4	Air bearing:	14	Y 8	J0003
5	Tape cleaner:	11	19	J0004
6	BOT/EOT photo sensor:	11	11	J0008
7	Column interior, glass over:	11	7.5	J0003

J0001 R/W Head and Erase Head Cleaning

Hold autocleaner tape path to the right and clean the Read/Write head and Erase head with a gauze cloth soaked in solvent, using a circuilar motion. Never wipe the head with any hard materials.

After cleaning, check that no gauze thread is left on the heads.

J0002 Capstan Roller Cleaning

While turning the capstan by hand (covered with gauze cloth or clean glove), clean the capstan carefully with a gauze cloth soaked in solvent.

Do not touch the surface of the capstan directly.

Check for any peels of the surface coating and wears. Replace the capstan motor (L0130), if a discrepancy is detected.

J0003 Tape Guide, Air Bearing, Threading Chute, Roller Guide, Upper and Lower Threading Channels, Column Interior, and Glass Cover Cleaning

Clean each part carefully with a gauze cloth soaked in solvent.

To clean the narrower parts, use a cotton swab which contains solvent.

To remove dirt which cannot be removed easily with a gauze cloth or cotton swab, use a brush (containing solvent) and then use the gauze cloth or cotton swab (containing solvent).

J0004 Tape Cleaner Cleaning

Clean the edges of the tape cleaner with a gauze cloth or cotton swab soaked in solvant.

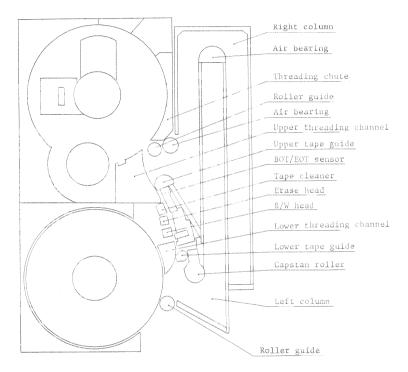


Fig. 1

J0005

Tape Guide Disassembly and Cleaning

Remove the tape guides at upper and lower from the body, disassemble the guides, and clean the elements carefully with a gauze cloth, cotton swab, and brush soaked in solvent.

The air outlet hole in the upper guide must be completely free of dust.

With a gauze cloth soaked in solvent, clean the panel surface on which the guides are to be mounted.

Check the guide and flanges for any damage or groove caused by wear. Replace the guide if a discrepancy is detected. Then, assemble and attach the guides.

Refer to upper guide replacement (L0070) and lower guide replacement for the assembly and disassembly of the guides.

J0006

Air Bearing Disassembly and Cleaning

Disassemble the air bearing and clean it carefully with a gauze cloth, cotton swab, and brush soaked in solvent.

The air outlet holes in each air bearing must be completely free of dust. With a gauze cloth soaked in solvent, clean the panel surface on which the air bearing is to be mounted. Then, attach the air bearing.

J0007

Tape Cleaner Disassembly and Cleaning

Disassemble the tape cleaner and clean it and the head mounting base carefully with a gauze, cotton swab, and brush soaked in solvent.

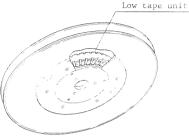
Refer to "Tape Cleaner Replacement" (L0050) for the assembly and disassembly of the tape cleaner.

J0008

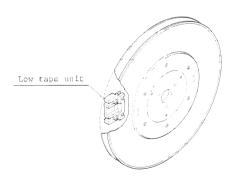
BOT/EOT Sensor and Low Tape Unit Cleaning

Clean the surfaces of the light emission and reception elements of the BOT/EOT sensor and the low tape unit with a brush.

Before cleaning the low tape unit, machine reel must be removed. (Refer to L0230.)



Machine reel



J0009 Machine Reel, Panel Surface, and Door Glass Cleaning

Clean the external surface and interior of the machine reel, panel surface, and the both sides of the door glass with a gauze cloth soaked in solvent.

J0010 Mechanism Section Rear Side Cleaning

With a vacuum cleaner, clean the mechanism section from the rear.

J0011 Air Filter for Cooling Cleaning

Remove the air filter from the body and clean it with a vacuum cleaner.

Refer to "Air Filter (cooling) Replacement" (L0370) for the assembly and disassembly of the air filter (cooling).

J0012 MTC Air Filter Cleaning

Remove the air filter and clean it with a vacuum cleaner.

K0000

Check and Adjustment Procedure

#### General Cautions

- 1. Adjust oscilloscope and tester before measurement.
- Unless otherwise noted, adjust the meter value to the center of the specified standard value.
- 3. Record the data at check and adjustment.
- Handle the master skew tape carefully.
   Always remove the write enable ring during check and adjustment.
   (Operation requires the file protection.)

## MTC Check and Adjustment Items

No.	Check & adjustment item	MAP No.	Period
1	Power supply voltage	К0001	Annually
2	VFO free-running frequency (6250 rpi, 1600 rpi)	К0002	Every 6 months
3	Clock width check and adjustment	к0003	Annually
4	System setting MTC address	К0004	_
	" MTC EC level	K0005	-
	" , MTC feature	K0006	
	" Interface unit setting	K0007	-

## MTU Check and Adjustment Items

No.	Check & Adjustment Items	MAP No.	Period
1	Power supply voltage	K0100	Annually
2	Clock pulse check	K0101	Annually
3	Capstan tachometer output	K0110	Every 3 months
4	Azimuth	K0120	Every 6 months
5	Read signal level (6250/1600 rpi MTU)	K0130	Every 6 months
6	Read signal level (1600/800 rpi MTU)	K0140	Every 6 months
7	Read and Write Skew (1600/800 rpi MTU)	К0150	When necessary
8	Write voltage	к0160	Annually
9	Erase effect	К0170	When necessary
10	Hose tube	к0180	When necessary
11	Pressure level (pressure, vacuum)	K0190	When necessary
12	Belt tension (air supply unit)	ко200	When necessary
1.3	BOT/EOT detection circuit	K0210	Annually
14	Low tape detection circuit	к0220	Annually
15	Tape loop position detection circuit	K0240	Annually
16	File protect mechanism	K0260	Every 6 months
17	Front door synchronous belt tension	К0280	When necessary
18	Auto cleaner	K0290	When necessary

Measure and adjust the following voltages with a 0.5 class or more voltmeter.

Voltage	Measurement point	Allowable range	Adjustment point
+5 V	+5 V Terminal (Shelf)		+5 V VOLT ADJ (Power supply unit)
-5.2 V	-5.2 V Terminal (Shelf)	-5.46 ∿ -4.94 V	-5.2 V VOLT ADJ (Power supply unit)

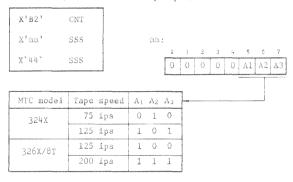
Refer Fig. 1 on MAP B0102

K0002 VFO Free-Running Frequency Check (6250 rpi, 1600 rpi)

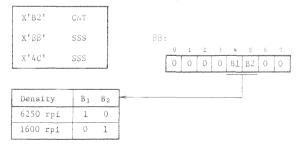
#### VFO Free-Running Frequency Check (6250 rpi, 1600 rpi)

- Attach the Field-Tester to MTC and turn the ONLINE-OFFLINE switch to OFFLINE.
- 2. Set the tape speed and the density of MTC as following.

Field tester manupilation to set Tape speed



Field tester manupilation to set Density



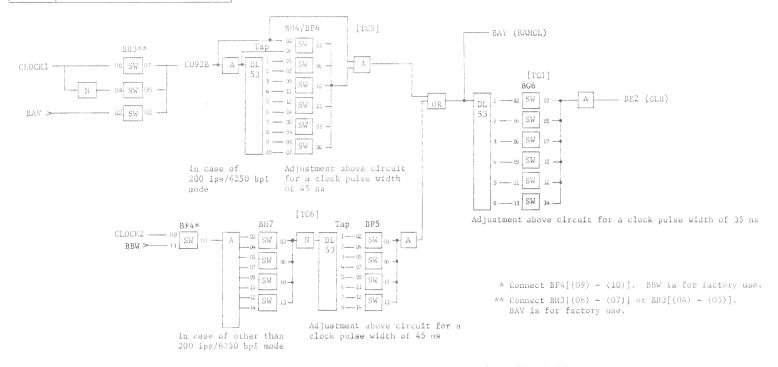
Clamp following back panel pins to 0 V, and measure the oscillation frequency of VFO. (Using appropriate columns on a per track basis.)

		0 V clamp po	int	
Bit		324X	326X/8T	Measurement point
0		1A03 AB8	1A03 AA9	1A03 AA6
1		AE2	AAY	ABX
2		AE5	ADX	AD8
3		AG1	AH3	AEX
4	1A03	AHX	AL1	AGX
5	Signal GND	AKX	вв2	AL8
6	AL4	BA5	BA3	BP7
7		BE3	BD4	BAV
8		BEV	BDU	BEU

Recording density	Tape speed	Allowable range	Duration	Tolerance
	200 ips	1.80 MHz ± 15 %	555 ns	<u>+</u> 83 ns
6250 rpi	125 ips	1.13 MHz ± 15 %	885 ns	+130 ns
	75 ips	678 MHz ± 15 %	1.48 µs	+0.22 µs
	200 ips	320 MHz ± 15 %	3.2 µs	+0.47 µs
1600 rpi	125 ips	200 MHz ± 15 %	5.0 µs	+0.75 µs
	75 ips	120 MHz ± 15 %	8.33 µs	+1.25 μs

4. Remove the 0 V clamp after the check.





Circuit Diagram Number TCO/TC1/TC5/TC6
Setting PCA C16B-5121-0870#U or C16B-5325-0540#U

Check and adjust the clock width with an oscilloscope

1. Check and adjustment of a clock having a pulse width of 45 ns in the 200 ips/6250 bpi mode

Measuring point	Allowable range	Adjusting method				
		DL53 Tap	SH09 mounting position			
RAMCL 1A04 BAY	45 ⁺⁵ ns	1 2	05 07 06 BH4 ε	se one of them for djustment		
		3 - 4 - 5 - 6 - 7 - 8 - 9 - 10	12 14 13 J	Pulse width narrows y 2 ns for the in- crement of one tap on the left column.		

Note: Set the MTC in the 200 ips/6250 bpi mode before checking of this mode. To set the MTC in this mode, set X'08' to the register address X'4C' of the microprocessor and X'08' to X'4C'. (Refer K0002)

2. Check and adjustment of a clock having a pulse width of  $45~\mathrm{ns}$  in other than the 200 ips/6250 bpi mode

Measuring point	Allowable range		Adjusting method
		AND cir- circuit DL53 Tap	SH09 mounting position
RAMCL 1A04 BAY	45 ⁺⁵ ns		02 03 1A04 Use one of them for BH7 adjustment 05 06 Rough adjustment is done by this setting. When setting the bottom part on the left of the above figure, pulse width increases by 3 to 6 ns for the increment of one tap.
		1 2 3 4 5 6 7 8	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

- Notes: 1) In this setting there are two setting portions.
  - 2) Set the MTC in the appropriate mode before checking this mode. (either  $800\ \text{or}\ 1600\ \text{BPI})$
- 3. Check and adjustment of a clock having a pulse width of 35 ns

Measuring point	Allowable range	Adjusting method	
		DL53 Tap SH09 mounting position	DL53 Tap
CLH 1AO4 BE2	35 ⁺⁵ ns	1 02 03 2 04 05 3 06 07 4 09 10 5 11 12 6 13 14 01 and Use one of them for adjustment A pulse width narrows for every increment of one tap on the left column.	2 3 4 5



K0004 System Setting ... MTC Address

The MTC address is set with 0 to 4 on the ADDRESS BUS.

			MTC				MTU	
bit	0	1	2	3	4	5	6	7

Connection for Route A side channel

MTC address	Connected t	erminal No.	Short-circuit	
bit No.	11011	"1"	mounting position	
0	04-03	02-03		
1	07-06	05-06	1A08 AG7	
2	11-10	09-10	22100 2101	
3	14-13	12-13		
4	04-03	02-03	1A08 AG6	

Circuit Diagram Number [IA3]

Setting PCA C16B-5121-0840#U

This content can be ensured setting  $(00)_{16}$  to the address '58' of microprogram register using a field tester to display the contents of Address '58' (bits 0 to 4) of microprogram register. Refer Map K0013.

Connection for Route B side channel

MTC address	Connected to	erminal No.	Short-circuit
bit No.	"0"	"1"	mounting position
0	04-03	02-03	
1	07~06	05-06	1A09 AM5
2	11-10	09-10	
3	14-13	12-13	
4	04-03	02-03	1A09 AM6

Circuit Diagram Number [JA3]

Setting PCA C16B-5121-0830#U

Using a field tester, this content can be ensured by displaying the content of bits 0 to 4 of address 64 of microprogram register. Refer Map K0013.

K0005 System Setting ... MTC EC Level

The EC level of MTC is determined by plugging pins on the terminal board (SHO9) on a PCA.

MTC EC	EC Connected terminal No.		Short-circuit
BIT No.	11011	"1"	mounting position
0	09-10	11-10	PCA 512585U BB1 (1A07)
1	12-13	14-13	17
2	02-03	04-03	lf
3	05-06	07-06	8.8

Circuit Diagram Number MP1

Using a field tester, this content can be ensured by displaying the content of bits 4 to 7 of address '61' of microprogram register. Refer Map K0013.

Mounting position	Pin No. portion A	Meaning	Pin No. protion B	Meaning
1A07 AA7	03-04	For the MTC other than that to MEMOREX Co.,	02-03	For the MTC to MEMOREX Co.,
	06-07	IB.ARA write retry is not carried out.	05-06	IB.ARA WRITE RETRY is carried out.
	10-11	Normal IBG (0.3")	09-10	Long IBG (0.4")
	13-14	800 read, IBM mode	12-13	800 read, FJ mode
1A07 AA6	03-04	15 m check (RWTOV) function is valid.	02-03	15 m check (RWTOV) is not checked.
	06-07	Normal Sense Byte. (IBM compatible)	05-06	Special Sense Byte assignment.
	10-11	Normal	09-1.	Sredni SíS 80 MODE ON
	10-11 13-14	Spare Portion A is always set in this state.	09-10	Protion B must not be set on this side for future use.

Mounting position of the setting PCA is at 07 column, and specification No. is C16B-5121-0850#U. This setting is at '7F' for consignment, so setting pins must not be changed unless the above mode is changed.

This content can be ensured by displaying the content of address '63' of microprogram register using a field register. When pins are set at the above portion A, lamp lights, and when pins are set at the above portion B, lamp is turned off.

The following explains the above bits:

Bit	0	*MRX		Shows	whether	the	MTC	ís	for	MEMOREX	Co.
-----	---	------	--	-------	---------	-----	-----	----	-----	---------	-----

Bit l *IBRTRY: In case of portion B, IB and ARA write retry is carried out

three times.

Bit 2 *LIBG : In case of portion B, IBG is set to 0.4 inch in the 6250 rpi

mode.

Bit 3 I-800 : In case of portion A, noise (sense byte 1, bit 0) is not

reported for a block less than 8-bit cell at 800 rpi in the IBM

compatible mode.

Bit 4 15CK : In case of portion B. RW Time Over check function is

suppressed, then long data block can be written (more than

15 m).

Bit 5 NSB : In case of portion B, sense byte 4 bit 0 is 20 m check and

sense byte 4 bit 4 is MP Hardware error. Under IBM OS, setting

must be portion A.

Bit 6 *SP MUDE: For SPERRY System 80, setting must be portion B.

Under IBM OS, setting must be portion A.

Pit " reserved for future use.

Mounting position	Pin No. portion A	Meaning	Pin No. protion B	Meaning
1A08 AG6	09-10	IBM compatible mode	10-11	Not IBM compatible mode
	05-06	IBM type BMC	06-07	Special setting for FJ BMC (SBMC)

Mounting position of the setting PCA is at 08 column, and specification No. is  $\text{C16B-5121-0840} \, \text{MU}$ .

This content can be ensured by setting  $(00)_{16}$  at address '5F' of microprogram register using a field tester and by displaying the content of bit 5 and 6 of address '58'. Refer Map K0013.

Setting should be IBM compatible mode and IBM type BMC.

K0007 System Setting .... Interface Unit Setting

Short-c	circuit PCA ndition	Connected terminal No. SW1
DGCMU	SELECT OUT receiving	03-04 06-07 13-14
SW1	SELECT IN receiving	02-03 05-06 12-13

MTC miscel- laneous	Connected terminal No.	Short-circuit mounting position
must be	05-06 12-13	1A08 AG6
connected as right.	06-07 10-11 13-14	1AO9 AM6
	03-04	1A07 BG7

K0008 Channel Extension Feature

Maximum length for channel cable can be increased by channel Extension Feature. In this case, data transfer between MTC and Channel are performed with Offset-Interlock mode rather than normal Interlock. There are some restrictions to select this feature. See Installation Manual, Section 3.

Feature selected	Connected terminal No.	Short circuit position		
Normal mode	12-13	Column 1A08		
Channel Extension Feature	13-14	PCA 512184U Location AG6		

K0009	Other	Setting	

If 2-channel switch is installed, setting must be 2-channel switch mode. Other two setting is not used.

Meaning	Connected terminal No.	Short circuit Position
	05-06	
Not used	06-07	
Not used	09-10	Column IA09 PCA 512183U
	10-11	
2-channel switch	12-13	Location AM6
W/O 2CH SW	13-14	

Follow setting is for special mode other than IBM type, setting must be normal mode.

Meaning	Connected terminal No.	Short circuit Position	
Special mode	02-03	Column 1A07 PCA 512185U Location BG7	
Normal mode	03-04		

Note: There is no functional difference between two mode.

K0010 MTU settings ... PCA at 1A06 (1)

The PCA at 1A06 has five short-circuits (SH09) for setting of the serial manufactured number, the EC level and function. The serial manufactured number, EC level and function shall be set at the replacement.

In the 1A06 PCA replacement is for trouble recovery, the short-circuits setting contents are different, so, pay attention to the short-circuit setting for the PCA.

PCA designation	Setting contents	SH09 mounted position	Connected pin number	Remarks
512182U or 512649U	Tape Unit Unique ID	AG4, AG6, AG5, AG7 (See Fig. 1)	Procedure 1	Manufactured Serial No.
	EC Level	AF4 (See Fig. 1)	Procedure 2 (Next page)	Engineering Change Level
		AG4 (See Fig. 1)	Procedure 3 (Next page)	Extended In- terface,Skip File Feature, Enable Inter- rupt
Only 512649U	Function	AJ6 (See Fig. 1)	Procedure 4 (Next page)	SAGC step, streaming, Dual Density

Procedure 1 Setting of Manufactured Serial No.

Read the manufactured serial number of the right lower side at the back of MTU and convert the number to 13 bit binary code.

Correspondence of each bit and pin number of SHO9 at the PCA

Short-circuits	Connected	77		
mounted posi- tion	101	,1,	Remarks	
AG4	12 - 13	13 - 14	TID12 (2 ¹² )	
AG6	02 - 03	03 - 04	TID11 (2 ¹¹ )	
	05 - 06	06 - 07	TID10 (2 ¹⁰ )	
	09 - 10	10 - 11	TID9 (29)	
	12 - 13	13 - 14	TID8 (28)	
AG5	02 - 03	03 ~ 04	TID7 (2 ⁷ )	
	05 - 06	06 - 07	TID6 (2 ⁶ )	
	09 - 10	10 - 11	TID5 (2 ⁵ )	
	12 - 13	13 - 14	TID4 (2")	
AG7	02 - 03	03 - 04	TID3 (2 ³ )	
	05 - 06	06 - 07	$TID2 (2^2)$	
	09 - 10	10 - 11	TID1 (2 ¹ )	
	12 - 13	13 - 14	TIDO (2°)	

Set by inserting thirteen short-terminals to short-circuit SH09. (See Fig. 2 of next page.)

Note: In case of replacement for trouble recovery, set the short-circuit (SHO9) according to above Procedure 1.

Example: When manufactured No. 538

Binary code	0	0 0 1 0	0 0 0 1	1 0 1 0
	AG4	AG6	AG5	AG7
Connected Pin No.	12-13	2-3 5-6 10-11 12-13	2-3 5-6 9-10 13-14	3-4 5-6 10-11 12-13

PCA Parts Number: C16B-5121-0820#U or C16B-5126-0490#U

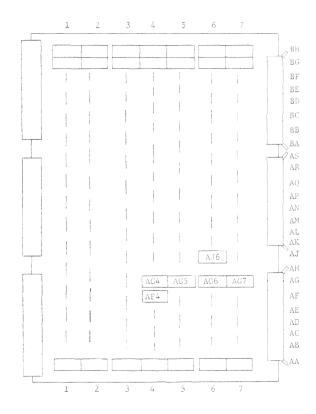


Fig. 1 SH09 location

K0011 MTU settings ... PCA at 1A06 (2)

Procedure 2 Setting of EC Level

Convert the EC level to  4  bit binary code and set the short-circuit SH09 (AF4) as follows.

Correspondence of each bit and connected Pin No.

Bynary code	2 ³	2 ²	2 ¹	2 ⁰
Setting of 'l'	3-4	6-7	10-11	13-14
Setting of '0'	2-3	5-6	9-10	12-13

Connected pin No.

Set by inserting four short-terminals to the short-circuit SH09 (AF4). (See Fig. 2.)

Note: If EC level is not changed, PCA setting shall be the same as the previous  $\mbox{PCA}$ .

When MTU model has been converted (e.g. from 125 ips to 200 ips MTU), this  $2^3$  bit is set to '1'. This bit means MODEL CONVERSION.

Example: When EC level is 05

Procedure 3 Setting of Function

Set the short-circuit SHO9 (AG4) as follows.

	Extended interface	Skip file feature	Enable interrupt
Setting of 'l'	3-4	6-7	(10-11)
Setting of '0'	(2-3)	(5-6)	9-10

Set by inserting three short-terminals to the short-circuit SH09 (AG4). (See Fig. 2.)

Note: Extended interface ... When MTU has the Streaming function or Skip file function, set it to 1.

Skip file feature .... When MTU has the Space File and Backspace File functions, set it to 1.

Enable interrupt .... To set Interrupt when the status is Not Ready to Read, set it to 1.

Short-terminal



SHO

Fig. 2 Setting for manufactured No., EC level and function

Procedure 4 Setting of Function

Set the short-circuit SHO9(AJ6) in PCA 512649U as follows.

	Not Used	SAGC step	Streaming function	Dual Density
Setting of "l"		(6-7)	10-11	13-14
Setting of "0"	2-3	5-6	(9-10)	_

Set by inserting four short-terminals to the short-circuit  ${\tt SH09}\ ({\tt AJ6})$  . (See Fig. 2.)

Note: SAGC step ........ If the read slice level change when the SAGC step is greater than C, set it to 0.

If the read slice level change when the SAGC step

is greater than A, set it to 1.

Streaming function ... If User not use the streaming function, set it to 0. In case of 200 ips MTU, it must be set to 0'.

Dual Density ..... Always 1.

K0012	MTU	settings	 PCA	at	1A05	

The PCA on 1A05 has a circuit for selecting options. All of them are set to 0 because no option function is implemented at present.

Procedure 1 Setting of Option

Set the short-circuit SHO9 (BG7) as follows.

	Option O	Option 1	Option 2	Option 3
Setting of '1'	3-4	6-7	10-11	13-14
Setting of '0'	2-3	5-6	9-10	12-13

Install jumpers to select options SH09 (BG7). (See K0011, Fig. 2.)

Note: Set all to be 0 because of no option function is implemented now,

PCA Parts Number: C16B-5121-0810 U or C16B-5126-0480 U or C16B-5325-0210 U

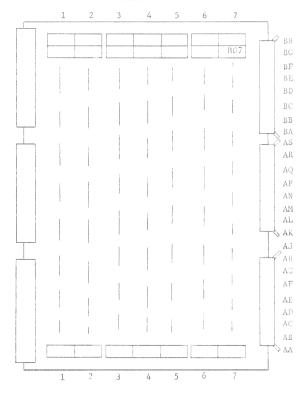
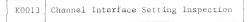


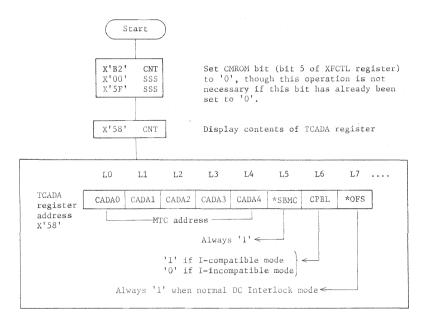
Fig. 1 SHO9 location



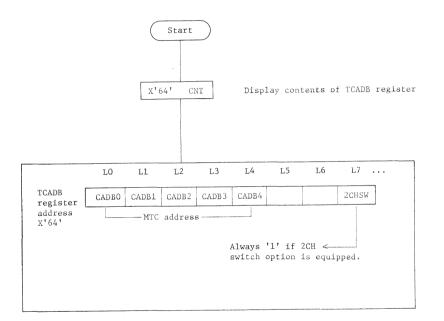
The setting of the MTC address, etc, can be displayed and checked by displaying the contents of the TCADA (address X'58') and TCADB (address X'64') registers with the field tester.

### - Channel (A) interface -

The MTC must be in a stop or idle status.

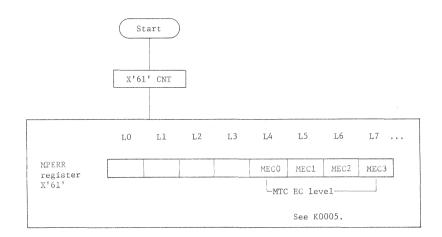


# - Channel (B) interface -

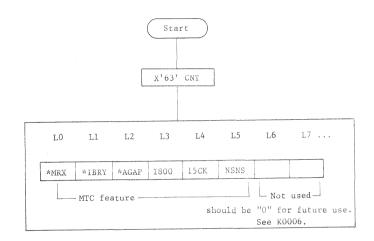




- MTC level inspection -



- MTC feature inspection -



K0100 | Power Supply Unit Check and Adjustment

Check and adjust the following items with potentiometer or digital voltmeter.

### Confirmation items

Voltage	Check point	Allowable range	Adjustment position
+ 5V	Gate part 1A04 +5 V AK1 0 V AK2	+5 V±2%	1A02 VQJMU RV1
<b>+</b> 12 ∇	WR_MU CHWRl on CHWR*	+12 V±8%	
-6 V	WR∟MU CHWR5 on CHWR	-6 V±8%	
±13 V	Gate part 1A01 +13 V ADV -13 V AEV	±13 V±8%	

^{*:} File protect pin must be pushed in.

# Procedure of exchanging PCA VQJMU

- (1) Detach the connectors (CNP33, CNP35, CNP36) of VQJMU and confirm that the voltage (±24 V) across 6 and 7 and across 8 and 7 of terminal board TRM41, and the voltage (+11 V) between 4 and 5.
- (2) Connect connector CNP33 only and temporarily adjust variable resistor RV1 on VQJMU to satisfy that the voltage across +5 V check point and 0 V check point is 5 V $^{\pm}$ 2%.
- (3) Connect connectors CNP35 and CNP36, and check the voltages listed in the above table (+5  $\overline{v}$  and confirm +12  $\overline{v}$ , -6  $\overline{v}$ ,  $\pm$ 13  $\overline{v}$ ).

Note: If the requirements of  $\pm 24$  V and  $\pm 11$  V are not satisfied, replace the power supply unit. If the requirements of  $\pm 5$  V,  $\pm 12$  V,  $\pm 6$  V and  $\pm 13$  V are not satisfied, replace VQJMU.

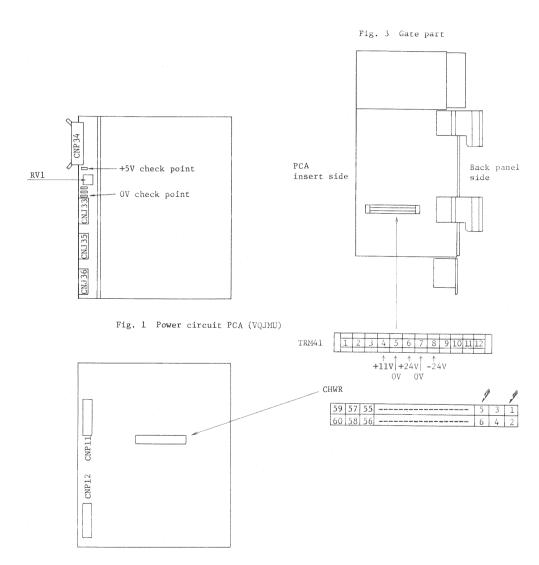


Fig. 2 Write/Read Amplifier PCA (WR. MU)

	T		
K0101	Clock	Pulse	Check

Check the following clock pulses with oscilloscope.

Item	Clock pulses	Check point	Allowable range	Remarks
1	CL8M	1A06 BB8 Gate section	$T_0 = 125 \text{ ns } \pm 1.5\%$ Duty $(Tw_0/T_0) = 50\pm 15\%$	C
2	CL1MA	1A06 BAX	T ₁ = 1 μs±1.5%	See Fig. l.
3	*DSPCL	1AO6 ALV	$T_2 = 500 \text{ ns} \pm 50 \text{ ns}$ $T_3 = 750 \text{ ns} \pm 50 \text{ ns}$	
4	PTYCL	1AO6 BBX	$Tw_1$ , $Tw_2$ , $Tw_3$ = 62.5 ns±20 ns	

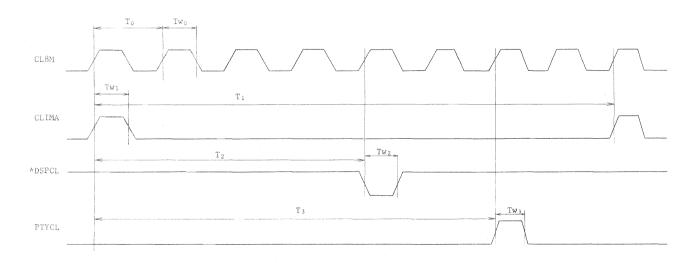


Fig. 1

K0110-1 Capstan Tachometer Output Check (1)

Check the following three items regarding tachometer output CPA and CPB of the capstan motor.

# I. Duty Check

Connect a field tester and load a magnetic tape. Observe CPA and CPB with an oscilloscope during forward (Command code: \$01) and backward (Command code: \$41) motions in continuous mode using a field tester. Check that both directions of motion satisfy the requirements shown in Fig. 1.

Capstan tachometer	Measurement position (back panel)	Requirement			
CPA CPB	1A01 AA6 1A01 AB6	Shown in Fig. 1			

(If the requirements are not satisfied, see next page K0110-2, Note 1 for adjusting the duty.)

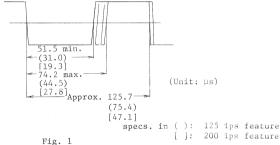
#### II. Phase Check

Measurement at FWD running (Command code: \$01):

- 1. Run a tape in the FWD direction in the same manner as item I above.
- 2. Observe CPA with channel (CHI) and CPB with channel (CH2) simultaneously.
- 3. Check that the requirements shown in Fig. 2 are satisfied when triggered by trailing edge of the pulse CPB (CH2).

Measurement at BWD running (Command code: \$41):

- 1. Run a tape in the BWD direction.
- 2. Measure at the same terminals as in FWD running. In this case, exchange the oscilloscope input CH1 and CH2.
- 3. Check that the measured values satisfy the requirements shown in Fig. 2.



[]: 200 ips feature

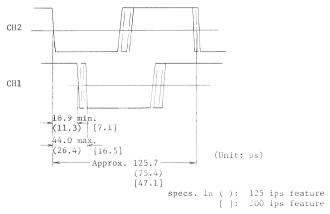


Fig. 2

K0110-2 | Capstan Tachometer Output Check (2)

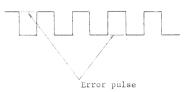
### III. Capstan High-speed Rotation Check

- 1. Remove the magnetic tape.
- 2. Connect a field tester with 1005, set switches  $0 \circ 7$  to \$9D, and push SSS switch. The capstan motor will rotate with high speed. Then, check the tachometer.
- 3. If an error occurs, Unit check LED is illuminated and error code is displayed. In this case, the capstan motor rotates with insecure speed.

Correct pulse form



Incorrect pulse form



Note 1: If the requirement for capstan pulse CPA or CPB is not satisfied, adjust the potentiometer that corresponds to CPA or CPB at capstan motor (refer to Caution below).

Correspondence between pulse and potentiometer:

Pulse CPA: Pot 1 shown in Fig. 1.

Pulse CPB: Pot 2

If a requirement is satisfied, do not adjust or touch the potentiometer. If there in no hole for adjustment on cover, do not adjust it.

### CAUTION

If a potentiometer is turned too far, the capstan will be in a runaway condition. If this occurs, immediately push the Door Interlock switch to stop the capstan. Return potentiometer(s) to midrange and repeat adjustment.

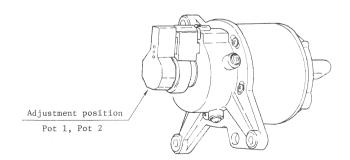


Fig. 1

K0120-1 Azimuth Check and Adjustment (1)

#### I. Azimuth Check

Check the azimuth according to the following procedure:

- 1. Demagnetize the read/write head and the erase head with a head eraser.
- Connect a field tester and load a master skew tape. (P/N: BM.BvMt 351d)
- Set the field tester to Low speed, PE mode and FWD read. (See Table 2.)
- 4. Now, trigger the read output of Track 1, and check that the phase difference with the read output of track 9 (Fig. 1) satisfies the requirements shown in Table 1. (See Fig. 2.)
- 5. Check that the other tracks have the same ROW output.
- 6. Observe the BWD (backward) operation in the same manner and check that the requirements shown in Table 1 are satisfied.
- If the FWD or BWD operations do not satisfy the requirements shown in Table 1, an adjustment of the azimuth must be performed according to item II.

Table 1

Model		Check p	oint	Requirement	
110000	Track 1	Track 9	Other tracks		
125 ips 6250/1600 rpi (WRHMU)	CHAJ-1	CHAR-1	CHAK-1 ∿ CHAQ-1	FWD skew	within 0.6 µs within 1 µs
75 ips 6250/1600 rpi (WRIMU)	CHAJ-1	CHAR-1	CHAK-1 ∼ CHAQ-1	FWD skew BWD skew	within l µs within l.6 µs
125 ips 1600/800 rpi (WRJMU)	СНАЈ-1	CHAR-1	CHAK-1 ∼ CHAQ-1	FWD skew	within 0.4 µs within 0.4 µs
75 ips 1600/800 rpi (WRKMU)	CHAJ-1	CHAR-1	CHAK-1 ∼ CHAQ-1	FWD skew	within 0.7 µs within 0.7 µs
200 ips 6250/1600 rpi (WRHMU)	CHAJ-1	CHAR-1	CHAK-1 ∼ CHAQ-1	FWD skew	within 0.4 µs within 0.6 µs

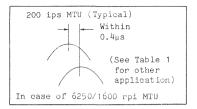


Fig. 1

Table 2 Field tester operation procedure

Pro- cedure	Operation	Switch $0 \sim 7$	SSS	Remarks
1.	Mode setting 6250/1600 rpi 1600/800 rpi	\$E0 \$E2	ON	MTU is in
2	Running direction Forward Backward	\$01 \$41		off line mode.
3	Execution		ON	
4	Stop		ON	

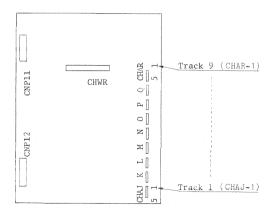


Fig. 2 Write/Read amplifier PCA

K0120-2 Azimuth Check and Adjustment (2)

# II. Azimuth Adjustment

- 1. Carry out adjustment of dynamic alignment. (L0130-2)
- 2. Trigger the read output of Track 1 and observe the phase difference with the Read output of Track 9 in the same way as in the azimuth check above. Turn the azimuth adjusting screw (A) (Fig. 3) with a screwdriver and adjust the phase of the two waveforms.
- 3. Check that other tracks have the same ROW output.
- Observe BWD operation in the same way and if the requirements shown in Table 1 is satisfied, no adjustment is needed.
- 5. If the requirements are not satisfied: 6250/1600 rpi MTU: Turn the upper capstan alignment adjusting screw until the backward skew is within the requirements.
  - (1) If track 9 leads track 1, turn the screw counter clockwise.
  - (2) If track 1 leads track 9, turn the screw clockwise. Note: The rotation of the azimuth adjusting screw must be within  $1/4 \ \text{turn}$ .
- Check that forward skew satisfies the requirements shown in Table 1 of K0120-1, and repeat steps 4 and 5.

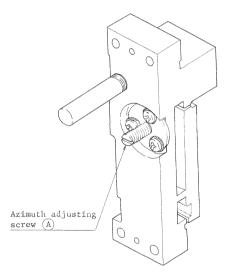


Fig. 3 Head block figure observed from back of mechanic panel

K0130-1 Read Signal Check and Adjustment, and Head Replacement Specification (6250/1600 rpi MTU) (1)

### Prerequisites for checking:

- 1. Clean the read/write and erase heads before checking. (See J0001.)
- 2. Use a tape free from damage.
- 3. The vacuum levels in columns shall be normal. (See K0190.)
- 4. Capstan alignment shall be normal. (See L0130.)

If the above prerequisites have been satisfied, then mount a field tester and load the tape. Then, check and adjust read levels for the respective modes as shown below. Some adjustment becomes necessary if any standard is not satisfied or a head has been replaced with another.

I. Low Speed PE signal check/adjustment (Including 200 ips start/stop mode)

Table 1

	Item		d tester		Standards	
At check time	At ad- justment time	Code	Setting switch name	Operation	(Statuses of LEDO to LED8)	Remarks
.1	1	\$1E	CNT	Set LEDs on the field tester to the TMSRO to TMSR8 (register \$1E) display mode.		At 200 ips mode. adjust RV4, RV5 to the middle of each range
2	2	\$E8	SSS	Set the tape speed to the low speed mode.		
	3	\$FA	SSS	Set the slice level to 100%.		
	4	\$89	SSS	Write 3200 fci in the low speed PE mode.	Adjust RVIJ to RVIR so that LEDs can be set to a semi- luminous status.	After adjustment, set the SSS switch to on and stop the tape.
3	5	\$F9	SSS	Set the slice level to 90%.		
4	6	\$89	SSS	Write 3200 fci in the low speed PE mode.	LEDO to LEDS shall all light.	After checking, set the SSS switch to on and stop the tape.
5	7	\$FB	SSS	Set the slice level to 110%.		
6	8	\$89	SSS	Write 3200 fci in the low speed PE mode.	LEDO to LED8 shall all be gone out.	After checking, set the SSS switch to on and stop the tape.

Notes: 1. A semi-luminous status is intermediate between the going-out and the most luminous status of a LED.

- 2. The word "lighting" refers to a status other than going-out.
- 3. The correspondences between LEDO to LED8 and RVIJ to RVIR are as follows:

Variable resistor	RV1J	RV1K	RV1L	RV1M	RV1N	RV10	RV1P	RV1Q	RV1R
Track No.	1	2	3	4	5	6	7	8	9
LED No.	5	7	3	8	2	1.	0	6	4

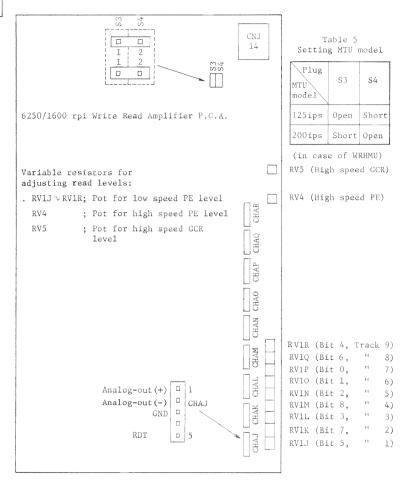


Fig. 1 Variable resistors and check terminals for 6250/1600 rpi MTU

	K0130-2	Read	Signal	Check	and	Adjustment	and	Head	Replacement	Specification	(6250/1600	rpi	MTU)		(2)
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II. High Speed PE signal check/adjustment

Table 2

I	tem	Field	d tester			
	At ad- just- ment time	-	Setting switch name	Operation	Standards (Statuses of LEDO to LED8)	Remarks
1	1	\$1E	CNT	Set LEDs on the field tester to the TMSRO and TMSR8 (register \$1E) display mode.		
2	2	ŞEC	SSS	Set the tape speed to the high speed mode.		
	3 .	ŞFA	SSS	Set the slice level to 100%.		
	4	\$89	SSS	Write 3200 fci in the high speed PE mode.	Adjust RV4 so that four or more LEDs of LED0 to LED8 can light.	After adjustment, set the SSS switch to on and stop the tape.
3	5	\$F5	SSS	Set the slice level to 80%.		
4	6	\$89	SSS	Write 3200 fci in the high speed PE mode.	LEDO to LED8 shall all light.	After checking, set the SSS switch to on and stop the tape.
5	5 7 \$F7 SSS		SSS	Set the slice level to 125%.		
6 8		\$89	SSS	Write 3200 fci in the high speed PE mode.	LEDO to LED8 shall be gone out,	After checking, set the SSS switch to on and stop the tape.

III. Low Speed GCR signal check (Including 200ips start/stop mode)

Table 3

	Field	l tester		Standards	
Item	Code	Setting switch name	Operation	(Statuses of LEDO to LED8)	Remarks
1	\$1E	CNT	Set LEDs on the field tester to the TMSRO and TMSR8 (register 1E) display mode.		
2	\$EA	SSS	Set the tape speed to the low speed mode.		
3	\$F3	SSS	Set the slice level to 51%.		
4	\$C6	SSS	Set the DGC amplifier to step 6.		Since the tape runs, set the SSS switch to on and stop the tape.
5	\$8B	SSS	Write 9042 fci in the low speed GCR mode.	LEDO to LED8 shall all light.	After checking, set the SSS switch to on and stop the mode.
6	\$F5	SSS	Set the slice level to 80%.		
7	\$8F	SSS	Perform a SAGC operation in the low speed GCR mode and write 9042 fci.	LEDO to LED8 shall all light.	After checking, set the SSS switch to on and stop the mode.
8	\$F7	SSS	Set the slice level to 125%.		
9	\$8B	SSS	Write 9042 fci in the low speed GCR mode.	LEDO to LED8 shall all be gone out.	After checking, set the SSS switch to on and stop the mode.
10	\$F3	SSS	Set the slice level to 51%.		
11	\$41	SSS	Read backward in the low speed GCR mode.	LEDO to LED8 shall all light.	Use the tape posi- tion written at item 9.

Note 1: Do not rewind the tape in the middle of performing each check item.

ко1 30-3	Read	Signal	Check	and	Adjustment	and	Head	Replacement	Specification	(6250/1600	rpi l	MTU)	(3)

IV. High Speed GCR signal check/adjustment

Table 4

	Item	Fiel	d tester		Standards	
At check time	At ad- justment time	Code	Setting switch name	Operation	(Statuses of LEDO to LED8)	Remarks
1	1	\$1E	CNT	Set LEDs on the field tester to the TMSRO and TMSR8 (register 1E) display mode.		
2	2	\$EA	SSS	Set the tape speed to the low speed mode.		
3	3	\$8F	SSS	Write 9042 fci in the low speed GCR mode.		After operating for one or more seconds, set the SSS switch to on and stop the tape,
4	4	\$EE	SSS	Set the tape speed to the high speed mode.		
	5	ŞFA	SSS	Set the slice level to 100%.		
	6	\$8B	SSS	Write 9042 fci in the high speed GCR mode.	Adjust RV5 so that four or more LEDs of LED0 to LED8 can light.	After adjustment, set the SSS switch to on and stop the tape.
5	7	\$F4	SSS	Set the slice level to 64%.		
6	8	\$8B	SSS	Write 9042 fci in the high speed GCR mode.	LEDO to LED8 shall all light.	After checking, set the SSS switch to on and stop the tape.
7	9	\$F7	SSS	Set the slice level to 125%.		
8	10	\$8B	SSS	Write 9042 fci in the high speed GCR mode.	LEDO to LED8 shall all be gone out.	After checking, set the SSS switch to on and stop the tape.
9		\$F3	SSS	Set the slice level to 51%.		
10		\$42	SSS	Read backward in the high speed GCR mode.	LEDO to LED8 shall all light.	Use the tape position written at item 8.

Note 1: Do not rewind the tape in the middle of performing each check item.

If adjustments I, II, and IV cannot be performed, then replace the head with another. If any standards of check III and check items 9 and 10 of check IV are not satisfied, then replace the head and perform checks I to IV once more.

For head replacement see L0010. If no check/adjustment can be done even after head replacement, then go to A7000.

,		
K0140-1	Read Signal Check and Adjustment	
	and Head Replacement Specification (1600/800 rpi MTU) (1	1)

### Prerequisites for checking:

- 1. Clean the read/write and erase heads before checking. (See J0001.)
- 2. Use a tape free from damage.
- 3. The vacuum levels in columns shall be normal. (See K0190.)
- 4. Capstan alignment shall be normal. (See L0130.)

If the above prerequisites have been satisfied, then mount a field tester and load the tape. Then, check and adjust read levels for the respective modes as shown below. Some adjustment becomes necessary if any standard is not satisfied or a head has been replaced with another.

# I. NRZI signal check/adjustment

Table 1

	Item	Field	d tester			
	At ad- justment time		Setting switch name	Operation	Standards	Remarks
1	1	\$E0 \$89	SSS	Write 800 fci in the NRZI mode.	Adjust RV1J to RV1R so that terminals CHAJ-1 to CHAR-1 can develope the following value: 2.0 Vp-p±10% (against the grounding). Use an oscilloscope for observation.	

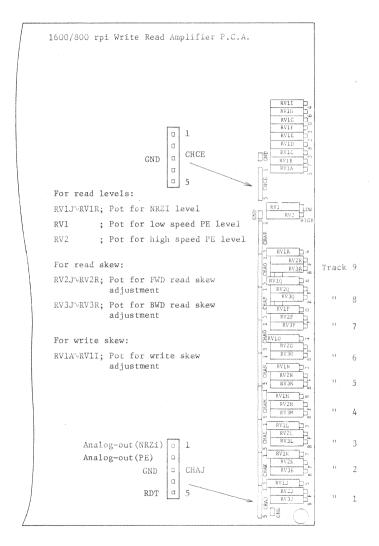


Fig. 1 Variable resistors and check terminals for 1600/800 rpi MTU

K0140-2	Read	Sígna	al Check	and	Adjustment				
	and	Head I	Replaceme	nt	Specification	(1600/800	rpi	MTU)	(2)

II. Low Speed PE signal check/adjustment

Table 2

At	Item At ad- justment		d tester Setting switch name	Operation	Standards (Statuses of LEDO to LED8)	Remarks
1	1	\$1E	CNT	Set LEDs on the field tester to the TMSRO and TMSR8 (register 1E) display mode.		
2	2	\$E2	SSS	Set the tape speed to the low speed mode.		
	3	\$FA	SSS	Set the slice level to 100%.		
	4	\$8B	SSS	Write 3200 fci in the low speed PE mode.	Adjust RV1 so that four or more LEDs of LED0 to LED8 can light.	After adjustment, set the SSS switch to on and stop the tape.
3	5	\$F5	SSS	Set the slice level to 80%.		
4	6	\$8B	SSS	Write 3200 fci in the low speed PE mode.	LEDO to LED8 shall all light.	After checking, set the SSS switch to on and stop the tape.
5	7	\$F7	SSS	Set the slice level to 125%.		
6	8	\$8B	SSS	Write 3200 fci in the low speed PE mode.	LEDO to LED8 shall all be gone out.	After checking, set the SSS switch to on and stop the tape.

# III. High Speed PE signal check/adjustment

Table 3

	Item	Fiel	d tester			
At check time	At ad- justment time	Code	Setting switch name	Operation	Standards (Statuses of LEDO to LED8)	Remarks
1	1	\$1E	CNT	Set LEDs on the field tester to the TMSRO and TMSR8 (register 1E) display mode.		
2	2	\$EC	SSS	Set the tape speed to the high speed mode.		
	3	\$FA	SSS	Set the slice level to 100%.		
	4	\$8B	SSS	Write 3200 fci in the high speed PE mode.	Adjust RV2 so that four or more LEDs of LED0 to LED8 can light.	
3	5	\$F5	SSS	Set the slice level to 80%.		
4	6	\$8B	SSS	Write 3200 fci in the high speed PE mode.	LEDO to LED8 shall all light.	After checking, set the SSS switch to on and stop the tape.
5	7	\$F7	SSS	Set the slice level to 125%.		
6	8	\$8B	SSS	Write 3200 fci in the high speed PE mode.	LEDO to LEDS shall all be gone out.	After checking, set the SSS switch to on and stop the tape.

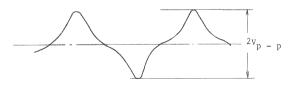
Notes: 1. A semi-luminous status is intermediate between the going-out and the most luminous status of a LED.

- The word "lighting" refers to a status other than going-out.

Track No.	1	2	3	4	5	6	7	8	9
LED No.	5	7	3	8	2	1	0	6	4

Track 1 corresponds to unit J; track 9 corresponds to unit R.

If adjustments I, II, and III cannot be performed, then replace the head with another. For head replacement, see L0010.



800NRZI mode

Fig. 2 Read signal waveform

K0150-1	Read	and	Write	Skew	Check	and	Adjustment	(1600/800	rpi	MTU)	(1)

Check and adjust read/write skew by taking the following steps:

I. Read skew check/adjustment

Check and adjust read skew by taking the following steps:

- Degauss the magnetic and erasing heads with the demagnetizer (eraser) and clean the heads.
- 2. Mount a field tester.
- Load a standard skew adjustment tape; check that the FILE PROTECT lamp on the operator panel is then lighting.
- 4. Run the tape forwards or backwards in the NRZI mode. Operation of the field tester is as follows:

а			Ì.

	Field tester			Remarks		
Item Code Setting Switch name		switch	Operation			
1	\$E0	SSS	Set to the NRZI mode.			
2	2 \$01 SSS For		Forward running	The tape stops running if		
	\$41	SSS	Backward running	a BOT or an EOT is detected.		

5. Reference track deskew pulse width check/adjustment Check that the pulse width developed at check terminal CHAN-5 for track 5 falls into the value shown below. Adjust the pulse width for the specified value with RV2N (forward running) and RV3N (backward running).

Table 2

Speed	Checked/adjusted pulse width (tw)	Observed waveform
75 ips (for 75/125 ips device)	3.0 µ <b>s</b> ±10%	CHAN-5
125 ips (for 125/200 ips device)	2.0 µs±10%	2.4°5V

6. Check that the rise times of pulses for the respective tracks fall into the standards as shown in Table 3 for forward and backward running when the output levels of other tracks are observed using the output level of check terminal CHAN-5 for track 5 as a reference.

Also, adjust the above rise times with RV2J to RV2R (except RV2N; forward running) and RV3J to RV3R (except RV3N; backward running).

Table 3

Speed	Running direction	Variable resistors	Check terminal	Standard (At) (See Fig. 1)	
75 ips	Forward	RV2J to RV2R (except RV2N)		0.3 μs or less	
•	Backward	RV3J to RV3R (except RV3N)	CHAJ-5		
125 ips	Forward RV2J to RV2R (except RV2N)  Backward RV3J to RV3R (except RV3N)		CHAR-5 (except CHAN-5)	0.2 us or less	



Fig. 1

Note 1: For locations of check terminals and variable resistors see Fig. 1 in  $\mathrm{K}0140\text{-}1$ .

K0150-2 Read and Write Skew Check and Adjustment (1600/800 rpi MTU) (2)

II. Write skew check/adjustment

Check and adjust write skew by taking the following steps:

- 1. Load a writable tape.
- 2. Write 800 fci in the NRZI mode.

Field tester code: \$E0
Field tester setting switch: \$SS
Field tester code: \$89

Field tester setting switch: SSS

3. Reference track deskew pulse width check/adjustment

Observe the deskew clock pulse width for track 5 of the write circuit at check terminal CHCE-1 and check that the clock pulse width falls into the value shown in Table 4. Also, adjust the pulse width for the specified value with RVIE.

Table 4.

Speed	Adjusted pulse width (tw)	Observed waveform
75 ips (for 75/125 ips device)	3.0 µs±10%	CHCE-1
125 ips (for 125/200 ips device)	2.0 µs±10%	2.445 V 000.4 V

4. Check that the rise times of pulses for the respective tracks fall into the standards as shown in Fig. 1 when the output levels of other tracks are observed using the output level of check terminal CHAN-5 for track 5 as a reference. Also, adjust the rise time with RVIA to RVII (except RVIE).

Table 5

Speed	Variable resistor	Check terminal	Standard (At) (See Fig. 1)
75 ips (for 75/125 ips device)	RVIA to RVII (except RVIE)	CHAJ-5 to CHAR-5	0.3 μs or less
125 ips (for 125/200 ips device)		(except CHAN-5)	0.2 µs or less

Note 1: For locations of check terminals and variable resister see Fig. 1 in K0140-1.

K0160 Check for Write Voltage

- 1. Connect a field tester and load a writable tape.
- 2. Set the field tester to the write mode (in P£ mode), erase mode, or read mode.
- 3. Check for voltage at each check point, (See Table 1.)

Table 1

Note. *; all Units

Mode Field tester	Revision	Check	Write mode		Erase mode	Read mode
command MTU type		point	E8 (SSS) 89 (SSS)	EC (SSS) 89 (SSS)	83	01
and the second s	*	CHWR- 6	11.2±1 V		Max. +0.4 V	Max. +0.4 V
6250/1600 rpi Mode	WRHM; * WRIM; B	CHWR- 8	5.6±0.4 V		May 40 4 V	Max. +0.4 V
Mode	WRIM; after E	CRWK- 0	5.2±0.4 V	5.8±0.4 V	1187. 10.4	nax. TU.4 V
Military	*	CHWR-10	2.4±0.4 V		2.4±0.4 V	Max. +0.4 V
1600/800 rpi	*	CHWR- 6	10.5±l V		Max. +0.4 V	Max. +0.4 V
Mode	*	CHWR-10	2.4±0.4 V		2.4±0.4 V	Max. +0.4 V

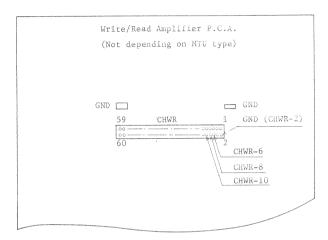


Fig. 1 Locations of check points

# K0170 Check for Erase Effect

- 1. Prepare a tape to which all 'l's have been written in the 1600 PE mode.
- 2. Connect a field tester and load the tape.
- 3. Erase the tape content by issuing an erase command from the field tester (code \$80).
- 4. Read the tape content and check that the output levels at the respective check points are to the specifications provided in Table 1.

Table 1

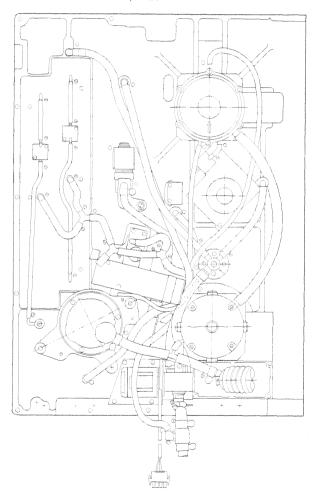
MTU type	Read mode (code)	Check points	Allowable range
6250/1600 rpi MTU	PE (\$E0, \$01)	CHAJ-1 to CHAR-1	At most
1600/800 rpi MTU	PE (\$E2, \$01)	CHAJ-2 to CHAR-2	40 mVp-p

Note: Locations of check points show the K0130-1 Fig. 1 (6250/1600 rpi MTU) or K0140-1 Fig. 1.

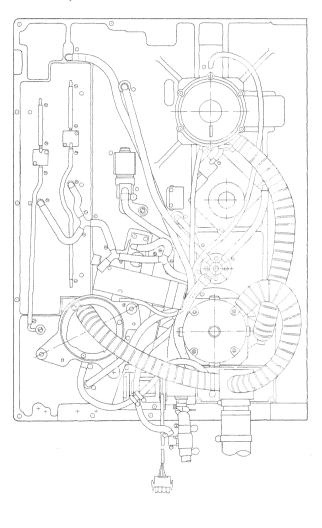
# Procedure:

- (1) Check to be sure that no cracks or other problems exist on the hoses and tubes.
- (2) Check for loose connection of tubes or disconnected tubes.
- (3) Check for folded hose or disconnected hose.

Pictorial: 1 75/125 ips MTU



Pictorial: 2 200 ips MTU



K0190

Check and Adjustment of Pressure and Vacuum Levels

# Checking and Adjusting Pressure

#### Checking Procedure:

During Threading

- (1) Connect a pressure gauge to Restraint Number Pressure Port C.
- (2) Mount the Special Tool (B960-0110-T026A) on the air outlet of restraint-member.
- (3) Check if the pressure is within Table 1 check specification.

During Servo On

- (1) With the tape loaded into the columns, connect the pressure gauge to servo on pressure port B.
- (2) Check if the pressure is within Table 1 check specification.

### Adjusting Procedure:

During threading

Adjusting the Distributor screw so that the pressure is within Table 1 adjust specification (Enter A5 into tester)

During Servo On

Adjust the pressure relief valve (See Fig. 1) that the pressure is within Table 1 adjustment specification.

- Note 1. When adjusting pressures/vacuum levels the following sequence shall be observed.
  - 1 Vacuum Column
  - 2 Servo On Pressure
  - 3 Restraint Pressure
- Note 2. In order to accurately check and adjust the vacuum and pressure levels it is necessary to allow the pneumatics assembly to thermally stabilise. Adjustments and measurements are therefore to be made to the time frames indicated in Table 1.

Table 1

Measuring port	All Figures mmH ₂ O	Check within	Adjust to
A	Vacuum Column	950 ± 50	950 ± 30
В	Servo on Pressure	2600 ± 50	2600 ± 30
С	Restraint Pressure	650 ± 30	650 ± 15
		Only after running for at least 10 minutes	Only after running for at least 30 minutes

# Checking and Adjusting Vacuum Levels

### Checking and Adjustment Vacuum Pressure

### Checking Procedure:

- (1) Connect the vacuum gauge to column vacuum measuring port A.
- (2) Check if the vacuum level is within Table 1 check specification.

### Adjusting Procedure:

Adjust the vacuum Restrictor so that the vacuum level is within Table 1 adjustment specification.

Note: Refer to Manual Sheet L0350 for parts layout such as check ports and restrictor.

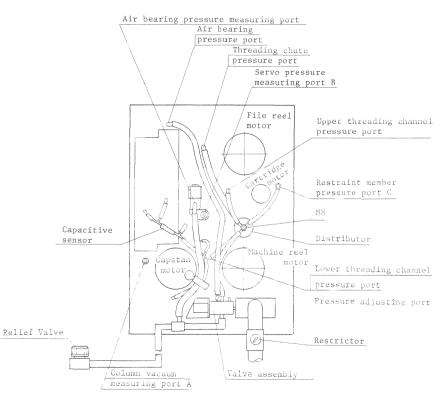


Fig. 1

# K0191-1 Frequency Setting (1)

Exchange large pulley, belts and the connections of CNP66, CNP66C, if necessary. (Refer to Fig. 1)

# 1. Exchange of connector positions

Exchange the connections of CNP66 and CNP66C. (See Fig. 1.)

# 2. Exchange of large pulley and belts

- Remove pulley and belts from the air supply cabinet. (In this case, detach fitting bolts.)
- 2. Detach the fitting bolts of the air supply cover and remove that cover.
- 3. Loosen the fitting bolts (a) (for the blower) and fitting bolts (b) (for the pump) and remove the bolts respectively. (See Fig. 2. ... Next page)
- Remove the fitting bolts (for the blower pulley) and fitting bolts (motor pulley on the pump side).
- 5. After replacing each pulley, attach a new belt and perform frequency conversion between 50 Hz and 60 Hz. (See Fig. 3.)
- 6. Check and adjust belt tension. (Refer to KO200.)
- 7. Check and adjust the pressure and vacuum level. (Refer to KO190.)

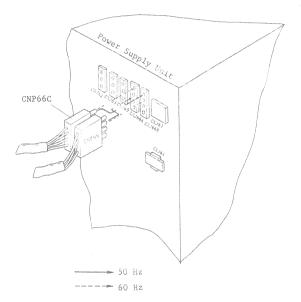
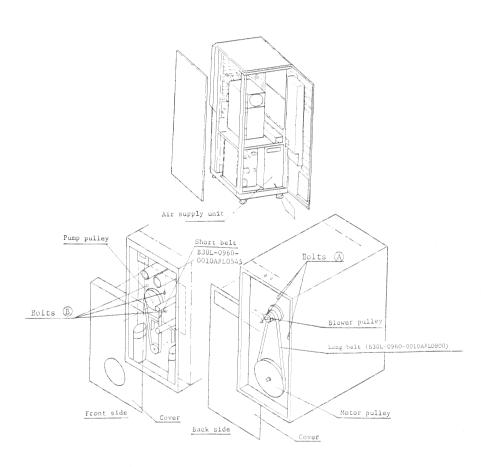
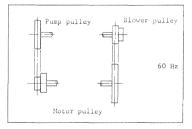


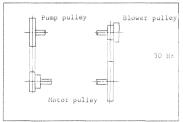
Fig. 1

K0191-2 Frequency Setting (2)

K0191-3 Missing Description for altitude Setting (3)







- Detach the fitting bolts of the rear and front of MTU and remove the air supply from the rear of unit.
- 2. Remove the front and rear covers.
- 3. Measure the belt tension with a tension meter.

Turn the motor pulley 3 to 5 turns by hand before measurement. Snap the belt as shown in Fig. 3, push up the lever with a finger as shown in Fig. 2, 3 and read the value in pound at the time when the back of the belt comes into contact with "A" part indicated by the arrow in Fig. 3.

- 4. Adjust the belt tension by shifting the fixing position of the blower or pump.
  - o If the belt is to be replaced, the new belt must be adjusted so that the tension level required in Table 1 are satisfied.
  - o If the old belt is to be used again, measure its tension before removing it, and adjust the belt to that tension when putting it back on. (Set the belt in same direction as removing).

Table 1

Belt	Required value	Adjusted value		
3010	Medarrea large	New belt using	Old belt using	
Belt between motor and blower (longer belt)	16.5 (1bs) or more	29~34 (1bs)	Original tension (Refer to Note 2.)	
Belt between motor and pump (shorter belt)	12.5 (lbs) or more	29^34 (lbs)		

- Note 1: The belt tension repidly deteriorates in several days  $^{\circ}$  several months. If the required value is not satisfied, the belt must be replaced.
  - 2: Since the old belt has been extended, its life may be extremely shortened if its tension is adjusted to the adjusted value for a new belt.

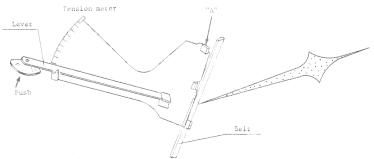


Fig. 3

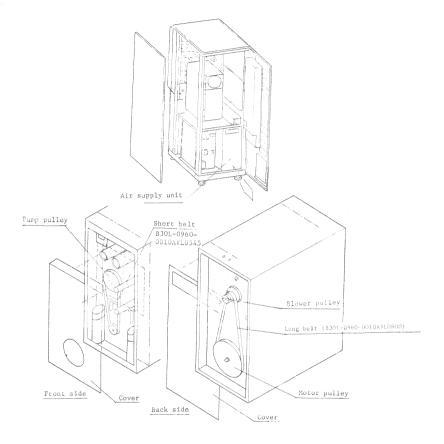


Fig. 2

# K0210 | Check and Adjustment of BOT and EOT Detection Circuits

- Prepare a new magnetic tape and two new reflective markers. Attach these
  markers to the magnetic tape as shown in Fig. 1.
- 2. Without the tape being loaded, adjust the voltage level at check terminals "BOT" and "BOT" with degital voltmeter to 2.0 V with the poteniometer "RV5" and "RV6" respectively on the tape drive PCA.
- 3. Connect a field tester and load the tape prepared in step 1 above.
- 4. After the tape stopped at the BOT, measure the check terminal "BOT" level. If the level is lower than 2.0 V adjust the level to  $\pm 1.6$  V by the potentiometer "RV5" again.
- Set the field tester to FWD, CONTI, and READ (Command code: \$01) and run the tape.
- 6. After the tape has stopped at the EOT, check that the "BOT" level is lower than  $\pm 0.3~\mathrm{V}$ .
- 7. Measure the "EOT" level. If the level is lower than 2.0 V adjust level to +1.6 V by again.
- 8. Set the field tester to REW (Command code: \$47). After the tape has stopped at the BOT, check that the "EOT" level lower than +0.3 V.

# K0220 Check of Low Tape Detection Circuit

Check the low tape detection circuit according to the following procedure.

- 1. Without the tape being loaded, connect the field tester.
- 2. Set the field tester to Machine Reel FWD (Command code: \$D2).
- 3. Check that check terminal "lAO1 AB8" output voltage level is  $\pm 1.4$  Vp-p or more. (Fig. 3)

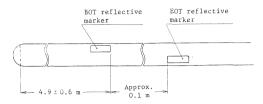


Fig. 1

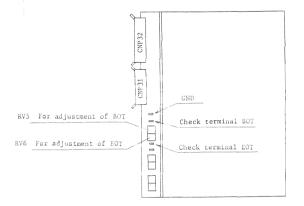


Fig. 2 Tape Drive PCA (TKBMU or TKHMU)



Fig. 3 Low Tape Output

# K0240 | Check and Adjustment of Tape Loop Position Detection Circuit

1. Confirm that the column vacuum and the pressure of capacitive sensor satisfy the requirements. (Refer to K0190.)

Column vacuum

950 mmH₂0 ± 10%

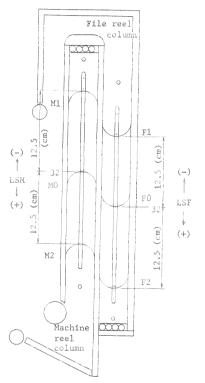
Pressure of capacitive sensor

240 mmH₂0

- 2. Do a load, pull tape from columns and hit reset twice.
- 3. Turn on the air supply with a field tester (Command code: \$A8 and SSS switch on), feed the tape inside the column, and fix the tape loop at FO and MO. (See Fig. 1.)
- 4. Adjust RV2F and RV2M of TKBMU or TKHMU, which is mounted on 1A04, to approximately 50%.
- Adjust RV1F and RV1M so that the output voltage of the sensor satisfies the following requirements:

	Check position	Sensor output voltage
File reel:	LSF (TKBMU or TKHMU) or AD8 (1A01)	0 ± 0.2 V
Machine reel:	LSM (TKBMU or TKHMU) or AE7 (1A01)	0 ± 0.2 V

- 6. Set Switch 6 of the field tester on (Command code: \$AA). The loop of the magnetic tape will stop at position FI and M1. Under this condition, adjust RV2F and RV2M so that the absolute value of the voltage on the check position is in the range of 6.5 V  $\pm$  0.2 V.
- 7. Set Switch 7 of the field tester on (Command code: \$AB). The loop of the magnetic tape will stop at positions F2 and M2. Under this condition, if the absolute value of the voltage on the check positions is below 6.5 V, adjust RV2F and RV2M so that it satisfies 6.5 V  $\pm$  0.2 V.
- 8. Set off Switch 7 of the field tester (Command code: SAA) and check that the voltage at each check point is about 6.5 V  $\pm$  0.2 V (Absolute).
- 9. Set on SSS to terminate the test.



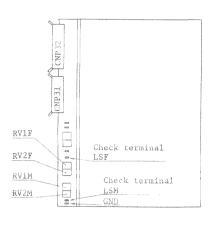


Fig. 1

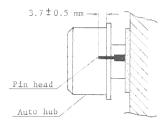
Fig. 2 Tape drive PCA (TKBMU or TKHMU)

K0260

Check and Adjustment of File Protection Mechanism

Check and adjustment of the file protection mechanism is performed by confirming the position of the pin head of the file protection both in a usual state and when the magnetic tape with enable ring loaded.

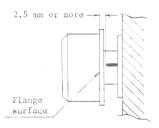
# 1 Usual state



When magnetic tape with enable ring is loaded

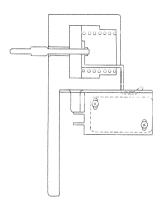
Push the pin head as far as the flange surface, and press the LOAD/REWIND button. Check that the distance between flange surface and pin head is 2.5 mm or more.

The file protection must be replaced if the specified value is not satisfied.



Push the pin head with a hand. Check that the micro switch is actuated before the pin point is moved 1 to 2.8 mm.

If not, remove the file protection from the panel and adjust the position of the micro switch.



K0280

Check and Adjustment of Front Door Synchronous Belt Tension

If there is a problem concerning the tension of the front door synchronous belt, check and adjustment are performed in accordance with the procedures described below.

# Measuring instrument:

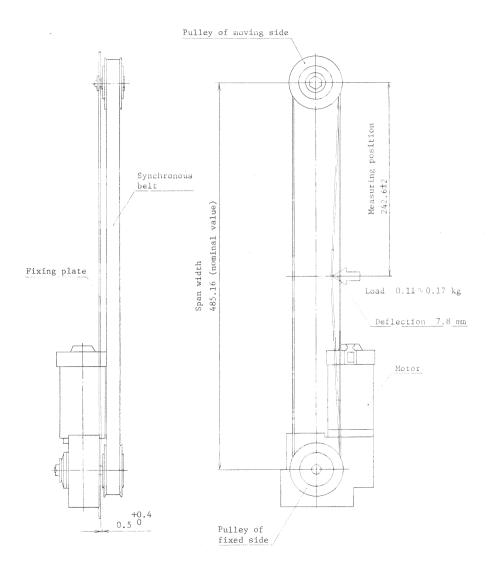
Spring scale (1 kg maximum)

### Check Procedures:

Place the spring scale against the belt at the position indicated by the arrow. When the belt deflection is about 7.8 mm, the belt shall be pushed straight up with 0.11  $\sim$  0.17 kg force. For the measurement, slide-rail part must be removed from the belt and the belt must be free.

### Adjustment Procedures:

Belt tension adjustment is performed by loosening one fixing screw of the pulley on moving side and moving the pulley up or down.



K0290 | Check of Auto Cleaner

- 1. The auto cleaner can be positioned with the guide pins on the magnetic head. (See Fig. 1.)
- Check that the ribbon is taut and is properly mounted on the ribbon guide and slide part.

If it is loose, depress the load button after turning the power on. Then the motor turns automatically and the sag is eliminated.

Magnetic head

Guide pin

Moving part

Fig. 1 Magnetic head and auto cleaner

L0000 Parts Replacement Procedure

### General Precautions

- 1. In general, the power supply must be turned off for replacing part.
- 2. Correctly calibrated tools must be used.
- Any work designated to be performed by two CE's must not be performed by one CE alone.
- 4. Be careful not to loss any removed screws, washers, and nuts.
- 5. Any parts that fall into the equipment must always be removed.
- Remember the conditions prior to replacement for the convenience of checking the conditions and performances after replacement.
- 7. In replacement of PCA with Green Mark, you must check and adjust.

# MTU Parts Replacement Procedure

Item	Parts name	MAP No.
1	Read/write head	L0010
2	Erase head	L0020
3	Read/Write PCA (Write Read amplifier)	L0030
4	Threading channel	L0040
5	Tape cleaner	L0050
6	EOT/BOT sensor	L0060
7	Tape guide	1.0070
8	Roller guide	F0080
9	Auto cleaner	L0110
10	Capstan motor	L0130
11	Threading chute and restraint member	L0140
12	Cartridge opener	L0150
13	Error marker	L0160
1.4	File protect mechanism	L0170

Item	Parts name	MAP No.
15	Auto hub	L0180
16	Cover assembly	L0190
17	Latch	L0200
18	Cam assembly	L0210
19	Rear housing assembly	L0220
20	Machine reel	L0230
21	Low tape sensor	L0250
22	Reel motors	L0260
23	Vacuum column cover	L0270
24	Vacuum column section	L0280
25	Micro switch for opening/closing glass	L0300
26	Front door clutch section	L0310
27	Valve ASM vacuum and pressure	L0330
28	Restrictor	L0350
29	Fan unit	10360
30	Cooling air filter	L0370
31	Absolute filter	L0380
32	Air supply unit	L0400
33	Threading cover	L0410
34	Cartridge sensor	L0420
35	Capacítive sensor	L0430
36	Power supply unit	L0440
37	Operator panel	L0450
38	Door switch	L0460
39	Rib	L0470

L0010 Replacement of Read/Write Head

### Procedure:

### [Removing]

- 1. Remove FPC board connectors and frame ground terminal from the head.
- 2. Loosen erase head set screws, and remove erase-head from its plate.
- 3. Loosen the block screws, and remove the block.
- 4. Loosen the two head plate set screws, and remove the head base from head block.

### [Mounting]

- 1. Place the head plate onto the plate positioning pin, and then place and tighten two screws other than those for erase head and head block.
- 2. Place the block in position by using the positioning pin, and tighten screws with holding the block onto head.
- 3. Place erase head in position using positioning pin, and tighten screws with holding the head onto the other pin.
- 4. Connect FPC board connectors and fix the frame ground terminal.
- 5. Check the Azimuth. (Refer to K0120, K0130)

Replacement of Erase Head

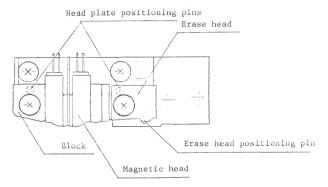
### Procedure:

### [Removing]

- 1. Remove connectors.
- 2. Remove screws and erase head.

# [Mounting]

1. Place erase head onto its positioning pin, and tighten screws with holding the head onto the other pin.



L0030 Replacement of Read/Write PCA

Be sure to turn off power before replacement of the Read/Write PCA.

### Removal

- Open the column cover and threading cover, detach the ground terminal screw of the FPC cable, and remove the erase connector (CNJO3). (See Fig. 1.)
- Detach the following connectors, which are connected with Read/Write PCA on the back of the unit. (See Fig. 2.)

Read FPC cable, Write FPC cable, interface connector (CNJ13) and Power supply connector (CNP14)

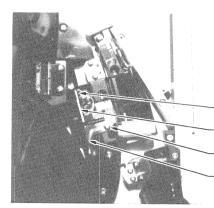
 Pull the neightlatch and remove Read/Write PCA, being careful not to damage the PCA.

# Mounting

- 1. Set or check the MTU model setting plug in case of WRHMU (K0130)
- 2. Put Read/Write PCA on a leading groove and set the nieghtlatch.
- 3. Attach all the connectors and the ground terminal screw.

Confirmation and adjustment:

- 1. Write voltage (K0160)
- 2. Read signal level (K0130, K0140)
- 3. Read and write skew (K0150)



Erase connector

Write FPC cable

Earth fitting screw

Read FPC cable

Fig. 1

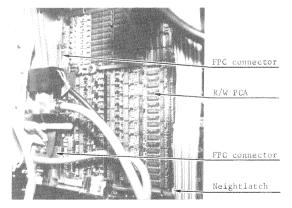


Fig. 2

L0040 | Replacement of Threading Channel

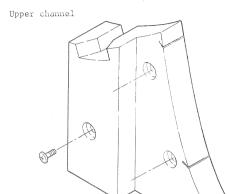
# Procedure:

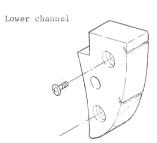
# [Removing]

- 1. Open both the column covers and threading covers.
- 2. Remove either three setscrews and upper channel or two setscrews and lower channel.

# [Mounting]

Place the upper or lower channel onto its positioning pin, and tighten screws. (Note: Use three screws for mounting upper channel, while use two screws for lower channel.)





L0050

Replacement of Tape Cleaner

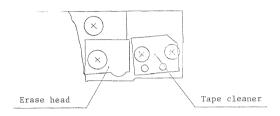
Procedure:

[Removing]

Remove two screws and tape cleaner.

[Mounting]

Place the tape cleaner onto its positioning pin, then tighten two screws.



L0060 Replacement of EOT/BOT Sensor

# Procedure:

# [Removing]

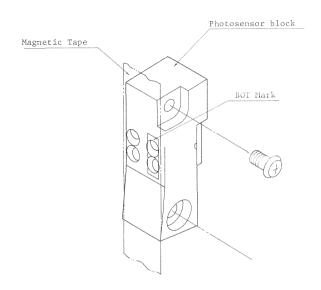
- 1. Pull out connector (CNJ54) from the photosensor-block.
- 2. Loose the two screws and remove the photosensor-block.

# [Mounting]

- 1. Place photosensor block onto its positioning pin, and tighten two
- 2. Insert the connector into photosensor block.

# Checkout:

Check and adjust the BOT and EOT detector circuits.



L0070-1 Replacement of Fix Upper and Lower Tape Guides (6250/1600 rpi MTU)

# Procedure:

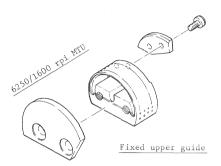
# [Removing]

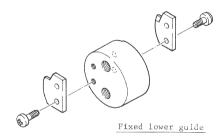
- 1. Remove two setscrews and the upper or lower guides.
- 2. Remove fixed flange from the guide.

# [Mounting]

Perform the reverse procedure above.

Fig. 1





L0070-2

Replacement of Moving Upper and Lower Tape Guides (1600/800 rpi MTU)

# Procedure:

# [Removing]

1. Remove two setscrews and the upper or lower guide.

Note: Each moving guide has a spring at its flange. Keep the spring when handling moving guides.

Remove moving flange from the guide by removing setscrew from the insulator.

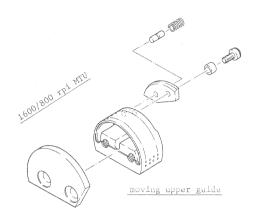
# [Mounting]

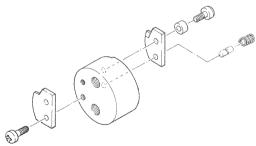
Perform the reverse procedure above.

# Checkout:

Check to be sure that the assembled moving flange moves smoothly.

Fig. 1





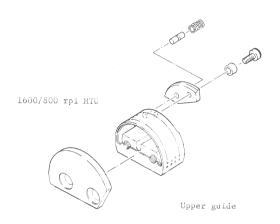
moving lower guide

L0070-3 Checking Guides

# Procedure:

- (1) Remove upper and lower channels, and clean upper and lower guides and around of them. (See Manual Sheet L0070-2 for cleaning
- (2) Check for scratches or grooves due to wear on the guide face and
- (3) Replace damaged parts (L0070-2).

Fig.



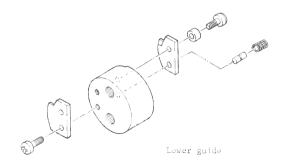


Fig. 1

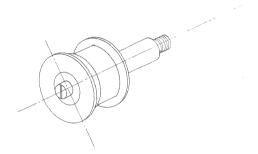
Procedure:

[Removing]

Insert the flat-blade screwdriver into the slit of roller guide and rotate it counterclockwise.

[Mounting]

Insert and rotate the flat-blade screwdriver to tighten the roller guide.



L0110 Replacement of Auto Cleaner

Procedure:

# [Removing]

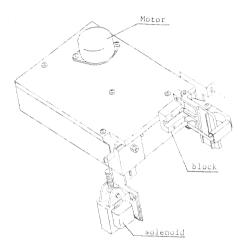
- 1. Remove two setscrews.
- 2. Remove auto cleaner.

Note: Do not contact auto cleaner to the head when removing it.

# [Mounting]

- Place auto cleaner onto its positioning pin at the rear of block, and push down the cleaner until it reaches block.
- 2. Tighten two setscrews.

Fig. 1



#### Procedure:

### (Removing)

- 1. Disconnect connectors CNJ51 and CNP82.
- 2. Loosen the nut of spring section and remove both vasher and spring.
- 3. Carefully take out the motor. Note: Take care not to damage the capstan roller.
- 4. Remove the tube or hose.

# (Mounting)

- 1. Connect the tube to the air suction pipe. (incase of 200ips MTU)
- 2. Mount the motor onto the shaft of spring section and insert the motor until it atops at the bolt.

Note: Take care not to damage the capstan roller

- 3. Mount the spring and whasher, and then tighten the nut 9 to 9-1/2turns to compress the spring from its free length.
- 4. Connect connectors CNJ51 and CNP82.

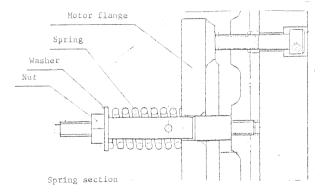
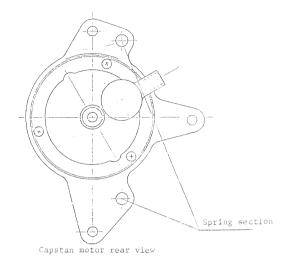


Fig. 2

# Fig. 1



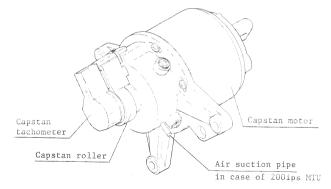


Fig. 3

L0130-2

Replacement of Capstan Motor

(2)

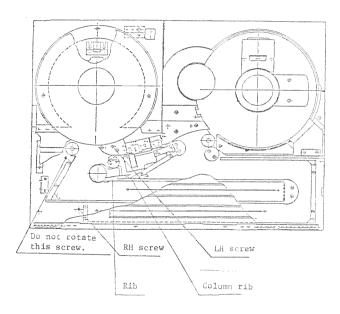
### Precautions:

- Perform alignment adjustment whenever the capstan motor has been replaced.
- Use a tape in good order (do not use a worn tape) and being 12.63 to 12.65 mm wide.
- Mount against the rib onto column rib so that the largest clearance is obtained between capstan and rib (XO18A).
- 4. If the adjusting screw is required to be rotated two turns or more, take care the clearance between capstan, rib and casting face, or the capstan may be damaged.
- 5. During adjustment, check for the correct tape speed.

### Adjustment Procedure:

- Load the tape and set column-in, then remove the threading cover and lower channel.
- Remove the front flange of lower tape guide, and mount the tape guide.
- Feed the tape in FWD (Cont) mode, and adjust the adjusting LH screw so that the front edge of tape is just at the edge of tape guide.
- Select the REW (Cont) mode, and adjust the adjusting RH screw so that the front edge of tape is just at the edge of tape guide.
- Repeat an item 3 and 4 until the front and rear of tape does not move when switch over FWD (Cont) and REW (Cont) modes.

Fig. 4



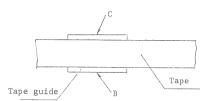
L0130-3 Replacement of Capstan Motor (3)
------------------------------------------

6. After the adjustment above, rotate both the RH and LH adjusting screws clockwise. When the tape is in FWD (Cont) or REW (Cont) mode, the surface guide of its portions B and C must slightly be observed (for type A), or the surface guide of portion B must slightly be observed (for type E).

Note: An excessive tape edge shaking in the transverse direction requires to perform the adjustment again.

7. Remove the tape and mount all the remaining parts.

Fig. 5



L0130-4	Electrical	Check	of	Capstan	Motor	(1)

- I Check of Capstan Starting Time/Stop Time (Normal mode)
  - In the servomechanism-on state(means tape loaded), set command code \$EO with a field tester to put the unit in Normal mode.
  - 2. Set command code \$30 and perform Forward Start/Stop operation.
  - Trigger the leading edge of signal CAPGO (at 1AO5 AAV), and then check that the time T shown in Fig. 1 satisfies the specifications in Table 1.
  - 4. Check the time Ts shown in Fig. 2 satisfies the specifications in Table 2.
  - Set command code \$6A and perform the Backward Start/Stop operation, and then check the time T, Ts in the same manner as above.

Table I Specification of starting time T

	Running direction		Check		
K		75 ips MTU	125 ips MTU	200 ips MTU	position
	FWD	1.50 ∿ 2.00 ms	0.70 ∿ 1.10 ms	0.70 ∿ 1.10 ms	DAC (1A04
	BWD	1.80 ~ 2.70 ms	0.90 ∿ 1.25 ms	0.80 ∿ 1.20 ms	ADV)

Table 2 Specification of stop time Ts

-	Model	Stop time Ts (FWD/BWD)	Vps	Check position
	75 ips	2.15 ± 0.2 ms	Max. 1.0 V	DAC
	125 ips	1.30 ± 0.2 ms	Max. 1.7 V	(IAO4 ADV)
	200 ips	1.20 ± 0.3 ms	Max. 1.7 V	

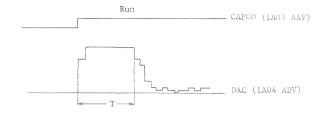


Fig. 1 DAC output

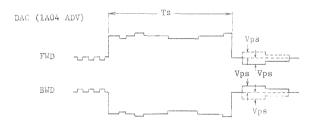


Fig. 2 DAC output

# L0130-5 Electrical Check of Capstan Motor (2)

- II Check of Capstan Starting Time/Stop Time (Streaming mode)
  - Set command code \$E4 with a field tester and put the unit in the Streaming mode.
  - 2. Set command code \$25 and perform the Forward Start and Stop operation. (See Fig. 3.)
  - 3. Trigger the leading edge of signal ACT (at 1A05 BE7), and then check that the time Tst and Tsp shown in Fig. 3 or Fig. 4 satisfies the specification in Table 3.
  - When it is in Streaming mode, the start and stop time can be measured by moving the tape in forward or backward direction.
    - The Backward Start/Stop operation is performed by command code \$65. (See Fig. 4.)

Table 3 Specification of starting time Tst and stop time Tsp

Model	Direction	Tst	Tsp	Vco
125 ips	FWD	2.8 ∿ 3.9 ms	1.3 ± 0.2 ms	±1.7 V
	BWD	2.4 ∿ 3.6 ms		or less
200 ips	FWD	1.4 ∿ 1.9 ms	2.5 ± 0.2 ms	±1.7 V or less
	BWD	1.3 ∿ 1.8 ms		ii./ V of less

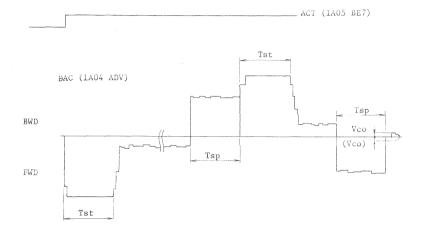


Fig. 3 DAC output (Forward Start/Stop)

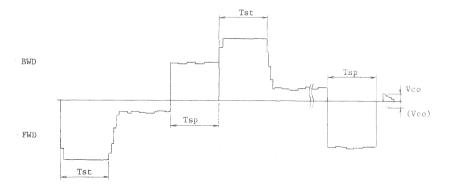


Fig. 4 DAC output (Backward Start/Stop)

Replacement of Threading Chute and Restraint Member

# Procedure:

# [Removing]

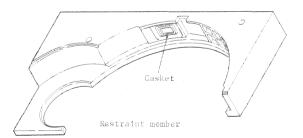
Remove three threading chute mounting screws and four restraint member mounting screws.

# [Mounting]

Mount the separated threading chute and restraint member onto their positioning pins.

### Checkout:

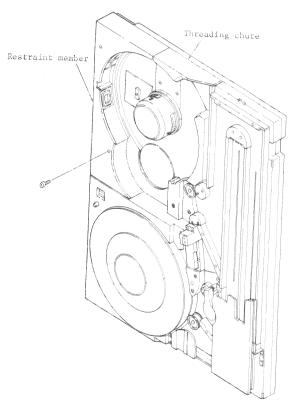
Press the gasket of the restraint-member with a finger, release it, and confirm that gasket is restored to the original shape.





Threading chute

Fig. 1



L0150 Replacement of Cartridge Opener

# Procedure:

# [Removing]

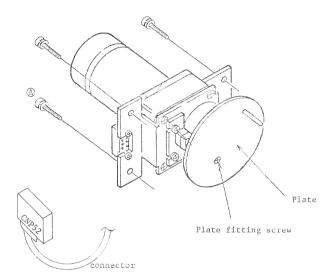
- 1. Remove the plate fitting screw, and remove the plate.
- 2. Open the rear plate and detach the connector [CNP52].
- 3. Remove the three screws  $ext{ } ext{ }$

# [Mounting]

- 1. Secure the cartridge opener on the casting panel with three screws  $\,\, \, \! \big( \! \! \big) \,$
- 2. Insert the connector [CNP52].
- 3. Fit the plate with the plate fitting screw.

Fig. 1

# Cartridge opener



L0160 Replacement of Error Marker

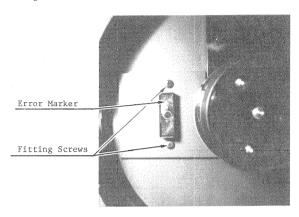
# Removal:

Open the rear door, detach the connector CNP53 above the file reel motor, remove the two error marker fitting screws, and remove the error marker.

### Mounting:

Carry out the above procedures in the reverse sequence.

Fig. 1



### L0170

Replacement of File Protection and Microswitch

### Removal the file protection:

- 1. Remove the two fitting screws that are securing the file protection on the panel. (Fig. 1)  $\,$
- Pull out the whole file protection, and remove the air tube and microswitch. (Fig. 2)
- 3. Disconnect the microswitch lead wires.

# Mounting of the file protection:

- 1. Remove the fitting metal assembly with microswitch from the file protection. Note: Do not detach the microswitch from the fitting metal.
- 2. Connect the lead wires to the microswitch.
- 3. Screw the fitting metal assembly with microswitch onto the file protection.
- 4. Insert the air tube.
- 5. Screw the file protection to the panel.

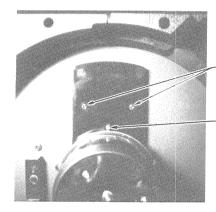
### Removal of the microswitch:

Carry out the same procedure as above "Removal of the file protection".

### Mounting of the microswitch:

- 1. Connect the lead wires to the microswitch.
- 2. Mount the microswitch on the file protection, inserting vanish glass cloth into between the microswitch and metal fitting.
- 3. Insert the air tube.
- 4. Screw the file protection to the panel.
- Check and adjustment Check and adjust the file protection mechanism (refer to KO260).

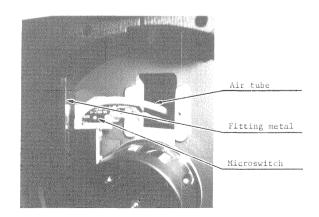
(Fig. 1)



Fitting screws

File protection

(Fig. 2)



L0180

Replacement of Auto-hub and Reel Boss

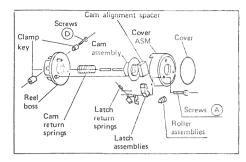
#### Removal:

- 1. Peel off the cover.
- 2. Insert the cam alignment spacer (B960-0110-X085A, thickness 6.5mm) between th cover assembly and the cam.
- 3. Loosen the screws B , and remove the rear cover.
- 4. Loosen the screw © , and remove the clamping.
- 5. Remove the rear housing assembly.
- 6. Remove the bushing.
- Loosen the three screws (A), and remove the cover assembly.
   When removing these screws, be sure to keep the cover assembly pressed lest it should jump out by the force of the cam return spring.
- 8. Pull out the cam assembly and cam return spring.
- 9. Pull our the latch assemblies together with the latch return spring and roller assemblies, from the pins. (Refer to LO200 Latch assembly)
- 10. Loosen the screw D , and remove the reel boss from the motor shaft.

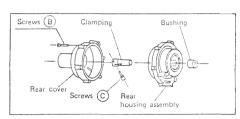
### Mounting:

- 1. Mount the reel boss to the reel motor shaft using a clamp key, and adjust the reel boss position as shown in Fig. 3.
- Mount the roller assemblies and latch assemblies to the reel boss pins and then mount latch return spring. (Refer to L0200 Latch assembly).
- Mount the cam assembly and cam return spring so that the three notches of the cam assembly are aligned with the pin positions.
- 4. While pressing the cover assembly with hand, screw the three cup fitting screws  $\textcircled{\mathbb{A}}$  into the reel boss pin.
- 5. Insert the cam alignment spacer between the cover assembly and the cam.
- 6. Put the bushing on the reel motor shaft.
- 7. Mount the rear housing assembly so that the bushing is inserted into the bearing of the rear housing assembly. At this time, the housing assembly should be oriented so that the stopper screw on the rear side of the file reel (see Fig. 2 in LO220) may be inserted into the screw hole on the housing.
- 8. Insert the clamping into the rear housing assembly, and push the clamping so as to hit the bushing. Then, fasten the screw  ${\Bbb C}$  .
- 9. Place the rear cover, and secure it with the screws B .
- 10. Take out the cam alignment spacer.
- 11. Stick a new cover.

(Fig. 1)



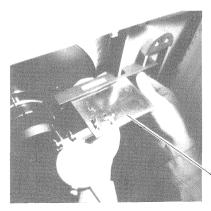
(Fig. 2)



(Fig. 3)

### Adjusting method

- 1. Remove the threading chute.
- Set the short pointer of dial gauge 4mm to 6mm and adjust the long hand of dial gauge 0.79mm on the main column surface.
- Fit the adjustment tool on the column surface.
- 4. Adjust the reel boss position so that the distance between the column surface and the rubber ring on the reel boss surface is 2.79±0.05mm, then the long pointer of dial gauge indicates 0±0.05mm.



Adjustment Tool (B960-0110-T015A) or (B960-0110-T030A)

Note: B960-0110-T015A; for checking B960-0110-T030A; for adjusting L0190 Replacement of Cover Assembly

Removal:

Peel off the cover, and remove the screws  $\widehat{A}$ . (Fig. 1)

Mounting:

1. While pressing the cover assembly, screw the three screws  $\widehat{\mathbb{A}}$  into the reel boss pin.

2. Stick a new cover.

L0200 Replacement of Latch Assembly

Removal of the latch assembly:

- 1. Peel off the cover, loosen the screws  $\widehat{\mathbb{A}}$  , and remove the cover assembly. (Fig. 1)
- From the reel boss pin, remove the latch assembly together with the latch return spring and roller assemblies.

Take sufficient care not to lose the latch return springs. (Fig. 2)

Mounting of the latch assemblies:

- 1. Mount the latches and roller assemblies and then mount latch return springs. (Fig. 2)  $\,$
- 2. Mount the cover assembly (Refer to L0190).
- 3. Stick a new cover.

L0210-1 Cam Assembly Exchange (1)

Removal of cam assembly:

- 1. Peel off the cover.
- 2. Insert the cam alignment spacer between the cover assembly and the cam. Fig. 1, page 10210-2
- 3. Loosen the screws  $(\widehat{A})$ , and remove the rear cover.
- 4. Remove the screw (B), and remove the clamping.
- 5. While pressing the cover assembly, loosen the screws  $\hat{\mathbb{C}}$ , remove the cover assembly, and pull out the cam assembly. Fig. 2, page LO210-2

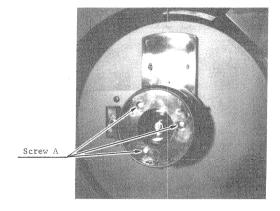


Fig. 1 (Cover is removed)

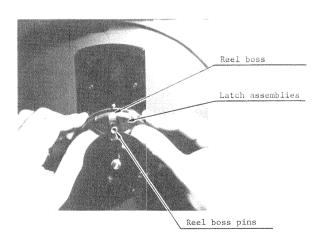


Fig. 2 (Cam assembly is removed)

L0210-2 Cam Assembly Exchange (2)

Mounting of the cam assembly:

- 1. Set the cam return spring on the cam assembly, and insert the cam shaft through the bushing and clamping (Fig. 1, Fig. 2).
- 3. Insert the cam alignment spacer between the cover assembly and the cam.
- 4. Push the clamping till the clamping hits the bushing, secure the clamping by fastening the screw  $\widehat{\mathbb{B}}$ .
- 5. Place the rear cover, and secure it with the screws  $\widehat{A}$ .
- 6. Remove the cam alignment spajer between the cover assembly and the cam.
- 7. Stick a new cover.

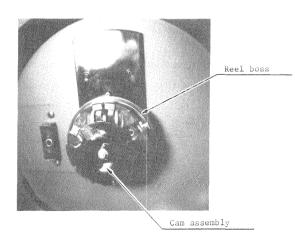


Fig. 3

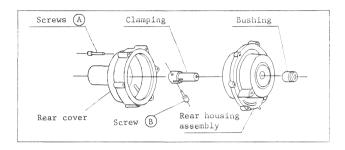


Fig. 1

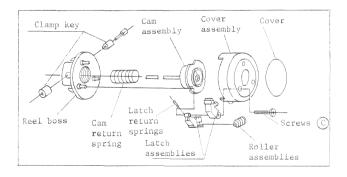


Fig. 2

L0220 Replacement of Rear Housing Assembly

# Removal (Fig. 1)

- 1. Peel off the cover.
- 2. Insert the cam alignment spacer between the cover assembly and the cam.
- 3. Loosen the screws  $(\widehat{A})$ , and remove the rear cover.
- 4. Loosen the screw (B), and remove the clamping.
- 5. Remove the rear housing assembly.
- 6. Remove the bushing.

# Mounting (Fig. 1, Fig. 2)

- 1. Put the bushing on the reel motor shaft. (Fig. 1, Fig. 2)
- Mount the rear housing assembly so that bushing is inserted into the bearing of the housing.
  - Note: At this time, the housing should be oriented so that the stopper screw on the right of the reel motor may be inserted into the hole on the rear housing.
- 3. Insert the clamping into the rear bearing.
- 4. Push the clamping till clamping hits the bushing and then secure the clamping by fastening the screw  $\widehat{(B)}$ .
- 5. Place the rear cover, and secure it with the screws (A).
- 6. Stick a new cover.

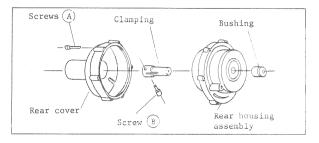


Fig. 1

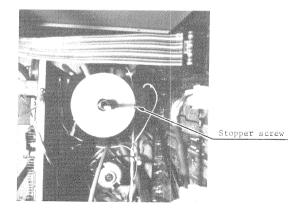


Fig. 2

L0230 Replacement of Machine Reel

Removal (see Fig. 1):

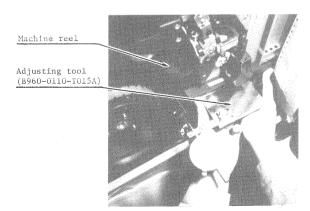
1. Remove the three screws (B) , and remove the machine reel.

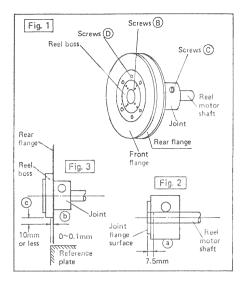
2. Loosen the screws (C) , and remove the joint from the reel motor shaft.

### Mounting:

- 1. Measure the distance between the joint flange surface and the tap of the reel motor shaft (a) in Fig. 2) with calipers. Adjust the distance to 7.5mm, and tentatively secure the joint with the screws  $\bigcirc$ .
- 2. Secure themmachine reel with the screws  $\widehat{\mbox{\sc B}}$  . Remove the screws  $\widehat{\mbox{\sc D}}$  and remove front flange.
- 3. At (c) in Fig. 3, adjust the distance between the rear flange and the reference plate (subcolumn) ((b) in Fig. 3) to from 0 to 0.1mm using the adjusting tool (B960-0110-T010A) shown in Fig. 4.
- 4. Finally secure the joint.
- 5. Mount the front flange.
- 6. Attachethe cover, and stick a new cover.

(Fig. 4)





### Adjusting method:

- 1. After steps 1 and 2 of "mounting", remove the left threading channel.
- Carry out zero adjustment of the adjusting tool on the main column surface. (Short pointer of dial gauge must indicate 4mm or 5mm).
- 3. Fit the adjusting tool on the reference plate, and hold it so that the dial gauge pin comes into contact with the rear flange at (c) in Fig. 3.
- 4. While manually rotating the machine reel, check whether the dial gauge reading including fluctuation is within the specified range.
- 5. Slightly pull out the whole assembled part prior to the adjustment, and adjust the distance (b) into the specified range by gradually pushing in the whole assembled part while measuring the distance.

L0250 Replacement of Low Tape Sensor

# Procedure:

# [Removing]

- 1. Remove three reel boss setscrews, and remove front disk plate, reel boss, and rear disk plate.
- 2. Remove two low tape sensor mounting screws and the low tape sensor.
- 3. Disconnect connector [CNJ56].

### [Mounting]

Perform the reverse procedure given above.

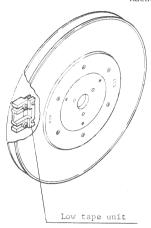
Note: When mounting the low tape sensor, hold down the sensor onto the casting base.

# Checkout:

Check the low tape detector level (seeK0220)

Fig. 1

Machine reel



L0260

Replacement of Machine Reel Motor, File Reel Motor

### Removal of file reel motor:

- 1. Remove the error marker. (Refer to L0160.)
- 2. Remove rear cover, clamping, rear housing assembly and bushing according to steps 1 to 6 of L0180.
- 3. Loosen the reel boss securing screw and pull out the auto-hub. (Refer to step 10 of Removal of L0180.)
- Detach the connector CNP87 from the connector CNJ86 of the tape drive circuit (TVBMU at the middle portion of the right side).
- 5. Remove the four screws  $\widehat{(A)}$  , and remove the motor.

#### Mounting of the file reel motor

- 1. Remove the air inlet pipe from the edge on the motor flange. (200 ips MTU only)
- Mount the reel motor so that the lead wires and stopper screw may be oriented as shown in Fig. 1 when looked at from the reel motor rear side.
- 3. Fasten the four screws (A) , and attach the connector CNP86.
- 4. Mount the auto-hub by following the step 1 of Mounting of L0180.
- Mount bushing, rear housing assembly, clamping, rear cover, and cover according to steps 6 to 11 of Mounting of L0180.

#### Removal of the machine reel motor

- 1. Remove the machine reel. (Refer to L0230.)
- Detach the connector CNP88 from the tape drive circuit (TVEMU at the middle portion of the right side).
- 3. Remove the four screws (B), and remove the motor.

# Mounting the machine reel motor:

- 1. Mount the reel motor with its lead wires going out from its top, and faster the four screws B .
- 2. Mount the connector CNP88 to TVBMU.
- 3. Mount the machine reel. (Refer to L0230.)

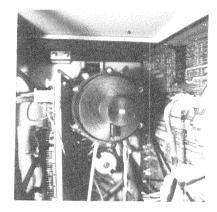


Fig. 1 (File reel motor)

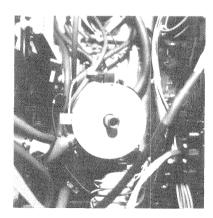


Fig. 2 (Machine reel motor)

# Procedure:

# [Removing Glass Plate]

- 1. Open the column cover and remove five glass plate (setscrews).
- 2. Remove the spring which holds the glass plate.

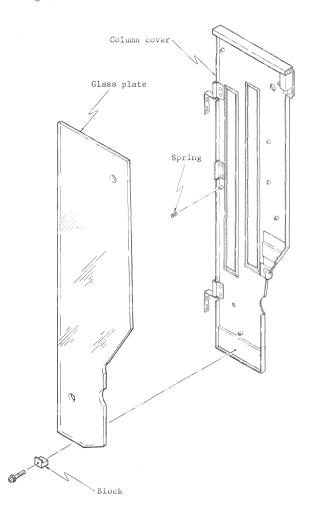
# [Mounting Glass Plate]

Place the spring between the column cover and glass plate, and tighten five glass plate mounting screws using screw blocks.

### Checkout:

Press the glass plate by your hand and (cheak) it moves smoothly and returns to its position.

Fig. 1



LO280 Replacement of Vacuum Column Section

Replacement of Roller Catch

### Removal:

Remove two Roller Catch's, which are fitted at the top and bottom left side of the column, by detaching the fitting bolts.

# Mounting:

Mount Roller Chath's with fitting bolts.

### Check and adjustment

When the cover is closed, check that the roller catch is firmly installed and that there is no gap between the column rib and the glass. If they are not satisfied, adjust them by the oval whole on the roller catch.

Fig. 1

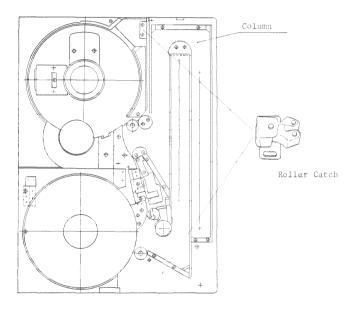


Fig. 1

LO300-1 Replacement of Micro Switch for Opening/Closing Slider

#### Removal:

- 1. Remove the cover of the front door.
- 2. Remove the micro switch to be replaced. Detach the lead from the terminal.

### Mounting:

Mount to micro switch by soldering its terminal and the lead at the proper position.

#### Check and adjustment

- 1. In the detecting status of the micro switch (Fig. 3), adjust the gap between the micro switch and the actuater to be from 0.33 mm to 0.55 mm by loosening two bolts of the fitting board.
  - Note: Before putting the micro switch in the detecting status. loosen the bolts of the fitting board to prevent the actuater part from being bent.
- 2. When the power supply is turned on and the door slider is opened and closed, check that the top of the slider touches the sponge If they are not satisfied, do the adjustment given above.

Note: When the micro switch is being adjusted, the power supply must be turned off.

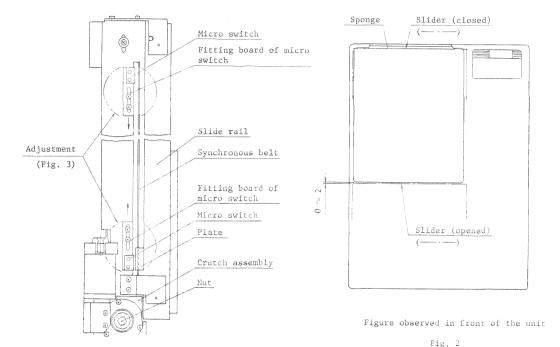


Fig. 1

Plate Check under the status shown that a thickness gauge of 0.33 mm can be inserted but 0.55 mm. Thickness gauge (Using 0.33 mm and 0.55 mm gauges)

Fig. 3

L0300-2

Replacement of Front Door Auto Window

### Procedure:

# [Removing]

- Open the front door, and remove six cover setscrews and covers.
- 2. Remove three slider setscrews.
- 3. Disconnect connector[CNP57].
- Remove three auto window setscrews and loosen one screw of it. Then slide to the left and remove the auto window.

# [Mounting]

- Mount the auto window onto the loosen screw and tighten the remaining four screws.
- Mount the slider and tighten three screws, and then connect connector [CNP57].
- 3. Mount covers and tighten six screws.

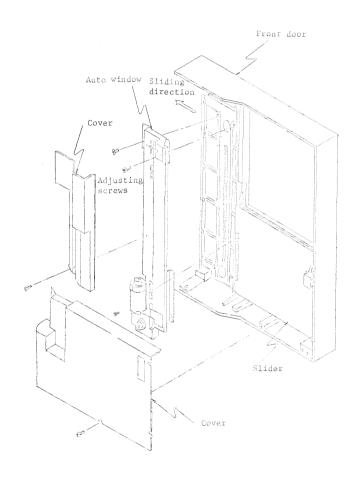
### CAUTION:

When mounting covers, do not place wires and cables between the cover and door,

### Checkout:

After assembling, check to be sure that the window operates correctly.

Fig. 1



L0310-1 Replacement of Front Door Clutch Section (1

# Procedure:

### [Removing]

- 1. Loosen hex socket screw of moving pulley to decrease belt tension.
- Remove the belt from the fixed pulley, then loosen hex socket screw and remove the fixed pulley.
- 3. Remove four microswitch setscrews.

Caution: Never remove or loosen any screws on the base plate, as they have been adjusted for proper positioning.

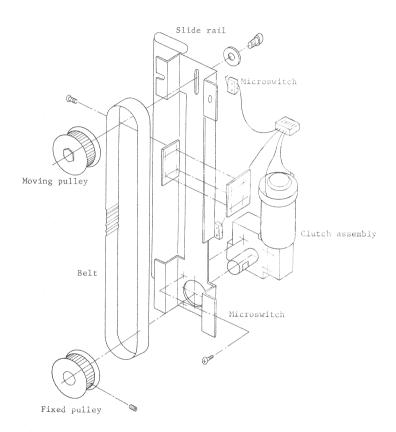
- 4. Remove cable clamping screws.
- 5. Remove four clutch ASM setscrews and the clutch section.
- When replacing the belt, remove four screws from the slide rail mounting plate and mounting plate. Then remove the belt.

### [Mounting]

Mount in sequence the clutch ASM, microswitch, fixed pulley, belt, and moving pulley.

Note: Mount the belt so that the belt is horizontal when it is held by pulleys.

Fig. 1



L0310-2 Replacement of Front Door Clutch Section

### Checkout:

- 1. Check that the belt tension is 0.11  $^{\circ}$  0.17 kg with deflection of 7.8 mm at position 242 mm away from the center of pulley.
- 2. Check that the mounting plate contacts in parallel to the microswitch.

### REPLACING SLIDE RAIL

# How To Replace Slide Rail:

# [Removing]

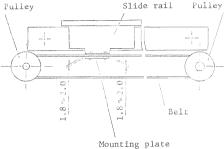
Remove two slide rail setscrews (flat-head screws) and the slide rail.

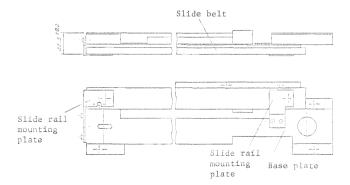
# [Mounting]

Mount the slide rail in position and tighten two screws.

Fig. 1







Replacement of Valve ASM Vacuum and Pressure

# Procedure:

# [Removing]

- Disconnect hoses, tubes and connector [CNP66] from the rear of Valve ASM Vacuum and Pressure.
- Remove Valve ASM Vacuum and Pressure setscrews (six screws of Valve ASM Vacuum and four of Valve ASM Pressure and the Valve ASM Vacuum and Pressure.

# [Mounting]

- Mount the Valve ASM Vacuum and Pressure (first, mount the Valve ASM Vacuum and then mount Valve ASM Pressure according to the center shaft).
- 2. Connect hoses, tubes and connector [CN66].

# Checkout:

Check for the correct air pressure and adjust it if needed. Refer to Manual Sheet KO190 for adjustment procedure.

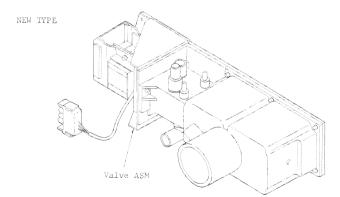
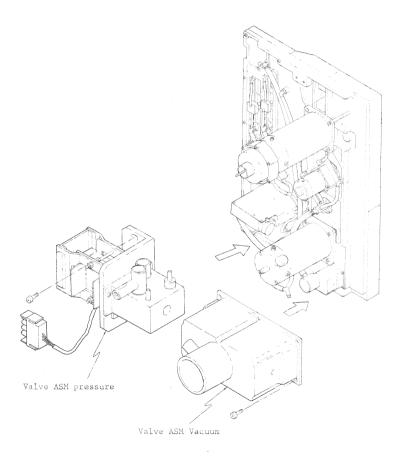


Fig.



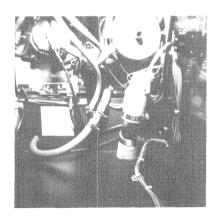
L0350 Replacement of Restrictor

# Removal and mounting:

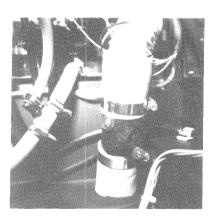
Loosen the hose bands at the both ends of the restrictor, and remove the restrictor. When attaching the restrictor, connect the hoses to the both ends, and fasten them with the hose bands.

# Check and adjustment:

Check and adjust the pressure and vacuum level .... K0190 (Pressure and Vacuum level check and adjustment during tape loading)







Restrictor

L0360-1

Replacement of Fans (1)

# Procedure:

(1) MTC and MTU gate fans

# [Removing]

- 1. Open the MTC front door and disconnect connectors from the fan.
- Remove four fan mounting screws and take out the fan with finger guard.

### [Mounting]

- 1. Mount the finger guard and fan onto the frame shelf and tighten four screws.
- 2. Connect all connectors.

# (2) Air supply cooling fan

# [Removing]

- Open the Front panel and internal doors by removing two screws, and then disconnect connector [CNJ42].
- Remove the filter and then remove four screws to remove the fan,

# [Mounting]

- Mount the fan in the frame and tighten four screws. Then mount the filter.
- Connect connector [CNJ42], close and fix the internal door by two screws, and close front door.

Fig. 1

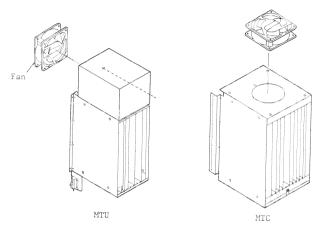
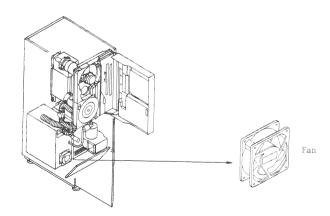


Fig. 2



# L0360-2 Replacement of Fans (2

# (3) Fan on rear door

# [Removing]

- 1. Disconnect connector [CNP46].
- 2. Loosen six nuts and remove the duct from the rear door.
- 3. Remove two setscrews and remove the fan from duct.

# [Mounting]

- 1. Mount the fam onto duct and tighten two screws.
- 2. Mount the duct onto rear door and tighten six duct (setscrews).
- 3. Connect connector [CNP46].

# (4) Fan unit

### [Removing]

- Open the cabinet front panel, and open internal door by removing two screws.
- 2. Disconnect connector [CNP43].
- 3. Remove two fan (setscrews) and fan unit.

# [Mounting]

- 1. Mount fan unit in the frame and tighten two screws.
- 2. Connect connector [CNP43].
- Glose and tighten internal door by two screws, and close front door.

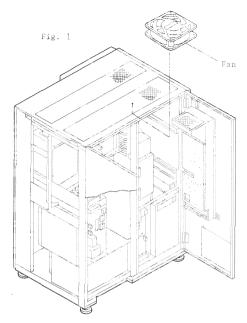
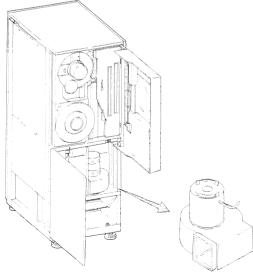


Fig. 2



Fan unit

L0370 Replacement of Cooling Air Filter

# Removal:

- 1. Open the front door and remove the filter.
- 2. Clean the filter with a cleaner.

# Mounting:

1. Set the filter on the guide rail and fit it at the proper position.

Fig. 1

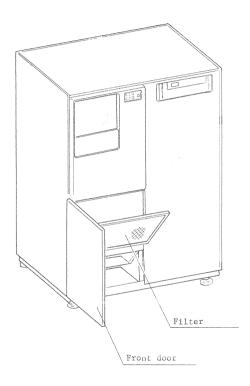


Fig. 1

L0380 Replacement of Absolute Filter

# [Removing]

- 1. Remove the joint, and remove the tube.
- 2. Remove the setscrew and remove the absolute filter.

# [Mounting]

- Mount the absolute filter and tighten the setscrew.
   CAUTION: When mounting the absolute filter, turn the hose tap below.
- 2. Connect the tube and connect the joint.

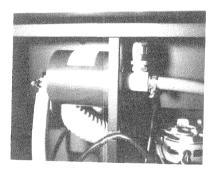


Fig. 1

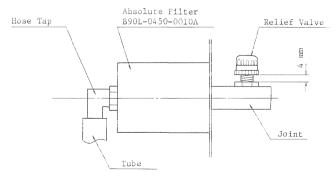


Fig. 2

L0400-1

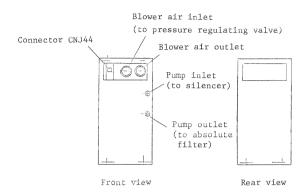
Replacement of Air Supply Unit (1)

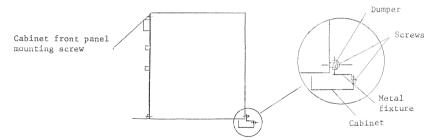
### Procedure:

# [Removing]

- 1. Remove the hose band of vacuum regulating valve.
- 2. Pull the hose from the blower exhaust duct.
- Loosen the tube band and disconnect the pump tube coming from the absolute filter.
- 4. Disconnect the silencer tube.
- 5. Open the rear door and remove two screws to remove air-supply mounting metal fittings. Remove two metal fittings mounting screws from the air supply, and then remove metal fittings including dumper rubber.
- 6. Disconnect power connector [CNP44] of air supply.
- Remove four air supply mounting screws located at the front of frame, and take out the air supply from the rear of frame.
- 8. Remove both the hose bands of blower inlet and outlet, then disconnect two hoses.

Fig. 1





Side view of air supply unit

L0400-2 Replacement of Air Supply Unit (2)

# [Mounting]

- 1. Connect two hoses to the blower and tighten the hose band.
- 2. Mount the air supply on the cabinet and tighten two cabinet front panel mounting screws.
- 3. Mount and tighten the metal fittings and rubber dumper at the rear of cabinet.
- 4. Connect connector [CNP44].
- 5. Connect silencer tube to the pump inlet.
- 6. Connect the tube (coming from absolute filter) to the pump outlet.
- 7. Place the hose of blower air outlet in the frame exhaust duct.
- 8. Connect the hose of blower inlet to the pressure regulating valve.
- 9. Follow the instructions of pressure regulation given on Manual Sheet KO190.

Fig. 2



Air supply

L0400-3

Replacement of Air Supply Belt

### Procedure:

# [Removing]

- I. Remove air supply unit.
- 2. Remove screws from the air supply belt cover.
- 3. Loosen blower/pump (setscrews), and remove the belt.

# [Mounting]

- Set the belt in position and tighten bolts with keeping an appropriate belt tension.
- 2. Mount air supply belt cover and tighten its screws.
- 3. Mount air supply unit.

# Setting Belt Tension:

Push a spring balancer against the belt at its center and adjust the belt tension to 29  $\sim$  34 lbs.

Caution: Do not push or pull the belt beyond the head of pulley.

Fig. 1

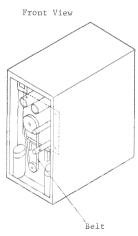
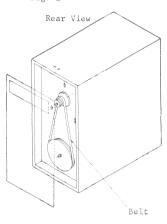


Fig. 2



# Procedure:

#### [Removing]

- 1. Open the column cover and threading cover.
- 2. Remove two setscrews from the upper hinge, and slightly pull up the threading cover and remove it.

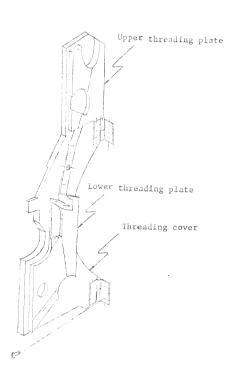
## [Mounting]

Place the lower hinge of threading cover in position, and then tighten two setscrews of upper hinge.

# Checkout:

Check to be sure that no interference occurs between the column cover and threading cover.

Fig. 1



# L0420

Replacement of Cartridge Sensor

# Procedure:

## [Removing]

- 1. Open the rear door, and remove two cartridge sensor setscrews and the cartridge sensor.
- 2. Remove three setscrews of microswitch leads and the leads.

# [Mounting]

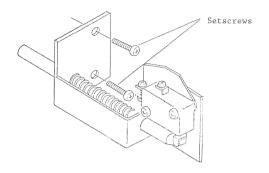
Perform the reverse procedure given above.

# Checkout:

Make sure that the cartridge detector rod can operate smoothly and return by the spring force.

# Fig. 1

# Cartridge sensor



Replacement of Capacitive Sensor

#### Procedure:

Note: Replace the sensor at the rear of system unit.

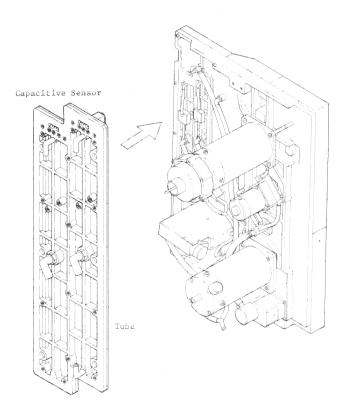
# [Removing]

- 1. Disconnect tube, connectors [CNJ55R and CNJ55L], and terminals SWP1 and SWP2 from the capacitive sensor.
- Remove six capacitive sensor mounting screws and the capacitive sensor.

# [Mounting]

- 1. Mount the capacitive sensor and tighten six screws.
- 2. Connect tube, connectors and terminals.

Fig.



Connector {CNJ55R CNJ55L

# Procedure:

# [Removing]

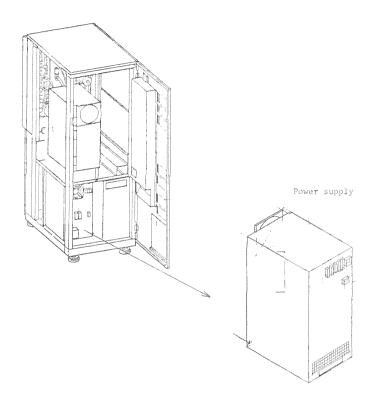
- 1. Disconnect all the connectors and terminals from the power supply.
- 2. Remove two screws and metal fittings, and take out the power supply.

# [Mounting]

- 1. Mount power supply in the frame and tighten two front screws. Then fix the metal fittings onto power supply and fix to the frame.
- 2. Connect terminals and connectors.

Caution: In case of 50 Hz connect CNP66 to CNJ66A, and CNP66C to CNJ66B.

> In case of 60 Hz connect CNP66 to CNJ66B. and CNP66C to CNJ66A.



L0450

Replacement of Operator Panel

# Procedure:

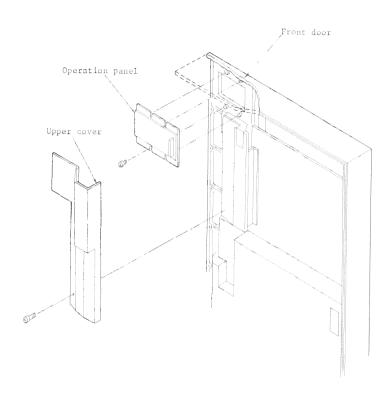
# [Removing]

- Open the front door, and remove two upper cover setscrews and the upper cover.
- 2. Disconnect connector [CNJ21].
- 3. Remove four operation panel (setscrews) and the panel.

# [Mounting]

Perform the reverse procedure above.

Fig. 1



L0460

Replacement of Door Switch

# Removal:

- 1. Detach three fitting bolts on the cover.
- 2. Detach the fasten terminals of door switch.
- 3. Remove the door switch by depressing it as shown at Fig. 1.

# Mounting:

- 1. Attach the fasten terminals with the door switch.
- 2. Mount the door switch at the box window of the cover.
- 3. Fasten the cover with three fitting bolts.

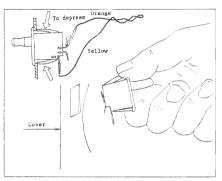


Fig. 1

LO470 Replacement of Rib

# Procedure:

# [Removing]

- 1. Remove rib mounting bolts and remove the rib from system panel.
- 2. Remove screws and metal fittings/flange.

# [Mounting]

- Mount the metal fittings/flange onto rib.
   Note: The metal fitting should not extrude from rib.
- 2. Mount the rib onto system panel using its bolts.

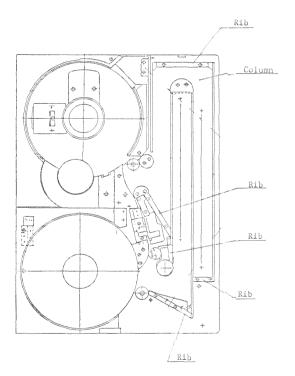


Fig. 1

M0000 Field Tester Operation

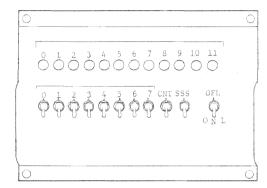
į				
-	1	View of Field Tester		M0001
	2	Field Tester Functions - 1		M0002
-	3	Field Tester Functions - 2		M0003
A BRANCHES OF	4	Field Tester Functions - 3		M0004
Security Sec	5	Field Tester Functions - 4		M0005
-	6	Field Tester Functions - 5		M0006
-	7	Field Tester Functions - 6		M0007
despitable (print)	8	Field Tester Functions - 7		M0008
September Street	9	Field Tester Functions - 8		M0009
NAME AND ADDRESS OF THE PERSON NAMED AND POST	10 11 12 13	Field Tester Functions - 9 Field Tester Functions -10 Field Tester Functions -11		M0010
-		Example of Field Tester Opera		M0100
	14	Example of Field Tester Opera		M0110
in land women on	15	Example of Field Tester Opera	ation (Interface Signal Display)	M0120
The second of the second of the second	16	Example of Field Tester Opera	ation (Microprogram Address Display)	M0130
-	17	Example of Field Tester Opera	ation (Register Write)	M0140
Contract Con	18	Example of Field Tester Opera	ation (CS Parity Scan)	M0150
<b>PRINCIPALITY</b>	19	Example of Field Tester Opera	ation (Address Compare)	M0160
Fernandon and American American	20	Example of Field Tester Opera	ation (Command Execution in the offline status of the MTC)	M0170
PARTICIPATION OF THE PARTICIPA	21	Example of Field Tester Opera	ation (Unit-Check Parameter)	M0171
	22	Example of Field Tester Opera	ation (Unit-Exception Parameter)	M0172
- Otto-service	23	Example of Field Tester Opera	ation (TU SCAN)	M0173
<b>Material International</b>	24	Example of Field Tester Opera	ation (Go-Down-Time Parameter)	M0174
distantantia.	25	Example of Field Tester Opera	ation (TEST MTC)	M0175
<b>Ministratory</b>				
Melitelaninima				

# MTU field tester operation

1.	Usage of Field Tester with MTU	M1000
2.	Field Tester Function (1)	M1001
3.	Field Tester Function (2)	M1002
4.	Field Tester Function (3)	M1003
5.	Field Tester Function (4)	M1004
6.	Field Tester Function (5)	M1005

M0001 View of Field Tester

Field Tester of MTC



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- The switch and lamp arrangement of the field tester is shown on M0001, and their various functions are explained below.
  - 1. OFL/ONL (two-position toggle switch)

OF

ONL

This switch is used to change the MTC between the online and offline states. When it is switched, the MTC executes System Reset.

2. S0-S7 (two-position toggle switch)



These switches are used to set the register address, command, byte count or start/stop address to be displayed and provide control information such as a command/microprogram control.

3. CNT (two-position momentary toggle switch)

CNT

9

This nonlock-type switch is used to set the various control modes of the Field Tester. This is also used to display the contents of the internal register.

4. SSS (two-position momentary toggle switch)

SSS



This nonlock-type switch is used to set the data necessary to control the internal register, to start a command excution, and to step the microprogram for various control functions provided on the Field Tester.

5. LO-L11 (LAMPS)



These lamps are used to display the data of various display functions explained later. They are active when lit.

Field Tester Functions - 2

## 2. Display Functions

This section explains the various display functions equipped in the Field Tester. They are valid in both online and offline states of the MTC.

2.1 Display of Channel Interface Signals and Associated Signals

If switches 50 - 57 are set to  $X'80'^{1)}$ , signals shown below are displayed on lamps L0 - L11.

Note 1: X'80' means that 80 in the hexadecimal notation is to be set. Switches are '1' when they are at "ON" (upwards in Fig. 1) and are '0' at "OFF" (downwards in Fig. 1).

LAMP LO-L11 | SLIG | OPI | DXFO | RQIA | RTA | DXRQ | MCY | B1600 | ERRF | ACMP | PHLT | PERR

SLIG: SELECT-IN-GATE Signal

When this signal is active (LO lit), it indicates that the controller is selected from the channel.

OPI; OPERATIONAL-IN Signal

When this signal is active (L1 lit), it indicates that the controller is connected to the channel and is in communication.

DXFO; DATA-TRANSFER-OUT Signal

This signal indicates the data transfer direction between the channel and controller. When this signal is active (L2 lit), it means data is transferred from the channel to the controller (WRITE OPERATION).

RQIA; REQUEST-IN-A Signal

This signal is active (L3 lit), when the controller requests an interrupt at Channel-A interface side.

RTA; ROUTE-A Signal

This signal is active (L4 lit), when the controller is logically connected to Channel-A interface side.

DXRQ: DATA-TRANSFER-REQUEST Signal

This signal is active  $(1.5\ \text{lit})$ , when the controller is ready to transfer data to the channel.

MCY: MACHINE-CYCLE Signal

This signal is active (L6 lit), when the controller is controlling the MTU to execute a command.

B1600; 1600 BPI Signal

This signal is active (L7 lit), when the controller is in the  $1600\ \mathrm{BPI}\ \mathrm{mode}$ .

ERRF: ERROR FLAG Signal

ACMP:

This lamp informs operators of an error detected by the microprogram when the controller is offline. This lamp lights when some error is detected during the execution.

ADDRESS COMPARE Signal

This signal is active (L9 lit), if a microprogram has passed the address specified by the SAD Register explained later. This signal can be reset by pressing the SSS switch.

PHLT; PROCESSOR HALT Signal

This signal is active (L10 lit), when the microprocessor is at HALT status.

PERR; PROCESSOR ERROR Signal

This signal is active (L11 lit), if some error is detected within the hardware organizing the microprocessor.

M0004 | Field Tester Functions - 3

2.2 Display of Microprogram Registers (Register display)

If switch 0 is set to '0', the contents of any of the microprogram register whose address is specified by switches  $\mathrm{S1}$  -  $\mathrm{S7}$  is displayed on lamps  $\mathrm{L0}$  -  $\mathrm{L7}$ . Although the latest register contents is displayed if the microprogram is pausing, the microprograms is interpupted at the following timings and the contents at that moment is displayed while it is running:

- o When the CNT switch is ON.
- o If the microprogram passes the stop address specified by the SAD Register when executing the Address Compare Display operation.

 SWITCH S0-S7
 S0 S1 S2 S3 S4 S5 S6 S7

 SWITCH S0-S7
 0 RA0 RA1 RA2 RA3 RA4 RA5 RA6

Sets the register address to be displayed

	LO	L1	L2	L3	L4	L5	L6	L7	L8	L9	L10	L11
-	REG0	REG1	REG2	REG3	REG4	REG5	REG6	REG7				

Display register contents

2.3 Display of Stop Address

If switches SO - S7 are set to X'Al', the contents of the SAD Register is displayed on LO - Lll.

Switch	S0	S1	52	S3	S4	S5	S6	S7
Setting	1	0	1	0	0	0	0	1
			Α				1	

2.4 Display of Branch Address

If switches SO - S7 are set to X'A2', the contents of the upper 4 bits of the branch address is displayed on LO - L3.

Register Write Data 0 - 7 is displayed on L4 - L11.

Swi	tch	s0	S1	S2	s3	S4	S5	S6	s7
Set	ting	1	0	1	0	0	0	1	0
			Α					2	

## 2.5 Display of Microprogram Address

If switches S0 - S7 are set to X'A4', the contents of the microprogram address (CAD 0 - 11) is displayed on L0 - L11.

Switch	S0	·S1	S2	s3	S4	S5	S6	S7
Setting	L	0	1.	0	0	1	0	0
<u> </u>		A				2	ì	

# 2.6 Display of Address Compare Control Flag

If switches SO - S3 are set to  $X^{\dagger}C^{\dagger}$ , the status of the Address Compare Control Flag is displayed on L4 - L7.

Switch	S0	S1	S2	S3	S4	S5	S 6	S7	
Setting	1	1	0	0	Х	Х	Х	Х	
							Х:	Don't	care
Lamp	LO	Ll	L2	L3	L4	L	.5	L6	L7
Indication	1	1	0	0	S.DAC	В.2	ADC	I.ADC	W.AD



M0005 Field Tester Functions - 4

# 2.7 Display of Microprogram Control Flag

If switches S0 - S3 are set to  $X^{\dagger}E^{\dagger}$ , the status of the Microprogram Control flag is displayed on L4 - L7.

Switch	S0	S1	S2	S3	S4	S5	S6	57
Setting	1	L	1	0	X	Х	Х	X

Lamp		Ll	L2			L5	L6	L7
Indication	1	1.	1	0	STEP	ROSF	SINH	SPARE
			r			\		

SINH; ]

If switches SO - S3 are set to X'F', lamps LO - L11 light.

M0006 Field Tester Functions - 5

#### 3. Execution of Offline Command Operation

The Field Tester can let the controller execute channel commands. Operations of the Field Tester for this function are described here. These functions are valid when the controller is in offline mode.

#### 3.1 Write into the Microprogram Register

Using this function, any data can be written into any microprogram register.

(1) Setting the Register Write Mode

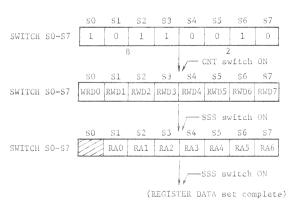
If switches SO - S7 are set to X'B2' and the CNT switch is ON, Register Write Mode is set.

(2) Setting of data to be written in the microprogram register

After setting to Register Write Mode, data to be written is set onto switches 80-87 and the SSS switch is made ON. Then by setting switches 80-87 to  $X^1A2^1$ , write data can be indicated on lamps 14-11.

(3) Write into the Microprogram Register

If S1 - S7 Register Address are set to SSS switch is ON.



- . RWDO-7 REGISTER WRITE DATAO-7
- . RAO-6 REGISTER ADDRESSO-6

#### 3.2 Setting the Command Code

Using the Register Write function (See 3.1), any desired Command Code can be written into the Command Register whose register address is X'3D'.

## 3.3 Setting the Device Address

Using the Register Write function (See 3.1), any desired Device Address can be written into the Device Address Register whose register address is X'3E'.

Three bits (BIT 5-7) of the register are used to set the device address in binary notations.

Bit O indicates SBCT to be mentioned later.

# 3.4 Setting the Byte Count

Using the Register Write function (See 3.1), any desired Byte Count can be written into the Byte Count Register whose register address is  $X^{\dagger}3F^{\dagger}$ .

The Byte Count value set by switches SO - S7 changes its weight depending on the bit O "SBCT" of the register whose address is X'3E'.

Weight of Byte Count Value

# 3.5 Setting the Command Parameter

Any desired parameter for offline command execution can be set with the Register Write function (See 3.1).

Bit assignments of the microprogram registers whose register address are X'3C' and X'3E' are as follows:

Field Tester Functions - 6

#### Command Parameters

Bit Reg. Name Address	0	I	2	3	4	5	6	7
Off-line Control X'3C'	U.STP	UC.RP	UX.STP	UX.RW	UX.RV	RPOS	REPET	TUSCAN
Off-line Device Address X'3E'	SBCT					DVAO	DVAl	DVA2

U.STP : UNIT CHECK, STOP

If Unit Check occurs during command execution, it stops after executing the command.

UC.RP; UNIT CHECK, REPOSITION

If Unit Check occurs during command execution, Repositioning is performed to retry the command after completing the command execution.

If UCK occures during write command execution, Back Space and Erase operation is automatically performed.

UX.STP; UNIT EXCEPTION, STOP

If Unit Exception occurs during command execution, it stops after executing the command.

UX.RW; UNIT EXCEPTION, REWIND

If Unit Exception occurs during command execution, Rewinding is done after completing the command execution.

UX.RV; UNIT EXCEPTION, REVERSE

This is valid for the Read and Read Backward commands. If a Tape mark is detected when executing a command, the Read Command whose tape running direction is reversed is executed.

RPOS : REPOSITION

After executing the command, it automatically repositions to process the same block again.

REPET ; REPEAT

The command is repeatedly generated as long as this bit is 'l'. However, it is not generated if SINN bit is true.

TUSCAN; TAPE UNIT SCAN

If this bit is active, the device address is incremented after executing each command. After that, when a restart is indicated, the command is executed on the device whose address is the incremented value. If execution is impossible, the device address is increased until a device on which the command can be executed appears: When the device address becomes '8', the device address after increment is '0'.

SBCT : SHORT BYTE COUNT

This determines the weights of bits of the Byte Count used in the offline command control. Refer to MAP M0006 "Set of Byte Count".

#### 3.6 Start of Command Execution

After performing the operations described in sections 3.2-3.5, if SINH bit (See 4.1) is at flase, a command is issued by the SSS switch in ON. If the SINH bit is true, a command is not issued by the SSS switch in ON.

A command is executed once unless "REPET" is specified. After that, each time the SSS switch is made ON, a command is executed once. The result can be monitored using the indication function shown in MAP MO003  $\sim$  MO005.

If "REPET" is specified, command execution starts when the SSS switch so set is "ON" and, next command is automatically issued without making the SSS switch ON. This is valid as long as "REPET" or SINH bit is specified.

"REPET" bit may be made OFF to stop issuing command.

Registers related to offline command execution are as follows: Detail information of these registers are described on MAP M0011.

Table 1

			Tab.	Le i				
Register Name	SDIAO	SDIAl	SDIA2	SD1A3	OFLCNT	OFLCMD	OFLDVA	BCT
Address	38	39	3A	3 B	3C	3D	3E	3F
bit 0	DMW/DMR		1	*	STP.UCK		SBCT	
1	MARG	INV	*MASK		RPS.UCK			BYTE
2	IPOST/XFR		track •Marginal Address	GDT lower	STP.UEX	CMD code	(RPSCY)	Count
3	GDT		or		REW.UEX		(REVCY)	
4	IPRE/MARA		*GDT Upper		REV.UEX		(OFSCY)	
5	SLWR	MASKP			RPS		OFDVAO	
6	MASK				REPEAT		OFDVA1	
7	TMTC		V	V	TUSCAN	Ÿ	OFDVA2	V

M0008 Field Tester Functions - 7

#### 4. Control of Microprogram

Pause, single step, and address comparison of microprogram can be executed from the Field Tester. These functions are explained in this section. Functions described in this section are valid regardless of the MTC condition (online or offline) and they are not reset when ONL/OFL is switched.

## 4.1 Specify/Release of Microprogram Control Function

After setting switches SO - S3 to  $X^{\dagger}E^{\dagger}$  and setting the necessary bits of switch S4 - S7, control functions of the microprogram are specified when the CNT switch is made ON, and the lamps of the corresponding bits between L4 - L7 light.

In order to release the specified control functions, set SO - SS to '1110' and the necessary bits of SA - SF to '0' and make the CNT switch ON.



STEP; Set to '1' to put the microprogram into the single step mode. Single step is executed with the SSS switch.

ROSF : READ ONLY STORAGE FUNCTION

While this bit is active, data is continuously read from the control ROM in the microprocessor and is parity checked.

When any parity error occurs, it stops at the address where 1 is added to the address where the error was detected.

SINH : START INHIBIT

When this bit is active, command issue in the offline mode is inhibited.

SP1: SPARE 1

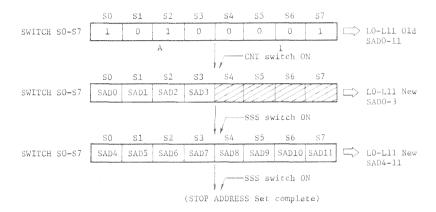
# 4.2 Setting the Stop Address

(1) Setting the Stop Address Mode

If switches SO - S7 are set to X'Al', the stop address at SADO - SADII is indicated on LO - L11 (See 2.3). To change the stop address, set switches SO - S7 to Stop Address Mode by making the CNT switch ON.

## (2) Setting the Stop Address

After setting to the Stop Address Mode, set the upper 4 bits of a stop address (SAD 0 - 3) on switches S0 - S3 and make the SSS switch ON. Also, set the lower 8 bits of the stop address (SAD 4 - 11) on switches S0 - S7 and make the SSS switch ON. The set stop address can be confirmed with the Stop Address Display function.



#### 4.3 Setting the Branch Address

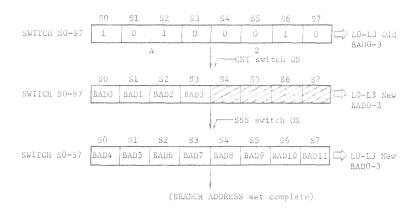
(1) Setting the Branch Address Mode

If the CNT switch is made ON with setting switches SO - S7 to  $\rm X'A2'$  , the Branch Address Mode is set to.

# (2) Setting the Branch Address

After setting to the Branch Address Mode, set the upper 4 bits of the branch address on switches 80-83 and make the SSS switch ON. The Branch Address of the upper 4 bits set can be confirmed with the Branch Address Display function (See 2.4). The lower 8 bits of the branch address are set by switches 80-87. (The Branch Address Register is provided only for the upper 4 bits.)





#### 4.4 Setting the Microprogram Address

When the microprogram is in the step mode, the microprogram can be branched to a certain address from the Field Tester by changing the contents of the CS address the Field Tester by changing the contents of the CS address register. After changing the CS address, if the program is single-stepped using the SSS switch, maintaining the step mode, the program is executed from the changed address. If the step mode is released, the microprogram starts from the changed address.

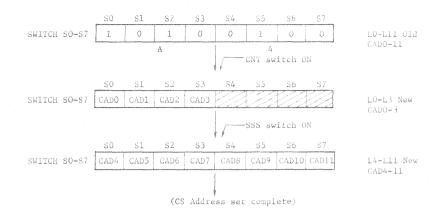
#### (1) Setting the Microprogram Address Mode

After setting the microprocessor into the Step Mode and setting switches SO - S7 to  $X^{T}A4^{T}$ , switches SO - S7 are set to the GS address mode by making the CNT switch ON.

#### (2) Setting the CS Address Register

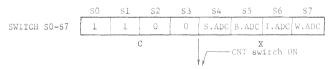
After setting Microprogram Address Mode, set the upper 4 bits of the CS address (CADO - 3) on switches SO - S3 and make the SSS switch ON. Further, set the lower 8 bits of the CS address on switches SO - S7 and make the SSS switch ON. Thus, the CS address is set into the CS address register.

The address set can be confirmed using the Microprogram Address Display function (See 2.5).



#### 4.5 Setting the Address Compare Control Flag

Set switches 80-83 to  $X^{\dagger}C^{\dagger}$  and set the desired Address Compare Control Flag on 84-87. Then, make the CNT switch ON.



(ADDRESS COMPARE CONTROL FLAG Set complete)

# S.ADC ; STOP, ADDRESS COMPARE

When the address of the microprogram coincides with the address specified by the Stop Address Register, it stops the microprogram.

#### B.ADC ; BRANCH, ADDRESS COMPARE

When the microprogram coincides with the address specified by the Stop Address Register, the microprogram is forced to branch to the address indicated by the Branch Address Register and SWO - SW7.

#### I.ADC ; INDICATE, ADDRESS COMPARE

When the microprogram coincides with the address specified by the Stop Address Register, the contents of the register whose address is specified by SWI-SW7 is displayed on LO-L7.

M0010 Field Tester Functions - 9

W.ADC ; WRITE, ADDRESS COMPARE

When the microprogram coincides with the address specified by the Stop Address Register, the contents of the RWD (Register Write Data) register is written into the register whose address is specified by SWI - SWV.

# 5. LAMP TEST/SYSTEM RESET

If switches S0 - S3 are set to '1', lamps L0 - L11 turn ON. Thus, System Reset is performed when the CNT switch is mode ON.

Note: Since System Reset causes Specify/Release of the Microprogram Control function (See 4.1) depending on conditions of S4 - S7, exercise care.

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M0011 | Field Tester Function - 10

- Offline command execution parameters -

See MAP MOOO7.

(1) SDIAO  ${\scriptstyle \circ}$  SDIA3 are the same as the 4 byte diagnostic flag specified in set diagnose command.

When MTC is in offline status, if diagnostic flag bytes are set directly in these registers (without executing the above commands), the specified diagnostic operation may be carried out by executing the command operation without chaining to SDIA command. The SDIA data once set, is not be altered till MTC is set to online status or system reset.

#### (2) Tape Unit Scan

When the OFLCNT register TUSCAN byte is set 'l', the OFLDVA register (OFDVAO 2 ) byte data) is advanced by +1. If repeat bit has also been set 'l', commands are issued serially to all MTU's.

#### (3) REPEAT

When OFLCNT register, REPEAT bit is reset  ${}^{1}O^{1}$ , a command is executed everytime the SSS switch is pressed.

Unless this bit is reset ('0'), (while REPEAT bit is '1'), the command activated by SSS switch is repeated continuously.

In this case all the functions specified by bits other than the REPEAT bit are valid.

## (4) Reposition

The following offline repositioning operation is carried out irrespective of the end status when the OFLCNT register RPS bit is set.

The commands and addresses entered in OFLCMD and OFDDVAO 2  remain unchanged even after offline repositioning operation.

Table 1 Offline Reposition

Commands set in OFLCMD register	Offline Reposition Operation
01 (Write)	Back space command is executed after a Write Command. However if TDBCK (ID Burst check) at sense byte 5 bit 3 or SAGC (byte8, bit4) is activated, Rewind Command will be executed instead of the Back Space Command.
02 (Read)	Back Space Command follows the Read Command. However, if NCAP (Not capable) has occurred, Rewind Command will be executed.
OC (Backward Read)	Space Command follows the Backward Read Command.
Other commands	No operation.

## (5) UEX Function

The following operation is executed when UEX bit is included in the END status by using combinations of STP, UEX, REW, UEX, REV.UEX in OFLCNTL register.

Table 2 UEX Functions

STP .UEX	REW .UEX	REV .UEX	UEX Function Description								
1	Х	X	Processing is looped within the offline service routine from the time UEX bit turned ON till STP.UEX bit is reset '0' or SINH is specified.								
0	0	0	No operation (UEX bit is not checked)								
0	0	1	When UEX bit is set 'l' the OFLCMD register command codes are replaced by Reverse Commands as follows:								
			Old OFLCMD → New OFLCMD  WT(01) → BRD(OC) RD(02) → "  BRD(OC) → RD(02) SP(37) → BSP(27) BSP(27) + SP(37) ERS(17) → BRD(OC) WTM(1F) → BSPF(2F) DSE(97) → BSPF(2F) NOP(03) → BRD(OC) Others → Not changed								
0	1	0	Rewind Command is issued when UEX bit is set ${}^{\dagger}1^{\dagger}$ .								
0	1	1	Rewinds MTU by issuing a rewind command when UEX bit is set ('l'). At this stage F617/F618 MTUs are reversed from Normal Speed to High Speed or from High Speed Mode to Normal Speed.								

M0012 Field Tester Function - 11

# (6) UCK Function

If UCK bit is included in End Status, the operations shown in the following table 5.13 are carried out. The operations are specified by combinations of STP.UCK, RPS.UCK bits. ERRF lamp is turned ON when the UCK bit is set '1' (Errors may be detected by checking this lamp).

Table 3

		,
STP .UCK	RPS .UCK	UCK Function Description
0	0	UCK bit is not checked.
0	1	The repositioning operation described in (4) is executed when the UCK bit is set '1'. Any errors in this operations are iquored (UCK).
1	0	Processing is looped within the offline service route from the time UCK bit is set 'l' till STP.UCK bit is reset or SINH is specified.
1	1	The repositioning operation in (4) is executed when the UCK bit is set. Any new errors (UCK) during repositioning operation are looped in the offline service routine till STP.UCK bit is reset '0' or SINH is specified.

# (7) SINH (Start Inhibit)

When SINH bit on the field tester is ON, commands from SSS switch are inhibited.

A loop created by STP.UCK or STP.UEX bits may be released by setting the SINH bit. (If SINH is turned OFF again, commands will be issued again (in case of REPEAT)).

Commands are temporarily inhibited if SINH bit is set (ON) when REPEAT has been specified. This fascilitates temporary stopping or starting of commands in manual mode.

Example of Field Tester Operation

Table 1 is a list of various functions of field tester operation.

Practical examples of field tester operation will be described in M0110 through M0200. The method of the description used in these examples will be explained below.

Expression X'0F' indicates that SO - S7 are to be set to a hexadecimal '0F', and expression X'0F' CNT indicates that after SO - S7 are set to '0F' and the switch CNT is turned on.

Similarly, expression X'3B' SSS indicates that SO - S7 are set to a hexadecimal '3B' and switch SSS is turned on.

Expression "ONL/OFL = ONL" indicates that the switch ONL/OFL of field tester is turned to the ONL position.

Accordingly, expression "ONL/OFL = OFL" in dicates that this switch is turned to the OFL position.

The practical examples given hereinafter are those considered effective for maintenance, which do out, however, encompass the examples explaining all the functions of field tester listed in Table 1.

RAO  $\sim$  RA6 : Register address SADO  $\sim$  SAA11: Stop address BADO  $\sim$  BAD11: Branch address

CAD  $^{\circ}$  CAD11 : CS (microprogram) address RWD  $^{\circ}$  RWD7 : Register write data

Table 1 A list of operational functions of field tester

Item				Swi	tch				Hex.	Set							Disp	lay					
r cem	SO	Sl	S2	s3	S4	85	S6	S7	code	key		L0	L1	L2	L3	L4	L5	L6	L7	L8	L9	1.10	Lll
1	0	KAO	RA1	RA2	RA3	RA4	RA5	RA6	00∿7F	CNT	Register display	REG 0	REG 1	REG 2	REG 3	REG 4	REG 5	REG 6	REG 7				
2	1	0	0	0	0	0	0	0	80		Interface signal display	SLIC	OPI	DXFO	RQIA	RTA	DXRQ	MCY	B1600	ERRF	ACMP	PHLT	PERR
3	1	0	1	0	0	0	0	. 1	Al		Stop address display												
	1	0	1	0	0	0	0	1	Al	CNT	Stop address mode	SAD		SAD	SAD	SAD	SAD		SAD	SAD	SAD	SAD	SAD
	SAD 0	SAD	SAD 2	SAD 3					XX	SSS	Set upper SAD	0	1	2	3	4	5	6	7	8	9	10	11
	SAD 4	SAD 5	SAD 6	SAD 7	SAD 8	SAD 9			XX	SSS	Set lower SAD												
4	1	0	1	0	0	. 0	1	0	A2		Branch address display												
	1	0	1	0	0	0	1	0	A2	CNT	Branch address mode	BAD	BAD	BAD	BAD	RWD	RWD	RWD	RWD	RWD	RWD	RWD	RWD
	BAD 0	BAD 1	BAD 2	BAD 3					XX	SSS	Set upper BAD	0	1	2	3	0	1	2	3	4	5	6	7
	BAD 4	BAD 5	BAD 6	BAD 7	BAD 8	BAD 9	BAD 10	BAD 11	XX		Set lower BAD												
5	1	0	1	0	0	1	0	. 0	Α4		CS address display												
	1	0	1	0	0	1	0	0	A4	CNT	CS address mode	CAD	CAD		CAD	CAD	CAD	CAD	CAD	CAD	CAD	CAD	CAD
	GAD 0	CAD	CAD 2	CAD 3					XX	SSS	Set upper CAD	0	1	2	3	4	5	6	7	8	9	10	11
	CAD 4	CAD 5	CAD 6	CAD 7	CAD 8		CAD 10	CAD	XX	SSS	Set lower CAD												
6	1	0	1	1	0	0	1	0	В2		Register write display												
	1	0	1	1	0	0	1	0	В2	CNT	Register write mode	BAD		BAD	BAD	RWD	RWD	RWD	RWD	RWD	RWD	RWD	RWD
	RWD 0	RWD	RWD 2	RWD 3	RWD 4	RWD 5	RWD 6	RWD 7	XX	SSS	Register write data	0	1	2	3	0	1	2	3	4	5	6	7
		RAO	RAI	RA2	RA3	RA4	RA5	RA6	XX	SSS	Register address												
7	1	1	0	0	S. ADC	B. ADC		W. ADC	CX	CNT	Address compare control & display	S0	Sl	5.2	S3	S. ADC	B. ADC	I. ADC	W. ADC				
8	1	1	1	0	STEF	ROSE	SINH	SP2	EX	CNT	MP cont <b>rol</b> RSL & display	S0	Sl	S2	S3	STEP	ROSF	SPl	SP2				
9	1	1	1	1					FX		Lamp test	1	1	1	1	1	1	1.	1	1	1	1.	1
10	1	1	1	1	STEP	ROSF	SINH	SP2	FX	CNT	System reset & MP control	1	1	1	1	1	1	1	1	1	1	1	1

- Address Compare Function -

S.ADC : Stop with address compare
B.ADC : Branch with address compare
I.ADC : Indicate address compare
W.ADC : Write register address compare

- Microprocessor Control Function -

STEP: Microprocessor step
ROSF: Read only strage function
SINH: Start inhibit

SP2 : Spare 2

Example of Field Tester Operation (Register Display)

#### Register Display

The microprocessor of the MTC aims at accomplishing a predetermined work through the control of 104-byte register (out of which 64 bytes are used for the RAM, (See MOILI,)

Using a field tester, the contents of these registers can be displayed at any time.

The procedure for display is to set the objective register address to  ${\rm SO}$  -  ${\rm S7}$  and turn on CNT switch.

If the microprocessor in the MTC is in the halt status¹⁾, what is to be done is only to set the register address to SO - S7 and the CNT switch does not have to be operated, so the operation is simpler.

Through this operation, the content of the register is displayed on L0 - L7.

Note 1: When the microprocessor in the MTC is set in the STEP status or when the microprocessor turns to the halt status by an address compare stop function, PHLT bit (the L10 to be used when SO - S7 are set to  $X^{\dagger}SO^{\dagger}$ .) lights.

Register display:

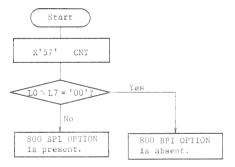
X'YY' CNT

YY: Register address

Example 1: Inspection of the Presence or Absence of 800 BPI OPTION

Whether the 800 BPI OPTION PCB is equipped can be ensured by observing whether the PCB of 512189 is inserted in column 1A01 of the MTC. To check whether the insertion of the PCB has been ensured by the microprocessor, it is intended to ensure it through register display

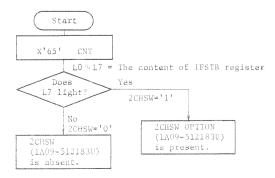
If a 800 BPI OPTION is present, the content of ZOP register (register address '57') can be one other than '00'. Now, let's display the content of register address 57.



Example 2: Inspection of the Presence or Absence of 2CH SWITCH OPTION

Similarly to the example 1 let's try to check 2CHSW

bit (Bit 7 of IFSTB register - address '65')



MO111 MTC Register Table

110111	1111	C Register	14016															
		0	1	1 2	3	4	5	6	7	8	9	A	В	C	D	E	F	
Nickn	ame	DVENQO	DVENOI		DVENQ3	DVEN04	DVENO5	DVENO6	DVENQ7	MODEM	SCANP	DSB	LCMD	DVSO	DVSI	DVS 3	DVS8	Nickname
LYLCEL	0	RSVAO		-27 4 23 ( 1 %)						1600A	CCF	(OST)	20110					0
	1	LENGA0	-							800A	INST	STM		7				1
		BENQAO	-							1600B	RMTU	CUE	LAST					2
			-							800B	WORK	BSY	COMMAND	-				3 0
0	3	SENQA0		E	inquiry m	nemory for	each Devic	9		CUBMA	WORK	CHE	CODE	- I	Device se	nse byte sta	ick	
	4	RSVBO	4								DVIIO	. Leave we		-{				4
	5	LENQBO	_							CUBMB	DVA0	DVE						5
	6	BENQBO									DVAL	UCK						<u> </u>
	7	SENQB0									DVA2	UEX						<del>  / _             _  </del>
Nickn		WO	WI	W2	W3	W4	W5	W6	W7	MCYENT	CMDSEQ	SUB0	SUB1	PDSB(Q0)	<u>Q1</u>	Y0	¥1	Nickname
	0																	0
	1																	1
	2																	2
	3				Tampoor	ry working	a manager and a second					Ctn	tic worki	ne wonich	are			$ \begin{array}{c c}  & 1 \\ \hline  & 2 \\ \hline  & 3 \\ \hline  & 4 \\ \hline  & 5 \\ \hline  & 6 \\ \hline  & 7 \end{array} $
7	4				rembors	ny worming	2 register					Jea	CIC WOIKE	116 1-5101	010			4 1
	5																	5
	6																	6
	7									1								7
Nickn	ame	SB0	SB1	SB2	SB3	SB4	: SB5	SB8	SB9	SB10	SB11	SB22	SB23	RO	. R1	CMD	DVA	Nickname
	0	CMJ	NOIS	ETO	VRC	MPHE		IBGD	102CR	STRJ	RWTO				·	1	i	0
	ī	IRO	TUSA	ETL	MLT/LRC		-	ET8	VLCG	CMRJ	MISP			:		Cmmand	Device	
	2	BOC	TUSB	ET2	SKW	TI	WTMC	1224	XFBC	CTRJ	TAGIC	-			<del> </del>	Code	Adrs	+ 2
	3			ET3	EDC/CRC		IDBC	EBRC	CRC3	NBLK	REGE	(FRU1)	(FRU2)	1	-	i		1 3
2		EQC	(TOVR)			WVAL	SRDC		(6250CU)	DVRS	DMPE	(4401)	(1104)	+	1	Stack	Stack	+ /- 2
	4	DCK	(BOT)	ET4	EVC	T 1 1 2 2		SAGC	(052000)		THE RESERVE OF THE PERSON NAMED IN COLUMN TWO	(550)	/ mm + 1		<u>.</u>	L	÷	5
	5	OVRN	(WRS)	ET5	1600	LWR	PREC	SBRC	-	TCSF	ROME	(E50)	(E51)	<del></del>	<del>!</del>	<b>.</b>		
	6	WCZ	(FP)	ET6	BWD	TUC	POSE	SERC		(SRJF)	·	ļ						- 6
	7	(SPND)	NCP	ET7	PCMP	(WCALM)	(WEOVF)	VLRY		VLCK	(TUROM)			A STATE OF THE	1 077 0170		L	1,/
Nickn		ERC0	ERC1	ERC2	ERC3	ERC4	ERC5	ERC6	ERC7	SDIA0	SDIA1	SDIA2	SDIA3	OFLCNT	OFLCMD	OFLDVA	BCT	Nickname
	0									DMW/DMR				UC.STP		SBCT	÷	0
	1									MARG	INV			UC.RP	OFFLINE	(DOMESTIC)	C. T. S. T. S.	<u> </u>
	2	-								IPVS/XFR	<u> </u>	Diagnos		UEX.STP	COMMAND	(RPSCY)	OFFLINE	4-4-
3	3		R	eserved	(not us	ed with F6	17/F618)			GDT		flag by	ce z, s	UEX.REW	CODE	(REVCY)	BYTE	3
	4				,					IPRE/MARA	ļ	stack		UEX.REV	-	(OFCY)	COUNT	4
	5									SLWR2	MSDKP			RPOS		OFLDVAO	·	5
	6									MASK				REPEAT	·	OFLDVA1	4	6
	7		epromoting.							TMTC	-			TUSCAN		OFLDVA2	<u> </u>	7
Nickn	name	TMCTL	TIMER	DVSEL	DVRSV	DVTAG	DVBO	DVBI	DVSNS	MASK	DACTL	WTCTL	RDCTL	MODE	RDSNS	CRCST	FMERR	Nickname
	0	MCT0	CT0/8	TAGI	RSV0	GO	DB00	DBIO	GAPC	MASKO	DMW	WTM	ROK	MCY	HNOIS	*MCRC	*SRDC	0
	1	MCT1	CT1/9	XCAL	RSV1	TAGVL	DBOl	DBI1	CPFWD	MASK1	DMR	IBW	STPHK	BWD	HBLK	*MCRCZ	*EDC	1
	2	CQTP	CT2/10	*DVENB	RSV2	TAGO(STS)	DB02	DBI2	MPXBO	MASK2	IHPRE	WEC	VFOS	WRS	HTM	*EP=CR	*SLIPC	2
4	3	ERRF	CT3/11	SLTAG	RSV3	TAG1(CTL)	DB03	DBI3	MTCS	MASK3	IHPOS	ALIWI	IHDXF	ERD	WIND	*B=D	*NOISC	<u> </u>
1 4	4	RCNT/SCNT	CT4/12	DVBSY	RSV4	DBMPX	DBO4	DB L4	VLOK	MASK4	INVLD	WOK	THCOR	6250	PHOK	*B=C	*WBOC	4 4
1	5	RGTRU/CTRU		DVA0	RSV5	TSP0	DBO5	DBI5	RVLC/VLC	MASK5	ALMSK	.0.	*HIG	1600	PREA	*MCRCC	*WVRC	5
	6		CT6/14	DVA1	RSV6	TSPL	BD06	DBI6	TCSG	MASK6	MASK	BFUL	ISPHE	CMCY	POSA	*A=B	*OVRN	6
	7	RQTP/DQTP	CT7/15	DVA2	RSV7	VHSP	DBO7	DBI7	TCSP	MASK7	MASK8	RBCY/BCY	SKWMG	CBR	EPOSA	*XBIC	*CMP	7
Nickr		TSNS	POINT	BLFMT	RDERR	ZETK	ZCTL	ZMRG	ZOP	TCADA	OUTAG	CHBO	IFSTA	INTAG	CHBI	IFCTL	XFCT1.	Nickname
1	0	*TSNSO	*DETO	*IORCR	*VRCE		SFCRC	*NVRCE	1		ADO	CBOO(RCTO)	CUBSA	OPI	CBIO	RRSA/OVR2	DXFI	
		*TSNSO *TSNS1 *TSNS2	*DET1	*DET8	*MLTE	ETKO ETK1	SFCRC LRC CRC	ETK8	8000P	CADAO CADA1	; CMO	CB01(RCT1)	SPOA	MADI	CBII	S.BCT/*XTAG	DXFO	I
	2	*TSNS2	*DET1 *DET2	*TSNS8	*SKWE	ETK2	CRC	*NSKEW	8000P	CADA2	SVO		SERA	MSVI	CBI2	SBCT/DXFE	MPRD	2.
5	3	*TSNS3	*DET3	*DIBG	*DBCK	ETK3	HBLKN	SDRST/*LRCE	CANY1	CADA3	SLIG	CBO3(RCT3)	SYRA	MSTI	CB13	SUCT/DXRQ	SCAN	3 5
_	4	*TSNS4	*DET4	*DNOIS	*DROE	ETK4	BLKED	TMO	<del>-</del>	CADA4 (CMO)		CBO4(RCT4)	IFONA	RQIAF	CB14	SDCT/BIBSY	EBOPI	4
	12	*TSNS5	*DET5	*DBOB	PNMLT *POJAE	ETK5 ETK6	CRCHG CRCRG	TM1 TM2	ļ	SBMC (CM1)	MUSPE	CB05(RCT5); CB06(RCT6)	RTA URTO/RTB	ROLBE	CBI5	CTSTP/*ABPC	CMROM	<u> </u>
	6	*TSNS6 *TSNS7	*DET6 *DET7	*DARA *DTM	1.1 UJAE	ETK7	RRDB/RDBS	TM3		CPBL (CM2) *OFS (CM3)	TNS		WRTO/URRI	DSCI	CBI6 CBI7	RRCT/*BOPC	ROM2 ROM1	6 7
Nickn	i de la como		MPERR	VFSNS	UQID	TCADB	IFSTB	RTSNS	RICIL	1010 (0110)	, 4110	, 500 - (10x · )	c.coperate		1111	RCRY/CRCT	NOTIL	Miologramo
NICKT		T.INT	MRER/RENB		*MRX	CADBO	CUBSB	(INHA)	DSOKA	+								Nickname 0
		T.TMR		SP2	*IBRY	CADB1	SPOB	(INHB)	DSOKB	-								
	2	T.INS	CSPE	F.C=S	*AGAP	CADB 2	SERB	(*BWE)	DSOKB CRVA				AT					$-\frac{1}{2}$
6	2 3	T.INS T.PER	REGE	M	1800	CADB3	SYRB	(BFRE)	CRVB				NOE	used				3 6 4 5 6
0	4		MECO	SW7		CADB4	IFONB	(RQIB)	SSW/SW .									4
	5	M.TMR	MEC1	VFOR	-	SP5	OPOB	0	RUSE/*WE	-								5
	6	M.INS	MEC2	VFOM		SP6	101	GINHB	RRSB	_								6
	7	TMSK	MEC3	VFOL		SP7	2CHSW	GINHA	i									<u> </u>

Example of Field Tester Operation (Interface Signal Display)

#### Interface Signal Display

Principal signals of interface that indicate the operational condition of the MTC and signals indicating the status of the microprocessor can be displayed by a field tester.

The display function is available when the MTC is in any status.

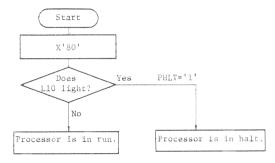
The procedure for display has only to set a hexadecimal '80' to SO - S7. Then, an objective signal can be displayed on LO - L11. (See MO003.)

Interface Signal Display:

X1801

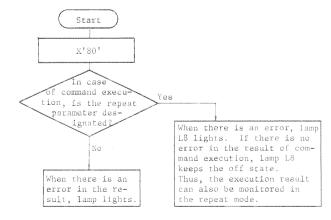
Example 1: The Microprocessor is Inspected Whether It is in the Halt Status.

When PHLT signal is '1', it indicates that the microprocessor is in the halt status.



Example 2: Monitoring of ERRF Bit

When setting the MTC in the offline status and executing a command from a field tester, the MTC is informed of the result of the execution through ERRF bit. When ERRF='1', it indicates that there is an error.



M0130 Example of Field Tester Operation (Microprogram Address Display)

# Microprogram Address Display

A microprogram for the MTC is stored in the ROM which plays a role of control storage (CS). The processor takes out microinstructions of the microprogram from the CS. The content of the address register for reading out microinstructions from the CS can be displayed using a field

When the processor is in the 'STEP' status, the step forwarding of the program sequence can be ensured, while if the processor is in the 'RUN' status the you can see the lighting condition of LO , which is effective for maintenance.

The procedure for display has only to set SO - S7 at 'A4'.

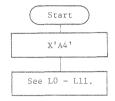
CS ADDRESS DISPLAY:

X1A41

The CS address can be set at a desired value only when the processor is in the 'STEP' status, and instruction can be stepped forward (To do such things, it is necessary to know the detail of the microprogram). The CS address set functions are as follows.

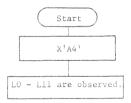
```
(X*E8*
            CNT ..... STEP)
X^{+}A4^{+}
            CNT
                          X: Arbitrary
X^{T} \ell X^{T}
X * mn *
            Set address 'lmn'.
```

Example 1: Lets try to inspect the CS address with the processor being in the 'RUN' status to investigate the idle state of the MTC.



o When the MTC is in the idle state, the idle program is stored in the lower address ('OXX' - '1XX') of CS. Accordingly, LO - L2 are turned off, and L3 - L11 are half bit (half lighting of 'lFF').

Example 2: Observation of CS address during the execution of command



o In company with the execution of command, LO - LII blink.

Example of Field Tester Operation (Register Write)

## Register Write

Arbitrary data can be written in registers controlled by the microprocessor of the MTC using a field tester.

Using this function, the operator of field tester can provide the microprogram of the MTC with various data. For example, in case of the execution of a command in the offline mode, various parameters necessary for the execution of a command can be specified by writing data in a particular register. For maintenance purpose, the register write function is important as a means of specifying parameters.

The method of writing predetermined data in a register is to execute the following procedure.

#### REGISTER WRITE:

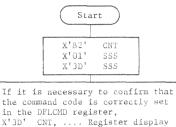
-	Х*В2*	CNT	
	X'dd'	SSS	dd: Write data
	X'aa'	SSS	aa: Register address

Other applications of the register write function is to carry out the manual control on the MTC or the MTU by executing various register write operations according to a predetermined procedure. However, since such case requires the detailed knowledge about register, the register write function would not be 50 useful for maintenance purpose.

Example 1: Command Code Setting to Offline Command Register

To issue a command from a field tester in the offline mode of the MTC, the command code needs to be set in the DFLCMD register (address  $^{\dagger}3D^{\dagger}$ ).

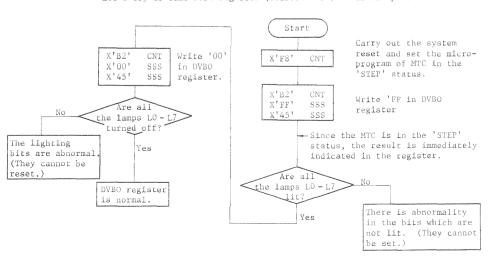
As an example, let's try to write the write command code ('01') in the DFLCMD register.



then check L0 - L7 = '01'

Example 2: Register Function Check

If there is doubt about the function of a register, a field tester is useful for writing data in the register by using the register write. Let's try to take DVBO register (address '45') as an example.



MO150 Example of Field Tester Operation (CS Parity Scan)

With the use of a field tester, all the addresses ('000' - 'FFF') of CS can be scanned to check its parity.

To start CS parity scan, the ROSF bit has only to be set.

When the scan begins, it is repeated until the ROSF bit is reset or a parity error is detected.

CS Parity Scan Starts

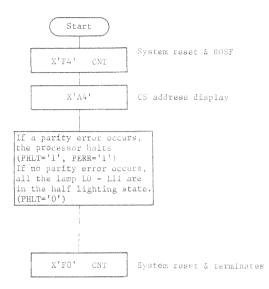
Ends

X 1 F4 1

X * F0 *

In addition, as STEP bit in conjunction with ROSF bit are set, the scan is stepped forward by switch SSS.

Example: Carrying out the parity scan of all the addresses of CS.



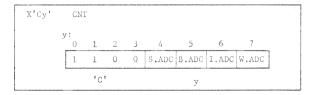
Example of Field Tester Operation (Address Compare)

A field tester can ensure that control passes a particular microprogram address. Also when control passes the address, field tester can direct the processor to halt, to carry out bypassing to another address, to display the content of register, to write data in a register, and so on.

However, to use these functions efficiently, it is necessary to have a knowledge of the contents of the microprogram and registers. In this sense, these functions are not usually used for the maintenance purpose. Here, an example of using these functions is introduced for reference.

Whether control passes a particular microprogram address can be ensured only by displaying the ACMP signal. (See M0003.) The ACMP signal can be reset by turning on the SSS switch.

Other functions are specified by the following procedure.

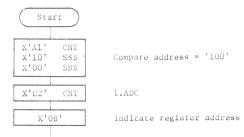


The compare address is set by the following operation.

In addition, since the compare output appears at card pin BEZ of 1AO7 (512185U), the passing timing can be observed by an oscilloscope.

Example 1: Confirmation of the Execution of a Trap Analysis Routine

When a trap occurs in the processor of the MTC, control passes microprogram address '100'. The example of displaying the content of LCMD register (address '0B') at the time when a trap occurs is explained below.

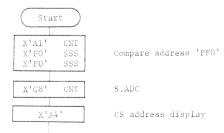


Command execution

When initiation from the channel takes place, a trap occurs. Accordingly, every time the initiation takes place, the content of LCMD register, the code of the command executed the most recently, is displayed.

Example 2: Address Compare Stop

The example of halting the processor immediately after control passes microprogram address 'FF0' of the MTC is shown below. Address 'FF0' is the address which control passes when a reset routine is executed.



When it is intended to execute the reset routine, the processor halts. Then, LO - L11 (CS address) display the next address. To release the processor from the halt status, switch SSS has only to be turned on. However, if the address compare is successful again, the processor will halt.

M0170 Example of Field Tester Operation (Command Execution in the Offline Status of the MTC)

If the MTC is in the offline mode, a command can be issued to the MTC by using a field tester. Command code, byte count, device address, and other parameters can be provided by writing appropriate data in predetermined registers.

All the registers concerned with command execution in the offline mode of the MTC are listed below.  $^{1)}$ 

```
SDIAO (address '38')
SDIA1 (address '39')
SDIA2 (address '3A')
SDIA3 (address '3B')

OFLCNT (address '3C') ... Command execution control parameter
OFLCMD (address '3D') ... Command code
OFLDVA (address '3E') ... Device address
BCT (address '3F') ... Byte count
```

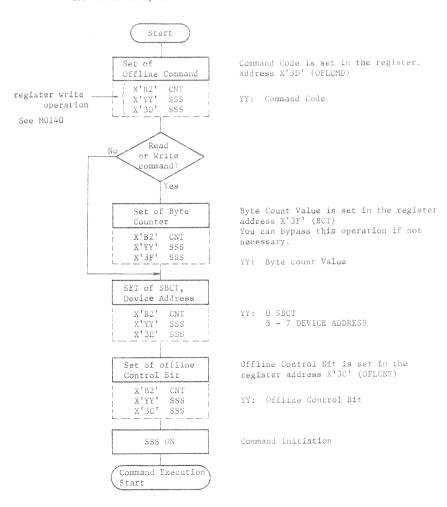
Since these registers are not reset²⁾ except the case of the MTC power on, once they are set it is not necessary to set them again unless any change is required.

Note 1: The write data in a write command is always 'FF'. Also, the data read by a read command is not sent out to the channel.

Note 2: When the command reverse function (REV.UEX parameter) is specified, the content of OFLCMD register changes. Also, when TUSCAN parameter is specified the content of OFLDVA register changes.

# Example: Command Execution

Contents of SDIAO - SDIA3 are usually '00'. The following operation is carried out when it is ensured that the contents of these registers are '00'. Also, the content of SINH is '0'.



M0171 Example of Field Tester Operation (Unit-Check Parameter)

When a command is executed in the offline mode of the MTC by a field tester, the following operations can be done if the result of the command execution causes an error (Unit-check is set). These operations are specified by UC.STP and UC.RP bits (bit 0 and bit 1) of OFLLCNT register (address '3C').

Unit-Check	Parameter	s	
UC.STP	UC.RP		
0	0		No function
0	1		When UCK occurs the repositioning operation is carried out. Then, an error occurring during repositioning is disregarded. (See Note 1.)
1	0	* * * *	When UCK occurs the microprogram carries out looping after executing a command. The looping continues until SINH bit is set, UC.STP parameter is reset, or the system reset is carried out. (See Note 2.)
1	1		When UCK occurs the repositioning operation is carried out. If there is an error newly occurring during repositioning, a microprogram performs looping after repositioning operation. The release condition for looping is the same as the above.

#### NOTE:

#### 1) Repositioning operation

For the write command — After backspacing an error block, an erase command is executed. (In case an error occurs during IB writing, a rewind command is executed.)

For the read command — An error block is backspaced.

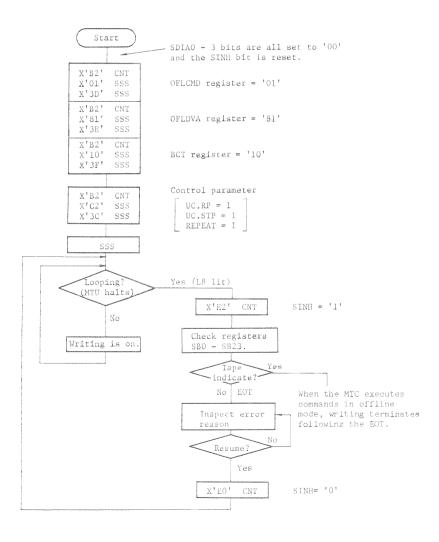
For the read backward command — An error block is spaced.

For other commands — No operation

## 2) SINH

If UC.STP or UEX.STP parameter is specified and a microprogram carries out looping, the loop is released when this SINH bit is set. If REPEAT parameter is specified the issuance of the next command is suppressed by setting this SINH bit on, so the command execution can be resumed by resetting the SINH bit again. (Refer M0008)

Example: Writing a 16-byte data pattern in the MTU of physical unit address. It is assumed that writing is carried out as far as the EOT and, when there is a write error, repositioning takes place. The example also assumes that when there is a repositioning error, writing is interrupted, looping is executed and then sense byte is checked.



# M0172 Example of Field Tester Operation (Unit-Exception Parameter)

In case a field tester executes a command in the MTC offline mode, the following operations can be handled by the field tester if the terminate status contains 'Unit-Exception' parameter.

UEX Paran	neters —			
UEX.STP	UEX.REW	UEX.REV		
1	X	Х	P + 6	When detecting UEX, the micro- program is looped. Release from the loop can be done by resetting UEX.STP parameter, setting the SINH bit, or by the system reset.
0	0	0		No function
0	0	1	* * *	When detecting UEX, the content of OFLCMD register is converted into the reverse command codel) and execution is continued.
0	1	0		When detecting UEX, the REWIND command is executed.
0	1	1	* * *	When detecting UEX, the REWIND command is executed, and then the speed mode is reversed (Normal speed ← high speed) to continue the command execution.

# NOTE 1) Reverse commands

	_					
Old OFLCMD	Reversed new OFLCMD					
WRT (01)	RDB (OC)		At the	time of	detecting	the EOT
RDF (02)	RDB (OC)		At the	time of	detecting	a tape mark
RDB (OC)	RDF (02)	* * * * * *	At the	time of	detecting	a tape mark
SP (37)	BSP (27)		At the	time of	detecting	a tape mark
BSP (27)	SP (37)		At the	time of	detecting	a tape mark
ERS (17)	RDB (OC)		At the	time of	detecting	the EOT
WTM (1F)	BSPF(2F)		At the	time of	detecting	the EOT
DSE (97)	BSPF(2F)					
NOP (03)	RDB (OC)					
Others	No change					

Example: Repetitive forward and backward read of blocks between two adjacent tape marks on such tape as shown in Fig. 1.

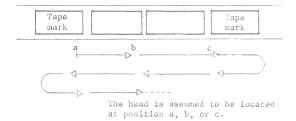
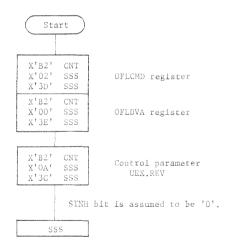


Fig. 1



Example of Field Tester Operation (TUSCAN Parameter)

When the MTC is in the offline mode, a field tester can issue a command to all the MTUs connected to the MTC sequencially.

The parameter used for this purpose is TUSCAN bit (Bit 7 of OFLCNT register address '3C').

When TUSCAN parameter is specified, the device address of OFLDVA register is increased by 1 (when the address was #7 it is changed to #0) when the microprogram of MTC completes the execution of a command given to a particular MTU (including the execution of such operation as the repositioning to be caused by control parameters if they are specified).

If a REPEAT parameter is not set, every time the SSS switch is operated commands are successively issued to all the MTUs connected to the MTC. If a REPEAT parameter is specified, what must be done is to operate only SSS switch once in the beginning.

It is not much practical to use TUSCAN parameter together with UC.STP parameter, for UCK is reported to the MTUs which are in the NOT READY status or which are not operational and therefore looping is not carried out every time a command is issued to the address of such MTU.

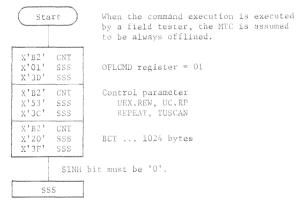
It is recommended to use TUSCAN parameter together not with UC.STP parameter but with UC.RP parameter and REPEAT parameter to operate a number of MTUs concurrently and observe their operation.

Example: Writing a 1024-byte data on tapes loaded on the MTUs numbered #0-#3

When writing reaches the EOT, rewinding is to be carried out on the MTU and then writing is to be continued. (UEX.REW parameter)

When an error occurs during the write operation, repositioning is assumed to be carried out. (UC.RP parameter)

However, when an error occurs during the repositioning, looping is assumed to be prohibited.



Although the MTU which is not in the READY status is set in UCK (IRQ), the command issuance is executed. (No looping) Accordingly, the MTU may be set in the READY status after executing the above operation. In this case, when the MTU is set in the READY status, the write operation can start.

MO174 Example of Field Tester Operation (Go-Down-Time Parameter)

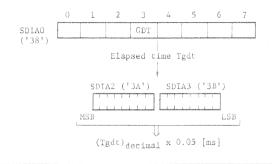
The diagnostic flag byte register (SDIAO - SDIA3, address '38' - '3B') is always effective when the MTC is offlined.

> (When the MTC is in the online mode, the diagnostic flag byte register is given by a SET DIAGNOSE command.)

Here, a practical example of the diagnostic flag byte register is shown by an example using the GDT (Go-Down-Time) parameter, (M0165 also explains TEST-MTC parameter).

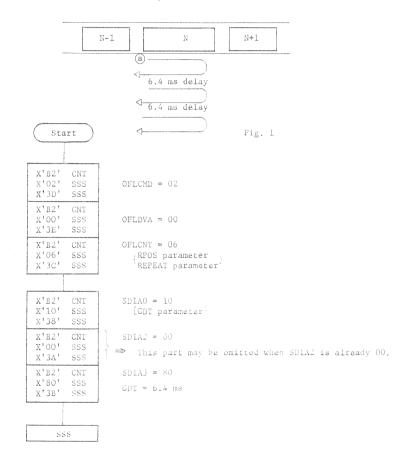
GDT parameter aims at providing a predetermined elapsed time between the time when the execution of a command terminates and the time when the next command is issued.

This elapsed time is determined by the content of registers SDIA2 and SDIA3.



Example: Repetitive Forward Reading of Data Block N at Every 6.4 ms (Using RPOS parameter)

> MTU #0 is loaded with such tape as shown in Fig. 1, and the magnetic head is assumed to be located at position a .



Example of Field Tester Operation (TEST MTC)

When TMTC parameter is set at bit 7 of the diagnostic flag byte register 0 (SDIAO - address '38') and a SET DIAGNOSE command (command code '48') is issued, a diagnostic program for the hardware of the MTC can be executed.

	0	1	2	3	4	5	6	7
SDIAO ('38')								TMTC

If there is an error in the diagnostic result, the unit check is contained in the end status. (EQC)  $\,$ 

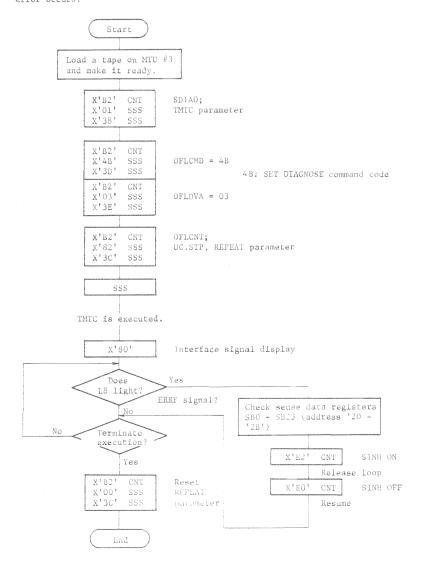
The operator of field tester can obtain the diagnostic result by checking whether ERRF (L8 at S0  $\sim$  S7 = '80'. See MAP M0120) is lit or DSB (address '0A').

To execute the TEST MTC, a SET DIAGNOSE command must be issued to the MTU being in the READY status.

SDIAD, bit 6 is other flag bits to direct diagnostic functions. bits are from OLTE program.

Refer to MO111, REG ADRS '38', to each bit definitions.

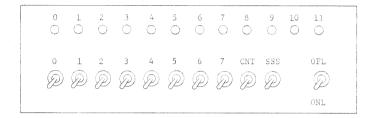
Example: TEST MTC is executed for the MTU #3. It is assumed that the execution uses REPEAT parameter and UC.STP parameter and is repeated until an error occurs.



M1000 Usage of Field Tester with MTU

The field tester is composed of LED lamps and switches, and by operating the switches, the internal signals of MTU can be displayed and the actions of MTU can be controlled (Command mode).

The field tester is connected with 1005 on the gate part. (Lower connector of 5121810)



#### 1. Display

The contents of the internal register file (address  $\$00 \,\%\,\$1F$ ) of MTU and the addresses of microprograms can be displayed by the following procedures.

- 1-1 To display the contents of register file:

  - (2) Push CNT switch up and the contents are displayed on LEDO  $\sim 7\,,$

And other LED lamps show the following;

LED8 : TMSR8 (illuminates upon detecting read data bit 8.)

LED9: TEST (includes that the field tester is running.)

LED10: Spare (reserved for the maintenance use. It can be checked by connecting a signal with 1A05 BBV.)

LED11: UCKLP (same as the LED lamps of Unit Check on the operator panel.)

- 1-2 To display the address of microprogram:
  - (1) Set switches 0 ~ 7 as follows;
    - \$80 (displays the addresses continuously.)
    - \$AO (displays the proper address at the moment of running.)
    - \$CO (displays the address at the time Unit Check is generated.)
  - (2) Push CNT switch up and the address is displayed.

		Τ-									
SVOR	Command	0	1	1.	1 3	Swi 4	tch . 5	. 6	1	HEX	Contents
-	1	+-	1	÷	+-	+-4	-1 -2			HEX	04 Forward Saunal Font Janous gave 1977
					i						U2 Ferward Streaming Continuous go to FOT
											07 Forward Fast go to EOT
1	Forward read	0	0	10	0		Co	ode		- QX	08 Load-Balaad Repeat action
	action									1	09 Forward Normal Continuous - Rewind Repeat action
				1							QA Forward Streaming " 6
U	1			i		Ì					OF Auto Load
		+		-	†					·	41 Backward Normal Continuous go to EOT
						į					42 " Streaming " "
	Backward read	0	1	10	1 0	-		,			47 - Rev. [15]
	action	0	1 -	1"	1 0	ľ		ode .		4 X	49 Backward Normal Continuous - Forward Fast repeat
	1									4	4A " Streaming " "
				1							4F Unload
	Turn	0	Long/	10	1	d. ree		1 - BWD		1X	Short time turn
			Short	1	1 *	1	to C Title.	DND	C AINC	SX	Long time turn
					1	1				2x	Forward Start/Stop (Short time) - Rewind repeat
	Start/Stop	0	BWD/	1	Long/	;- Go		L. Co.	down *	3X	(Long time)
			FWD	1	Short		· P			6 X	Backward Start/Stop (Short time) Forward Fast repeat
				ŀ						7 X	(Long time).
			Settlir	ng ti	me of		Switch [4,5				
-			Turn ar Stop	1d 52	art/		[6,7	0 0	0 1	1	3 0 . 1 1
						Mode	e tt (Ime	- 1 - 5 -		ms .	
						1	ct (Ime g time	50 ;			8 ms
						Long	g came		NS . 130	ms .	400 ms 1000 ms
	Write	1	0	0	0	WRT/	SACC		High/	8x	Continuous Write or Erase to EDT
		1				ERS	Í	1.0	Low	02	COST CHICAGO WILLE VI ELASE TO DO
	AGC or GSD	1	0	1	L	Error Stop	Singl/ Ropeat		0	BX	SAGE or GSD action (Slice level is to be Normal.)
	DGC AMP		1, 1		BWD/		CN4			CX	Forward Road (Settle the gain of GCR.)
	DGC APIF			U	FWD	CN8	i UNA	CNZ	CNI	DX	Fackward Rend ( " )
	Mode set	1		1	0	WRT/	STRMD	HD/	0	FV	Write/ Streaming/ High/
	House sec		1		. "	RD	518000	1.0		Į EX	Write/ Stronming/ High/ Road , Hormal , Low Density Set
						0	LVLTO	LVL11	LVLT2		Ser Slice level.
	Slice level	1	1	ì	1					FX	F9 Set Slice level to 90%,
	set					I	-	- Code		1	PA " 100%, Only GCR, PE
					L				,		FB 110%.
1/0	Photo sensor	1		0	1	0	1	0	1	95	MOT/LOT sensor, Error Code check
	check	-			1	1	ERCUT	0	High/ Normal	9χ	Capston tacho pulse check of High/Normal Speed (When ERRUT is equal to 0, it stops once by error.)
. ]						0	ALROV	SOLVI.	PRSVE		Air supply motor, Sciencid/Pressure Valve drive
	Air system action	1	0	1	0			janith Capatan		ΛX	
						1	0	drive	FWD		For theck and Adjustment of Capacitive Sensor
-					ļ '						81/89 Cartridge drive
0											82/BA Auto cleanor drive
	Mechanism action	1	0	1	1	Repeat		- Code		ВX	84/80 Error marker drive
											B6/BC Window drive
-											B7/BF Drive All of above
	Capstan	1		0	0	0	0	0	0	co	D/A Converter action check
	circuit check					C3	Tarres I			1 1	The second secon
ļ	Ruel drive	1	1	0	1	Slow/ Fast	BUD/ FWD	MR	FR	DX :	Machine and File reel drive
1/0	Reset	1	1 [	1	1	1	1	1	1	FF	Reset (same as Reset button of the operator panel)
					<u> </u>		·		<u></u>	Li	

M1001	Field	Tester	Function	(1)

#### 2. Command Mode

Run MTU commands with the following procedures.

- (1) Put MTU in offline mode.
- (2) Set OFL/ONL switch of the field tester to OFL.
- (3) Set a proper command on switches  $0 \sim 7$ . (See the Table.)
- (4) Push SSS switch up. The operation starts and LED9 illuminates.
- (5) The operation stops when LED9 is on if SSS switch is pushed up again.

## 2-1 Forward/Backward Single Motion (\$0X, \$4X)

During this operation, MTU enters Read status automatically.

Direction	ection SW0 ∿ 7 (Hex.) Contents								
	01	Continuous running in Forward direction to EOT in Normal mode.							
	02	Continuous running in Forward direction to EOT in Streaming mode.							
	07	Continuous running in Forward direction to EOT at about 200 ips.							
Forward	08	Repeat actions of Auto load and Unload.							
	09	Continuous running in Forward direction in Normal mode and Rewind upon EOT.							
	0A	Continuous running in Forward direction in Streaming mode and Rewind upon EOT.							
	0F	Auto load							
	41	Continuous running in Backward direction to BOT in Normal mode,							
	42	Continuous running in Backward direction to EOT in Streaming mode.							
Backward	47	Rewind							
	49	Continuous running in Backward direction in Normal mode and, upon BOT, Fast running in Forward direction.							
	4A	Continuous running in Backward direction in Streaming mode and, upon BOT, Fast running in Forward direction.							
	4 F	Unload							

## 2-2 Turn (\$1X, \$5X)

To perform bidirectional Start/Stop actions at a certain interval. The action time in Forward direction is set by SW4/5 and in Backward by SW6/7. And when SW1 is on (off), the action time is set to Long (Short). The settling time is measured from the time GAPCT (Gap Control) signal is set to 1.

SW									
0	1	2	3	4	5	6	7		
0	1:Long	0	1		rd time		ard time		
	0:Short			(Below	w table)	(perov	v table)		

SW 4,5 6,7 Mode	0 0	0 1	1 0	1 1
Short	0 ms	3 ms	8 ms	20 ms
Long	50 ms	150 ms	400 ms	1000 ms

## 2-3 Start/Stop (\$2X, \$3X, \$6X, \$7X)

To perform Start/Stop actions in one direction at a certain interval.

The direction (forward/backward) is specified by SW1.

The action time (Short/Long) is specified by SW3.

The go-time is set by SW4/5 and Stop time by SW6/7.

The settling time is the same as shown at  $2-2\ \mathrm{Turn}$ .

-	SW										
	0	1	2	3	4	5	6	7			
	0	1:Backward	1	1:Long	Go	time	Stop time	time			
		0:Forward		0:Short							

In case of Block write, perform the command \$2X or \$3X after Mode setting (Refer to 2-7 Mode set).

M1002 Field Tester Function (2)	)
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### 2-4 Write action (\$8X)

To write or erase to EOT with continuous running.

By SW4, whether to write or to erase is specified.

By SW5, whether SAGC is on or off at writing GCR is specified.

By SW6, whether High Density or Low Density is specified.

By SW7, write density is specified under each density mode.

SW								
0	1	2	3	4	5	6	7	
1	0	0	٥	l:Write	1:SAGC ON	l:High Density	l:High	
1	U	0	0	0:Erase	0:SAGC OFF	0:Low Density	0:Low	

Record density SW7	6250	1600	800
0: Low	3014 fci	1600 fci	200 fci
1: High	9042 fci	3200 fci	800 fci

### 2-5 AGC/GSD action (\$BX)

To perform the actions of SAGC (Self Adjust Gain Control) and GSD (Gain Step Down after 1 Block Read/Write) at a proper interval when a magnetic tape written continuously with 9042 runs.

By SW4, whether to stop at the error or not is specified.

By SW5, whether Single or Repeat is specified.

By SW6, whether SAGC action or GSD one is specified.

### Slice level is to be Normal.

				SW			
0	1	2	3	4	5	6	7
7	0	4	7	1:Error Stop	1:Single	1:GSD	
1	U	1	1	0:Non Stop	0:Repeat	0:SAGC	0

## 2-6 DGC AMP action (\$CX, \$DX)

To set count value of DGC AMP to any one in GCR mode.

By SW3, whether Forward or Backward is specified.

By SW4 $\sim$ 7, the count value is specified in hexadecimal notation.

	SW									
0	1	2	3	4	5	6	7			
- Paragraphic Control of the Control	-	0	1:Backward	Count	Count 4	Count 2	0			
4	1	U	0:Forward	Count o	Counc 4	Count 2	Count 1			

M1003 Field Tester Function (3)

2-7 Mode set (\$EX)

To set each mode of MTU.

By SW4, whether Write or Read mode is specified.

By SW5, whether Streaming or Normal mode is specified.

By SW6, whether High Density or Low Density is specified.

			e1	EY.			
			2,	W			
0	1	2	3	4	5	6	7
1	1	1	0	1:Write	1:Streaming	1:High Density	Λ
1	-	-	· ·	0:Read	0:Normal	0:Low Density	0

# 2-8 Slice level set (\$FX)

To specify Slice level to any one.

SW								
0	1	2	3	4	5	-6	7	
1	1	1	1	0	LVLTO	LVLT1	LVLT2	

To specify Slice level by the combination of bit 5, 6, and 7.

	Lev	e1	test	B	EAD	WRITE			
Purpose	0	1 2 FWD BWD				FWD	Methode		
	1	1	1		125 ± 12%				
	1	1	0		100 ± 12%				
	1	0	1		80 ± 8%				
Diagnosis	1	0	0						
	0	1	1						
	0	1	0		GCR/PE				
Marginal	0	0	1	15 ± 2%	10 ± 1% 15 (Note 1)	37 ± 4%			
Normal	0	0	0	10 ± 1%	7 ± 1% 10 (Note 1)	20 ± 2% 25 (Note 1)			
Marginal	Х	Х	1		26 ± 4%	50 ± 5%	NRZ1		
Normal	Х	X	0		17 ± 2%	40 ± 5%			

For the adjustment of Read Amplifier, Slice levels of 90%, 100% and 110% are provided. And at each Slice level, it can be adjusted by observing the signals of TMSR0  $\sim 8$  (To select \$1E as a register address in Display mode).

SWO ∿ 7 (Hex.)	Contents
F9	To set Slice level to $90\%$ at the adjustment of the level.
FA	To set Slice level to 100% at the adjustment of the level.
FB	To set Slice level to 110% at the adjustment of the level.

Note 1: 512182U; AGC8 or more 512649U; AGCC or more

M1004	Field	Tester	Function	(4)

# 2-9 Photo sensor check (\$9X)

To check BOT, EOT, error code indicator and capstan tachometer A/B. When checking the capstan tachometer, the motor can be rotated with insecure speed by setting SW5 on even if the error of a tachometer is detected.

SW0 ∿ 7 (Hex.)	Contents
95	To be used for check and adjustment of BOT/EOT and for check of error code indicator. BOT and EOT signals are output at bits 4 and 5 of address \$14 of jump condition As for displaying error codes, the code is changing as follows; $00+11 \neq 22 \dots 99 \rightarrow 00$
98 (9C)	To check duty and phase of the capstan tachometer. If an error is found, it is shown with an error code. In the case of error, setting SWO $^\circ$ 7 to \$9C makes the motor rotate with fixed voltage.
99 (9D)	To check the capstan tachometer in high speed rotation. If an error is found, it is shown with an error code. In the case of error, setting SWO 7 to \$9D makes the motor rotate with fixed voltage.

# 2-10 Air System action (\$AX)

To check and adjust the air system by activating air supply motor and valve.

0	3	2	3	4	5 .	6	7
1	0	1 0 0		0			1:Solenoid Valve Drive
						0: Off	0: Off

It is also performed for the check and adjustment of the capacitive sensor.

	SW										
0	1	2	3	4	5	6	7				
1	0	1	0	1	0	l:Capstan Drive	l:Backward				
-	Ů,	-		_	Ü	0: Coast	0:Forward				

Note in the check and adjustment of the capacitive sensor:

- (1) Set SW0  $\sim$  7 to \$A8, stop the tape loop at the center of each column sensor, and fix the reel.
- (2) Then, set SWO ∿ 7 to \$AA or \$AB, check it by moving tape loops.

M1005 Field Tester Function (5)

# 2-11 Mechanism action (\$BX)

To perform the actions of Cartridge, Auto Cleaner, Error Marker and Window.

These actions can be performed once (SW4 off) or repeatedly (SW4 on).

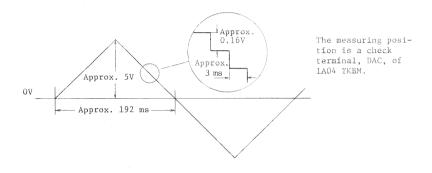
SWO ∿ 7 (Hex.)	Contents
B1	To open Cartridge
В9	To repeat open and close of Cartridge
В2	To drive Auto Cleaner
BA	To repeat on and off of Auto Cleaner
В4	To drive Error Marker
ВС	To repeat on and off of Error Marker
В6	To close Window
BE	To repeat open and close of Window
В7	To open Cartridge, to drive Auto Cleaner and Error Marker and to close Window
BF	To repeat above open and close or on and off

## 2-12 Capstan Circuit check (\$CO)

To confirm the action of capstan drive circuit by checking DAC (D/A Converter).

Set SW0  $^{\circ}$  7 to \$C0 and check DAC.

If DAC signal is a stepped waveform shown as below, the action is normal.



## 2-13 Reel Drive (\$DX)

To confirm the action of Reel motor drive circuit by rotating Reel motor clockwise or counterclockwise with the servomechanism turned off.

By SW4, Slow or Fast is specified.

By SW5, Forward or Backward is specified.

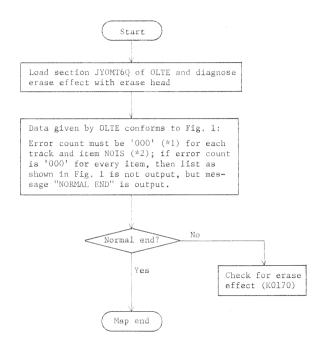
SW6 specifies Machine reel to be drived and SW6 File reel.

					SW			
***************************************	0	) 1 2 3				5	7	
	1	1 0		1	1: Slow	1:Counter- clockwise	l: ^{Machine} Reel Drive	l:File Reel Drive
	1	1	U	T	0: Fast	0:Clockwise	0: Stop	0: Stop

**(**).

1

TST6200 Diagnosis of Erase Effect [JYOMT6Q]



Note: Refer to section JYOMT6Q in the OLTE diagnostic manual for output formats and detailed diagnosis.

```
.....(SL=00001, TL=001).....
JYOMT60 V-02 RTN 01 DEV 0583 LEV 00 REF NO 0
ERASE CHECK
ERASE CHECK
                SLICE LEVEL = 10%
TRK BIT ERROR COUNT (100 SAMPLE)
         000
         000
  2
     3
         000
         003
               (*1)
         000
         000
         000
  7 0
         000
  8 6
  9 4
         000
  NOIS
         000
               (*2)
REFER TST6200 IN MAINTENANCE MANUAL
```

Fig. 1 Example of printed data

HEU023I S JYOMT6Q DEV 01E0 13.44.37 NORMAL END NORMAL END HEU024I T JYOMT6Q DEV 01E0 13.45.12

Fig. 2 Example of printed data when no errors are counted

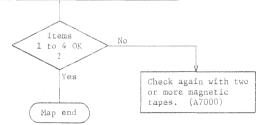
TST6210 Diagnosis of Read Signal Level [JYOMT6R]

Start

Load section JYOMT6R of OLTE and diagnose Read signal levels, ratio of WRT to RDF, and ratio of RDB to RDF for each track in GCR and PE modes. (See Note 1)

Allowable ranges of printed data in this section are as follows:

- 1. Read level for each track shall fall within 80% to 120% in each of GCR and PE modes.
- 2. For GCR level test, SAGC value on list shall be less than X'C'. (See Note 3.)
- 3. Ratio of WRT to RDF for each track shall be less than 130% in each of GCR and PE modes.
- 4. Ratio of RDB to RDF for each track shall be more than 50% in each of GCR and PE modes.



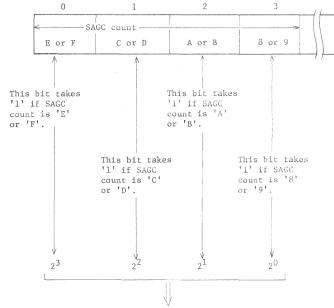
Note 1; WRT: Write and Read

RDF: Read FWD RDB: Read BWD

Note 2: Refer to section JYOMT6R in the OLTE diagnostic manual for output formats and detailed diagnosis.

Note 3: The SAGC count (bits 0 to 3 of MTU sense byte 5) is indicated at bits 0 to 3 of MTC sense byte 18. The correspondence between the SAGC value in data to be printed out from JYOMT6R and the SAGC count indicated at bits 0 to 3 of MTU sense byte 5 is as follows:





Indicated in hexadecimal notation by JYOMT6R

- o If the media and head take standard values, then the SAGC count of the MTU is '5' or '6'. Therefore, the SAGC value of printed data for JYOMT6 is '00'.
- o The gain difference between two steps of the SAGC count of the MTU is about 20%.

TST6211 JYOMT6R Printed Out Data Example - 1

JYOMT6R V-01 L-00 RTN 01 DEV/LN 01E0 REFNO 0 WRITE, READ SLICE LEVEL CHECK

WRITE SLICE LEVEL

MTU SPEED MODE = NORMAL MTU DENSITY MODE = GCR SAGC = 00 1 1 1 1 1 0 0 0 0 0 0 0 0 0 0 0 (%) 5 XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX 2 7 XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX 6 1 XXXXXXXXXXXXXXXXXXXXXXXXXXXXXX 7 0 XXXXXXXXXXXXXXXXXXXXXXXXXXXXXX 8 6 XXXXXXXXXXXXXXXXXXXXXXXXXXXXXX REFER TST6210 IN MAINTENANCE MANUAL

JYOMT6R V-01 L-00 RTN 01 DEV/LN 01E0 REFNO 0 WRITE, READ SLICE LEVEL CHECK

READ FORWARD SLICE LEVEL

MTU SPEED MODE = NORMAL

MTU DENSITY MODE = PE

								1	1	1	1	1	1	
TRK	BIT	4	5	6	7	8	9	0	1	2	3	4	5	
		0	0	0	0	0	0	0	0	0	0	0	0	(%)
1	5	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX						
2	7	XXX	XXXXX	XXXXX	XXXXX	xxxxx	XXXXX	XXXXX		-				
3	3	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX		i				
4	P	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX						
5	2	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX		1				
6	1	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX						
7	0	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX						
8	6	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX						
9	4	XXX	XXXXX	XXXXX	XXXXX	xxxxx	XXXXX	XXXXX		İ				
						i								
REFER	TST6	210	IN MA	INTEN.	ANCE 1	MANUA	L							
						1								

The slice level for each of high/normal speed mode, GCR mode, and PE mode must fall within the following range:

80% < Slice level < 120%

TST6212 JYOMT6R Printed Out Data Example - 2

JYOMT6R V-01 L-00 RTN 01 DEV/LN 01E0 REFNO 0 WRITE, READ SLICE LEVEL CHECK

WRITE/READ FORWARD LEVEL RATIO

MTU SPEED MODE = NORMAL

	M	TU D	ENSIT	( MOD	E = 0	CR		SAGC	= 00					
								1	1	1	1	1	1	
TRK	BIT	4	5	6	7	8	9	0	1	2	3	4	5	
		0	0	0	0	0	0	0	0	0	0	0	0	(%)
1	5	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
2	7	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
3	3	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX			ì			
4	P	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX.	XXXXX					
5	2	XXX	XXXXX	XXXX	XXXXX	XXXXX	XXXXX	XXX						
6	1	XXX	XXXXX	XXXX	XXXXX	XXXXX	XXXXX	XXX						
7	0	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
8	6	XXX	XXXXX	XXXX	XXXXX	XXXXX	XXXXX	XXX						
9	4	XXX	XXXXXX	XXXX	XXXXX	XXXXX	XXXXX	XXXXX						

JYOMTGR V-01 L-00 RTN 01 DEV/LN 01E0 REFNO 0

WRITE/READ FORWARD LEVEL RATIO

REFER TST6210 IN MAINTENANCE MANUAL

WRITE, READ SLICE LEVEL CHECK

REFER TST6210 IN MAINTENANCE MANUAL

MTU SPEED MODE = HIGH MTU DENSITY MODE = PE

								1	1	1	1	1	1	
TRK	BIT	4	5	6	7	8	9	0	1	2	3	4	5	
		0	0	0	0	0	0	0	0	0	0	0	0	(%)
1	5	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
2	7	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
3	3	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
4	P	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
5	2	XXX	XXXXX	XXXXX	XXXXXX	XXXXX	XXXXX	XXX						
6	1	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
7	0	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX			i			
8	6	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
9	4	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX			1			

The WRT/RDF level ratio must be less than 130%.

TST6213 JYOMT6R Printed Out Data Example - 3

JYOMT6R V-01 L-00 RTN 01 DEV/LN 01E0 REFNO 0 WRITE, READ SLICE LEVEL CHECK

READ BACKWARD/READ FORWARD LEVEL RATIO

MTU SPEED MODE = NORMAL MTU DENSITY MODE = PE

								1	1	1.	1	1	1	
TRK	BIT	4	5	6	7	8	9	0	1	2	3	4	5	
		0	0	0	0	0	0	0	0	0	0	0	0	(%)
1	5	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
2	7	XXX	xxxxx	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
3	3	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
4	P	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
5	2	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
6	1	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
7	0	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
8	6	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						
9	4	XXX	XXXXX	XXXXX	XXXXX	XXXXX	XXXXX	XXX						

REFER TST6210 IN MAINTENANCE MANUAL

JYOMT6R V-01 L-00 RTN 01 DEV/LN 01E0 REFNO 0 WRITE, READ SLICE LEVEL CHECK

READ BACKWARD/READ FORWARD LEVEL RATIO

MTU SPEED MODE = HIGH

REFER TST6210 IN MAINTENANCE MANUAL

The RDB/RDF level ratio must be more than 50%.

TST6220 Diagnosis of Capstan Normal Start/Stop, Tape Speed

• Each of sections JYOMT6T, -U, and -V measures the capstan characteristics of an aiming MTU and outputs the results in the form of tables.

They can print out the characteristics of the capstan in the form of graphs as well, though in this case the volume of lists printed may increase considerably.

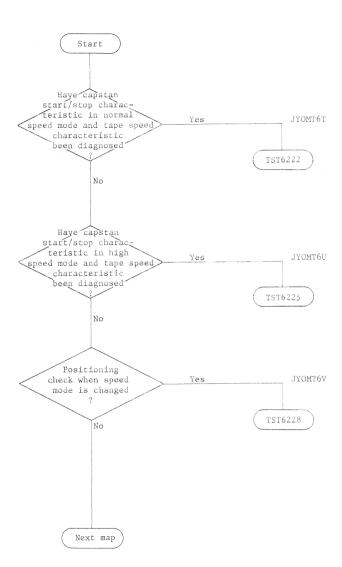
For details on how to specify parameters, refer to OLTE manuals.

These sections do not evaluate the results of measurement. So, the maintenance man should examine the values of lists output; judge their validity and the extent of degradation; take remedial actions.

Maps TST6221 to TST6229 show the criterions of the above judgement.

If an error or unusual measurement data occurs during running these sections of OLTE, then error messages may be output so that no results of measurement are printed out.

In such cases, most possible errors are due to execution of commands for diagnosis, which do not immediately affect usual read/write operation. Nevertheless, for close maintenance of the MTU/MTC functions, the maintenance man should follow up the cause of the error by examining error messages, determining the CCW data address, dumping measurement data, checking on the MTU for status, and performing other function tests.



TST6222 Diagnosis of Capstan Normal Start/Stop Characteristics and Tape Speed [JYOMT6T]

Note: To view start/stop characteristics with a scope, put input 'A' probe on 'analog +' of read amplifier and trigger on 'ACT' (1A05 BE7). Start Load the Section JYOMT6T of OLTE and diagnose the operation relating to the tape running. Allowable range are as follows. 1. Start characteristics and stop characteristics are as shown in TST6223. 2. The max. speed percentage should be less than 112% and the min, should be more than 88%. Item 1 and 2 are OK? Check the capstan tacho-pulse MAP End duty according to K0110. Duty OK? Refer to section JYOMT6T in OLTE diagnostic manual for output formats and detailed diagnosis. Load the JYOMT6T again and Adjust the duty according A0550 check the item of problem. to NOTE 2 in K0110-2. Yes Outy OK? OK? Yes Trouble of capstan tachometer. A0550 MAP End Replace the capstan motor (0130).

TST6223 JYOMT6T Output

JYOMT6T V-01 L-00 RTN 01 DEV/LN 0780 REFNO O CAPSTAN NORMAL START/STOP, TAPE SPEED CHECK

<< CAPSTAN CHARACTERISTIC TEST >>

MTU SPEED MODE = NORMAL MTU DENSITY MODE = GCR

TEST	LAST MT STATUS	BLOCK	START TIME(MS	5) FTP	VELOCITY MINIMUM	125 IPS= AVERAGE	LOO% MAXIMUM	STOP TIME(MS)	FTP
WRT	WRI	1	1.2 ^{max}	10 ^{max}	118 IPS (094%)	124 IPS (099%)	126 IPS (100%)	4.0 ^{max}	25 ^{max}
RDB	RDB	1	4.0 ^{max}	25 ^{max}	125 IPS (100%) 125 IPS	126 IPS (100%) 125 IPS	126 IPS (100%) 126 IPS	2.2 ^{max}	17 ^{max}
RDB	RDB	2	57	11	(100%)	(100%)	(100%)	11	FT
RDB	RDB	3	"	11	125 IPS (100%)	125 IPS (100%)	126 IPS (100%)	11	11
RDB	RDF	1	4.0 ^{max}	25 ^{max}	125 IPS (100%) 125 IPS	125 IPS (100%) 126 IPS	126 IPS (100%) 126 IPS	2.2 ^{max}	17 ^{max}
RDB	RDF	2	67	11	(100%)	(100%)	(100%)	*1	11
RDB	RDF	3	ts	n	125 IPS (100%)	126 IPS (100%)	126 IPS (100%)	86	11
RDF	RDF	1	1.2 ^{max}	10 ^{max}	124 IPS (099%) 122 IPS	124 IPS (099%) 124 IPS	125 IPS (100%) 126 IPS	4.0 ^{max}	25 ^{max}
RDF	RDF	2	4.1	11	(097%)	(099%)	(100%)	**	11
RDF	RDF	3	11	11	123 IPS (098%)	124 IPS (099%)	125 IPS (100%)	11	11
RDF	RDB	1	1.2 ^{max}	10 ^{max}	124 IPS (099%) 123 IPS	125 IPS (100%) 125 IPS	126 IPS (100%) 126 IPS	4.0 ^{max}	25 ^{max}
RDF	RDB	2	7.5	H	(098%)	(100%)	(100%)	2.0	11
RDF	RDB	3	11	11	124 IPS (099%)	125 IPS (100%)	125 IPS (100%)	47	11

REFER TST6220 IN MAINTENANCE MANUAL

Should be 88% ∿ 112%.

JYOMT6T V-01 L-00 RTN 01 DEV/LN 0780 REFNO 0 CAPSTAN NORMAL START/STOP, TAPE SPEED CHECK

<< CAPSTAN CHARACTERISTIC TEST >>

MTU SPEED MODE = NORMAL MTU DENSITY MODE = PE

TEST MODE	LAST MT STATUS	BLOCK	START TIME (MS	) FTP	VELOCITY MINIMUM	125 IPS= AVERAGE	LOO% MAXTMUM	STOP TIME(MS	) FTP
WRT	WRT	1	1.2 ^{max}	10 ^{max}	118 IPS (094%)	124 IPS (099%)	126 IPS (100%)	4.6 ^{max}	35 ^{max}
RDB	RDB	1	4.0 ^{max}	25 ^{max}	124 IPS (099%) 125 IPS	125 IPS (100%) 126 IPS	127 IPS (101%) 126 IPS	4.6 ^{max}	35 ^{max}
RDB RDB	RDB RDB	2 3	11	23	(100%) 126 IPS (100%)	(100%) 126 IPS (100%)	(100%) 126 IPS (100%)	11	11
RDB	RDF	1	4.0 ^{max}	25 ^{max}	125 IPS (100%) 125 IPS	126 IPS (100%) 125 IPS	126 IPS (100%) 126 IPS	4.6 ^{max}	35 ^{max}
RDB	RDF	2	11	11	(100%) 124 IPS	(100%) 125 IPS	(100%) 127 IPS	11	31
RDB	RDF RDF	1	1,2 ^{max}	10 ^{max}	(099%) 124 IPS (099%)	(100%) 124 IPS (099%)	(101%) 125 IPS (100%)	5.0 ^{max}	44 ^{max}
RDF	RDF	2	11	31	123 IPS (098%) 123 IPS	124 IPS (099%) 124 IPS	125 IPS (100%) 125 IPS	**	11
RDF	RDF	3	11	11	(098%)	(099%)	(100%)	11	11
RDF	RDB	1	1.2 ^{max}	10 ^{max}	123 IPS (098%) 124 IPS	124 IPS (099%) 125 IPS	125 IPS (100%) 125 IPS	5.0 ^{max}	44 ^{max}
RDF	RDB RDB	2	£1	63	(099%) 125 IPS (100%)	(100%) 125 IPS (100%)	(100%) 125 IPS (100%)	11	71

REFER TST6220 IN MAINTENANCE MANUAL

Should be 88% ∿ 112%.

TST6224 JYOMT6T Graphic Option

When JYOMT6T runs, if characteristic graphs are output with specifying graphic option, the outlines of the graphs are to be as follows.

Each measurement condition is shown with the following format.

(Test mode ← Last-MT-status, density, speed mode)

(1) (WRT ← WRT, GCR, Normal)



(2) (RDB + RDB, GCR, Normal)



(3) (RDB ← RDF, GCR, Normal)



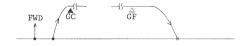
(4) (RDF ← RDF, GCR, Normal)



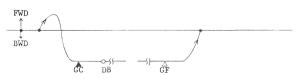
(5) (RDF ← RDB, GCR, Normal)



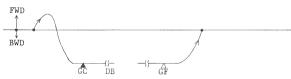
(6) (WRT ← WRT, PE, Normal)



(7) (RDB + RDB, PE, Normal)



(8) (RDB + RDF, PE, Normal)



(9) (RDF ← RDF, PE, Normal)



(10) (RDF ← RDB, PE, Normal)



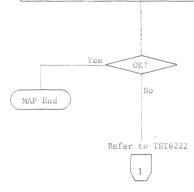
Diagnosis of Capstan High Start/Stop Characteristics and Tape Speed [JYOMT6U]



Load the Section JYOMT6U of OLTE and diagnosis the operation relating to the tape running.

Allowable range are as follows.

- 1. Start/stop characteristics are as shown in TST6226.
- 2. The max, speed percentage should be less than 112% and the min, should be more than 88%.



TST6226 JYOMT6U Output

JYOMT6U V-01 L-00 RTN 01 DEV/LN 0780 REFNO 0 CAPSTAN HIGH START/STOP, TAPE SPEED CHECK

< CAPSTAN CHARACTERISTIC TEST >>

MTU SPEED MODE = HIGH MTU DENSITY MODE = GCR

TEST	LAST MT STATUS	BLOCK	START TIME(MS) FTP	VELOCITY MINIMUM	125 IPS=1 AVERAGE		STOP TIME(MS)	FTP
WRT	WRT	1	6.4 ^{max} 54 ^{max}	199 IPS (099%) 199 IPS	200 IPS (100%) 200 IPS	202 IPS (101%) 201 IPS	24.0 ^{max} 2	
WRT	RDF	2	24.0 ^{max} 254 ^{max}	(099%)	(100%)	(100%)	11	11
WRT	RDB	3	24.0 ^{max} 254 ^{max}	199 IPS (099%)	200 IPS (100%)	201 IPS (100%)	11	11
RDB	RDB	1	15.0 ^{max} 127 ^{max}	200 IPS (100%) 200 IPS	202 IPS (101%) 202 IPS	204 IPS (102%) 203 IPS		78 ^{max}
RDB	RDB	2	17 11	(100%) 201 IPS	(101%) 201 IPS	(101%) 202 IPS	17	11
RDB	RDB	3	11 11		(100%)		TŤ	71
RDB	RDF	1	15.0 ^{max} 127 ^{max}	202 IPS (101%) 201 IPS	202 IPS (101%) 202 IPS	203 IPS (101%) 204 IPS	7.8 ^{max}	78 ^{max}
RDB	RDF	2	73 11	(100%) 201 IPS	(101%) 203 IPS	(102%) 204 IPS	11	11
RDB	RDF	3	11 11		(101%)		11	11
RDF	RDF	1	7 ^{max} 58 ^{max}	199 IPS (099%) 200 IPS	199 IPS (099%) 200 IPS	200 IPS (100%) 201 IPS	18.0 ^{max} 1	66 ^{max}
RDF	RDF	2	77 23	(100%)	(100%)	(100%)	11	11
RDF	RDF	3	0 11	200 IPS (100%)	200 IPS (100%)	201 IPS (100%)	11	11
RDF	RDB	ı	7 ^{max} 58 ^{max}	200 IPS (100%) 200 IPS	200 IPS (100%) 200 IPS	201 IPS (100%) 201 IPS	18.0 ^{max} 1	66 ^{max}
RDF	RDB	2	11 11	(100%)	(100%)	(100%)	77	11
RDF	RDB	3	ts ti	200 IPS (100%)	200 IPS (100%)	200 IPS (100%)	11	11

REFER TST6220 IN MAINTENANCE MANUAL

Should be 88% ∿ 112%.

JYOMT6U V-01 L-00 RTN 01 DEV/LN 0780 REFNO 0 CAPSTAN HIGH START/STOP, TAPE SPEED CHECK

<< CAPSTAN CHARACTERISTIC TEST >>

MTU SPEED MODE = HIGH MTU DENSITY MODE = PE

TEST	LAST MT		START	VELOCITY	125 IPS=1	.00%	STOP
MODE	STATUS	BLOCK	TIME(MS) FTP	MINIMUM	AVERAGE	MAXIMUM	TIME(MS) FTP
WRT	WRT	1	6.4 ^{max} 54 ^{max}	197 IPS (098%) 199 IPS	200 IPS (100%) 200 IPS	201 IPS (100%) 201 IPS	26.0 ^{max} 282 ^{max}
WRT	RDF	2	24.0 ^{max} 270 ^{max}	(099%) 199 IPS	(100%) 200 IPS	(100%) 202 IPS	11 11
WRT	RDB	3	11 11	(099%)	(100%)	(101%)	53 44
RDB	RDB	1	15.0 ^{max} 127 ^{max}	202 IPS (101%) 203 IPS	203 IPS (101%) 203 IPS	204 IPS (102%) 204 IPS	7.8 ^{max} 78 ^{max}
RDB	RDB	2	11 61	(101%) 203 IPS	(101%) 204 IPS	(102%) 204 IPS	11 11
RDB	RDB	3	11 [1	(101%)	(102%)	(102%)	33 918
RDB	RDF	1	15.0 ^{max} 127 ^{max}	204 IPS (102%) 203 IPS	204 IPS (102%) 204 IPS	204 IPS (102%) 204 IPS	7.8 ^{max} 78 ^{max}
RDB	RDF	2	11 11	(101%) 202 IPS	(102%) 203 IPS	(102%) 204 IPS	11 88
RDB	RDF	3	11 11	(101%)	(101%)	(102%)	11 11
RDF	RDF	1	6.8 ^{max} 56 ^{max}	199 IPS (099%) 199 IPS	200 IPS (100%) 201 IPS	200 IPS (100%) 202 IPS	18.0 ^{max} 197 ^{max}
RDF	RDF	2	11 11	(099%) 199 IPS	(100%) 200 IPS	(101%) 201 IPS	44 11
RDF	RDF	3	ti ff	(099%)	(100%)	(100%)	tt 11
RDF	RDB	1	6.8 ^{max} 56 ^{max}	199 IPS (099%) 200 IPS	200 LPS (100%) 200 TPS	201 IPS (100%) 201 IPS	18.0 ^{max} 197 ^{max}
RDF	RDB	2	11 11	(100%) 200 TPS	(100%) 201 IPS	(100%) 202 IPS	11
RDF	RDB	3	77 18	(100%)	(100%)	(101%)	11 11

REFER TEST6220 IN MAINTENANCE MANUAL

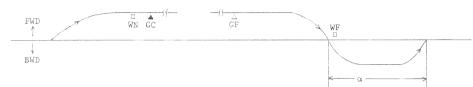
Should be 88% ∿ 112%.

When JYOMT6U runs, if characteristic graphs are output with specifying graphic option, the outlines of the graphs are to be as follows.

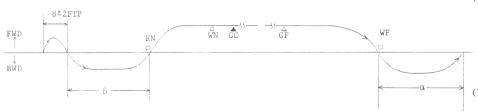
Each measurement condition is shown with the following format.

(Test mode + Last MT status, density, speed mode)

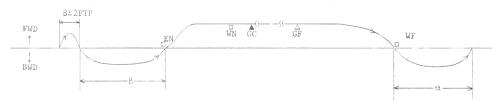
(1) (WRT ← WRT, GCR or PE, High)



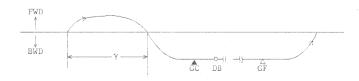
(2) (WRT + RDF, GCR or PE, High)



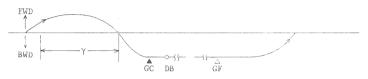
(3) (WRT ← RDB, GCR or PE, High)



(4) (RDB ← RDB, GCR or PE, High)



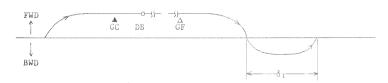
(5) (RDB + RDF, GCR or PE, High)



(6) (RDF ← RDF, GCR or PE, High)

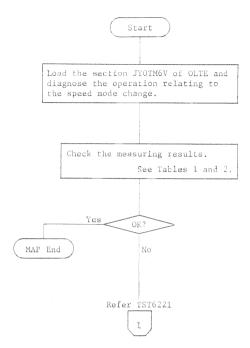
FWD	<b>G</b> C	 3	Λ
₩D			5.

(7) (RDF ← RDB, GCR or PE, High)



 $\alpha = \begin{cases} 138\pm5 & \text{FTP} & \dots & \text{GCR} \\ 138\pm5 & \text{FTP} & \dots & \text{PE} \end{cases}$   $\beta = \begin{cases} 90\pm5 & \text{FTP} & \dots & \text{GCR} \\ 107\pm5 & \text{FTP} & \dots & \text{PE} \end{cases}$   $\gamma = \begin{cases} 80\pm5 & \text{FTP} & \dots & \text{GCR} \\ 80\pm5 & \text{FTP} & \dots & \text{PE} \end{cases}$   $\delta_1 = \begin{cases} 96\pm5 & \text{FTP} & \dots & \text{GCR} \\ 96\pm5 & \text{FTP} & \dots & \text{PE} \end{cases}$ 

TST6228 Diagnosis of Capstan Positioning Characteristics Changing Speed Mode [JYOMT6V]



### Table 1

JYOMT6V V-01 L-00 RTN 01 DEV/LN 0780 REFNO 0 CHANGE SPEED CAPSTAN POSITIONING CHECK

<< CAPSTAN CHARACTERISTIC TEST >>

MTU DENSITY MODE = GCR

TEST MODE	LAST MT STATUS	POSITIONING TIME(MS) FTP			
NORMAL SPEED	WRT RDB RDF	30.0 max 234±5 10.0 max 56±5 10.0 max 70±5			
HIGH SPEED	WRT RDB RDF	10.0 max 70 5 10.0 max 70±5 10.0 max 57±5			

REFER TST6220 IN MAINTENANCE MANUAL

Table 2

JYOMT6V V-01 L-00 RTN 01 DEV/LN 0780 REFNO O CHANGE SPEED CAPSTAN POSITIONING CHECK

<< CAPSTAN CHARACTERISTIC TEST >>

MTU DENSITY MODE = PE

TEST MODE	LAST MT STATUS	POSITIONING TIME(MS) FTP
NORMAL SPEED	WRT RDB RDF	30.0 max 241±5 10.0 max 37±5 10.0 max 59±5
HIGH SPEED	WRT RDB RDF	10.0 max 36±5 10.0 max 52±5 10.0 max 45±5

REFER TST6220 IN MAINTENANCE MANUAL

TST6229 JYOMT6V Graphic Option	

When JYOMT6V runs, if characteristic graphs are output with specifying graphic option, the outlines of the graphs are to be as follows.

Each measurement condition is shown with the following format.

(Last MT status, test speed mode ← Last speed mode)

(1) (WRT, HSP + NSP)



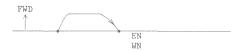
(2) (RDF, HSP ← NSP)



(3) (RDB, HSP ← NSP)



HSP: High speed NSP: Normal speed (4) (WRT, NSP + HSP)



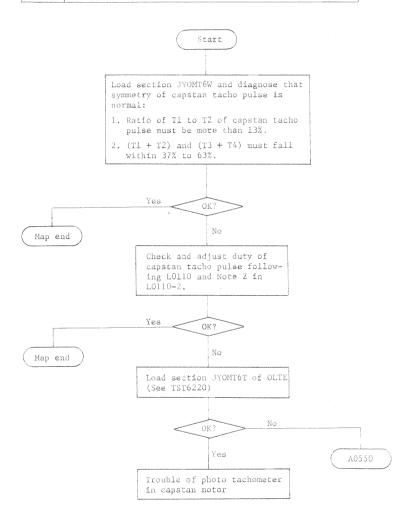
(5) (RDF, NSP + HSP)



(6) (RDB, NSP + HSP)



TST6230 Diagnosis of a Symmetry of Capstan Tacho Pulse [JYOMT6W]

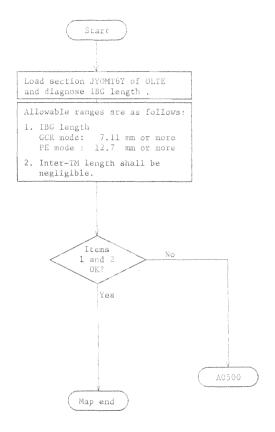


Note: Refer to section JYOMT6W in the OLTE diagnostic manual for output formats and detailed diagnosis.

A06	JYOMT6W CAPSTAN AS			O1 DEV/	LN 01E0	REFNO O
A06 A06	TACHO PU	LSE ASYM	METRY CH	ECK		
A06		MTU	SPEED	MODE = N	ORMAL	
A06		MTU	DENSITY	MODE = P	E	
A06						
A06		MIN	AVG	MAX		
A06						
A06				28.78		
A06		912.00	976.25	568.00	(MM)	
A06						
A06				26.13		
A06		208.00	833,85	240.00	(MM)	
A06					6.00	
A06	Т3			28.66		
A06		160.00	292.41	360.00	(MM)	
A06		0. / 1	00.07	26.25	/ 0/ \	
A06	T4			26.25		
A06		416.00	480.23	656.00	(rm)	
A06	md (m)	/0.00	E0 21	E0 97	(%)	
A06	T1+T2			50.84		
A06		320.00	810.11	608.00	(PIPI)	
A06	T3+T4	40 15	50 17	51 17	(%)	
A06 A06	13714			232.00		
A06		120.00	112.01	232,00	(1111)	
A06						
A06	REFER TST	6230 TN	MATNITENA	NCE MANIL	Δ1.	
2500	KELTY TOT	0230 111	TTET TAT T TITLE	131110:		

Fig. 1 Example

TST6240 Diagnosis of IBG (Interblock Gap) Length [JYOMT6Y]



Note: Refer to section JYOMT6Y in the OLTE diagnostic manual for output formats and detailed diagnosis.

Fig. 1 Output examples of JYOMT6Y

JYOMT6Y V-01 L-00 RTN 02 DEV/LN 01E0 REFNO 0

IBG	LENGTH CHECK		 DENSITY SPEED		PE NORMAL
	WRT-WRT-BSB	WRT-WRT-BSB-FSB	(MM)		
MIN	18.83	15.30			
AVG	19.07	15.48			
MAX	19.31	15.54			

REFER TST6240 IN MAINTENANCE MANUAL

JYOMT6Y V-01 L-00 RTN 01 DEV/LN 01E0 REFNO 0 IBG LENGTH CHECK TEST - 1

IBG	LENGTH CHECK		MIU DENSITY MIU SPEED	MODE = GCR MODE = NORMAL
	BLOCK - BLOCK	TM TM	BLOCK - ERG	- BLOCK (MM)
MIN	07.71	95.62	95.62	
AVG	07.77	95.73	96.09	
MAX	07.83	95.85	96.27	

REFER TST6240 IN MAINTENANCE MANUAL

JYOMT6Y V-01 L-00 RTN 02 DEV/LN 01E0 REFNO 0 IBG LENGTH CHECK TEST - 2

IBG	LENGTH CHECK		 DENSITY SPEED		GCR NORMAL
	WRT-WRT-BSB	WRT-WRT-BSB-FSB	(MM)		
MIN	09.26	09.26			
AVG	09.44	09.26			
MAX	09.62	09.32			

REFER TST6240- IN MAINTENANCE MANUAL

APPENDIX

FRU CODE TABLE

#### How to use the FRU code table

The F617/8 MT subsystem provides a total of 24 sense bytes, sense bytes 22 and 23 of which indicate the FRU code. The meaning of the FRU code depends on the contents of the other sense bytes. The FRU code table summarizes the contents and meaning of the FRU code.

In the F617/8 MT subsystem, the FRU code (sense bytes 22 and 23) is set in the following two ways:

- (1) When an error is detected and the sense bit associated with the error is set, the current status information is set in sense bytes 22 and 23 to help the user analyze the error.
- (2) When an error is detected and the sense bit associated with the error is set, the error reason code is set in sense byte 22 and the contents of a related register, if required, are moved to sense byte 23.

#### Analysis of the FRU code

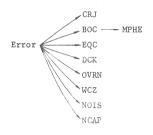
 First check the sense bit(s) indicated in the SENSE BIT INDICATION field of this table.

In the SENSE BYTE 22 and 23 fields, 'xx' indicates the error code (in hexadecimal) and (xxxx) indicates the status information.

When the contents of sense byte 22 match one of the error codes of this table, the cause of the error will be found in the DESCRIPTION field of this table. Most error codes are accompanied by status information in the SENSE BYTE 23 field, in which case the user can analyze the current status by referring to the DESCRIPTION field.

When sense byte 22 contains status information, the meaning of the bits of both sense bytes 22 and 23 will be found in the DESCRIPTION field.

(2) When two or more sense bits are set, first check sense byte 0 or 1.



SENSE BIT INDICATION	CONTENT OF SENSE BYTE 22	CONTEN OF SENSE BYTE 23	DESCRIPTION
	,01,	(CMD)	An invalid command was received from a channel. (CMD) indicates the command code. Check the CCW.
C R J  Command Reject [: byte 0, bit 0]	,02,	(CMD)	An Unconditional Reserve command ('14'), Tape Unit Reserve command ('B4'), or Tape Unit Release command ('94') was issued to an MTC that is in the I-compatible mode. Or, a Controller Reserve command ('F4') or Controller Release command ('D4') was issued to an MTC that is not equipped with the two-channel switch option.  (CMD) indicates the command code. Check the CCW, the MTC operation mode, and present of the two-channel option.
	'03'	(LCMD)	A DSE command ('97') was received from a channel, but it was not chained to an Erase command. (LCMD) indicates the last command code. When (LCMD) = '17', check the command chain flag. When (LCMD) # '17', check the CCW of the command that was entered immediately before the DSE command.
	1041	(CMD)	A Write ('01'), Write Tape Mark ('1F'), or Erase ('17') command was issued to an MTU that was file-protected. (CMD) indicates the command code.
	1051	(SDIA1)	The MTU was file-protected but it was directed to perform a diagnostic transfer operation, such as Capstan Transfer Write (SDIAl = 'AA'), Time Sense Transfer Write (SDIAl = 'AC'), or Erase Transfer (SDIAl = 'AD'). (SDIAl) indicates the diagnostic transfer code (diagnostic flag byte 1 of the SDIA command).
	1061	(SDIA1)	The MTU was directed to perform a diagnostic transfer operation while it was detecting the TWA or BOT. (SDIAL) indicates the diagnostic transfer code (diagnostic flag byte 1 of the SDIA command). When the MTU is in the TWA state, TI (sense byte 4, bit 2) is set. When the MTU is in the BOT state, BOT (sense byte 1, bit 4) is set.
	*07	(SDIAL)	An invalid diagnostic transfer code was specified. (SDIAL) indicates the accepted diagnostic transfer code (diagnostic flag byte 1 of the SDIA command). The following are valid diagnostic transfer codes. All other codes are considered invalid.
			'2A': CAP XFR FWD '6A': CAP XFR BWD 'AA': CAP XFR WRT 'EA': CAP XFR CGSP '29': ASYM XFR '2E': IBGL XFR 'AG': TS XFR WRT '2C': TS XFR FWD '6C': TS XFR BWD 'AD': ERS XFR '08': CHBF XFR
	1081	***	Not used

SENSE BIT INDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
CRJ	1091	(CMD)	A Sense & Controller Reserve ('F4'), Sense & Controller Release ('D4'), Sense & Tape Unit Reserve ('B4'), or Sense & Tape Unit Release ('94') command was issued midway in a command chain. (CMD) indicates the accepted command code. Check the CCW.
[Command Reject : byte 0, bit 0]			
	The state of the s	Ann	
	The state of the s		
	To the state of th		
	*OF*	(SDIA1)	The MTU was operating in the 800 rpi mode, but was directed to perform a diagnostic transfer operation. (SDIA1) indicates the accepted diagnostic transfer code (diagnostic flag byte 1 of the SDIA command).

SENSE BIT	INDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
		*BO*	(СНВО)	A parity error was detected in a command code that was received from a channel. (CHBO) indicates the received command code (contents of the channel bus out register).
B 0 C				
Bus Out Check [: byte 0, bit	2]			
	MPHE	,00,	*FF*	An error was detected during execution of the microprocessor (MTC) self-test routine.
	[MP Hardware Error]; byte 4, bit 0			
100000000000000000000000000000000000000	*1			
The second secon				
		'40' '67'	(W5)	An error was detected while conducting an EXR bit ON test in the diagnostic routine when the MTC power was turned on. Sense byte 22 indicates the address of the EXR register where the error was found. (W5) indicates the bit position that failed to turn on (flagged by a 'l').
		'70' ) '97'	(W5)	An error was detected while conducting an EXR bit OFF test in the diagnostic routine when the MTC power was turned on. The contents of sense byte 22 minus '30' equals the address of the EXR register where the error was detected. (W5) indicates the bit position that failed to turn off (flagged by a '1').
		1981	(MODE)	The MCY bit (bit 0 of the MODE register) failed to turn on during execution of the diagnostic routine when the MTC power was turned on. (MODE) indicates the contents of the MODE register immediately after the error was detected.
		1991	(MODE)	The MCY bit (bit 0 of the MODE register) failed to turn off during execution of the diagnostic routine when the MTC power was turned on. (MODE) indicates the contents of the MODE register immediately after the error was detected.
AND CO.	D. COLORGISTO DE STANDARDO STANDARDO STANDARDO STANDARDO STANDO STANDARDO ST			

^{*1:} A BOC error is reported with the MTHE bit indication when an error is detected during diagnostics performed when the MTC power is turned on or the MTC is idle, or for the purpose of indicating the cause of an ICC (Interface Control Check) that occurred immediately before the error.

SENSE BIT IN	NDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
B O C  Bus Out Check : byte 0, bit 2	[MP Hardware Error]: byte 4, bit 0	'D0' ~ 'D8'	(TMCTL)	An error was detected while conducting a timer circuit test in the diagnostic routine when the MTC power was turned on. (TMCTL) indicates the contents of the TMCTL register immediately after the error was detected.  TMCTL register (EXR address '40')  Count mode  MCTO MCT1 CQTP  Count mode  1 0 0 FTP count mode  1 0 1 QTP count mode  x 1 0 FTP interval count mode  x 1 1 QTP interval count mode
		'D0' 'D1' 'D2' 'D3' 'D4' 'D5' 'D6' 'D7'	(TMCTL)	An attempt was made to reset the timer trap mask bit (M.TMR bit), but the bit was not reset.  An attempt was made to reset the CTRU bit, but it failed.  The initial value was set in the upper half of the counter, but the counter input mode was not changed to the lower mode (CTRU bit '0').  The initial value was set in the lower half of the counter, but the counter input mode was not changed to the upper mode (CTRU bit '1').  The counter started operation (in the 1.66 µs clock count mode), but did not indicate the expected value after a certain time interval elapsed.  No carry signal is detected from the timer circuit after a certain time interval.  A carry signal was detected from the timer circuit, but the lower half of the timer value was not 'FF' at that moment.  A carry signal was detected from the timer circuit, but the upper half of the timer value was not 'FF' at that moment.

SENSE BIT INDIC	CATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
ВОС		'DA'	(Shift Count)	An error was detected while conducting a serial scan test of all flip-flops of the write circuit LSIs (the LSIs installed in the PCA 512186, namely one 61504 and one 61506) in the diagnostic routine when the MTC power was turned on. (Shift count) indicates the scan shift count.
Bus Out Check [: byte 0, bit 2]		'DB'	(Shift Count)	An error was detected while conducting a serial scan test of all flip-flops of the Read circuit LSIs (the LSIs installed in the PCA 512188, namely three 61507s, three 61508s, and one 61509) in the diagnostic routine when the MTC power was turned on. (Shift count) indicates the scan shift count.
М	PHE			
	MP Hardware Error : byte 4, bit 0			
		*FO*	(MPERR)	A processor failure was detected when the MTC was idle. (MPERR) indicates the contents of the MPERR register immediately after the error was detected.
				0 1 2 3 4 5 6 7  MPERR register (EXR address '61')  RENB OFL CSPE REGE MECO MEC1 MEC2 MEC3  MTC EC LEVEL  Register error: A parity error was detected while accessing the LSR.
			And the state of t	CS parity error: A parity error was detected while accessing the CS.
				Set to 'l' when the MTC is offline.
				LSet to '1' when the LSR initialization has been completed. The LSR is initialized when the power is turned on.  LSR: Local Storage Register  CS : Control Storage for microprogram
		* F 1 *	(Check result)	An error was detected during execution of the check-out routine when the MTC was idle. (Check result) indicates the value obtained by the check-out routine. The normal result is '8B'.

SENSE BIT IN	DICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
		*F2*	(TRAP)	An unaccountable trap was detected in the MTC microprocessor. (TRAP) indicates the contents of the TRAP register immediately after the trap occurred.
B O C  Bus Out Check  Substitute 1: byte 0, bit 2	MPHE			0 1 2 3 4 5 6 7  TRAP register (EXR address '60')  Timer trap  MTU interrupt trap  O 1 2 3 4 5 6 7  T.INT T.TMR T.INS T.PER M.INT M.TMR M.INS TMSK  Mask bit for each trap  Processor error trap  Initial selection trap
	MP Hardware Error; byte 4, bit 0	'F5'	(MCYENT)	A processor failure was detected while the MTC was executing a command or during a system reset or selective reset operation.  Sense byte 22 = 'F5' When the OPI signal is on (under connection to a channel).  Sense byte 22 = 'F6' When the OPI signal is off (control command, etc.).  When a failure is detected, an interface disconnect signal is sent to the channel.  (MCYENT) indicates the contents of the MCYENT register when the failure was detected.  O 1 2 3 4 5 6 7  MCYENT register LONG SHORT STRM STRM WT SKIP BR BR  (EXR address '1B') CRS TURN MODE FLAG CMD CMD CODEO CODE1  Long crease Branch code  flag bit.  Short turnaround Short turnaround flag bit.  Streaming mode control flag bits
		*F7*	(DVA)	An error was detected in the contents of the DVA register when the selective reset routine was to be executed. (DVA) indicates the contents of the DVA register immediately after the error was detected.  O 1 2 3 4 5 6 7  DVA register  (EXR address '2F')  Device address
		*F8*	LSR address	An error was detected while conducting an LSR read/write test in the diagnostic routine when the MTC power was turned on. (LSR address) indicates the LSR address where the error was found.
		'F9'	(LSR#00)	When the MTC power was turned on, an LSR read/write test of the diagnostic routine was conducted. In the test, an attempt was made to set 'FF' in the register at LSR address '00', but some of the register bits remained reset. (LSR#00) indicates the date read from the register at LSR address '00' when the error was detected.

SENSE BIT IN	DICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
ВОС		*FA*	(IFSTA)	A system reset or selective reset operation was requested from channel interface A, but the reset operation was not completed normally since the SERA or SYRA signal was not reset. (IFSTA) indicates the contents of the IFSTA register immediately after the error was detected.
Bus Out Check : byte 0, bit 2	MPHE  [MP Hardware Error] : byte 4, bit 0			O 1 2 3 Set to '1' when the channel interface A route is enabled.  (EXR address '5B')  CUB status  transfer flag  Suppress out signal of channel interface A.  Set to '1' when a selective reset signal is accepted from channel interface A.  Set to '1' when a selective reset signal is accepted from channel interface A.  Set to '1' when a selective reset signal is accepted from channel interface A.  Set to '1' when the channel interface A route is enabled.  Set to '1' when an unconditional reset signal is received from the MTC at the other end.  Set to '1' when the MTC channel switch is set to channel interface B.  Set to '1' when the MTC channel switch is set to the channel interface A.
		* FB *	(IFSTB)	A system reset or selective reset operation was requested from channel interface B, but the reset operation was not completed normally since the SERA or SYRA signal was not reset. (IFSTB) indicates the contents of the IFSTB register immediately after the error was detected.
				O 1 2 3 4 5 6 7  IFSTB register (CUBSB SPOB SERB SYRB IFONB OPOB 'O' 2CHSN)  (EXR address '66')  CUB status
			Total Control of the	Suppress out signal of
		'FC'	(IFSTA)	When the MTC power was turned on, the microprocessor was reset although no reset signal was issued from a channel. Or, an attempt was made to execute the reset routine, but the cause of the reset is unaccountable. (IFSTA) indicates the contents of the IFSTA register when the error was detected.
		FE	(LSR address)	An attempt was made to clear a particular LSR register, but it was not cleared even after the clear operation was retried. (LSR address) indicates the address of the LSR register.
		'FF'	XX	An error was detected in the MTC microprocessor self-test routine that was executed when the MTC power was turned on or when a system reset or selective reset operation was performed.

SENSE BIT	INDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
E Q C			The second secon	
Equipment Check : byte 0, bit 3				
	MPHE  [MP Hardware Error]  ; byte 4, bit 0			
		*40*	(W5)	An error was detected in an EXR bit ON test when the Test MTC operation of the SDIA command being performed. The contents of sense byte 22 indicate the EXR register address where the error occurred. (W5) indicates the bit position that failed to turn on (flagged by a '1').
		7701 \$ 1971	(W5)	An error was detected in an EXR bit OFF test when the Test MTC operation of the SDIA command being performed. The contents of sense byte 22 minus '30' equal the EXR register address wh the error occurred. (W5) indicates the bit position that failed to turn off (flagged by a '
		1981	(MODE)	When the Test MTC operation of the SDIA command was being performed, the MCY bit (bit 0 of t MODE register) failed to turn on. (MODE) indicates the contents of the MODE register immediafter the error was detected.
		1991	(MODE)	When the Test MTC operation of the SDIA command was being performed, the MCY bit failed to t off. (MODE) indicates the contents of the MODE register immediately after the error was det
	MPTRP	,78,	NGM NGM	A microprocessor trap took place while a command was being executed (or when the MCY bit is
	[MP Trap : byte 11, bit 6]			but the cause of the trap was not found.

SENSE BIT	INDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
		'CD'	(CMD)	A command was decoded abnormally in the command code decoding routine. (CMD) indicates the contents of the CMD register at that moment, namely the command code that was accepted by the MTC.
E Q C [Equipment Check [: byte 0, bit 3]	Equipment Check,	'DE'	(MASK)	An error was found in the phase error pointer circuit during a 6250-rpi-mode phase error test when the Test MTC operation of the SDIA command was being performed. (MASK) has the contents of the MASK register at that moment, in which the bit position that caused the phase error is flagged by a 'l'. When (MASK) = '00', bit 8 caused the phase error. When (MASK) = 'FF', the error occurred in the block check circuit (both the DBOB and DIBG signals are set). Sense byte 2 contains the contents of the pointer that was actually detected. Sense byte 2 normally matches the value of (MASK).
		, DE,	(MASK)	An error was detected in the phase error pointer circuit during a 1600-rpi-mode phase error test when the Test MTC operation of the SDIA command was being performed. The contents of (MASK) and sense byte 2 are set in the same way as in the sense byte 22 = 'DE' case.
		*D0 *	(TMCTL)	An error was detected in a timer circuit test when the Test MTC operation of the SDIA command was being performed. (TMCTL) indicates the contents of the TMCTL register immediately after the error was detected. The bit pattern of the TMCTL register and the meaning of the error codes 'DO' to 'D8' are the same as for the BOC-MPHE errors.
The second secon		The state of the s		

SENSE BIT	INDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
E Q C				
[Equipment Check : byte 0, bit 3]	STRJ  Status Tag Reject  : byte 10, bit 0 ]	(DVBO)	(DVBI)	While the MTU was being controlled by a status tag, the MTU status response was interrupted by a timeout. (DVBO) indicates the tag control information received from the MTC, and (DVBI) indicates the MTU response at the timeout.  O 1 2 3 4 5 6 7  (DVBO) Set Set Set Set Set MTU Set Set Set Erase Read FWD Read BWD Write Status Reset 6250/800 1600 LWR  FERS=1 FWD=1 BWD=1 WRS=1 TUC=0 1600=0 1600=1 Same value FWD=1 ERS=0 ERS=0 ERS=1 (DVINT=0) SAGC=0  EXPECTED BWD=0 WRS=0 WRS=0 BWD=0 LWR=0 LWR=0 LWR=0 LWR=0 LWR=0 LWR=0 LWR=0 LWR=0 SAGC=0 SAGC
				0 1 2 3 4 5 6 7  (DVBI) — ERS FWD BWD WRS TUC SAGC 1600 LWR
	CMRJ  Command Tag Reject [: byte 10, bit 1 ]	(DVBO)	(DABI)	While the MTU was being controlled by a command tag, the MTU command tag response was interrupted by a timeout. (DVBO) indicates the command tag information received from the MTC, and (DVBI) indicates the MTU response at the timeout.  (DVBO)

SENSE BIT	INDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
EQC [Equipment Check : byte 0, bit 3]	CTRJ  Control Tag Reject : byte 10, bit 2	(DVBO)	(DVBI)	While the MTU was being controlled by a control tag, the MTU control tag response was interrupted by a timeout. (DVBO) indicates the control tag control information and (DVBI) indicates the MTU response at the timeout.  O 1 2 3 4 5 6 7  (DVBO)  Level Level Level Set Set Set Set Set Set O 1 2 TSIM EMK DSE REW UNL  Expected bit  Same value  TSIM=1 (RDY=0)  EMK=1 REW=1 (RDY=0)  O 1 2 3 4 5 6 7  (DVBI)  Level Level Level TSIM EMK DSE REW UNL
	TIRC  [Tag in Response Check [: byte 11, bit 2]]	'E8'	(DVBO)	The MTC accessed an MTU sense byte, but the MTU made no tag-in response. (DVBO) indicates the contents of the DVBO register when the error occurred.  (DVBO) = '00' when TUSEO was accessed '01' when TUSEO was accessed '02' when TUSE1 was accessed '08' when TUSE8 was accessed
	TCSF [Tacho Start Failure] [: byte 10, bit 5]	'DD'	(W1) -	The MTU was started, but the tape was not moved at least as far as specified in the specified direction within the specified time period.  (W0) = 108 [QTP] - Total distance the tape moved [QTP]  (W1) = 20 [QTP] - Total distance the tape moved in the specified direction [QTP]  Note that when the MTU operates in the high-speed mode and (W0) = 'DD' is set, this indicates that no CAPC signal was detected within one second after the GO signal was set. In this case, the contents of sense byte 23 are unpredictable.
	MPTRP  MP Trap [: byte 11, bit 6]	*74*	-	A processor trap took place because of an abnormally long tacho pulse cycle time.

SENSE BIT	INDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
EQC	DYRV	1001	(W1)	The MTU was started by th GO signal, but the tape was moved farther than specified in the opposite direction.  (W1) = Distance the tape moved in the specified direction before this error was detected [QTP] 108 - (W1) = Distance the tape moved in the opposite direction before this error was detected [QTF]
Equipment Check: byte 0, bit 3	Dynamic Reversal : byte 10, bit 4]	*EE*	(TSNS)	While the tape was moving in the backward direction, the ARA ID Burst was detected but, no BOT marker was detected after that within a certain distance. (TSNS) indicates the time sense output produced when this error was found.
	VLCK Velocity Check [: byte 10, bit 7]	FTP cycle time Upper	FTP cycle time Lower	The MTU was started, but the nominal tape speed was not reached within a certain distance. Sense bytes 22 and 23 indicate the FTP cycle time when this error was detected. $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$
	IBGD  [BF detect [: byte 8, bit 0]	(TSNS)	(BLFMT)	The IBC was not detected within the specified time.  (TSNS) indicates the time sense information obtained when this error was detected, and  (BLFMT) gives block check information.  (TSNS)  (BLFMT)  0 1 2 3 4 5 6 7  0 1 2 3 4 5 6 7  (IO2) (DET8) TSNS8 DIBC DNIS DBOB DARA DTM  Each bit is set to '1' when a noise pattern is detected.  Set to '1' when the IBC pattern is detected.  Set to '1' when the ARA pattern is detected.  Set to '1' when a data block pattern is detected.

SENSE BIT INDICATION		CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
EQC  [Equipment Check : byte 0, bit 3]	WTMC  [Write Tape Mark Check			
	In the 1600/6250- rpi mode *2	(TSNS)	(BLFMT)	The tape mark was not be written correctly. (TSNS) and (BLFMT) give the time sense information and block check information (respectively) obtained when this error was detected. For the meaning of these information, see the EQC-IBGD error description.  If the tape mark is written normally, all TSNS bits of the tape mark except bits 1, 3, and 4 should be set to '1' and the DTM bit should also be set to '1'.
	In the 800-rpi	*31*	(ZCTL)	A tape mark byte that should have been wirtten could not be detected.
	mode *2	1321	(ZCTL)	The first byte written was not found to be a tape mark byte.
	^2	1331	(ZCTL)	A noise byte was detected between two tape mark bytes that had been written.
	THE STATE OF THE S	1341	(ZCTL)	Two tape mark bytes should have been written, but the second one could not be detected.
		'35'	(ZCTL)	Two tape mark bytes should have been written, but the second tape mark byte was not found.
		*36*	(ZCTL)	An abnormal noise byte was detected after two tape mark bytes that had been written.
			To the contract of the contrac	(ZCTL) indicates the hardware timing signal at the time when this error was detected.
				ZCTL register (SFCRC) LRC CRC HBLKN BLKED CRCHG CRCRG RPBS  Set to '1' when the LRC byte should have existed.  Set to '1' when the CRC byte should have existed.  Set to '1' when a certain byte was detected.  Set to '1' when a certain byte was detected.  Set to '1' when at least 5.3 bit cells have passed after the last byte was detected.  Set to '1' when at least 10.7 bit cells have passed after the last byte was detected.

*2: The 1600/6250 rpi mode and 800 rpi mode can be checked by referring to bit 5 of sense byte 3 (1600 rpi), bit 3 of sense byte 6 (Not Set 1600), and bit 4 of sense byte 6 (6250 TU).

6250TU	1600rpi	Not Set 16	00 mode
0	1	0	1600rpi
0	0	1	800rpí
1	1	0	-1600rpi
1	0	1	-6250rpi

SENSE BIT	INDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTIO	М
E Q C  Equipment Check  byte 0, bit 3	MPTRP  MP Trap [: byte 11, bit 6]				
	TI Tape Indicater [byte 4, bit 2]	1701	(DVBI)	While the MTU was operating in the test mode (that is , when the SDIA command was being executed or the MTU was offline from the MTC), the EOT marker was detected and a processor trap took place.	sense byte 0 when the processor trap occurred.
	BOT BOT 1:byte 1, bit 4	7707	(DVBI)	When the tape of the MTU was running in the back- ward direction, the BOT marker was detected and a processor trap took place.	0 1 2 3 4 5 6 7  BWD NOT TWA BOT WRS ONL TUC RDY
	A processor trap occurred because the MTU was inter- rupted by an SAG error.	Set to 'l' in the Not File Protect state.  Set to 'l' when the MTU is online.			
	FP File protect [:byte 1, bit 6]	*70*	(DVBI)	While data or a tape mark was being written or erased in the MTU, a file protect state was forced and a processor trap occurred.	Set to '1' Set to '1' while BOT while the MTU is detecting an error.  Set to '1' when the Set to '1'
	TUSTA  TU Status A  [:byte 1, bit 1]  &  TUSTB  TU Status B  [: byte 1, bit 2]  (TUST=11)	'70'	(DVBI)	While the MTU was skipping a file, it was interrupted because the tape had run farther than a certain distance (about 20 m) without detecting a tape mark, and a processor trap took place. (Tape overrun)	tape is at the TWA field when the MTU is ready.  Set to 'l' when' the backward direction.  Set to 'l' when the MTU is in a Write state.
	RJTU [Reject TU [:byte 4, bit 1]				
	IRQ [Intervention   Required   Libyte 0, bit 1]	*70*	(DVBI)	The MTU entered an IRQ state and a processor trap occurred while a command was being executed.	
	TCSF  [Tacho Start   Failure   byte 10, bit 5]	'74'	40-	A processor trap occurred because of an abnormally la	ong tacho pulse cycle time.
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SENSE BIT INDICATION		CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
E Q C	MPTRP [MP Trap : byte 11, bit 6]			
: byte 0, bit 3	RWOV [R/W overrun :byte ll, bit 0]	*77*	-	An abnormally long block was written or read.
	MPHE [MP Hardware Error :byte 4, bit 0]	1781	(DVBI)	A processor trap occurred while a command was being executed, but the cause of the trap was not found. (DVBI) indicates the contents of MTU sense byte 0 when the error occurred.
		'7F'	(DVBI)	A processor trap occurred because the MTU was interrupted, but the cause of the interrupt we not found. (DVBI) indicates the contents of MTU sense byte 0 when the error occurred.
	RJTU  [Reject Tapu unit] :byte 4, bit 1	, EO,	(DVSEL)	The tacho pulse cycle time became abnormally long while performing the Capstan XFR operation of the SDIA command. (DVSEL) indicates the contents of the DVSEL register at that moment.  O 1 2 3 4 5 6 7  DVSEL register (TAGI) (XCAL) *DVENB SLTAG DVBSY DVAO DVA1 DVA2 (EXR address '42')  Set to '1' when the MTU device enable switch is turned to the disable state.  Set to '1' when the MTU is busy with another MTC.  Set to '1' when the MTU is under control of this MTC.
		*E2*	(DVBI)	A TU check occurred while the MTU was being controlled by a command chain. (DVBI) indicates the contents of MTU sense byte 0 at that moment.
	WCALM [Write Circuit Alarm] :byte 6, bit 1	, OA ?	(DVBI)	An error was detected in the MTU write circuit. (DVBI) indicates the contents of MTU sense byte 0 when the error was detected.
	Noise   In the 6250 or 1600-rpi mode	(TSNS)	(BLFMT)	Noise was detected while the erase command was being executed or an additional erase operation was being performed. (TSNS) and (BLFMT) give the time sense information and block check information (respectively) obtained when the error was detected. (See the EQC-IBGD error description).

SENSE BIT	INDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
D C K [Data Check : byte 0, bit 4]	One of the following bits is set:  PCMP  [Parity Compare   byte 3, bit 7]  XBFC  [XFR buffer Check   byte 9, bit 2]  ORCE  [CRC error   byte 3, bit 3]  CRC3  [CRC3 Check   byte 9, bit 3]  WVRC  [Write VRC   Write VRC   byte 4, bit 3]	'lx'	(CRCST)	SENSE BYTE 22  0 1 2 3 4 5 6 7  0 0 0 1 1 0 ABRP DBCK WVRC  *MCRC *CRCZ EP≠CR B≠D B≠C *MCRCC A≠B XBIC  A/B register parity check  Deskewing buffer check  Set to '1' when a parity error is detected in write data after modulation  Set to '1' when a CRC error is detected in read data while reading or writing in the 6250 or 800-rpi mode.  Set to '1' when the CRC pattern (CRCA) generated by XFR buffer input does not match the CRC pattern (CRCB) generated by XFT buffer output.  Set to '1' when a parity error is detected in the XFR buffer input data. error pattern register.
	IBGD [IBG detect [: byte 8, bit 0]  SRDC [Start Read Check] [: byte 5, bit 4]  PREC [Partial record [: byte 5, bit 5]  POSAE [Postamble error [: byte 5, bit 6]	'A8'	(RDSNS)	Excessive drop-outs were detected while data writing, so the data write operation was stopped immediately. When this error occurs, the ENVC bit (Envelop Check: byte 3, bit 4) is also set. (RDSNS) indicates the contents of the RDSNS register set when this error was detected.  A drop-out was detected in the preamble.  A drop-out was detected in the data area.  A drop-out was detected in the postamble.

SENSE BIT IN	DICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
D C K  [Data Check : byte 0, bit 4]	IBDC (continued)			RDSNS register (EXR address '4D')  Set to '1' when a data block was detected.  Set to '1' when a block that could be identified as a data block was detected.  Set to '1' when a block was detected.  Set to '1' when the end of the preamble was detected.  Set to '1' when a tape mark block was detected.
	POSAE [Postamble error] : byte 5, bit 6	'DD'	The state of the s	A byte having a pattern other than the specified one was read between the beginning and end of the postamble.
	Others	*AA*	-	A tape mark block was detected, but while being read, it changed to a data block pattern. Therefore, the block was processed as a data block rather than a tape mark block.

SENSE BIT INDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
	*20*	(IFCTL)	The XFR buffer did not become idle after a certain time had elapsed after read operation.
OVRN  [Overrun	*21*	(IFCTL)	The XFR buffer became full during a read operation. Or, during a write operation, the XFR buffer became idle (in the 1600 or 800 rpi mode) or it was holding fewer bytes than specified (in the 6250 rpi mode) before the end of data transfer was reported from the channel. (OVRN signal)
. byte o, bit i	1221	(IFCTL)	When data was being transferred to or from the channel in the offset interlock mode, an abnormal SVO or DTO signal was detected. (OVRN2 signal)
		Opening and the state of the st	(IFCTL) indicates the contents of the IFCTL register set when the above errors were detected.  0 1 2 3 4 5 6 7
			IFCTL register (EXR address '5E') OVRN2 NO XTAG DXFE DXRQ (BIBSY) (NOT ABRPC) (NOT BOPC) (C.RCT)
			Set to 'l' when data transfer is requested by the read or write operation.  Set to 'l' when the end of data transfer is requested from the channel through the channel interface and data transfer between the MTC and channel has been completed.
	The state of the s		Set to 'l' when no SVO, SVI, DTO, or DTI signal is issued through the channel interface.  OVRN2 signal
W C Z	'FF'	Não .	The XFR buffer was not idle when data transfer was started to or from the channel for execution of a Write command.
[Word count zero]: byte 0, bit 6	1001	_	The interface was disconnected before data transfer was started to or from the channel for execution of a Write command.
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SENSE BIT INDICATION	CONTENT OF SENSE BYTE 22	CONTENT OF SENSE BYTE 23	DESCRIPTION
	(CHBI)	(TCADA)	The MTU speed mode does not match the VFO readable speed mode, (VFO Not capable)
N C A P  [Not Capable 1: byte 1, bit 7]			(CHBI)  0 1 2 3 4 5 6 7 0 1 2 3 4 5 6 7    VELO   VELI   (EXTF)   6250TU   STM   VFOH   VFOM   VFOL   TI
	(TSNS)	(BLFMT)	An ID Burst having a recording density unavailable in the MTU was detected.
			(TSNS) 0 1 2 3 4 5 6 7 0 1 2 3 4 5 6 7  TSNS 0 1 2 3 4 5 6 7  10 1 2 3 4 5 6 7  For details of (TSNS) and (BLFMT), see the EQC-IBGD error description.  (BLFMT) 10 1 2 3 4 5 6 7  10 1 2 3 4 5 6 7  Set to '1' when the IB Not Capable is detected.

^{*3:} VFO Not Capable and IB Not Capable are indicated in bit 0 of sense byte 23.